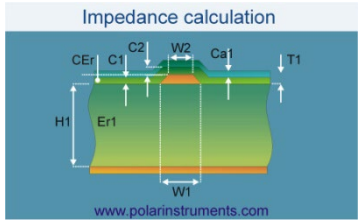

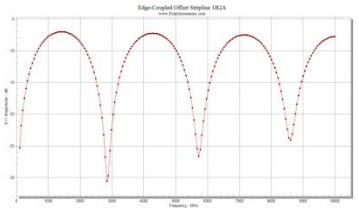

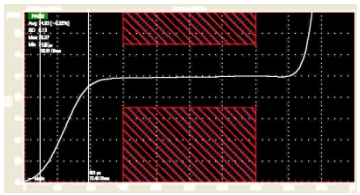

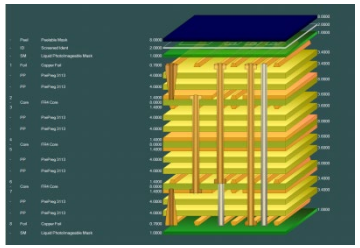

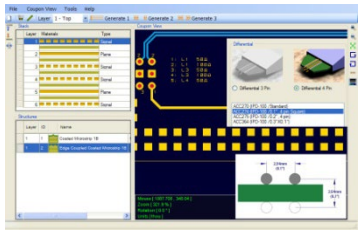

Speedstack 2026 Cumulative Updates

Richard Attrill – March 2026 (Rev 21)

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Speedstack v26.03.10 (March 2026)

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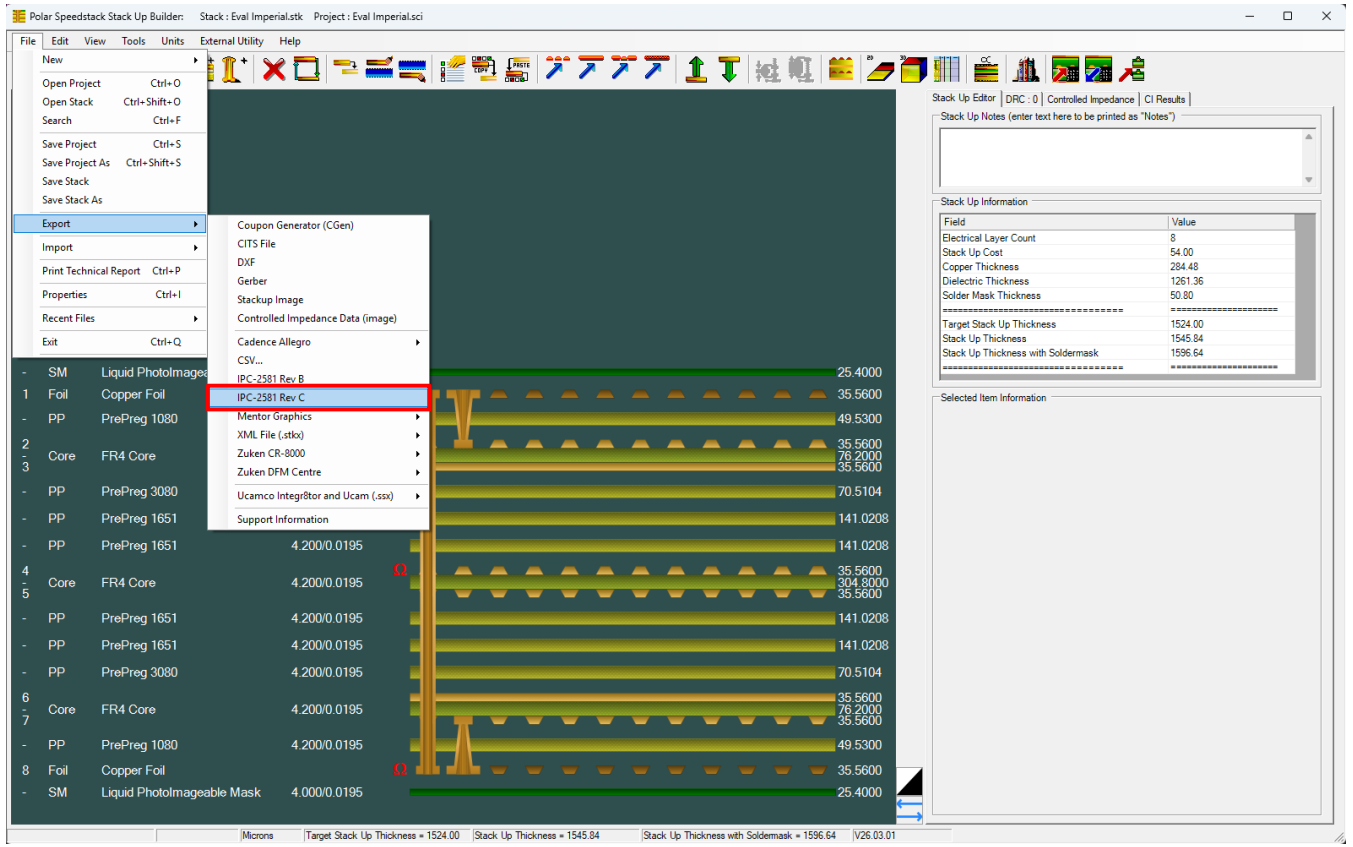
New File | Import / Export | IPC-2581 Rev C options



The new import / export IPC-2581 Rev C options allow for the transfer and exchange of stack up information with 3rd party systems that also support this format

IPC-2581 CONSORTIUM

Polar Instruments are a member of the IPC-2581 Consortium

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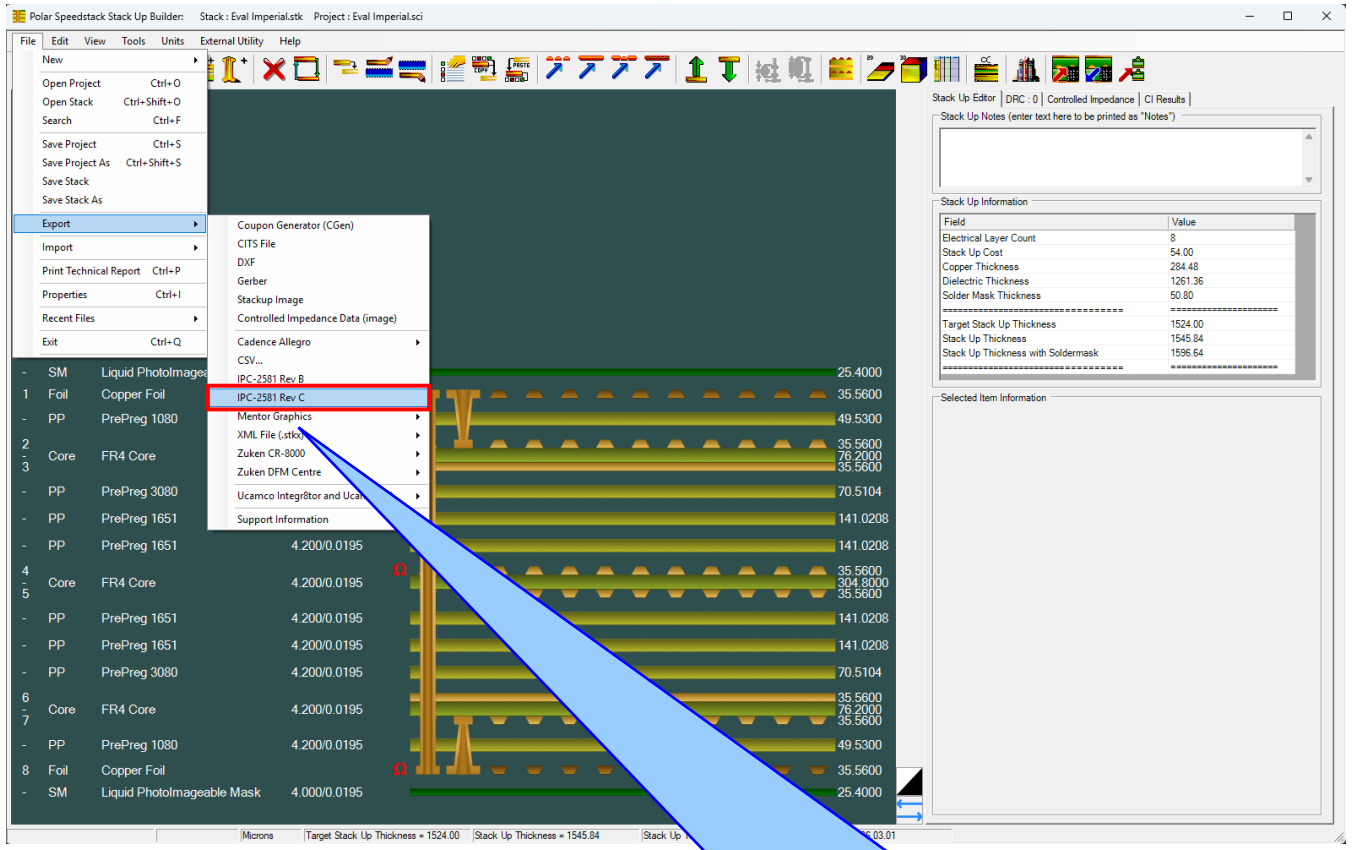
New File | Import / Export | IPC-2581 Rev C options



Rev C options allow for the transfer and exchange of stack up information with 3rd party systems that also support this format

Rev B Speedstack output supports one impedance structure per layer – Rev C supports multiple structures per layer.

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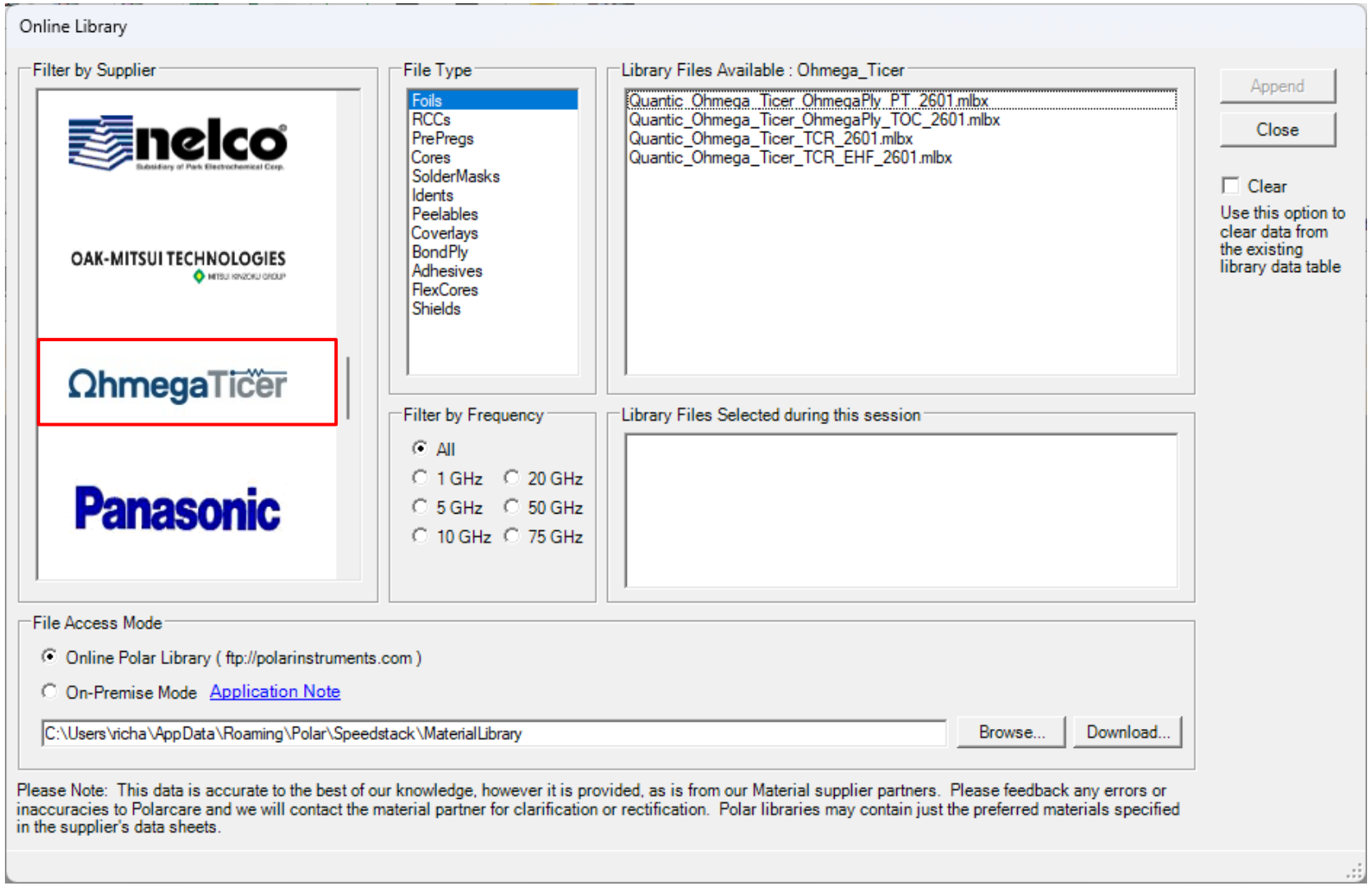
Ohmega Ticer materials added to the Online Library



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Enhancements

- FlexNet Publisher / FLEXlm v11.19.9.0 now supported

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Speedstack v26.01.02 (Jan 2026)

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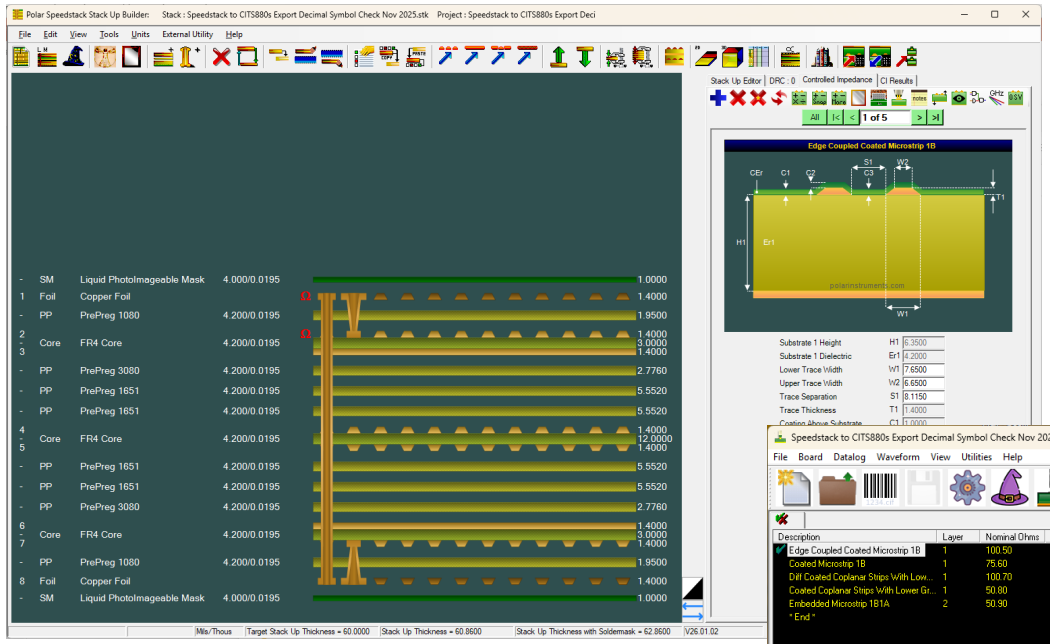
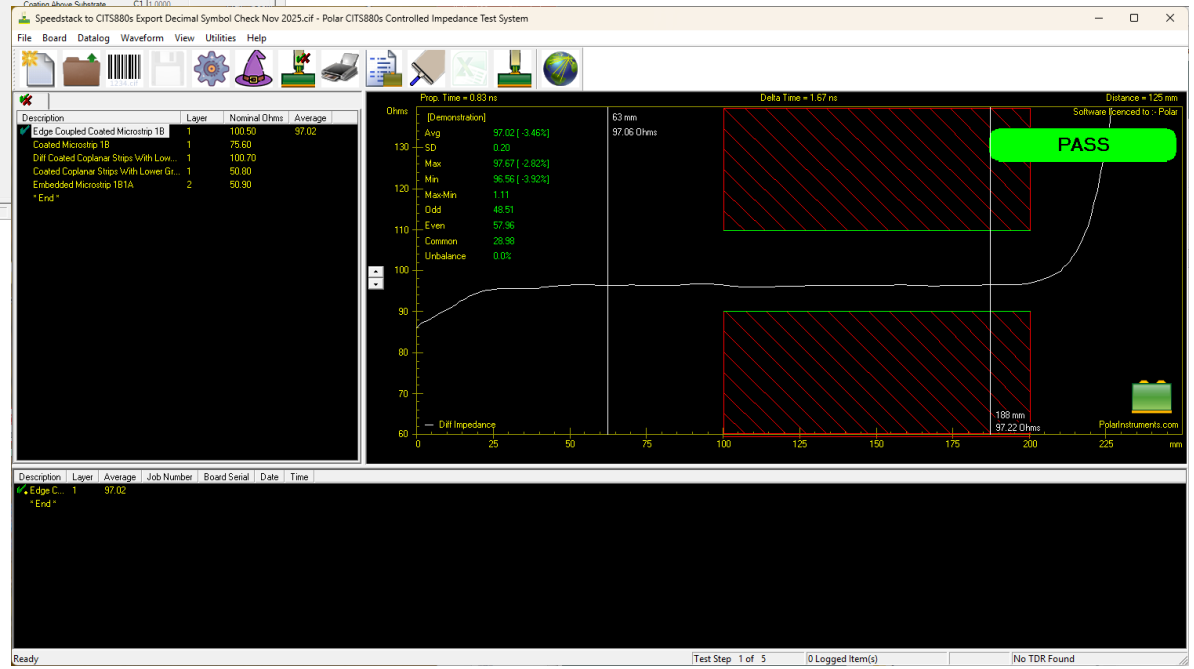
File | Export | CITS File enhancements



File | Export | CITS File enhancements include improved support for locales that use a comma as the decimal symbol



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Speedstack v26.01.01 (Jan 2026)

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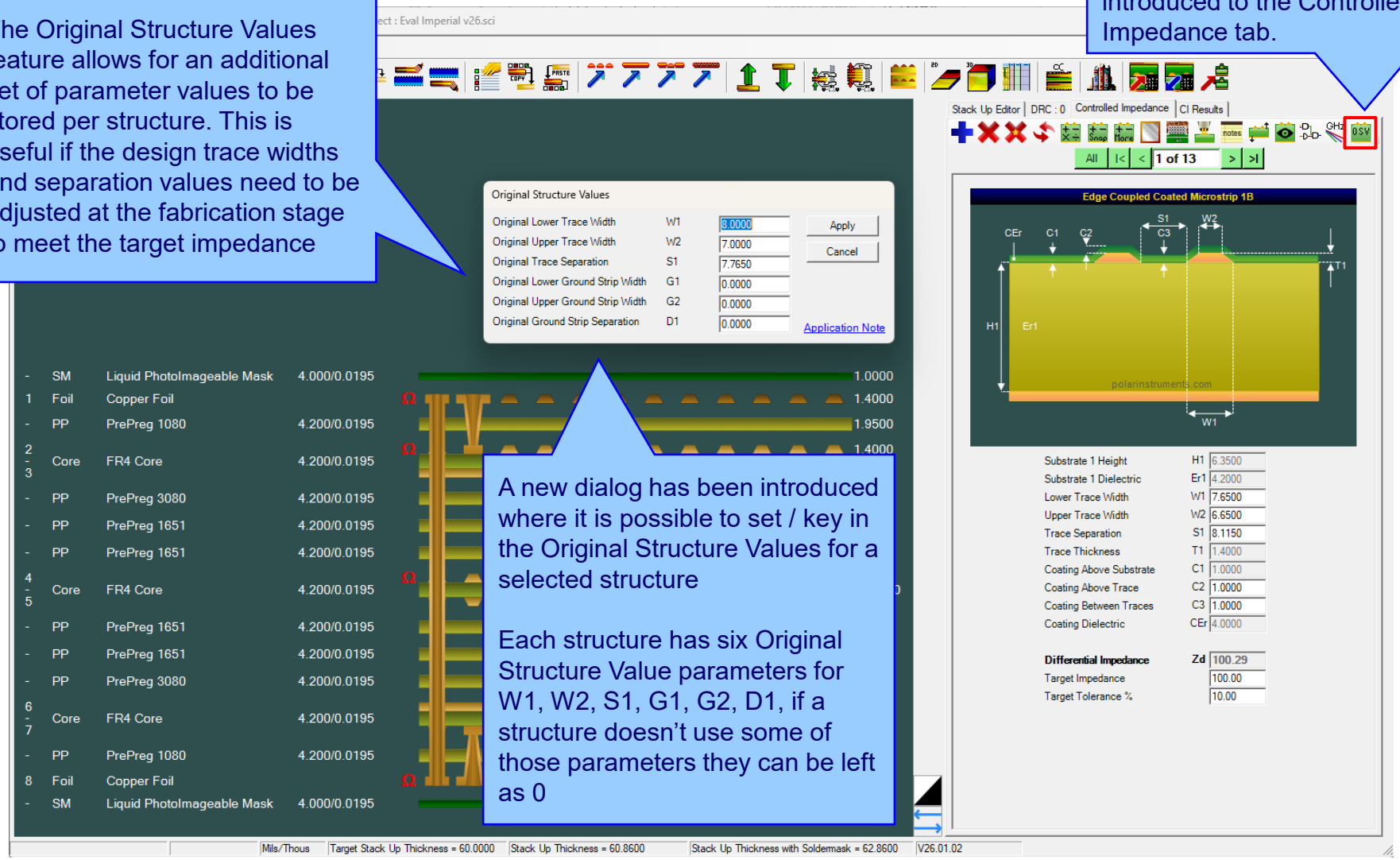
New Original Structure Values feature*

The Original Structure Values feature allows for an additional set of parameter values to be stored per structure. This is useful if the design trace widths and separation values need to be adjusted at the fabrication stage to meet the target impedance

A new Original Structure Values toolbar icon has been introduced to the Controlled Impedance tab.



A new dialog has been introduced where it is possible to set / key in the Original Structure Values for a selected structure

Each structure has six Original Structure Value parameters for W1, W2, S1, G1, G2, D1, if a structure doesn't use some of those parameters they can be left as 0

- Supports commonly used structures: See slide 12

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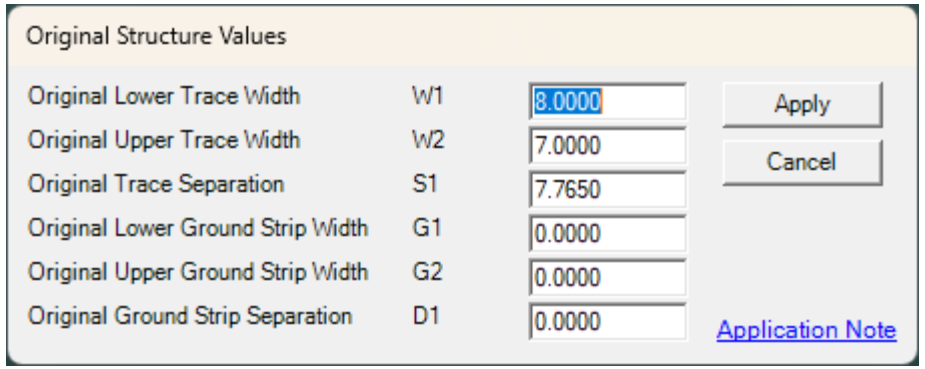
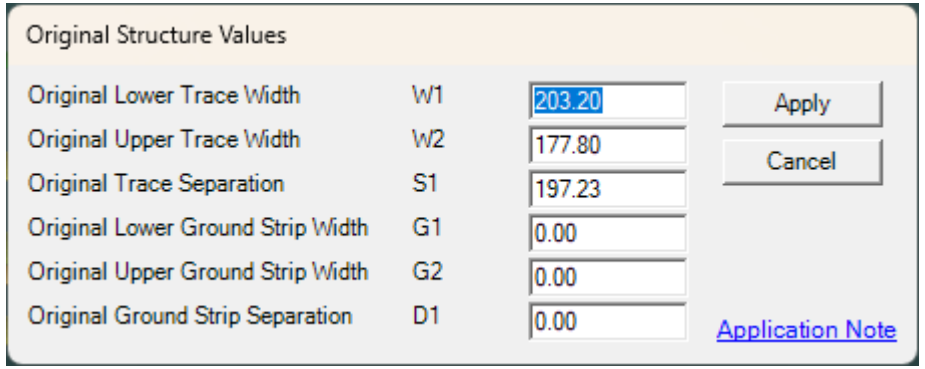
New Original Structure Values feature

Mils



Microns



The new Original Structure Values feature supports unit switching. This allows for reporting of these parameters in units that match your user / customer preference

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New Original Structure Values feature

C:\Apps\Samples\Eval Imperial v26.sci Units: Mils

Layer	Stack up	Supplier	Description	Type	Processed Thickness	Impedance ID
		Polar Samples	Liquid PhotoImageable Mask	SolderMask	1.000	
1		Polar Samples	Copper Foil	Copper	1.400	1, 2, 3, 4
		Polar Samples	PrePreg 1080	Dielectric	1.950	
2					1.400	5, 6, 7
		Polar Samples	FR4 Core	FR4	3.000	
3					1.400	
		Polar Samples	PrePreg 3080	Dielectric	2.776	
		Polar Samples	PrePreg 1651	Dielectric	5.552	
		Polar Samples	PrePreg 1651	Dielectric	5.552	
4					1.400	8, 9, 10, 11, 12
		Polar Samples	FR4 Core	FR4	12.000	
5					1.400	
		Polar Samples	PrePreg 1651	Dielectric	5.552	
		Polar Samples	PrePreg 1651	Dielectric	5.552	
		Polar Samples	PrePreg 3080	Dielectric	2.776	
6					1.400	
		Polar Samples	FR4 Core	FR4	3.000	
7					1.400	
		Polar Samples	PrePreg 1080	Dielectric	1.950	
8		Polar Samples	Copper Foil	Copper	1.400	13
		Polar Samples	Liquid PhotoImageable Mask	SolderMask	1.000	

62.86 / 60.86

Copper Thickness = 11.200 | Dielectric Thickness = 49.660 | Solder Mask Thickness = 2.000 |Stack Up Thickness = 60.860 | Stack U… kness with Solder…

Notes

Impedance ID	Structure Image	Impedance Signal Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer	Lower Trace Width (W1)	Original Lower Trace Width (W1)	Upper Trace Width (W2)	Original Upper Trace Width (W2)	Trace Separation (S1)	Original Trace Separation (S1)	Lower Ground Strip Width (G1)	Original Lower Ground Strip Width (G1)	Upper Ground Strip Width (G2)	Original Upper Ground Strip Width (G2)	Ground Strip Separation (D1)	Original Ground Strip Separation (D1)	Target Impedance	Tol (+/- %)	Calculated Impedance
1		1	3	0	7.650	8.000	6.650	7.000	8.115	7.765	0.000	0.000	0.000	0.000	0.000	0.000	100.000	10.000	100.290
2		1	3	0	4.000	4.500	3.000	3.500	0.000	0.000	0.000	0.000	0.000	0.000	0.000	0.000	75.000	10.000	75.800
3		1	3	0	9.313	9.500	8.313	8.500	15.688	15.500	100.000	90.000	99.000	89.000	10.000	15.000	100.000	10.000	99.600

StackName: Master	Version:	Revision:	Modification:	Date of Revision:	Editor	
Date:	Associated Documents:					Page 1/X
Author:						
Department:						
Site:						

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The six new Original Structure Value parameters have been introduced to the Controlled Impedance Table on the technical report. The position of the new Original Structure Value columns can be defined by the user

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Other enhancements

- New import / export XML STKX v26.00 and SSX v16.00 file formats to support the new Original Structure Values.
- Please note: This feature has been introduced to the most commonly used structures supported by Speedstack:

Coated Microstrip 1B
Edge-Coupled Coated Microstrip 1B
Coated Coplanar Strips with Ground 1B
Coated Coplanar Waveguide with Ground 1B
Diff Coated Coplanar Strips with Ground 1B
Embedded Microstrip 1B1A
Edge Coupled Embedded Microstrip 1B1A
Edge Coupled Embedded Microstrip 1B1A1R
Offset Stripline 1B1A
Offset Coplanar Stripline 1B1A
Offset Coplanar Waveguide Stripline 1B1A
Edge Coupled Offset Stripline 1B1A
Edge Coupled Offset Stripline 1B1A1R
Diff Offset Coplanar Waveguide 1B1A
Offset Stripline 2B2A
Edge Coupled Offest Stripline 2B2A
Broadside-Coupled Stripline 2S

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Speedstack v25.09.01 (Sept 2025)

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Enhancements

- Updated to support latest Boundary Element Method (BEM) Calculation Engine v25.07.23

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Speedstack v25.05.01 (May 2025)

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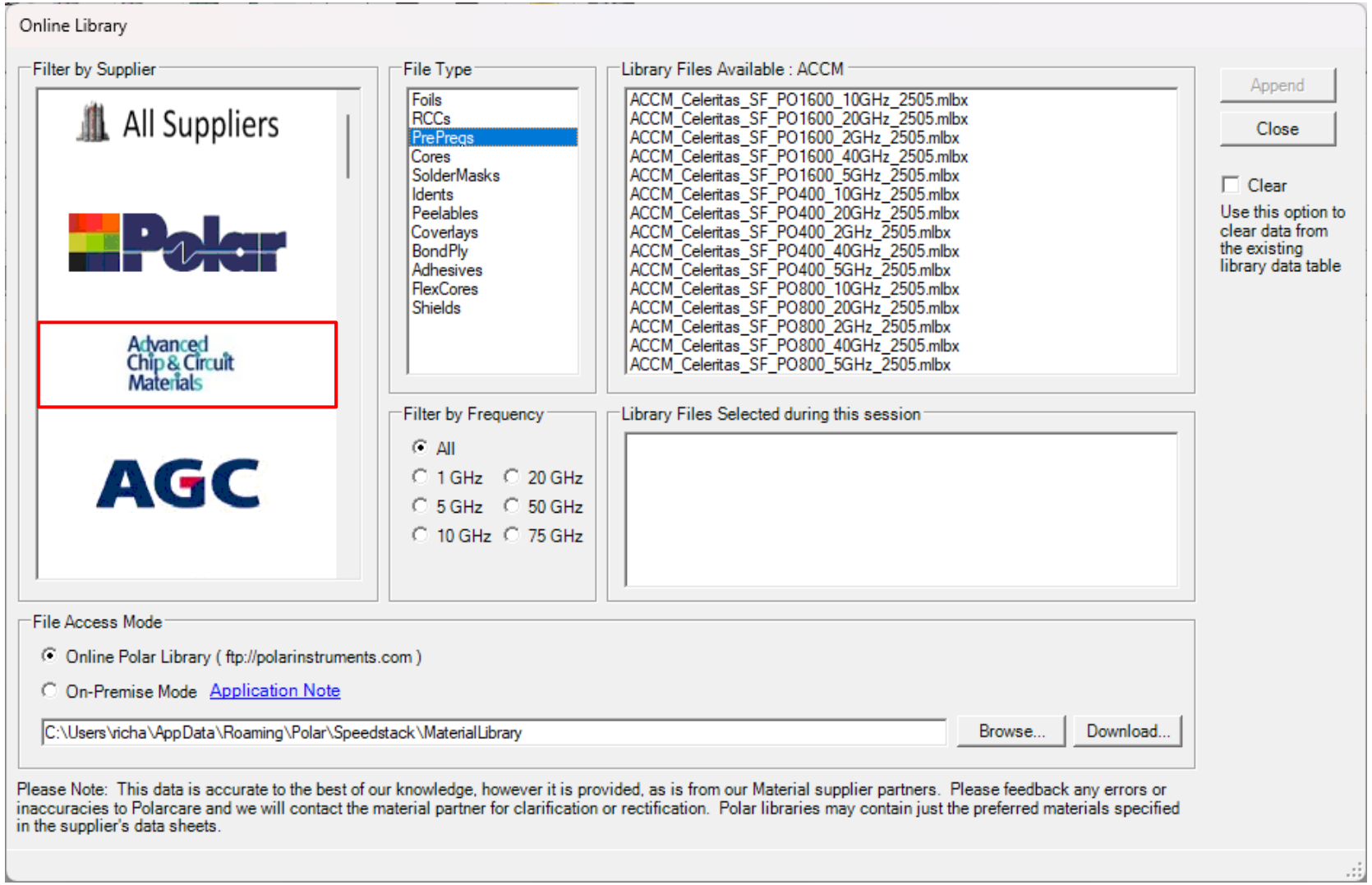
Advanced Chip & Circuit Materials added to the Online Library



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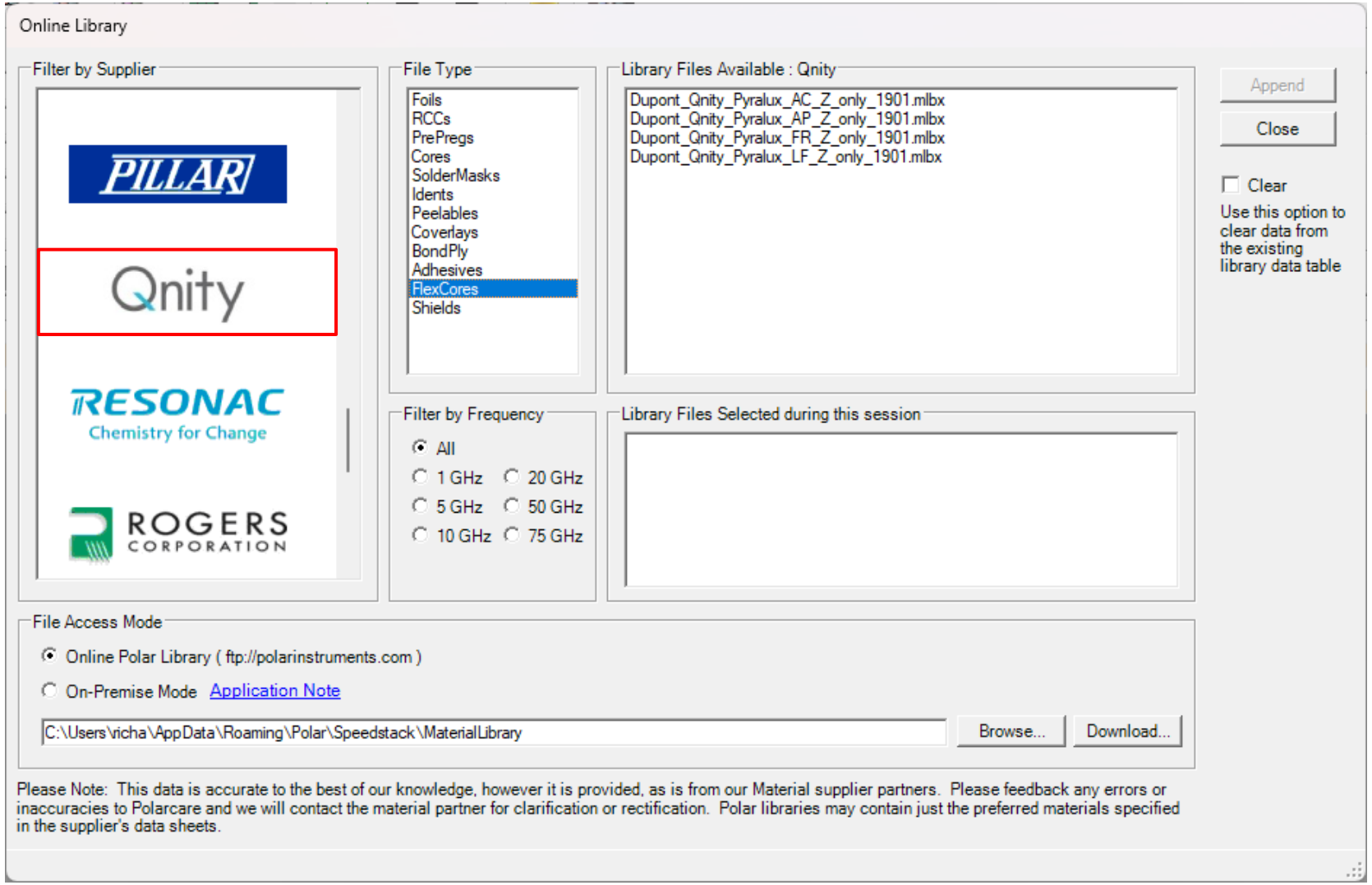
Qnity materials added to the Online Library



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Speedstack v25.01.01 (Jan 2025)

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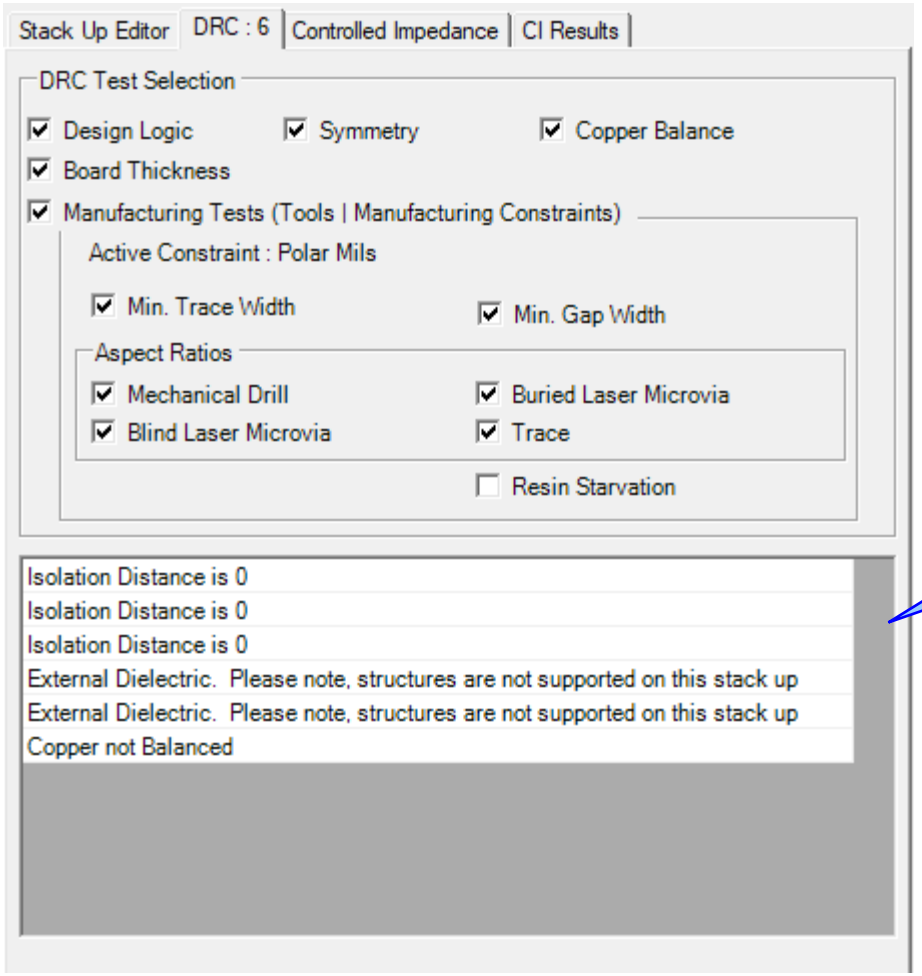
Design Rule Checks (DRC) now include more informative messages



The Design Rule Check messages have been enhanced. These new messages offer improved guidance to the user

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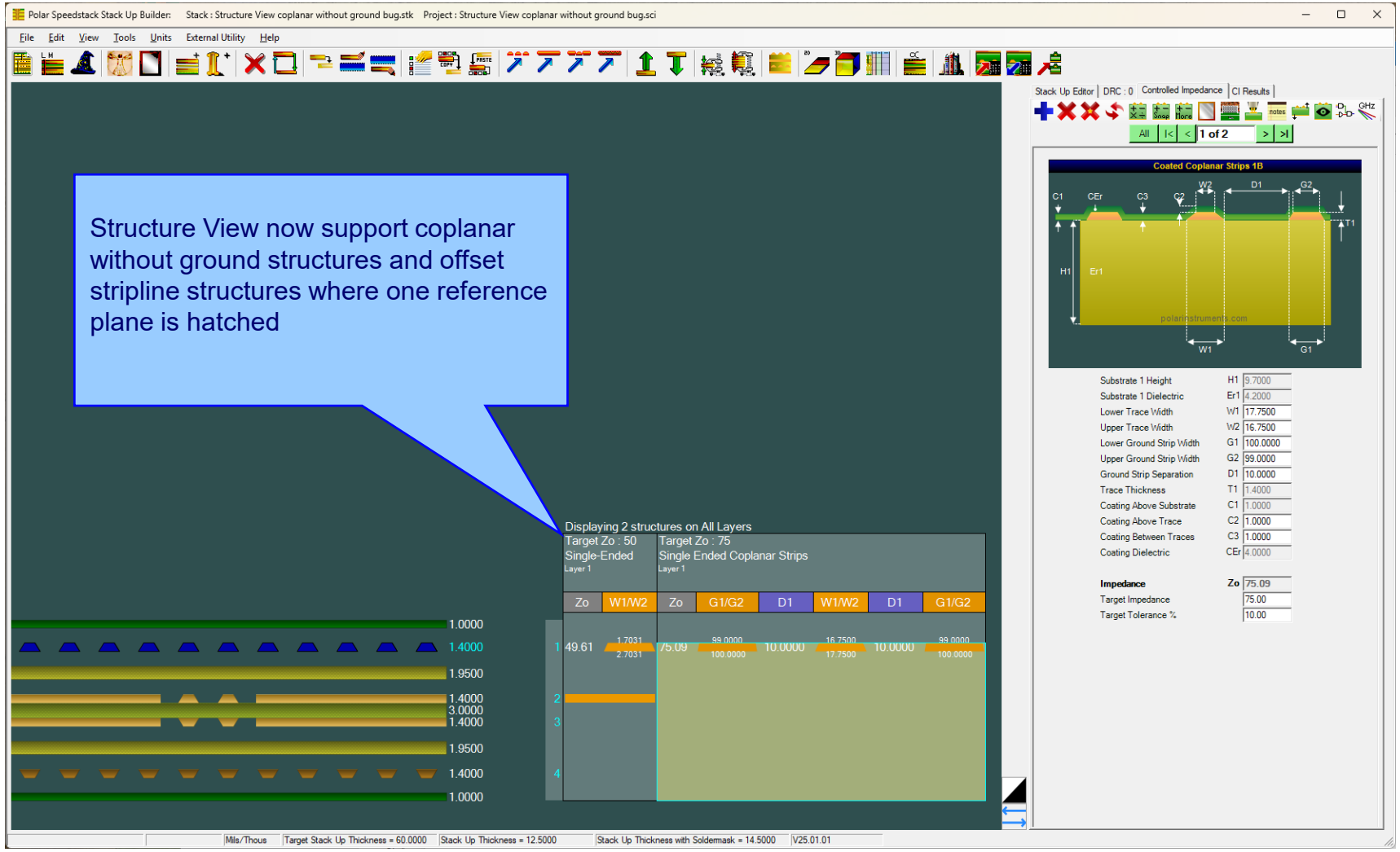
Structure View enhancements



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Full list of enhancements & fixes included with v25.01.01

1. Printing: The Solder Mask to Solder Mask dimension arrow now detects when only a single Solder Mask exists and suppresses the dimension arrow when the stack up spans two or more pages
2. Drilling: When adding a drill to a stack that contains just prepregs and no copper layers an exception error was displayed. This is now resolved
3. DRC: The 'Stack is impossible to build' message was rather vague. Now replaced with the more informative ‘Isolation Distance is 0' message
4. DRC: The 'External Dielectrics' message now replaced with 'External Dielectric. Please note, structures are not supported on this stack up' message
5. Messaging: More detail added to the messaging when Speedstack is unable to add structures to stack up - 001-00-000965

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Full list of enhancements & fixes included with v25.01.01

6. Messaging: When the stack up is modified after structures have been added a 'No Valid Mnemonic' message is sometimes displayed. A more detailed explanation of how to resolve the issue is now provided
7. Structure View Graphics: Fixed problem where inverted offset structures when using one hatched plane, shows the hatched plane in wrong position. This is now resolved
8. Structure View Graphics: When a coplanar without ground is added Structure View will not display. This is now resolved
9. Controlled Impedance Toolbar. When adding the first structure to a sub-stack with mini-stacks or air gaps in the sub-stack the toolbar is disabled. This is now resolved
10. Mini Stacks with Air Gaps: Display a warning message, when adding structures, that those types of stack up are not supported by the Simple Percentage Method finishing method

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Speedstack v24.09.01 (Sept 2024)

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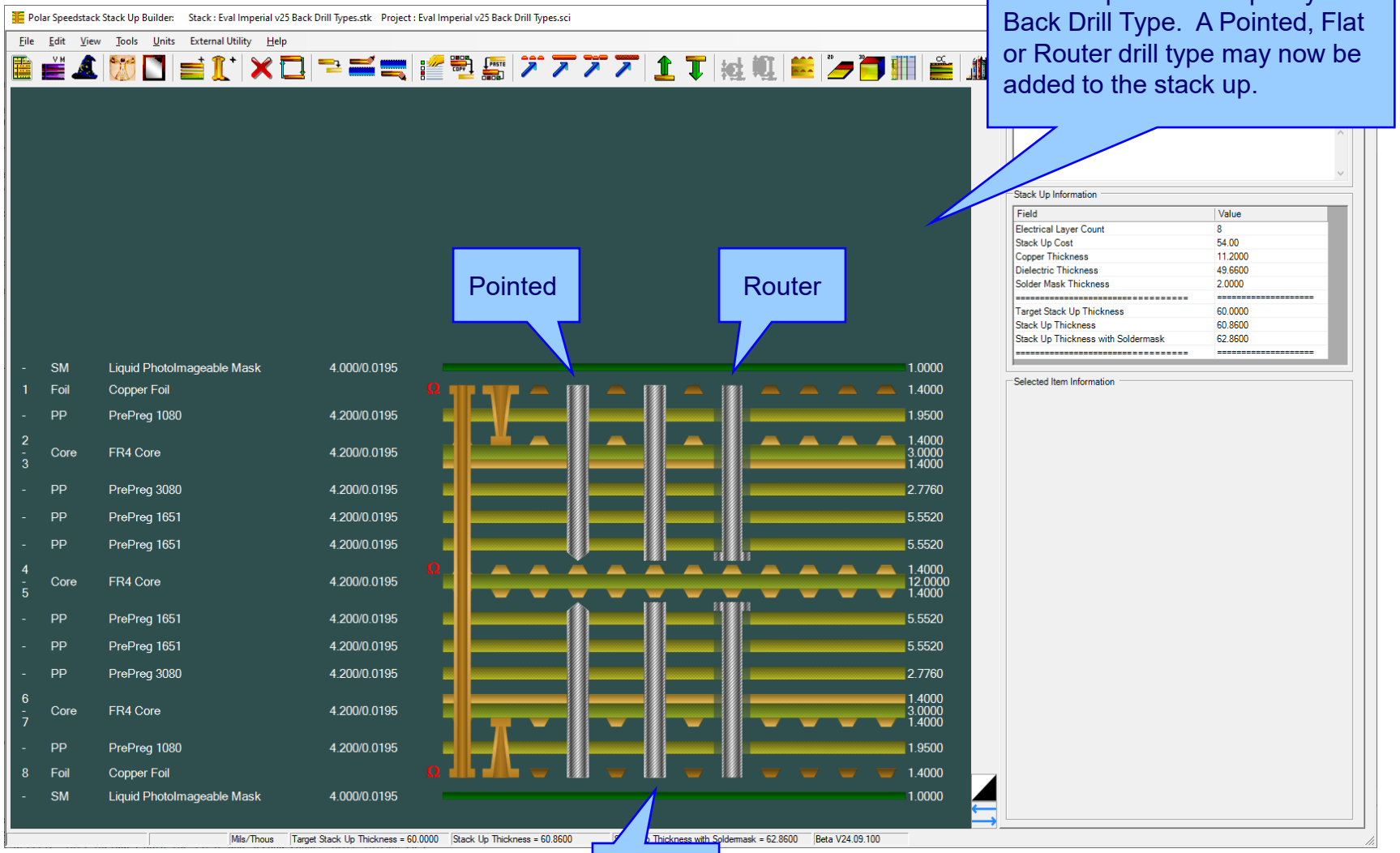
New Back Drill Types – Pointed, Flat and Router



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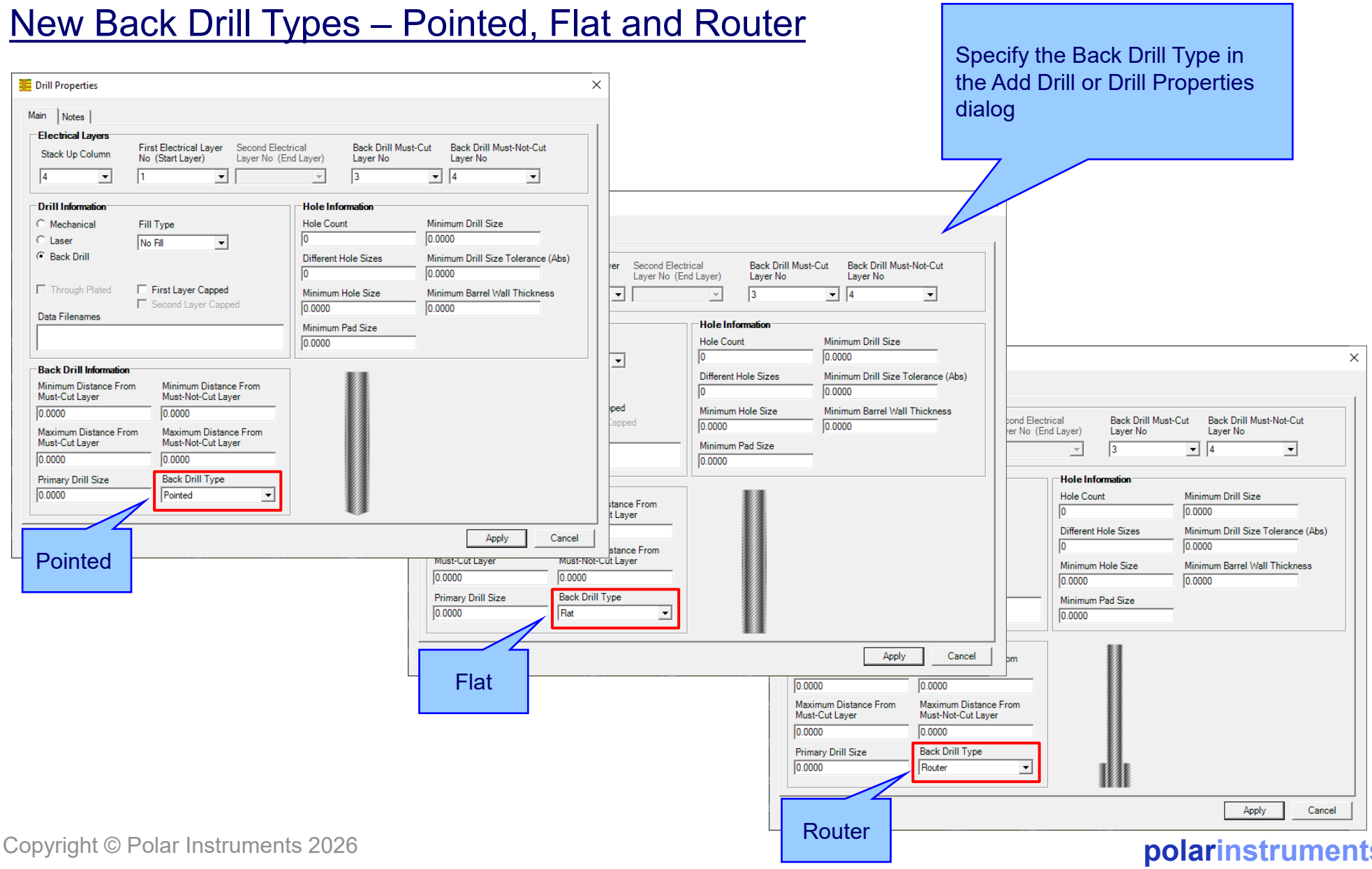
New Back Drill Types – Pointed, Flat and Router



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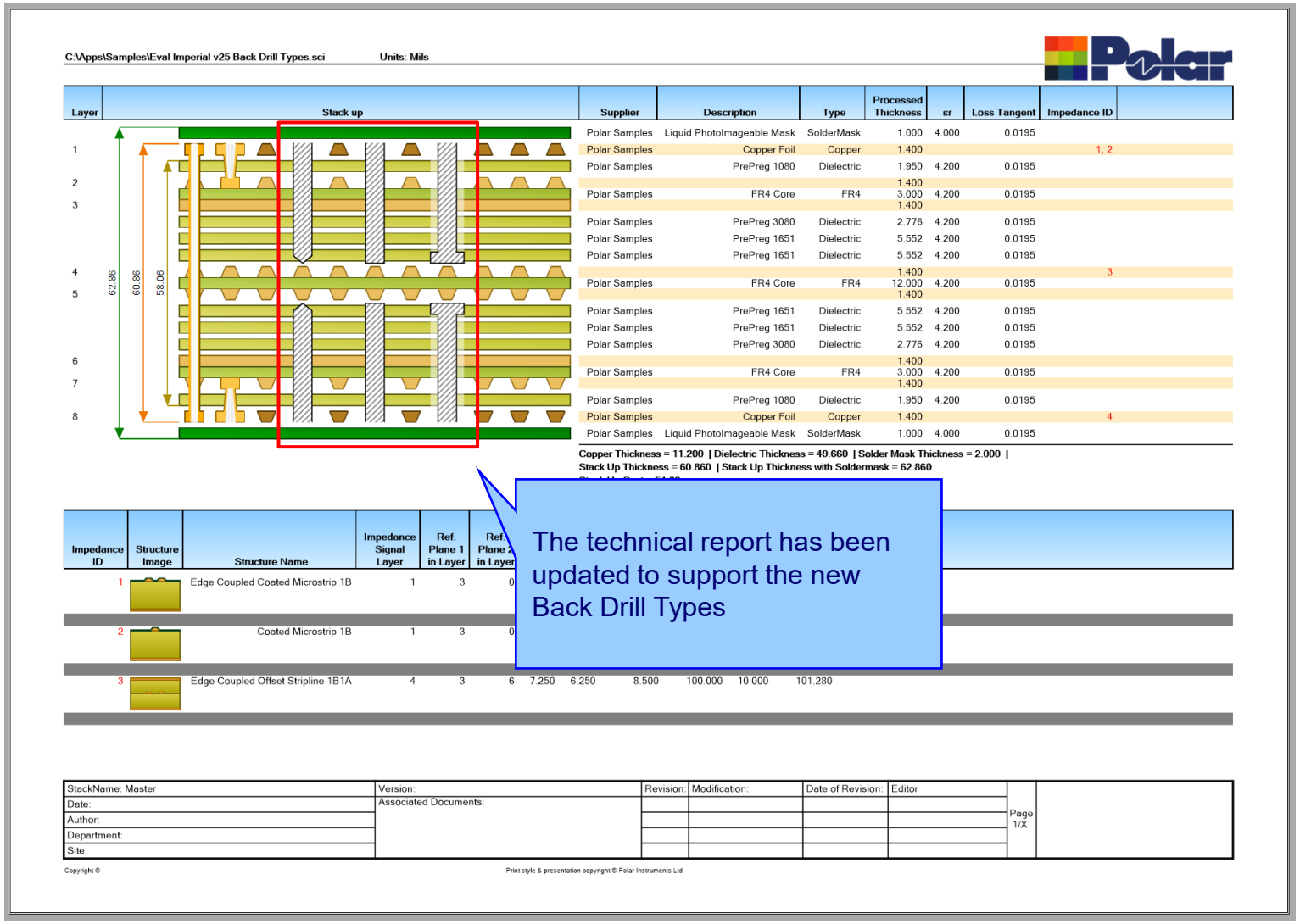
New Back Drill Types – Pointed, Flat and Router



C:\Apps\Samples\Eval Imperial v25 Back Drill Types.sci Units: Mils

Layer	Stack up	Supplier	Description	Type	Processed Thickness	εr	Loss Tangent	Impedance ID
1		Polar Samples	Liquid PhotoImageable Mask	SolderMask	1.000	4.000	0.0195	
		Polar Samples	Copper Foil	Copper	1.400			1, 2
		Polar Samples	PrePreg 1080	Dielectric	1.950	4.200	0.0195	
2					1.400			
3		Polar Samples	FR4 Core	FR4	3.000	4.200	0.0195	
					1.400			
		Polar Samples	PrePreg 3080	Dielectric	2.776	4.200	0.0195	
		Polar Samples	PrePreg 1651	Dielectric	5.552	4.200	0.0195	
		Polar Samples	PrePreg 1651	Dielectric	5.552	4.200	0.0195	
4					1.400			3
5		Polar Samples	FR4 Core	FR4	12.000	4.200	0.0195	
					1.400			
		Polar Samples	PrePreg 1651	Dielectric	5.552	4.200	0.0195	
		Polar Samples	PrePreg 1651	Dielectric	5.552	4.200	0.0195	
		Polar Samples	PrePreg 3080	Dielectric	2.776	4.200	0.0195	
6					1.400			
7		Polar Samples	FR4 Core	FR4	3.000	4.200	0.0195	
					1.400			
		Polar Samples	PrePreg 1080	Dielectric	1.950	4.200	0.0195	
8		Polar Samples	Copper Foil	Copper	1.400			4
		Polar Samples	Liquid PhotoImageable Mask	SolderMask	1.000	4.000	0.0195	

62.86 60.86 58.06

Copper Thickness = 11.200 | Dielectric Thickness = 49.660 | Solder Mask Thickness = 2.000 |
Stack Up Thickness = 60.860 | Stack Up Thickness with Soldermask = 62.860

Impedance ID	Structure Image	Structure Name	Impedance Signal Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer						
1		Edge Coupled Coated Microstrip 1B	1	3	0						
2		Coated Microstrip 1B	1	3	0						
3		Edge Coupled Offset Stripline 1B1A	4	3	6	7.250	6.250	8.500	100.000	10.000	101.280

StackName: Master	Version:	Revision:	Modification:	Date of Revision:	Editor	
Date:	Associated Documents:					Page 1/X
Author:						
Department:						
Site:						

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The technical report has been updated to support the new Back Drill Types

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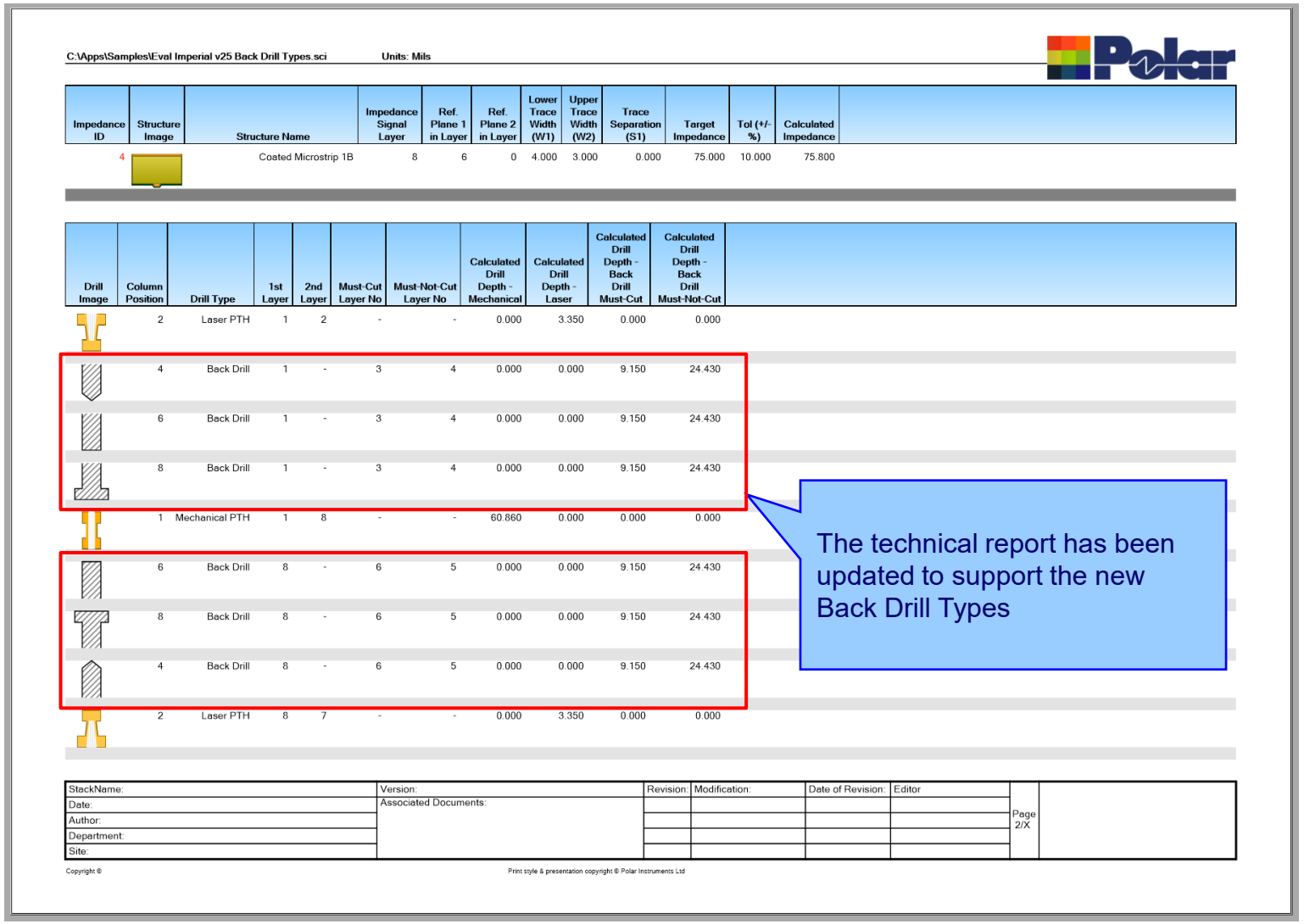
New Back Drill Types – Pointed, Flat and Router



C:\Apps\Samples\Eval Imperial v25 Back Drill Types.sci Units: Mils

Impedance ID	Structure Image	Structure Name	Impedance Signal Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer	Lower Trace Width (W1)	Upper Trace Width (W2)	Trace Separation (S1)	Target Impedance	Tol (+/- %)	Calculated Impedance
4		Coated Microstrip 1B	8	6	0	4.000	3.000	0.000	75.000	10.000	75.800

Drill Image	Column Position	Drill Type	1st Layer	2nd Layer	Must-Cut Layer No	Must-Not-Cut Layer No	Calculated Drill Depth - Mechanical	Calculated Drill Depth - Laser	Calculated Drill Depth - Back Drill Must-Cut	Calculated Drill Depth - Back Drill Must-Not-Cut
	2	Laser PTH	1	2	-	-	0.000	3.350	0.000	0.000
	4	Back Drill	1	-	3	4	0.000	0.000	9.150	24.430
	6	Back Drill	1	-	3	4	0.000	0.000	9.150	24.430
	8	Back Drill	1	-	3	4	0.000	0.000	9.150	24.430
	1	Mechanical PTH	1	8	-	-	60.860	0.000	0.000	0.000
	6	Back Drill	8	-	6	5	0.000	0.000	9.150	24.430
	8	Back Drill	8	-	6	5	0.000	0.000	9.150	24.430
	4	Back Drill	8	-	6	5	0.000	0.000	9.150	24.430
	2	Laser PTH	8	7	-	-	0.000	3.350	0.000	0.000

StackName:	Version:	Revision:	Modification:	Date of Revision:	Editor	Page 2/X
Date:	Associated Documents:					
Author:						
Department:						
Site:						

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The technical report has been updated to support the new Back Drill Types

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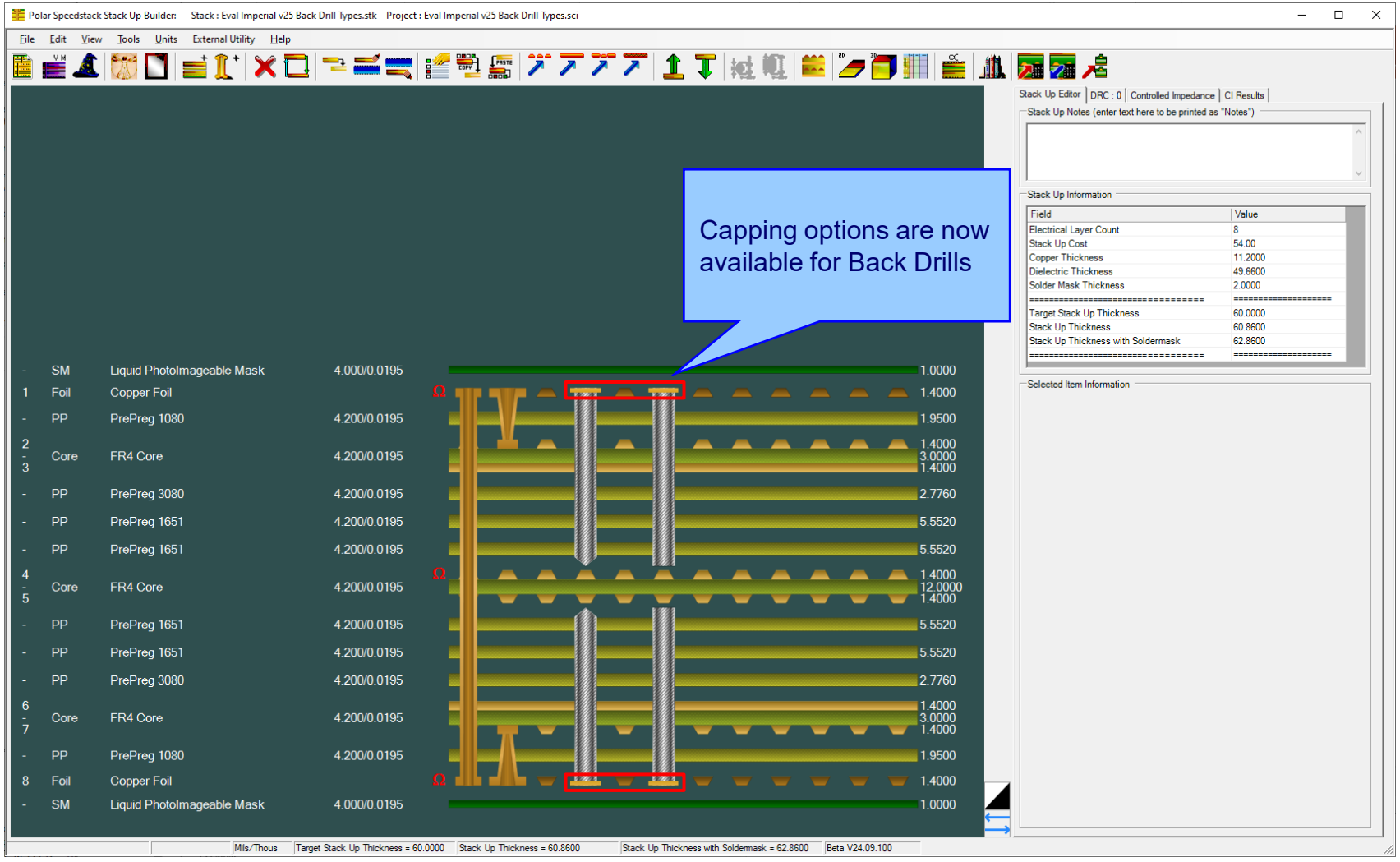
New capping options for Back Drills



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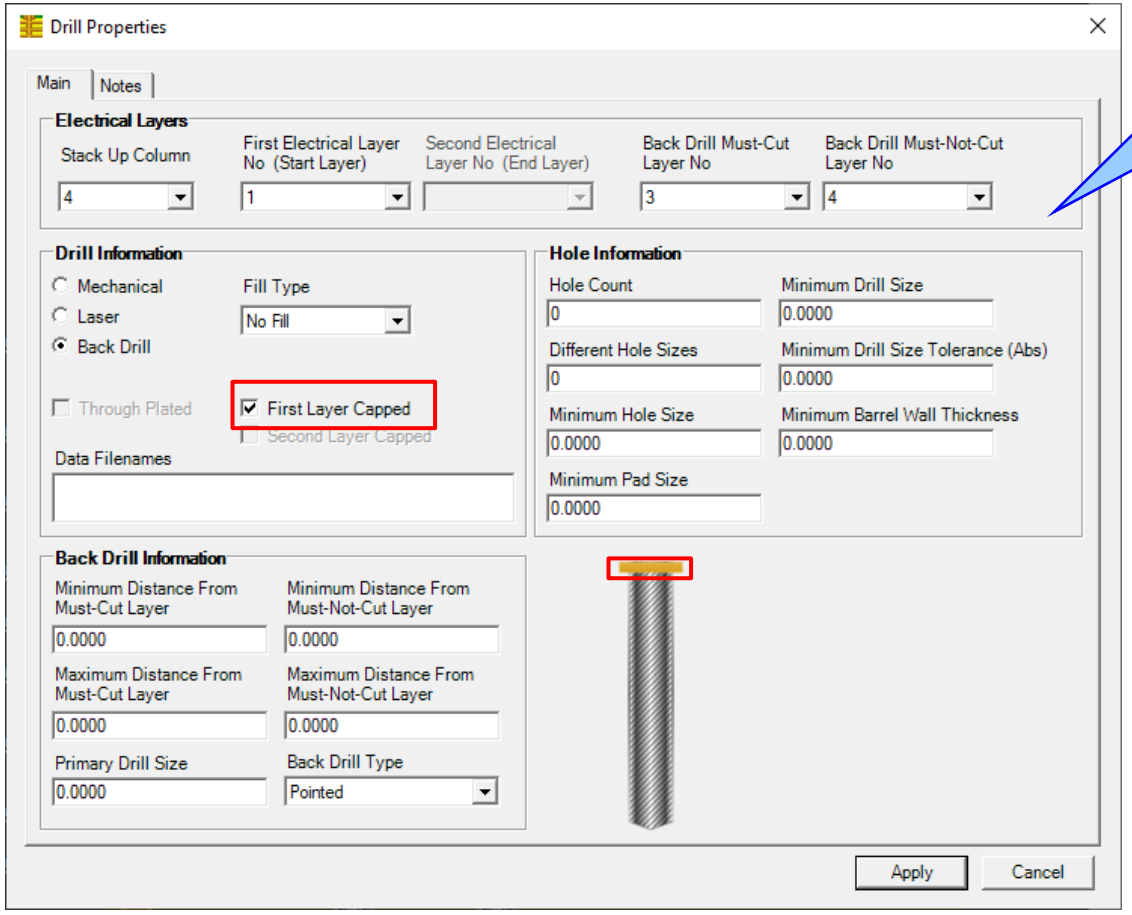
New capping options for Back Drills



Specify the Back Drill capping within the Add Drill or Drill Properties dialog

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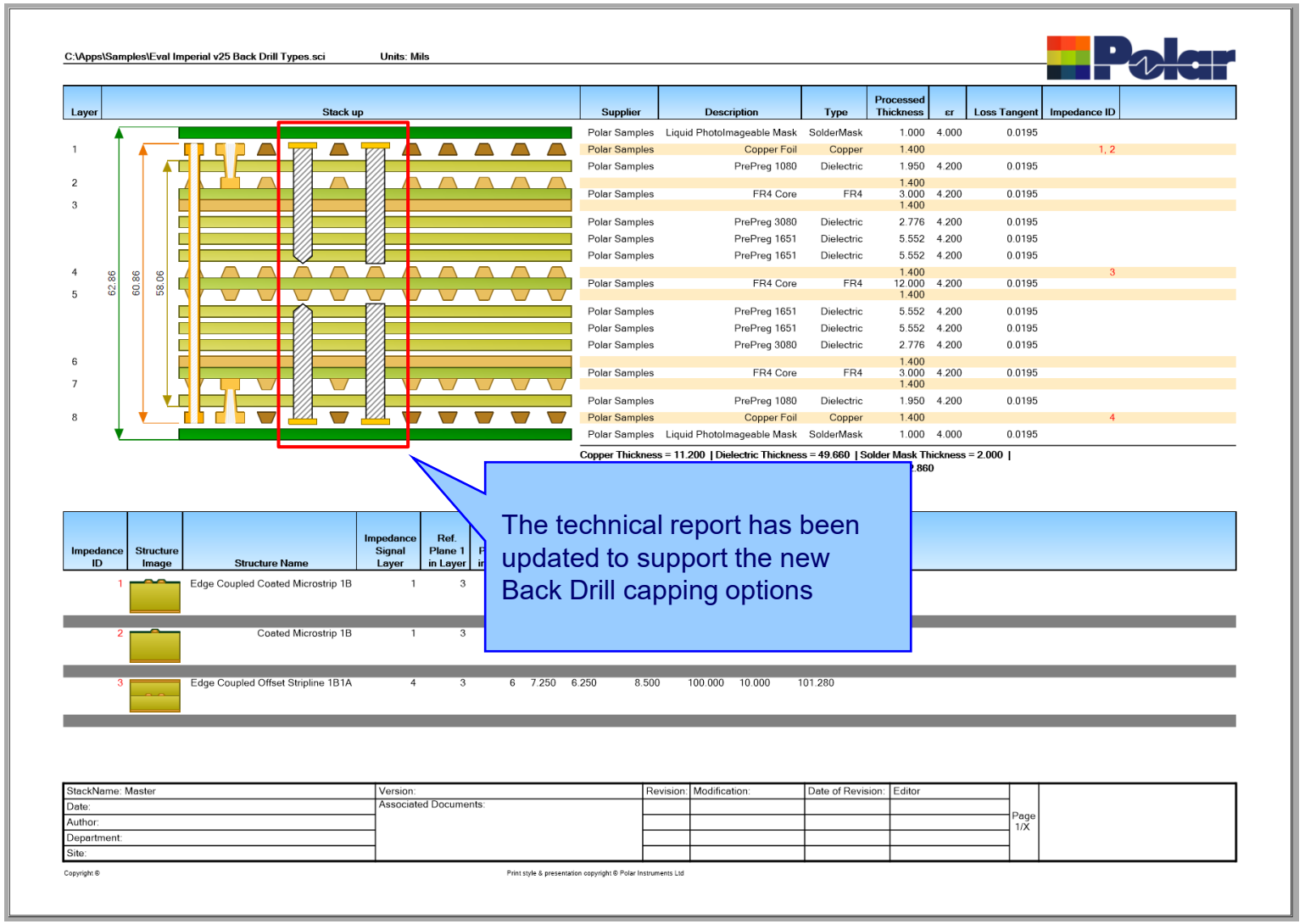
New capping options for Back Drills



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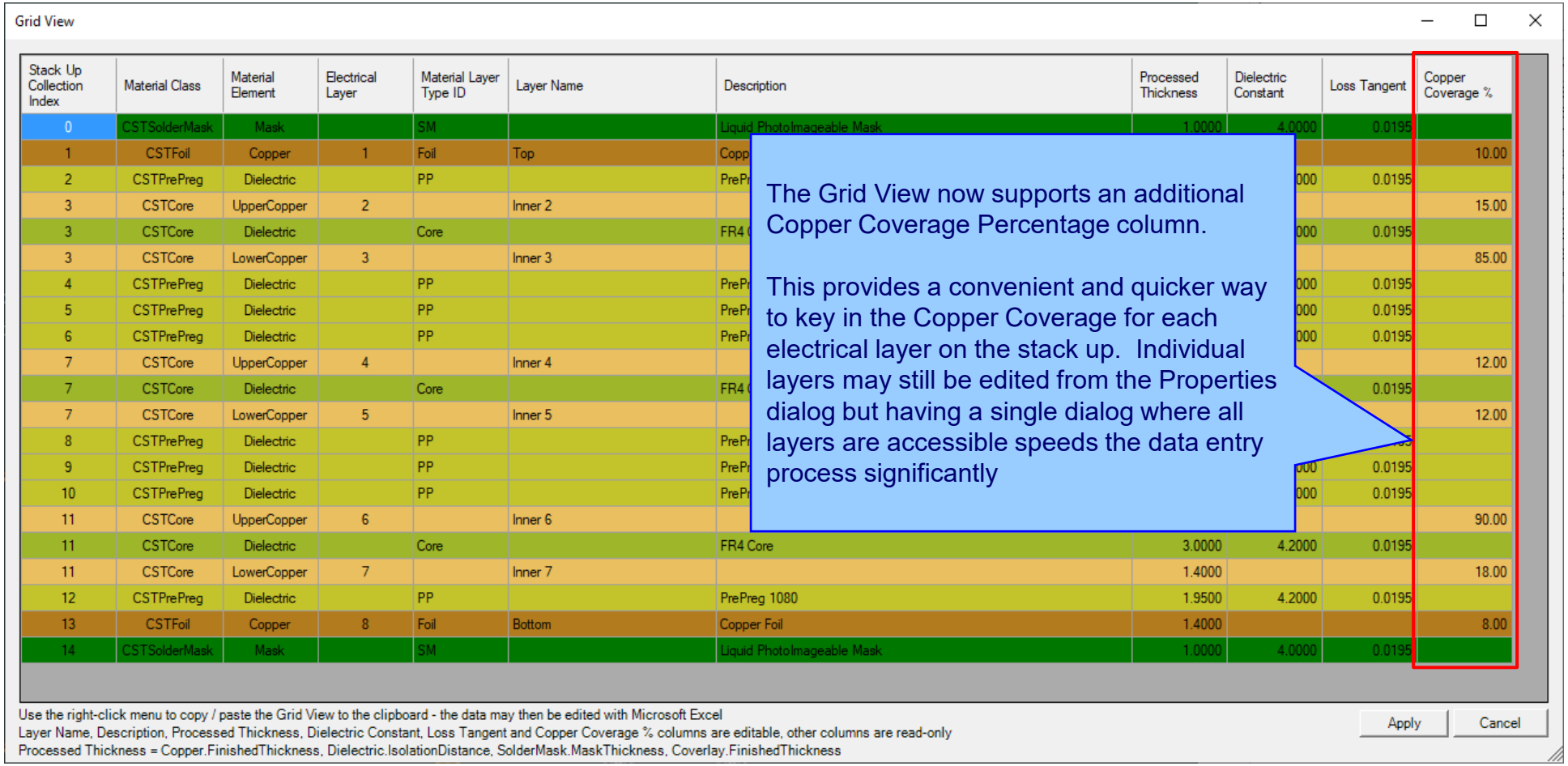
Grid View now supports Copper Coverage Percentage



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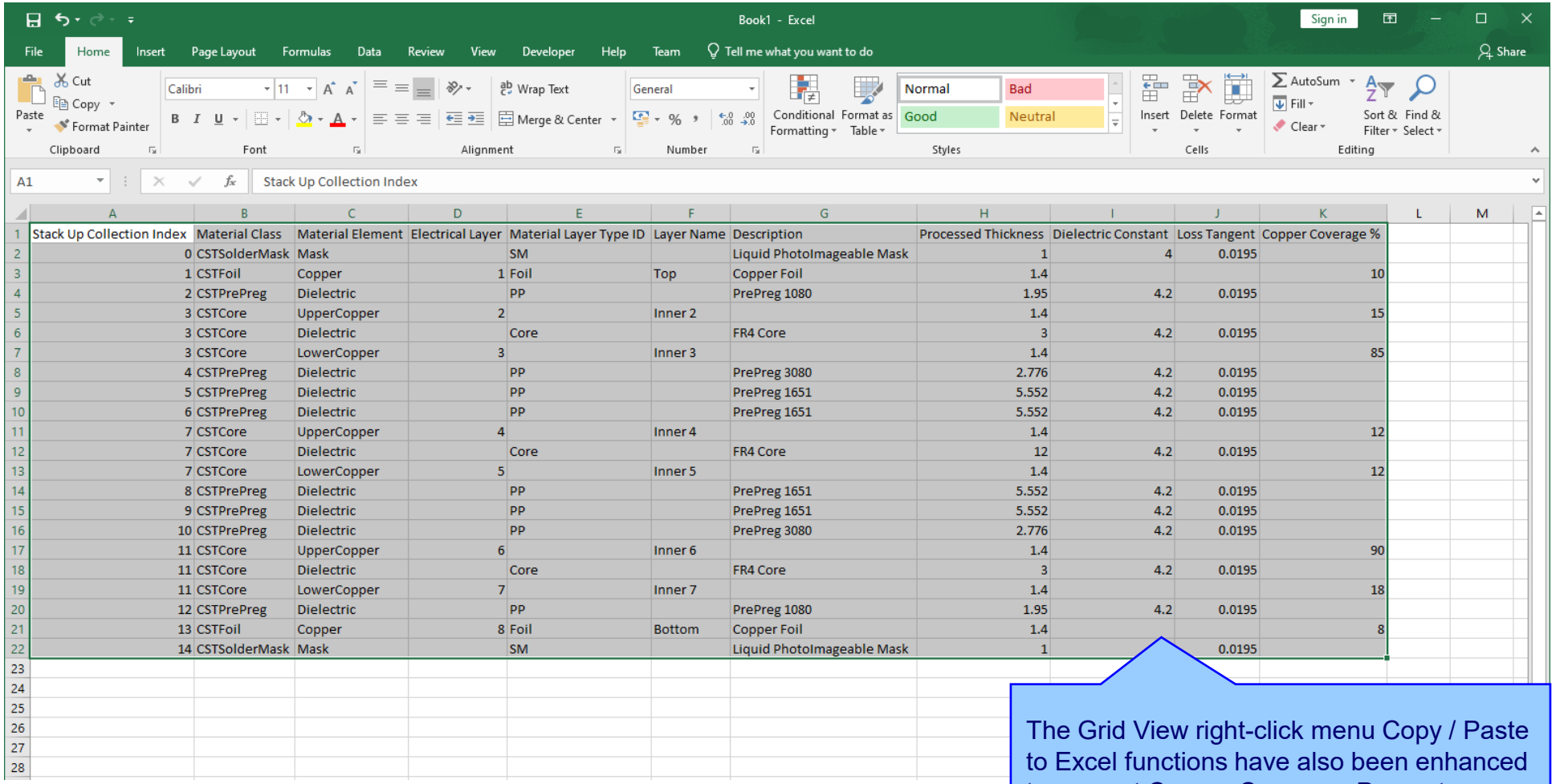
Grid View now supports Copper Coverage Percentage



Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name	Description	Processed Thickness	Dielectric Constant	Loss Tangent	Copper Coverage %
0	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1	4	0.0195	
1	CSTFoil	Copper	1	Foil	Top	Copper Foil	1.4			10
2	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.95	4.2	0.0195	
3	CSTCore	UpperCopper	2		Inner 2		1.4			15
3	CSTCore	Dielectric		Core		FR4 Core	3	4.2	0.0195	
3	CSTCore	LowerCopper	3		Inner 3		1.4			85
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.776	4.2	0.0195	
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195	
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195	
7	CSTCore	UpperCopper	4		Inner 4		1.4			12
7	CSTCore	Dielectric		Core		FR4 Core	12	4.2	0.0195	
7	CSTCore	LowerCopper	5		Inner 5		1.4			12
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195	
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195	
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.776	4.2	0.0195	
11	CSTCore	UpperCopper	6		Inner 6		1.4			90
11	CSTCore	Dielectric		Core		FR4 Core	3	4.2	0.0195	
11	CSTCore	LowerCopper	7		Inner 7		1.4			18
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.95	4.2	0.0195	
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.4			8
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1		0.0195	

The Grid View right-click menu Copy / Paste to Excel functions have also been enhanced to support Copper Coverage Percentage

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Other enhancements

- New import / export XML STKX v25.00 and SSX v15.00 file formats to support the new Back Drill Type and Capped Drill options.
- Drilling: When the Add Drill and Drill Properties dialogs are dismissed the current pan position is now retained. Previously, on high layer stack ups, the graphical image panned to the top of the stack up.
- Printing: The Isolation Distance (Summed) column calculation has been improved to offer better support when the stack up contains single-sided cores.

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Speedstack v24.05.01 (May 2024)

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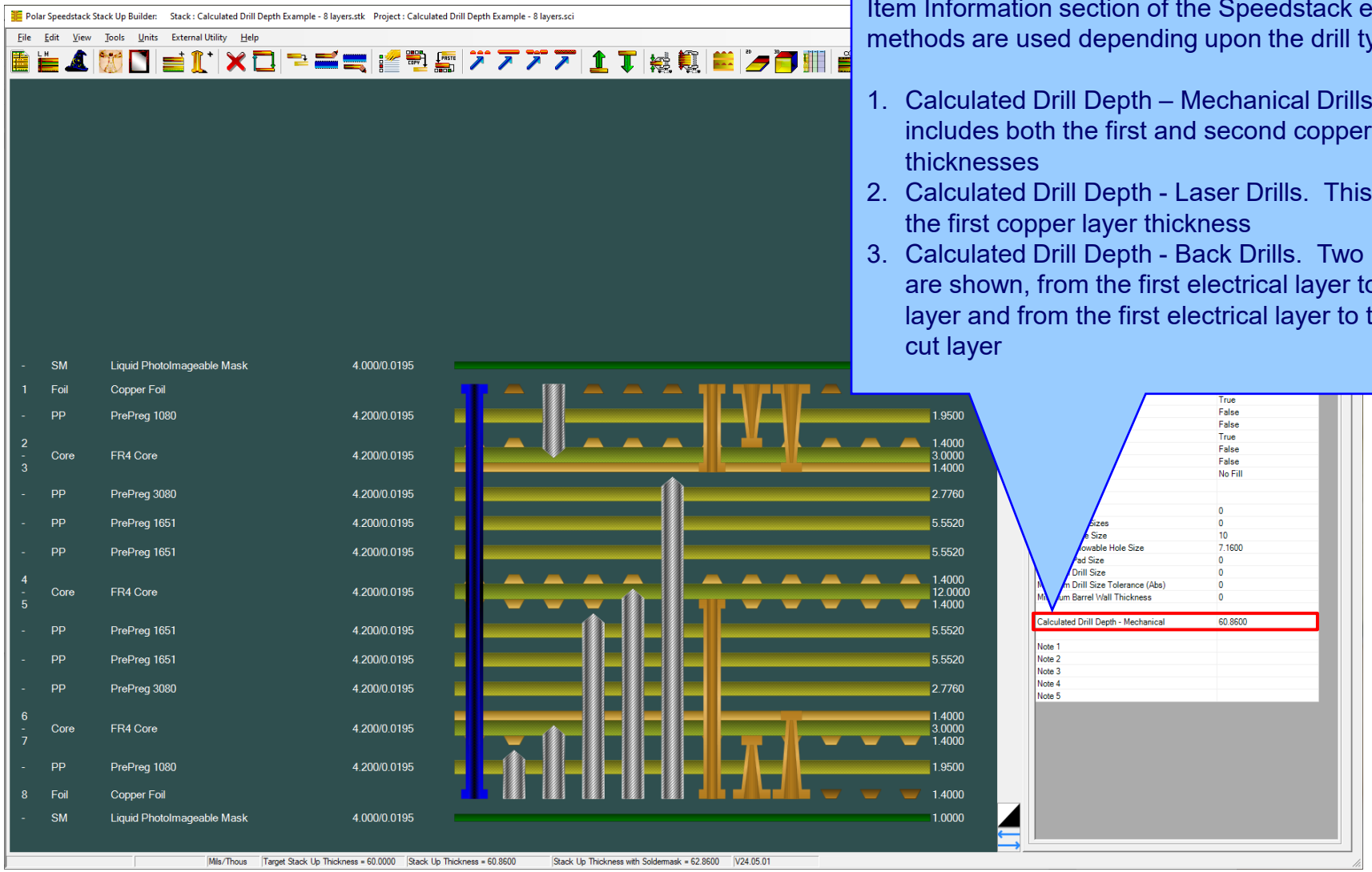
New Calculated Drill Depth enhancements

Calculate and display the Drill Depth under the Selected Item Information section of the Speedstack editor. Three methods are used depending upon the drill type:

1. Calculated Drill Depth – Mechanical Drills. This includes both the first and second copper layer thicknesses
2. Calculated Drill Depth - Laser Drills. This includes just the first copper layer thickness
3. Calculated Drill Depth - Back Drills. Two Drill Depths are shown, from the first electrical layer to the must-cut layer and from the first electrical layer to the must-not-cut layer



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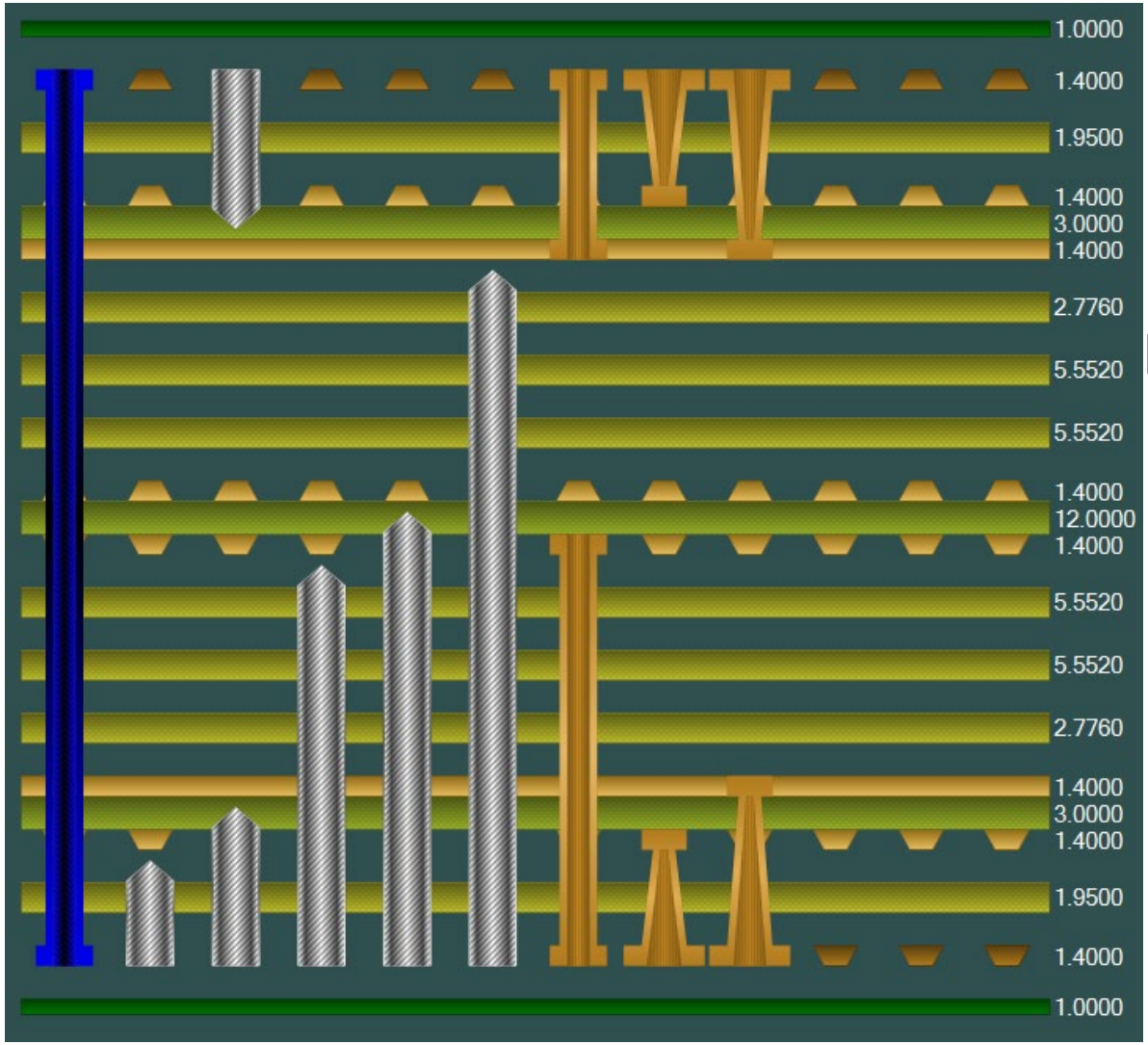
New Calculated Drill Depth – Mechanical Drills



Calculated Drill Depth – Mechanical Drills. This includes both the first and second copper layer thicknesses

Calculated Drill Depth - Mechanical	60.8600

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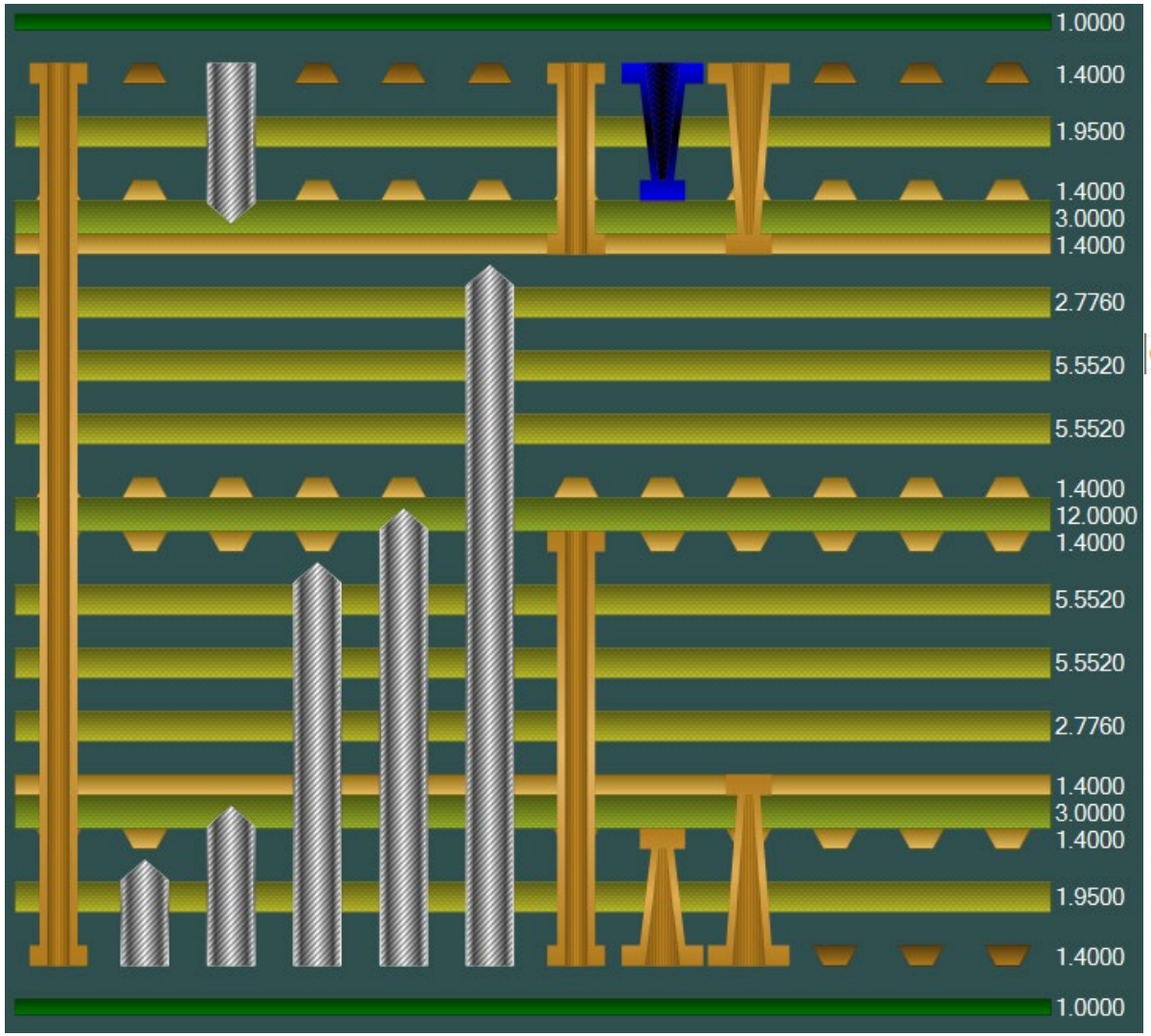
New Calculated Drill Depth – Laser Drills



Calculated Drill Depth - Laser Drills. This includes just the first copper layer thickness

Calculated Drill Depth - Laser	3.3500

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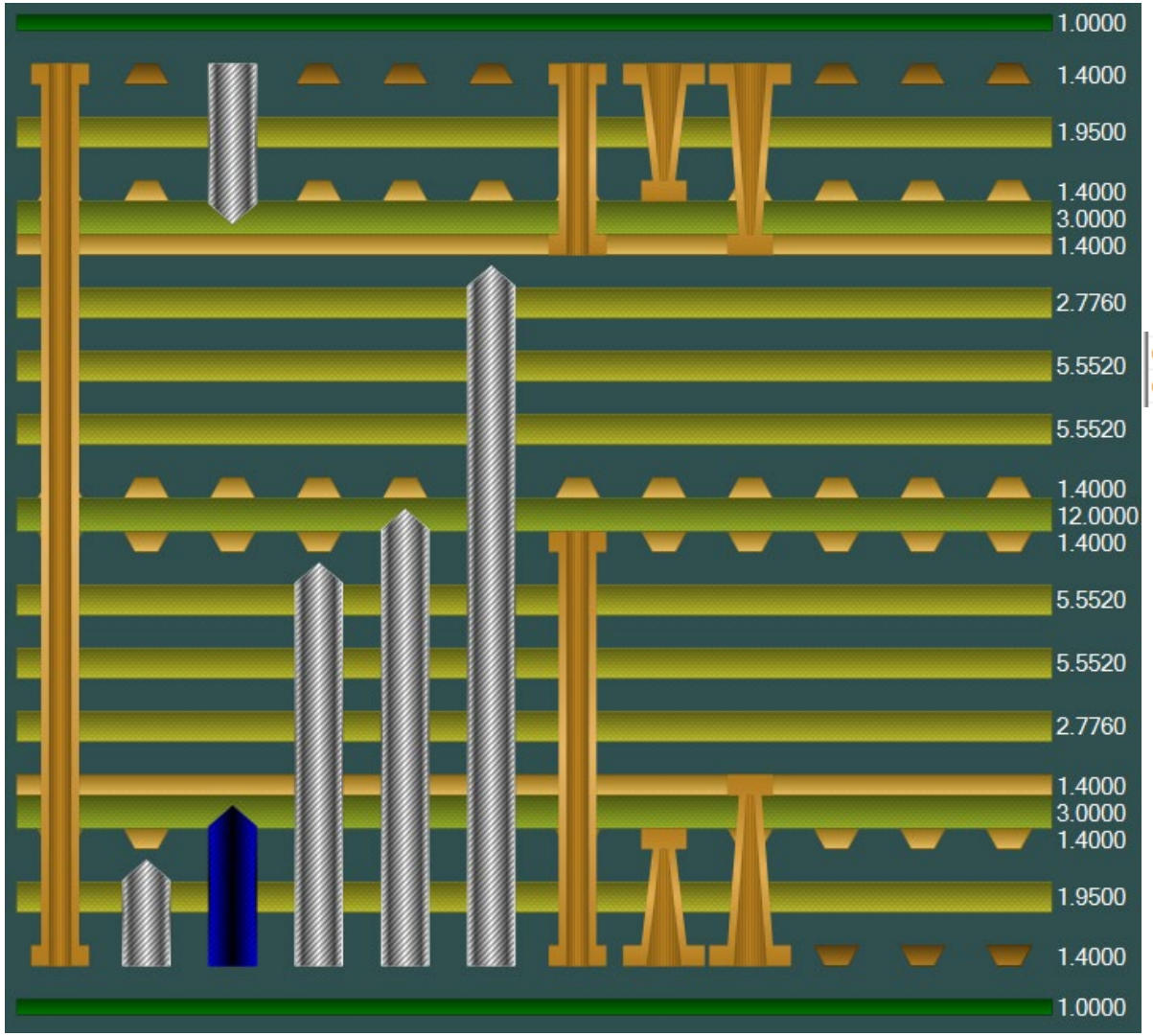
New Calculated Drill Depth – Back Drills



Calculated Drill Depth - Back Drills. Two Drill Depths are shown, from the first electrical layer to the must-cut layer and from the first electrical layer to the must-not-cut layer

Calculated Drill Depth - Back Drill Must-Cut	4.7500
Calculated Drill Depth - Back Drill Must-Not-Cut	9.1500

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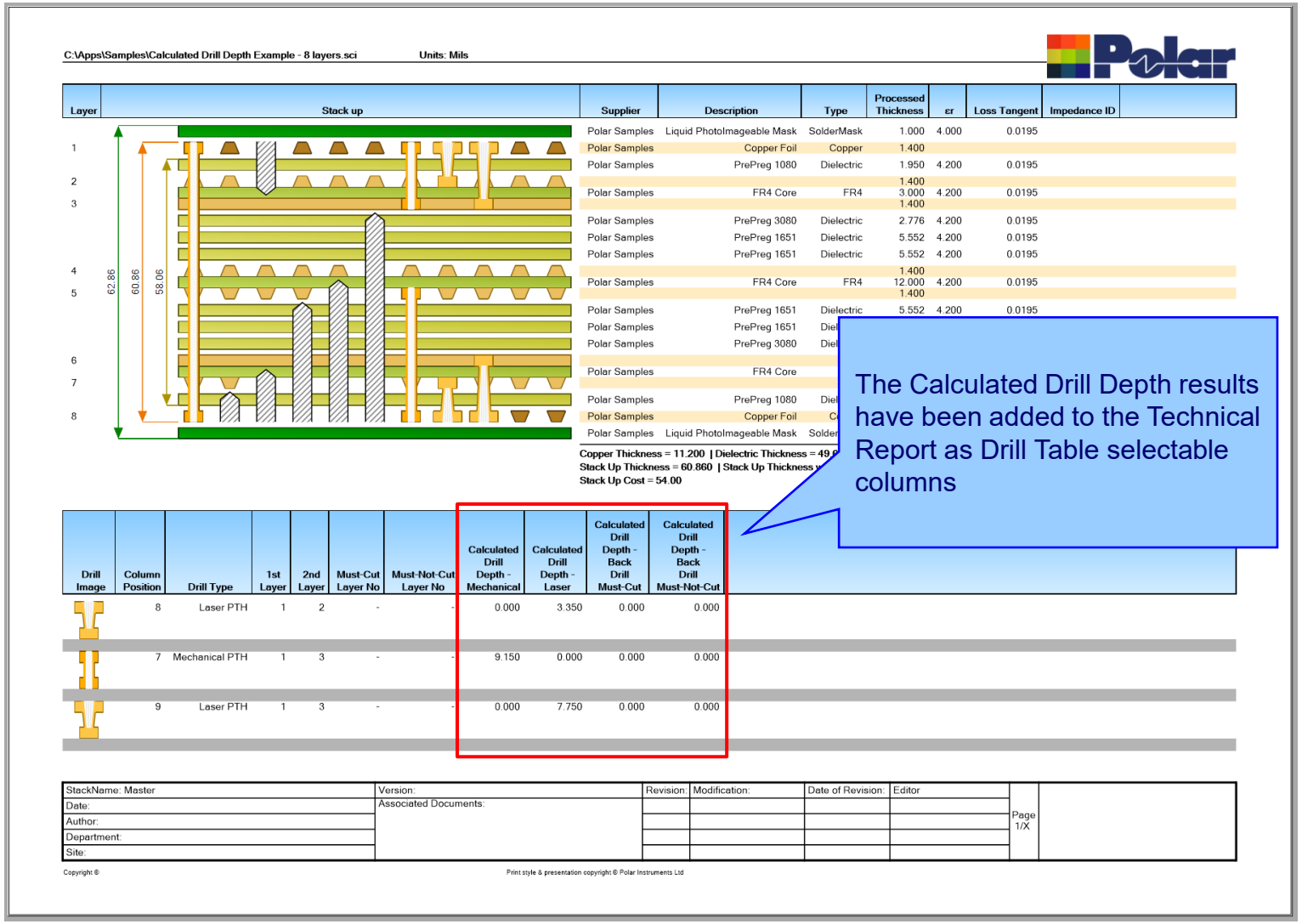
New Calculated Drill Depth enhancements



C:\Apps\Samples\Calculated Drill Depth Example - 8 layers.sci Units: Mils

Layer	Stack up	Supplier	Description	Type	Processed Thickness	εr	Loss Tangent	Impedance ID
1		Polar Samples	Liquid PhotoImageable Mask	SolderMask	1.000	4.000	0.0195	
		Polar Samples	Copper Foil	Copper	1.400			
2		Polar Samples	PrePreg 1080	Dielectric	1.950	4.200	0.0195	
					1.400			
3		Polar Samples	FR4 Core	FR4	3.000	4.200	0.0195	
					1.400			
		Polar Samples	PrePreg 3080	Dielectric	2.776	4.200	0.0195	
		Polar Samples	PrePreg 1651	Dielectric	5.552	4.200	0.0195	
		Polar Samples	PrePreg 1651	Dielectric	5.552	4.200	0.0195	
4					1.400			
5		Polar Samples	FR4 Core	FR4	12.000	4.200	0.0195	
					1.400			
		Polar Samples	PrePreg 1651	Dielectric	5.552	4.200	0.0195	
		Polar Samples	PrePreg 1651	Diel				
		Polar Samples	PrePreg 3080	Diel				
6								
7		Polar Samples	FR4 Core					
		Polar Samples	PrePreg 1080	Diel				
8		Polar Samples	Copper Foil	C				
		Polar Samples	Liquid PhotoImageable Mask	Solder				

62.86 60.86 58.06

Copper Thickness = 11.200 | Dielectric Thickness = 49.
Stack Up Thickness = 60.860 | Stack Up Thickness
Stack Up Cost = 54.00

Drill Image	Column Position	Drill Type	1st Layer	2nd Layer	Must-Cut Layer No	Must-Not-Cut Layer No	Calculated Drill Depth - Mechanical	Calculated Drill Depth - Laser	Calculated Drill Depth - Back Drill Must-Cut	Calculated Drill Depth - Back Drill Must-Not-Cut
	8	Laser PTH	1	2	-	-	0.000	3.350	0.000	0.000
	7	Mechanical PTH	1	3	-	-	9.150	0.000	0.000	0.000
	9	Laser PTH	1	3	-	-	0.000	7.750	0.000	0.000

StackName: Master	Version:	Revision:	Modification:	Date of Revision:	Editor	Page 1/X
Date:	Associated Documents:					
Author:						
Department:						
Site:						

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The Calculated Drill Depth results have been added to the Technical Report as Drill Table selectable columns

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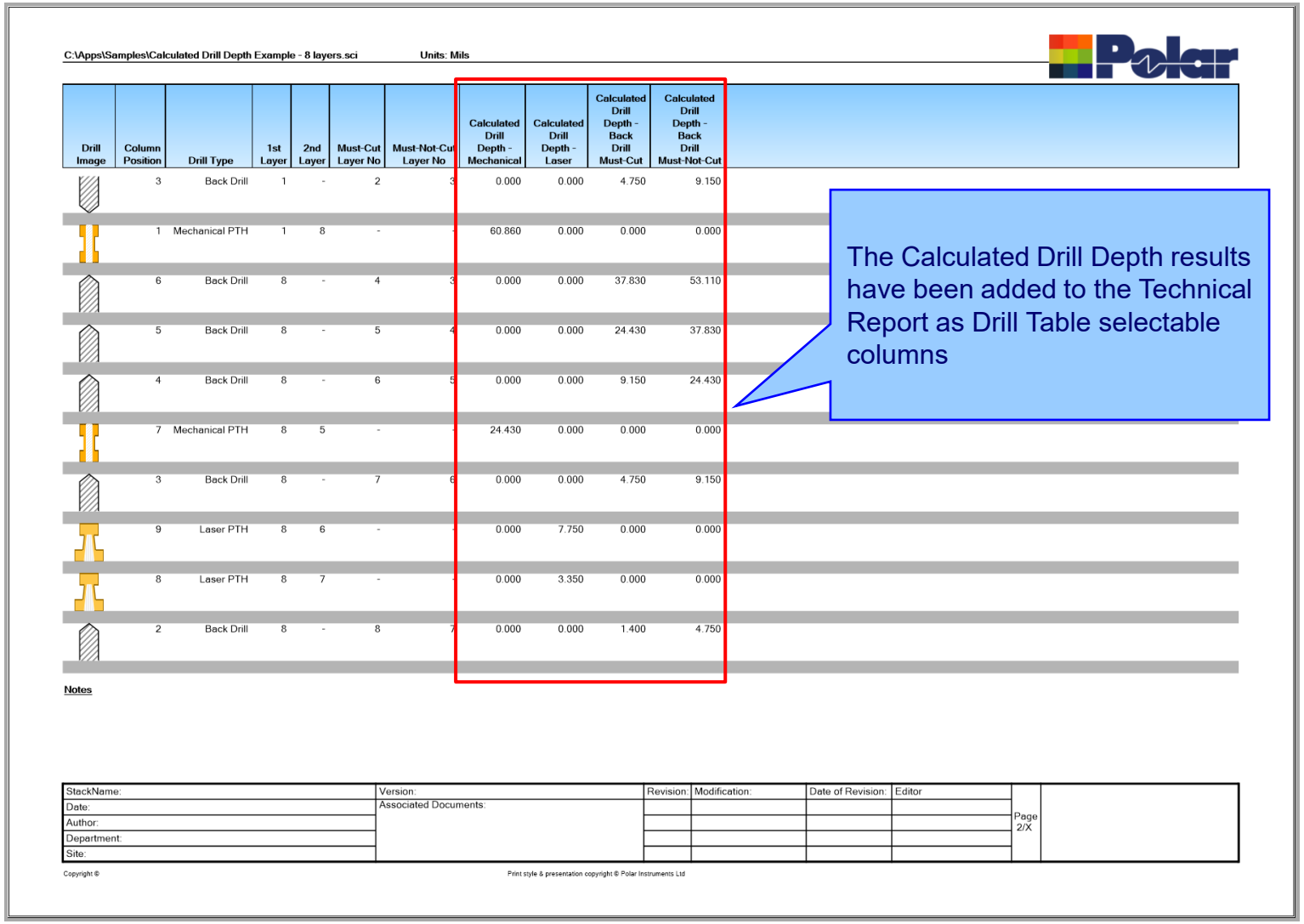
New Calculated Drill Depth enhancements



C:\Apps\Samples\Calculated Drill Depth Example - 8 layers.sci Units: Mils

Drill Image	Column Position	Drill Type	1st Layer	2nd Layer	Must-Cut Layer No	Must-Not-Cut Layer No	Calculated Drill Depth - Mechanical	Calculated Drill Depth - Laser	Calculated Drill Depth - Back Drill Must-Cut	Calculated Drill Depth - Back Drill Must-Not-Cut
	3	Back Drill	1	-	2	3	0.000	0.000	4.750	9.150
	1	Mechanical PTH	1	8	-	-	60.860	0.000	0.000	0.000
	6	Back Drill	8	-	4	3	0.000	0.000	37.830	53.110
	5	Back Drill	8	-	5	4	0.000	0.000	24.430	37.830
	4	Back Drill	8	-	6	5	0.000	0.000	9.150	24.430
	7	Mechanical PTH	8	5	-	-	24.430	0.000	0.000	0.000
	3	Back Drill	8	-	7	6	0.000	0.000	4.750	9.150
	9	Laser PTH	8	6	-	-	0.000	7.750	0.000	0.000
	8	Laser PTH	8	7	-	-	0.000	3.350	0.000	0.000
	2	Back Drill	8	-	8	7	0.000	0.000	1.400	4.750

Notes

StackName:	Version:	Revision:	Modification:	Date of Revision:	Editor	Page 2/X	
Date:	Associated Documents:						
Author:							
Department:							
Site:							

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The Calculated Drill Depth results have been added to the Technical Report as Drill Table selectable columns

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Speedstack v24.04.08 (April 2024)

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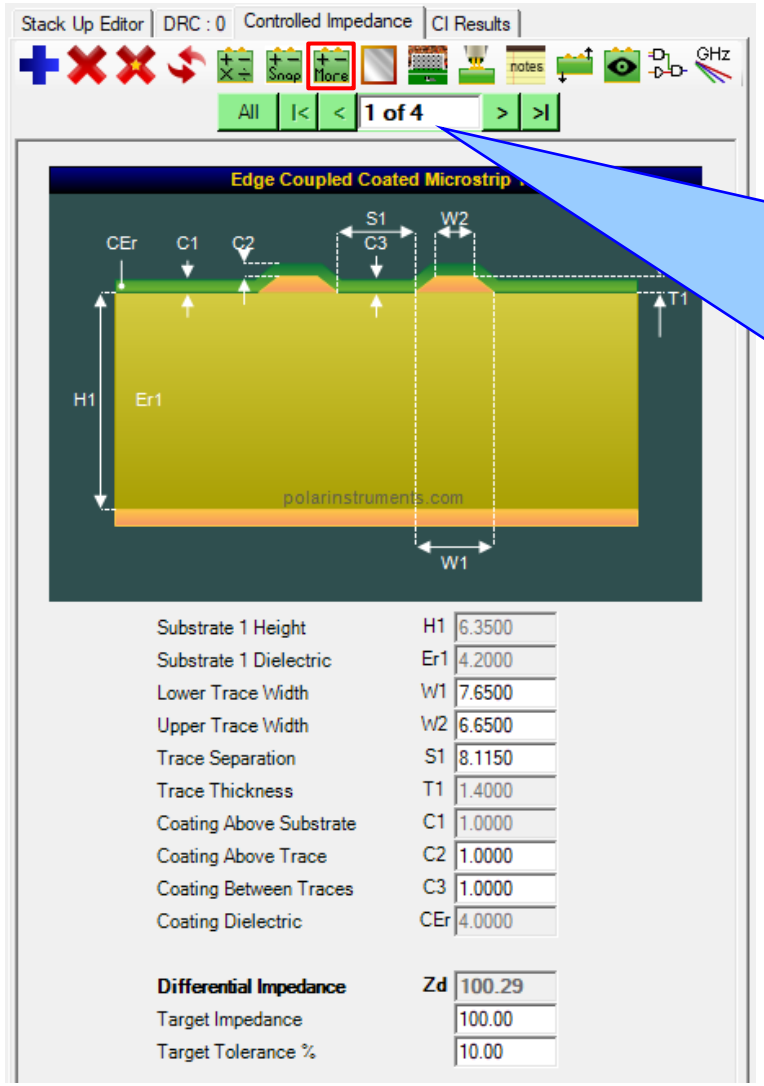
New Structure More Calculations option



On the structure toolbar there is a new More Calculations button. On selecting this option the following field solver results will be calculated:

Singled-Ended Structures: Impedance (Zo), Delay, Inductance, Capacitance, Effective Dielectric Constant, Velocity of Propagation

Differential Structures: Differential Impedance (Zdiff), Delay (Odd Mode), Odd Mode Impedance (Zodd), Even Mode Impedance (Zeven), Common Mode Impedance (Zcommon), Effective Dielectric Constant, Velocity of Propagation, Near-End Crosstalk (NEXT), Coupling Percentage

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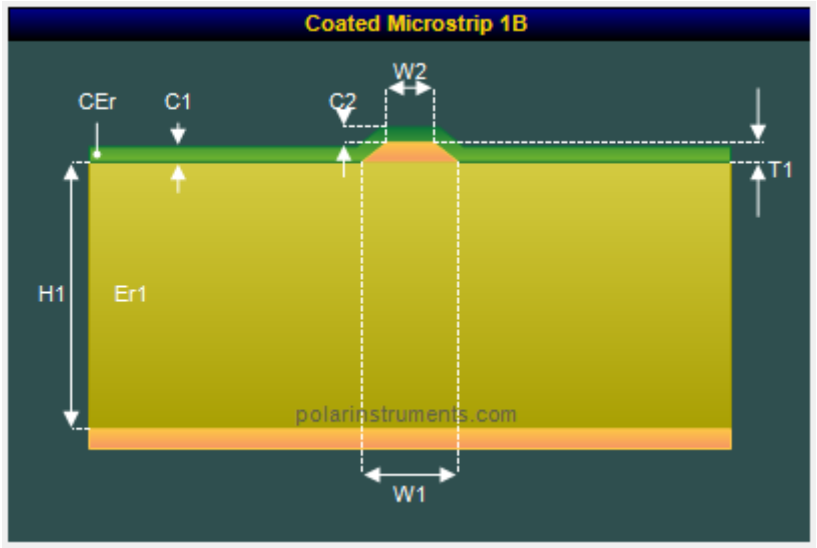
New Structure More Calculations option

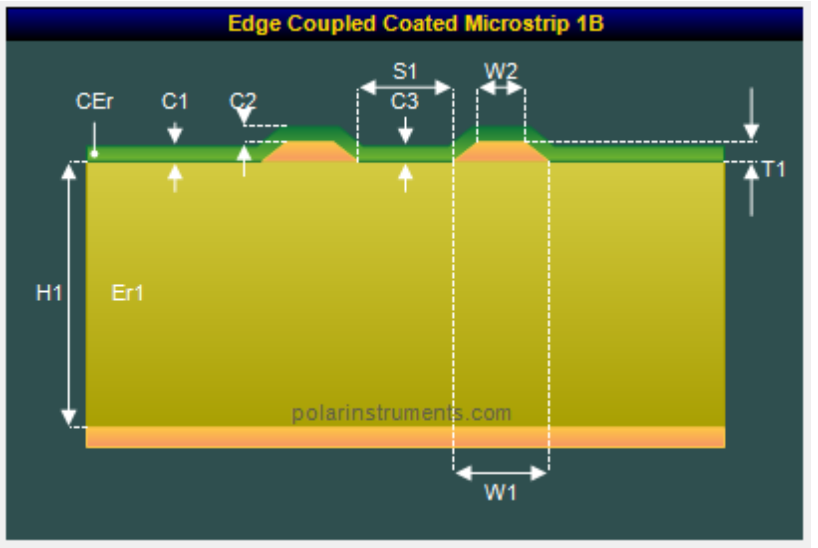
Single-ended structure results



More Calculations

Impedance	Zo	75.802	Close
Delay (ps/in)	D	152.272	
Inductance (nH/in)	L	11.543	
Capacitance (pF/in)	C	2.009	
Effective Dielectric Constant	EEr	3.230	
Velocity of Propogation (CITS)	Vp	0.556	

Differential structure results



More Calculations

Differential Impedance	Zdiff	100.289	Close
Delay (Odd Mode) (ps/in)	D	147.683	
Odd Mode Impedance	Zodd	50.144	
Even Mode Impedance	Zeven	67.086	
Common Mode Impedance	Zcommon	33.543	
Effective Dielectric Constant	EEr	3.038	
Velocity of Propogation (CITS)	Vp	0.574	
Near-End Crosstalk (NEXT)	Kb	7.2257E-02	
Coupling Percentage	CP	7.226	

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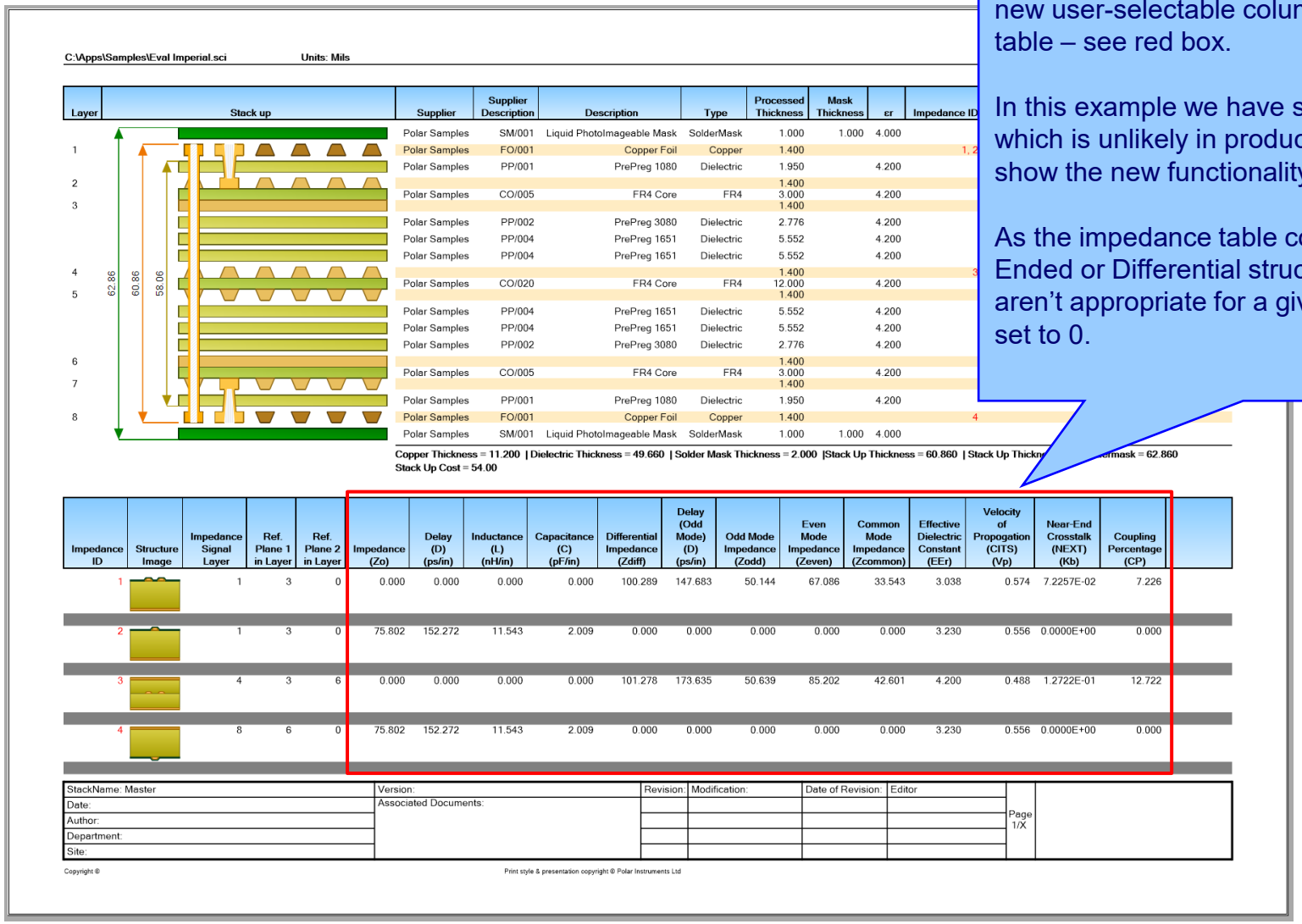
New Structure More Calculations option



C:\Apps\Samples\Eval Imperial.sci Units: Mils

Layer	Stack up	Supplier	Supplier Description	Description	Type	Processed Thickness	Mask Thickness	εr	Impedance ID
1		Polar Samples	SM/001	Liquid PhotoImageable Mask	SolderMask	1.000	1.000	4.000	
		Polar Samples	FO/001	Copper Foil	Copper	1.400			1, 2
		Polar Samples	PP/001	PrePreg 1080	Dielectric	1.950		4.200	
2						1.400			
3		Polar Samples	CO/005	FR4 Core	FR4	3.000		4.200	
						1.400			
		Polar Samples	PP/002	PrePreg 3080	Dielectric	2.776		4.200	
		Polar Samples	PP/004	PrePreg 1651	Dielectric	5.552		4.200	
		Polar Samples	PP/004	PrePreg 1651	Dielectric	5.552		4.200	
4						1.400			3
5		Polar Samples	CO/020	FR4 Core	FR4	12.000		4.200	
						1.400			
		Polar Samples	PP/004	PrePreg 1651	Dielectric	5.552		4.200	
		Polar Samples	PP/004	PrePreg 1651	Dielectric	5.552		4.200	
		Polar Samples	PP/002	PrePreg 3080	Dielectric	2.776		4.200	
6						1.400			
7		Polar Samples	CO/005	FR4 Core	FR4	3.000		4.200	
						1.400			
		Polar Samples	PP/001	PrePreg 1080	Dielectric	1.950		4.200	
8		Polar Samples	FO/001	Copper Foil	Copper	1.400			4
		Polar Samples	SM/001	Liquid PhotoImageable Mask	SolderMask	1.000	1.000	4.000	

62.86 60.86 58.06

Copper Thickness = 11.200 | Dielectric Thickness = 49.660 | Solder Mask Thickness = 2.000 |Stack Up Thickness = 60.860 | Stack Up Thickn ermask = 62.860
Stack Up Cost = 54.00

Impedance ID	Structure Image	Impedance Signal Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer	Impedance (Zo)	Delay (D) (ps/in)	Inductance (L) (nH/in)	Capacitance (C) (pF/in)	Differential Impedance (Zdiff)	Delay (Odd Mode) (D) (ps/in)	Odd Mode Impedance (Zodd)	Even Mode Impedance (Zeven)	Common Mode Impedance (Zcommon)	Effective Dielectric Constant (EEr)	Velocity of Propogation (CITS) (Vp)	Near-End Crosstalk (NEXT) (Kb)	Coupling Percentage (CP)
1		1	3	0	0.000	0.000	0.000	0.000	100.289	147.683	50.144	67.086	33.543	3.038	0.574	7.2257E-02	7.226
2		1	3	0	75.802	152.272	11.543	2.009	0.000	0.000	0.000	0.000	0.000	3.230	0.556	0.0000E+00	0.000
3		4	3	6	0.000	0.000	0.000	0.000	101.278	173.635	50.639	85.202	42.601	4.200	0.488	1.2722E-01	12.722
4		8	6	0	75.802	152.272	11.543	2.009	0.000	0.000	0.000	0.000	0.000	3.230	0.556	0.0000E+00	0.000

StackName: Master	Version:	Revision:	Modification:	Date of Revision:	Editor	
Date:	Associated Documents:					Page 1/X
Author:						
Department:						
Site:						

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The technical report has been enhanced with 13 new user-selectable columns on the impedance table – see red box.

In this example we have selected all 13 columns, which is unlikely in production use, but is good to show the new functionality.

As the impedance table contains both Single-Ended or Differential structures the columns that aren't appropriate for a given structure type are set to 0.

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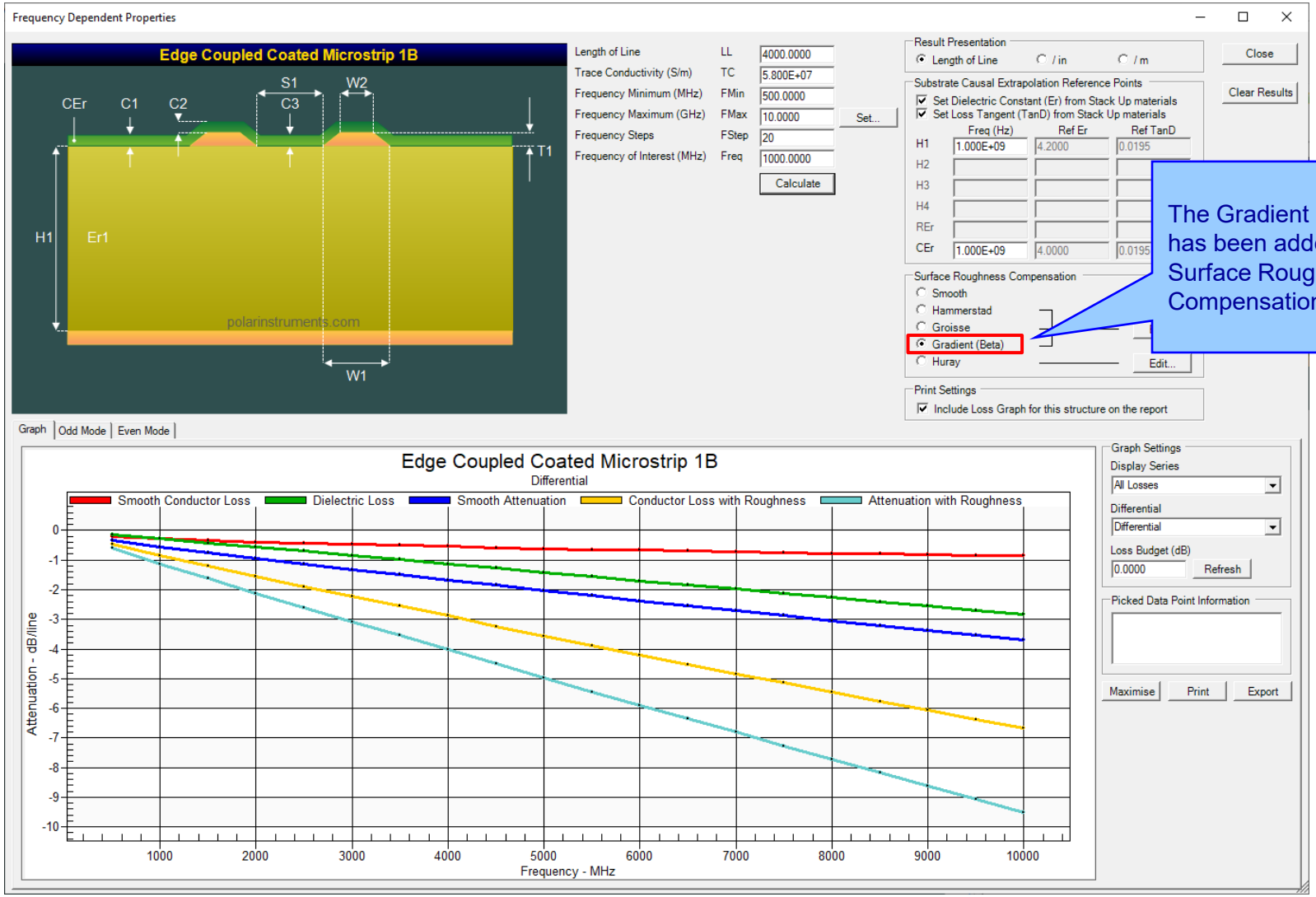
Gradient Roughness Method



The Gradient method has been added to the Surface Roughness Compensation options

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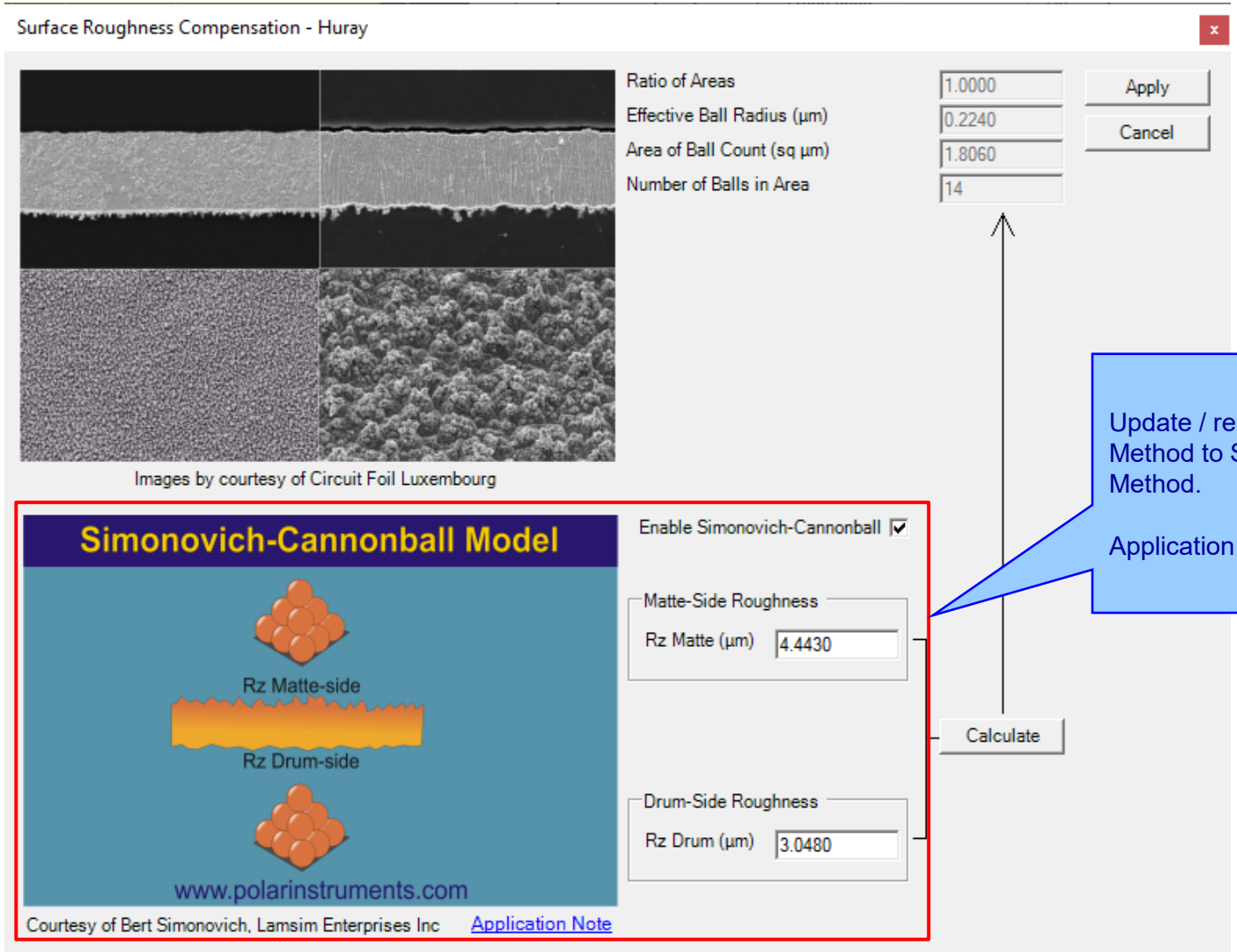
Update Cannonball-Huray Method to Simonovich-Cannonball Method



Update / rebrand of the Cannonball-Huray Method to Simonovich-Cannonball Method.

Application Note now links to two papers

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Other enhancements

- New import / export XML STKX v24.00 and SSX v14.00 file formats to support the new Gradient Surface Roughness Compensation Method
- Updated to support latest BEM Calculation Engine
- FlexNet Publisher / FLEXlm v11.19.0.0 supported
- Printing: Fixed problem where the Laminate to Laminate dimension was not calculated corrected when materials spanned multiple print pages

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Speedstack v24.01.01 (Jan 2024)

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Enhancements

- From 2024 Speedstack will be running on the Microsoft .Net Framework 4.8. It has migrated as a result of customer IT policy requests and we are working on new functionality for releases later in Q1 based on this new platform

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Speedstack v23.09.01 (Sept 2023)

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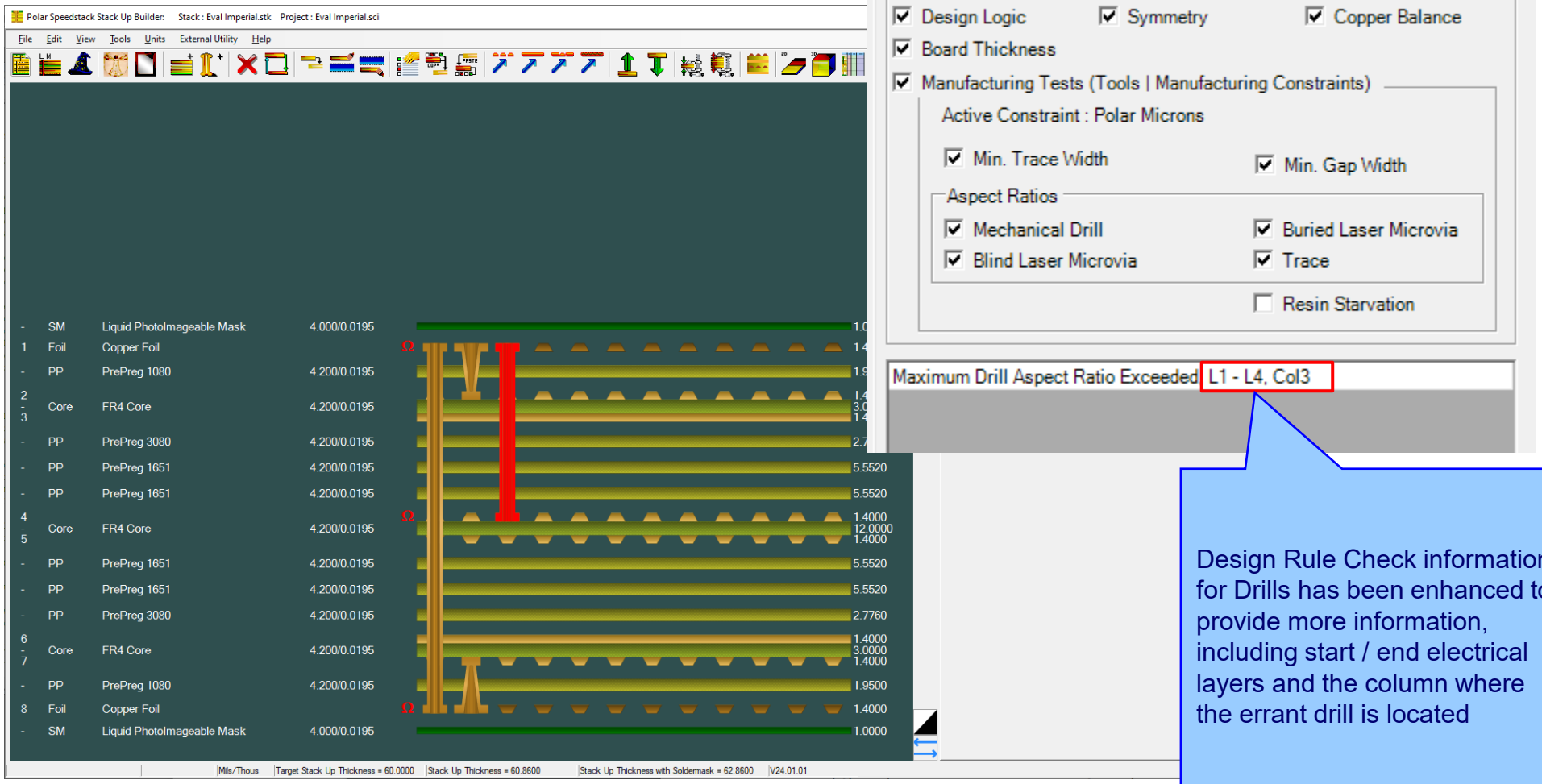
Design Rule Check (DRC) Enhancements



Design Rule Check information for Drills has been enhanced to provide more information, including start / end electrical layers and the column where the errant drill is located

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Other enhancements

- Printing: Improvements to the Solder Mask to Solder Mask thickness line, particularly when an ident / coverlay / peelable material is above or below the Solder Mask
- Printing: Bill of Materials (BOM) table enhancements including options to enable / disable Number of Panels, Circuits Per Panel, Cost Per Circuit that appear under BOM table
- Editor: Multi-selected materials will now stay selected when right-mouse menu is used to bring up context menu

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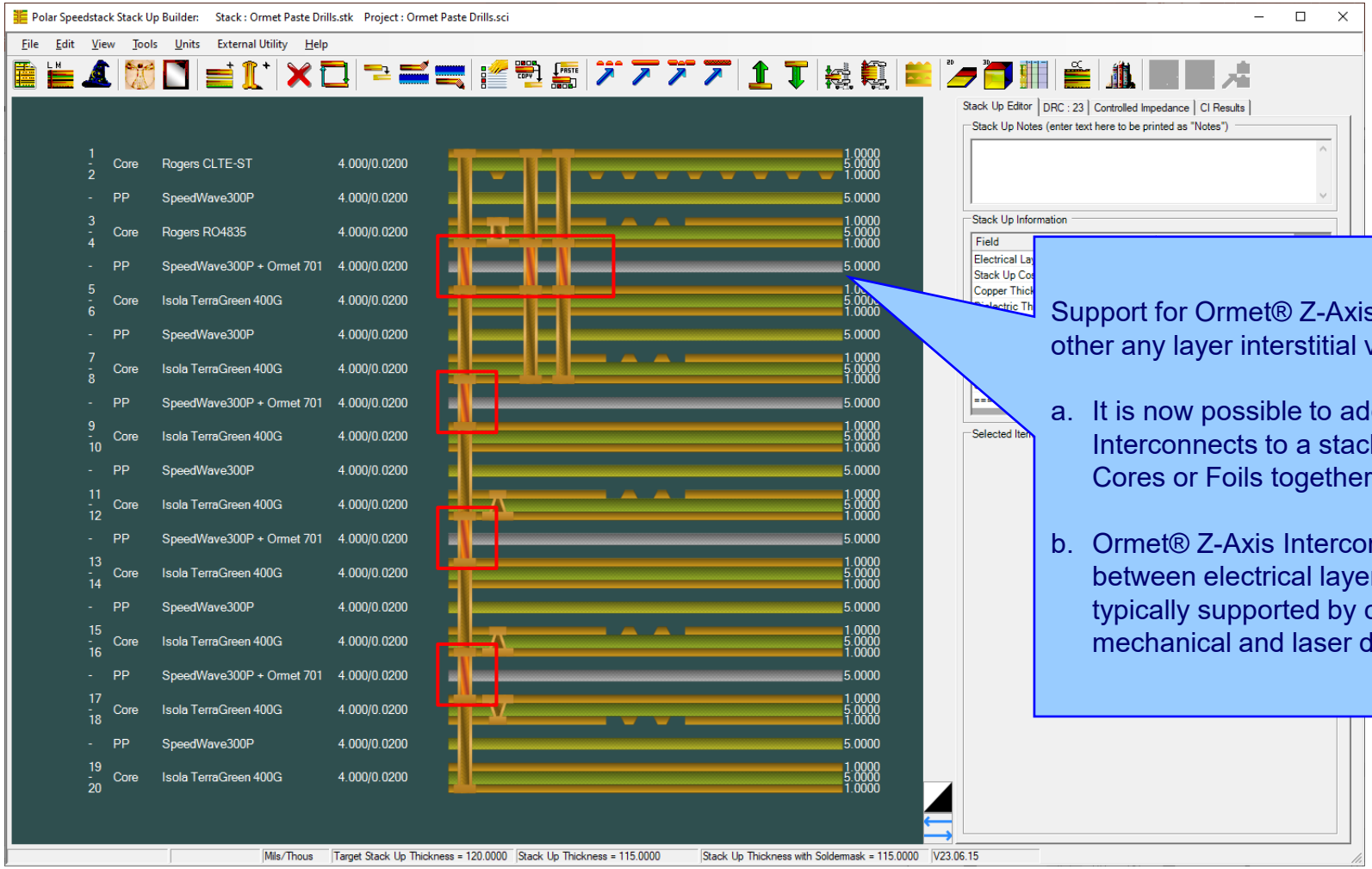
Drill Enhancements including support for Ormet® Z-Axis Interconnects or other any layer interstitial via technology



Support for Ormet® Z-Axis Interconnects or other any layer interstitial via technology

a. It is now possible to add Ormet® Z-Axis Interconnects to a stack up to connect two Cores or Foils together

b. Ormet® Z-Axis Interconnects can be placed between electrical layers which are not typically supported by conventional mechanical and laser drills

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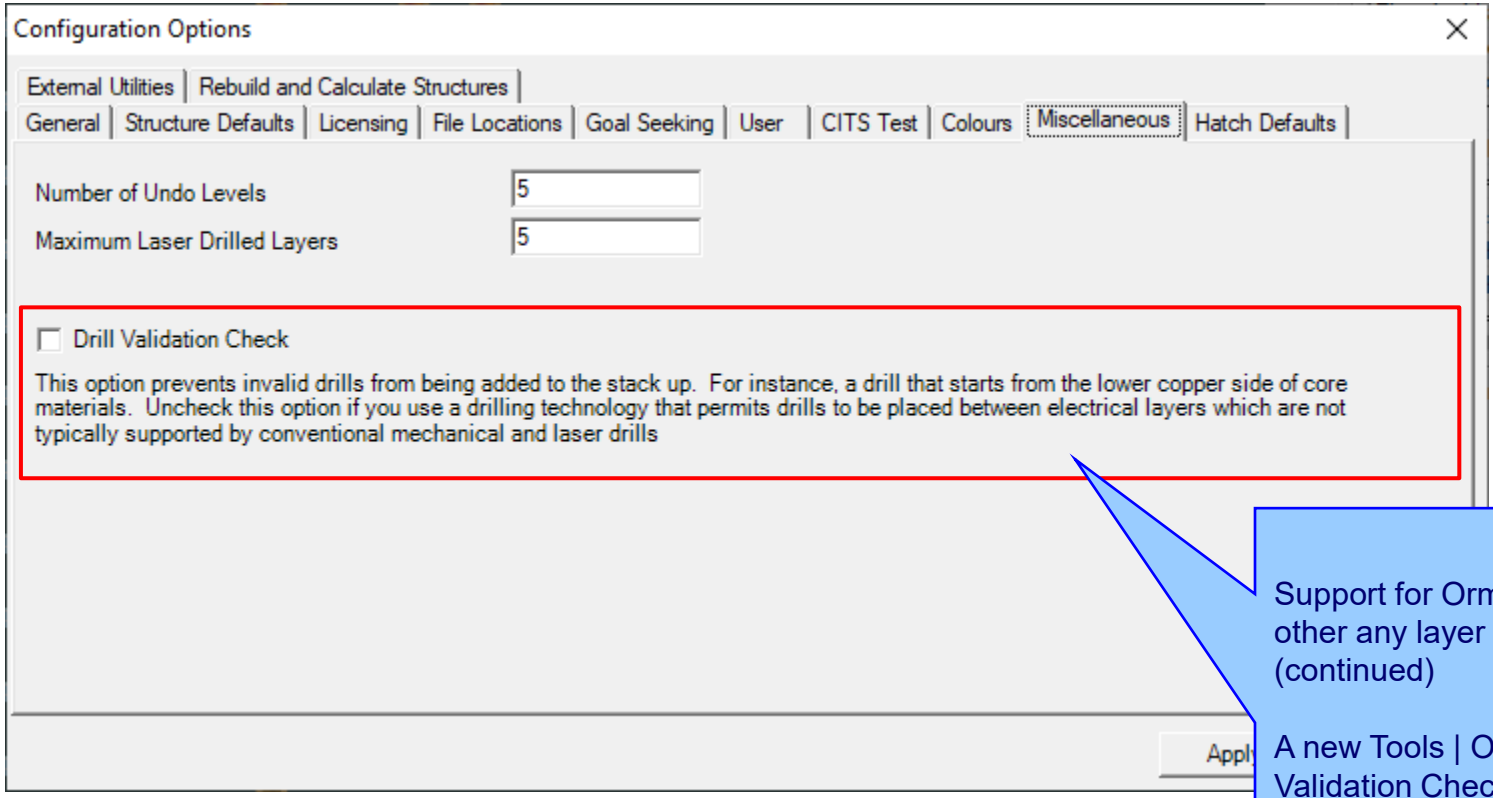
Enhancements including support for Ormet® Z-Axis Interconnects or other any layer interstitial via technology



Support for Ormet® Z-Axis Interconnects or other any layer interstitial via technology (continued)

A new Tools | Options | Miscellaneous tab Drill Validation Check option has been introduced. Unchecking this option will disable the Speedstack invalid drills check in order to support the Ormet® Z-Axis Interconnects technology

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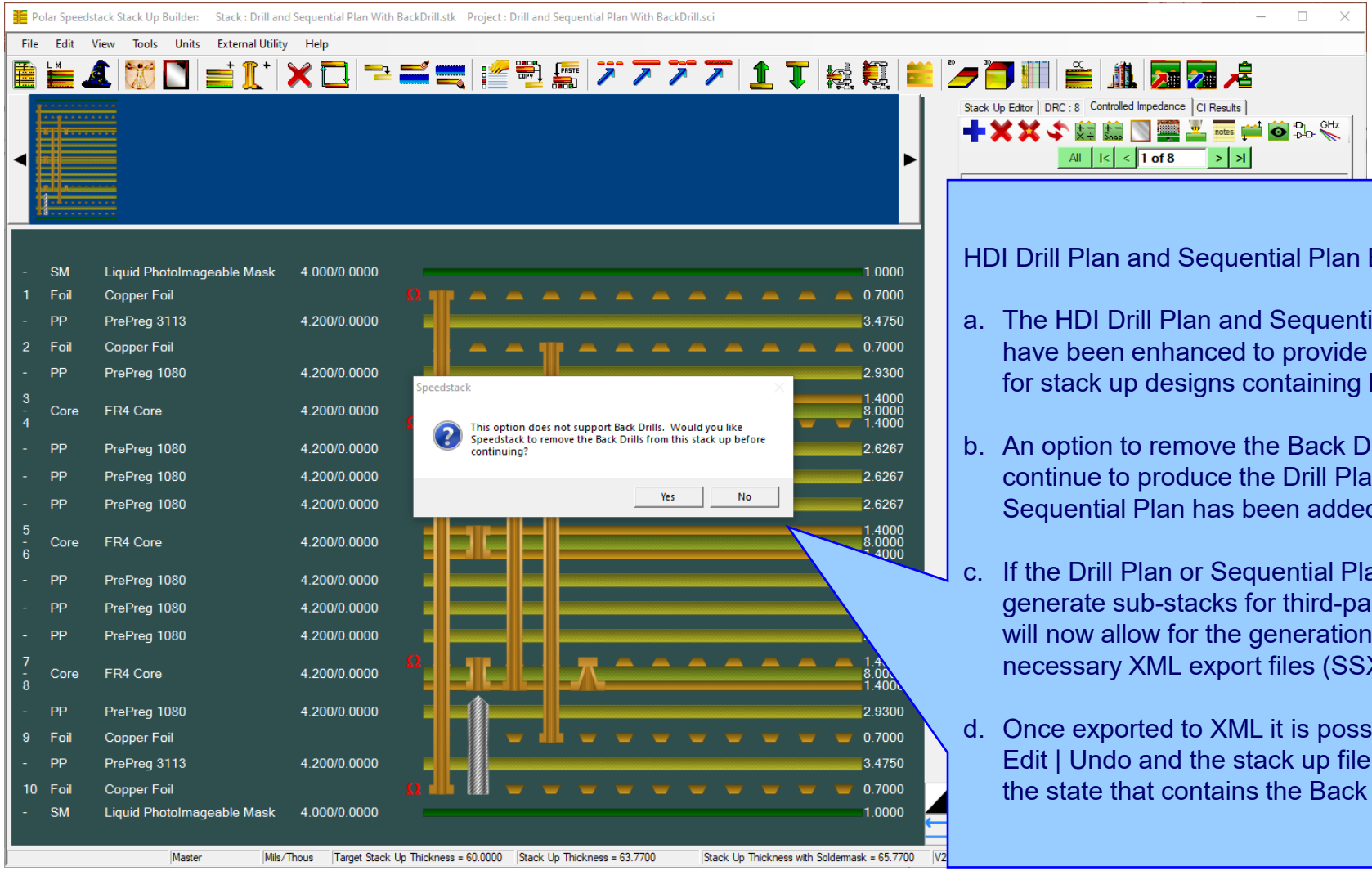
HDI Drill Plan and Sequential Plan Enhancements



HDI Drill Plan and Sequential Plan Enhancements

a. The HDI Drill Plan and Sequential Plan options have been enhanced to provide better support for stack up designs containing Back Drills

b. An option to remove the Back Drills and continue to produce the Drill Plan or Sequential Plan has been added

c. If the Drill Plan or Sequential Plan is used to generate sub-stacks for third-party tools, this will now allow for the generation of the necessary XML export files (SSX)

d. Once exported to XML it is possible to select Edit | Undo and the stack up file will return to the state that contains the Back Drills

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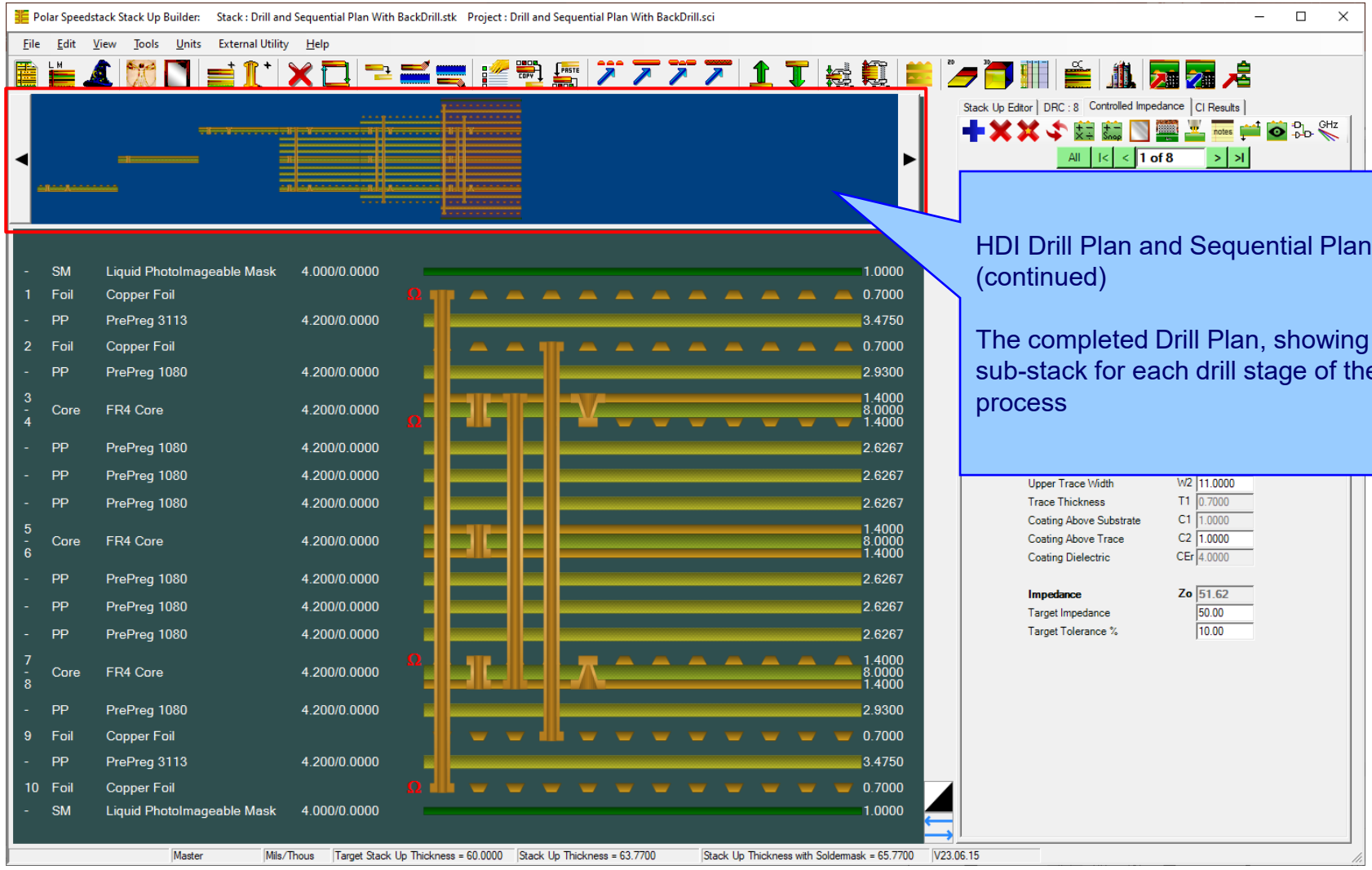
HDI Drill Plan and Sequential Plan Enhancements



HDI Drill Plan and Sequential Plan Enhancements (continued)

The completed Drill Plan, showing a separate sub-stack for each drill stage of the fabrication process

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Speedstack v23.05.01 (May 2023)

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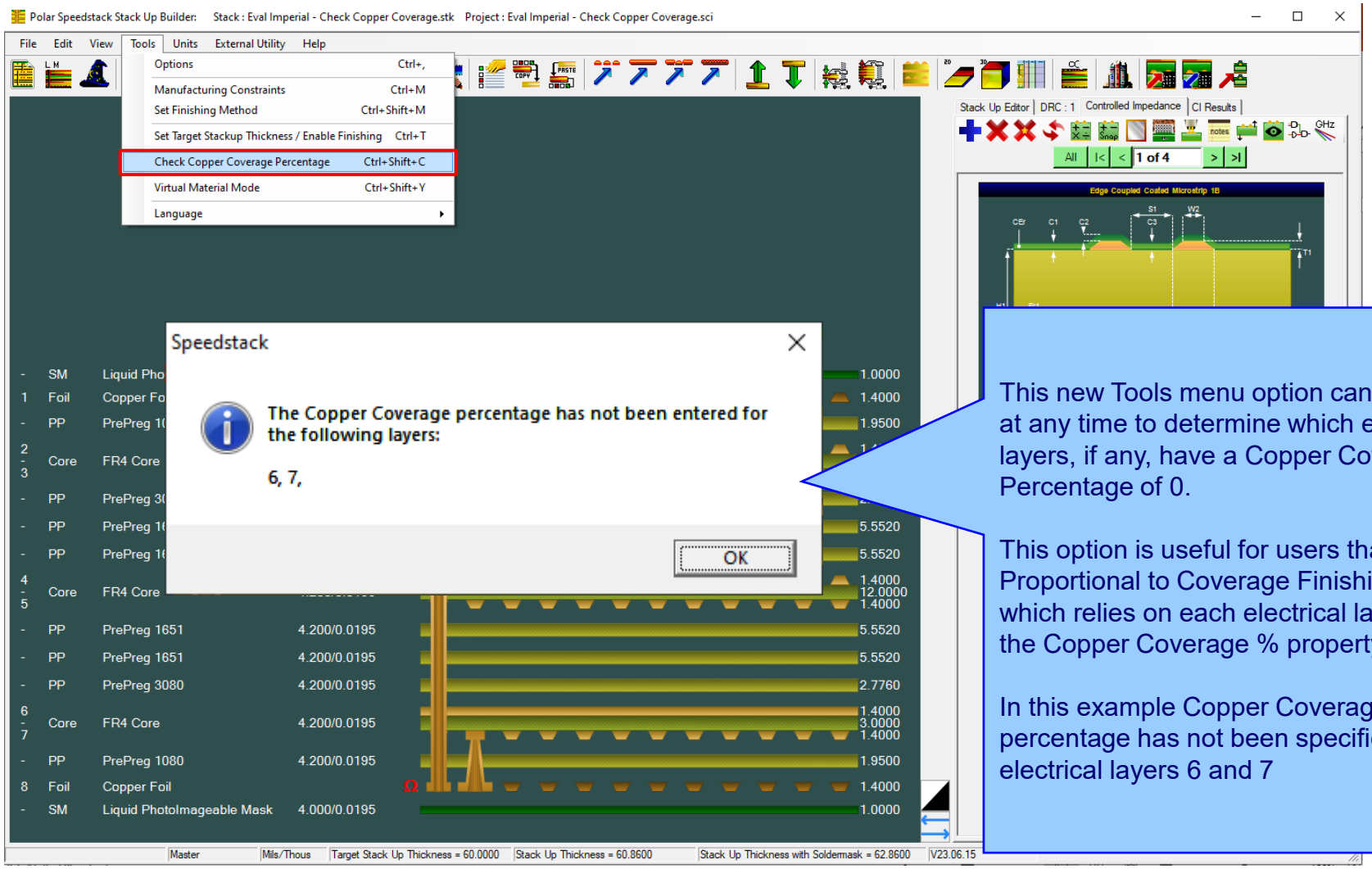
New Check Copper Coverage Percentage option



This new Tools menu option can be selected at any time to determine which electrical layers, if any, have a Copper Coverage Percentage of 0.

This option is useful for users that select the Proportional to Coverage Finishing method, which relies on each electrical layer having the Copper Coverage % property populated

In this example Copper Coverage percentage has not been specified for electrical layers 6 and 7

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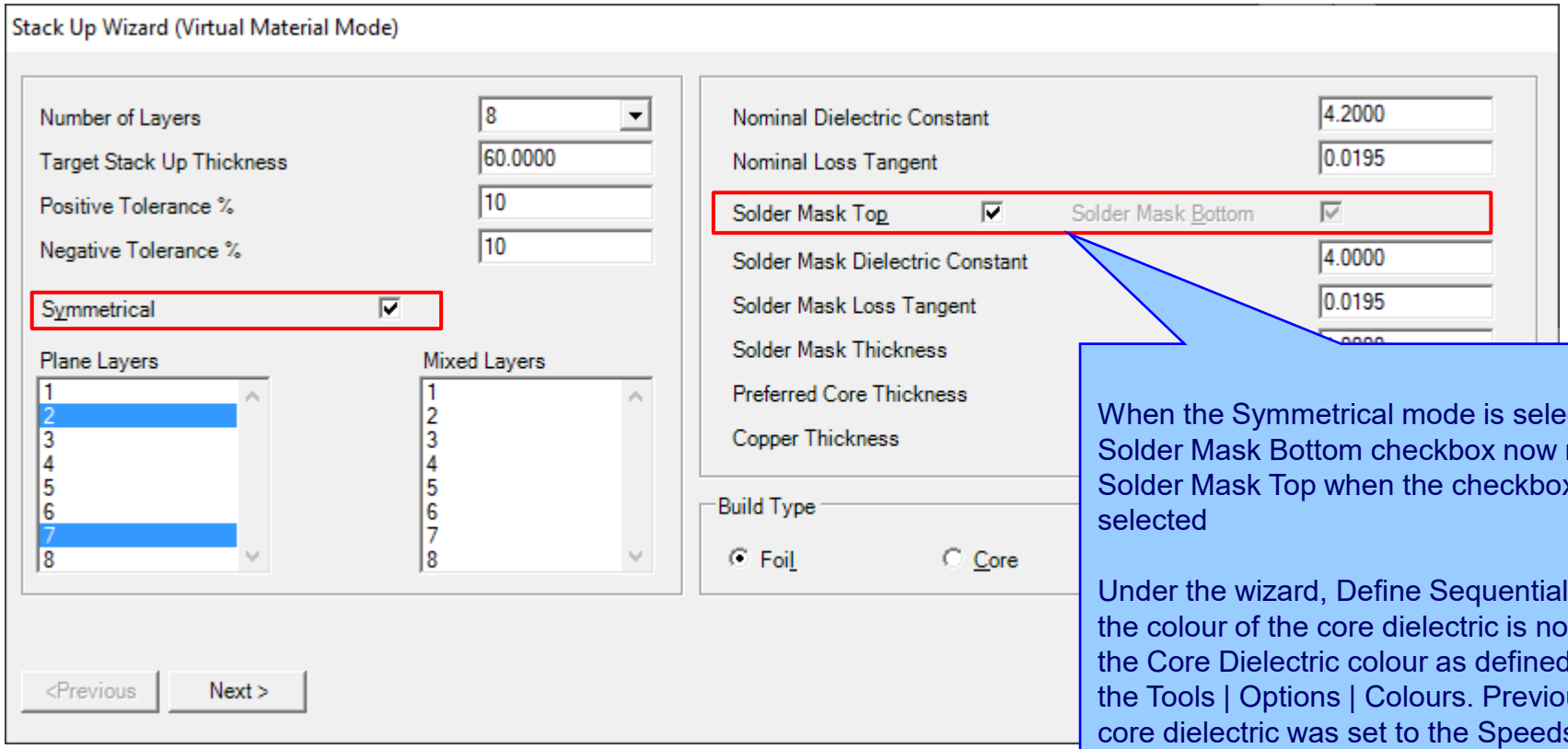
Virtual Material Wizard Improvements



When the Symmetrical mode is selected, the Solder Mask Bottom checkbox now matches Solder Mask Top when the checkbox is selected

Under the wizard, Define Sequential Build, the colour of the core dielectric is now set to the Core Dielectric colour as defined under the Tools | Options | Colours. Previously, the core dielectric was set to the Speedstack default colour

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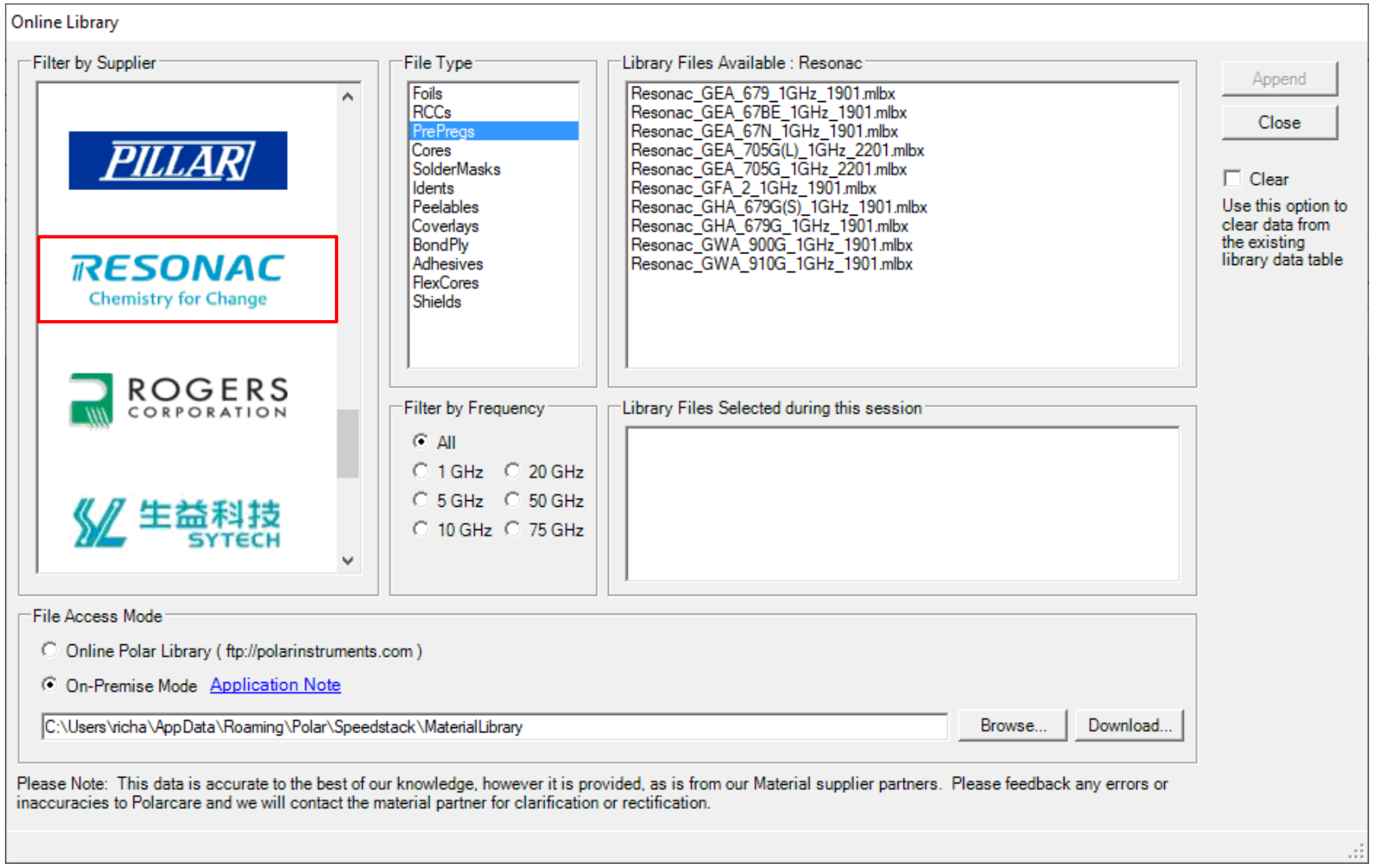
Resonac materials added to the Online Library



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Speedstack v23.04.02 (April 2023)

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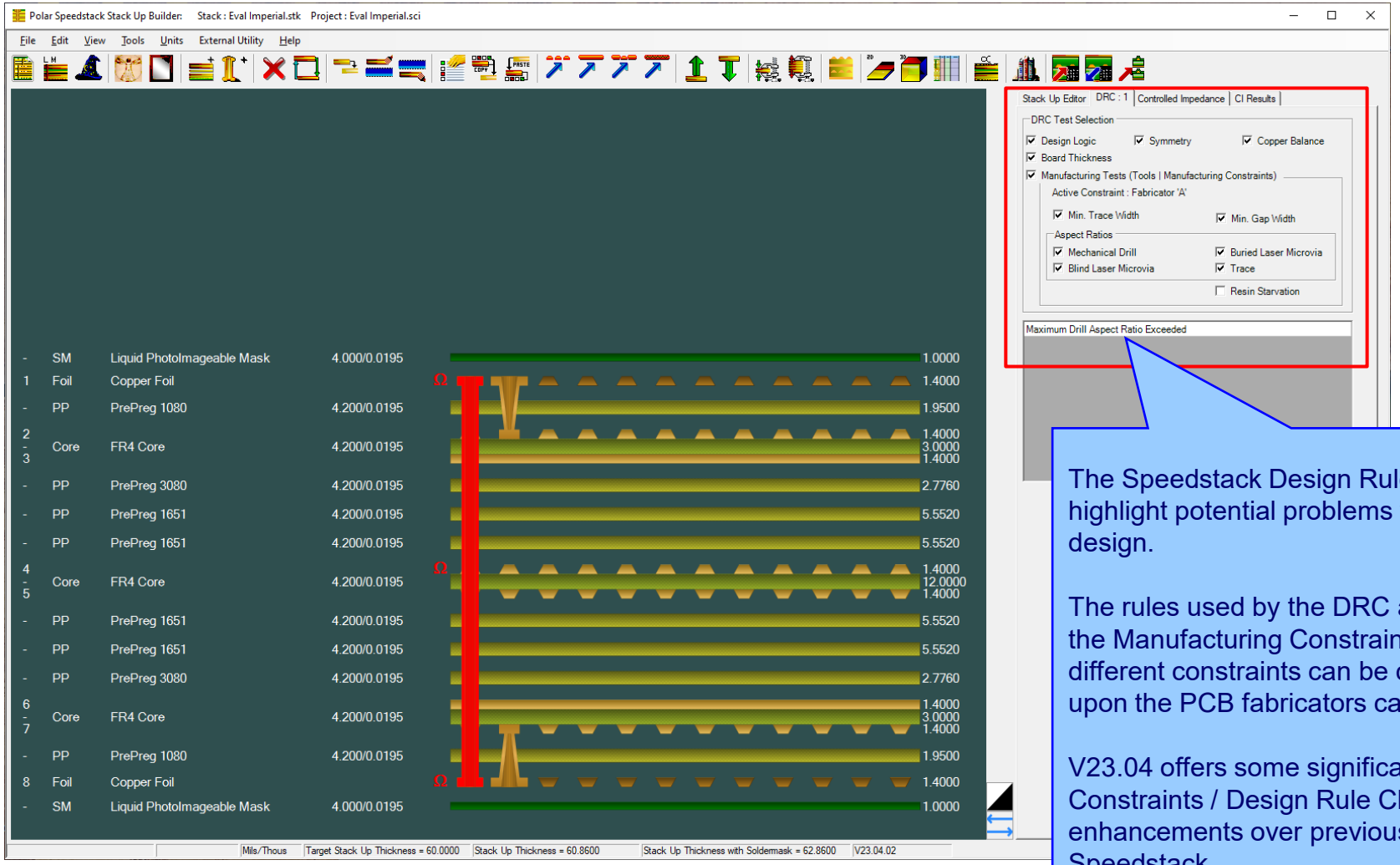
Manufacturing Constraints / Design Rule Check Enhancements



The Speedstack Design Rule Checks (DRC) highlight potential problems with the stack up design.

The rules used by the DRC are held within the Manufacturing Constraints, where different constraints can be configured based upon the PCB fabricators capabilities.

V23.04 offers some significant Manufacturing Constraints / Design Rule Check enhancements over previous versions of Speedstack.

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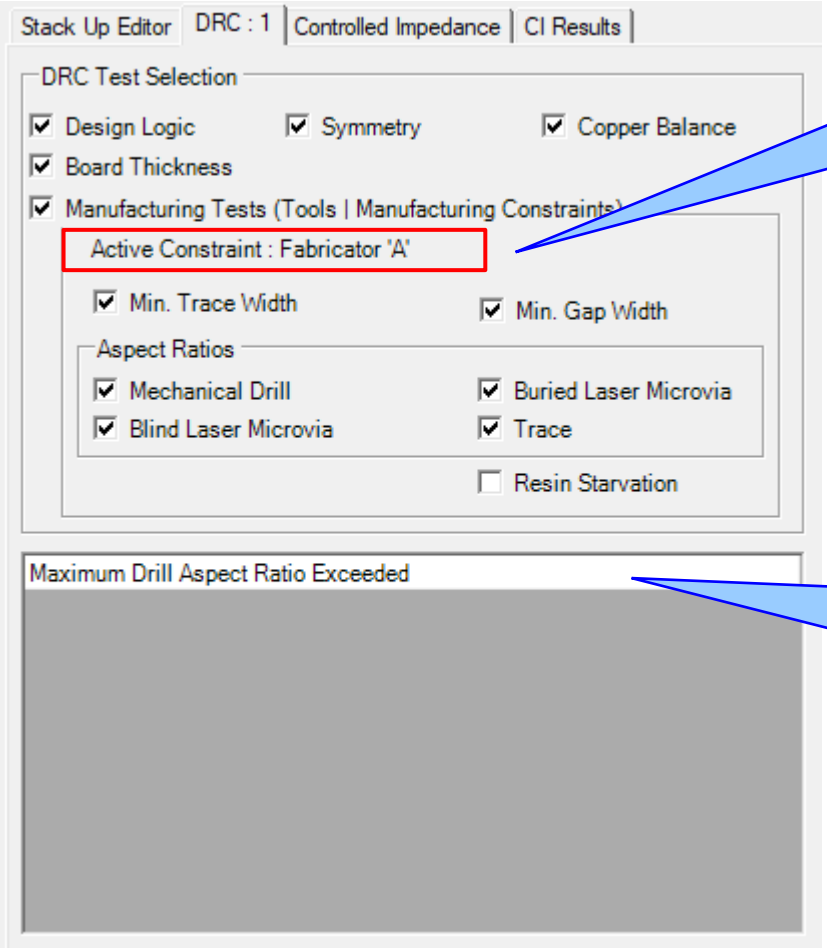
Manufacturing Constraints / Design Rule Check Enhancements



The Active Constraint name is now displayed here so the current selected set of Manufacturing Constraints is easily identifiable

DRC errors are listed here. Clicking the error will graphically highlight the problem on the stack up

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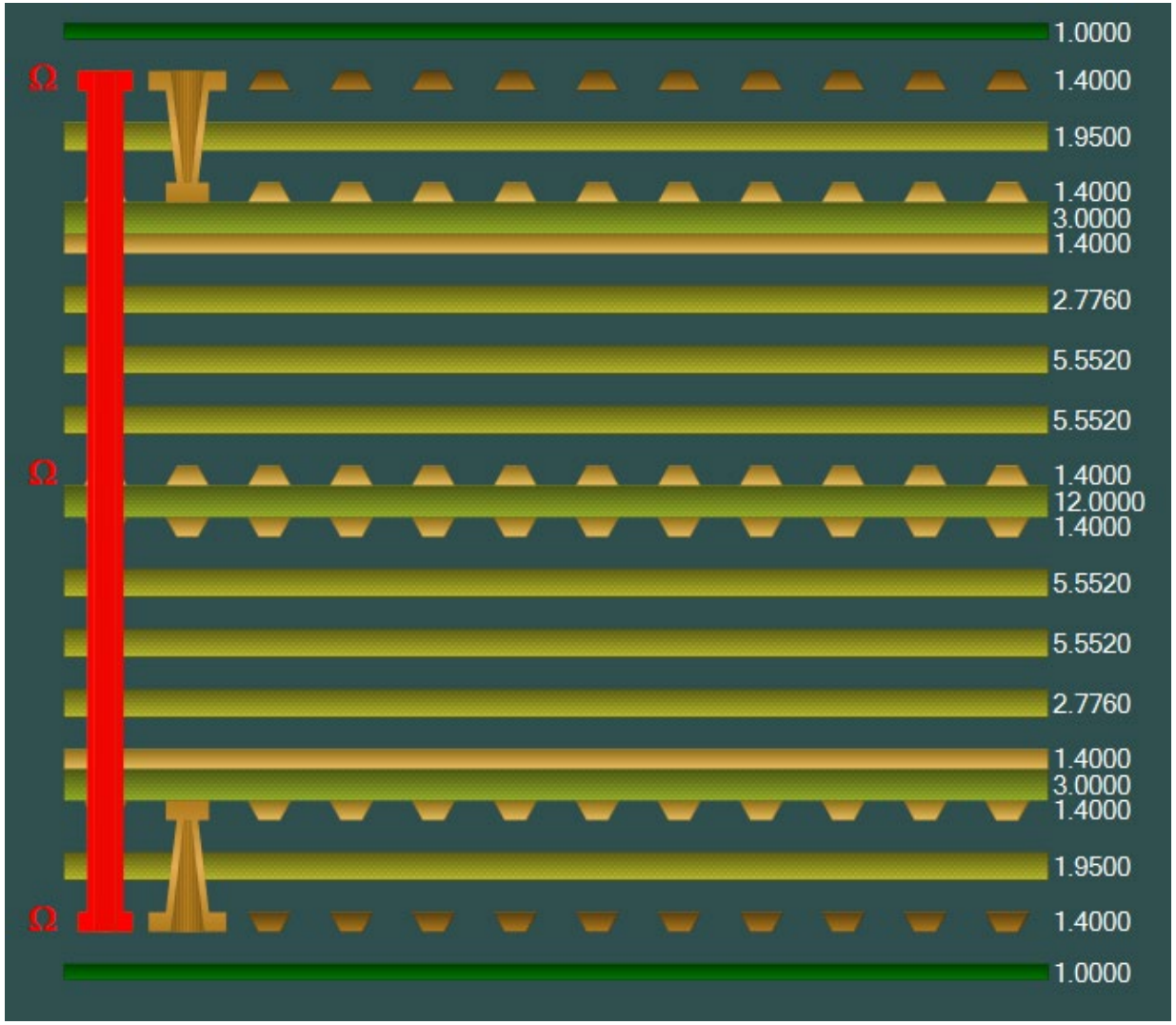
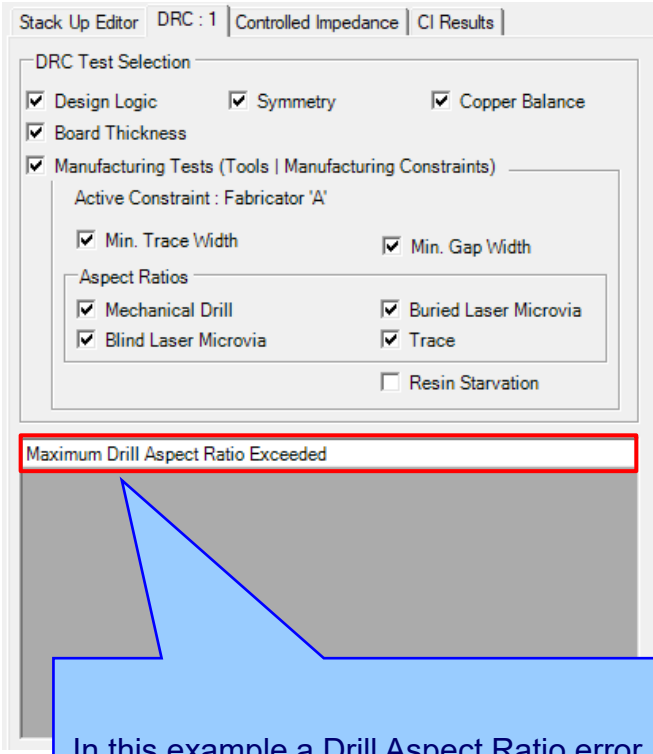
Manufacturing Constraints / Design Rule Check Enhancements





In this example a Drill Aspect Ratio error has been identified, clicking on the error will highlight the offending drill in red.

Drill Aspect Ratio checks the length of the drill against the diameter to determine whether plating problems might occur

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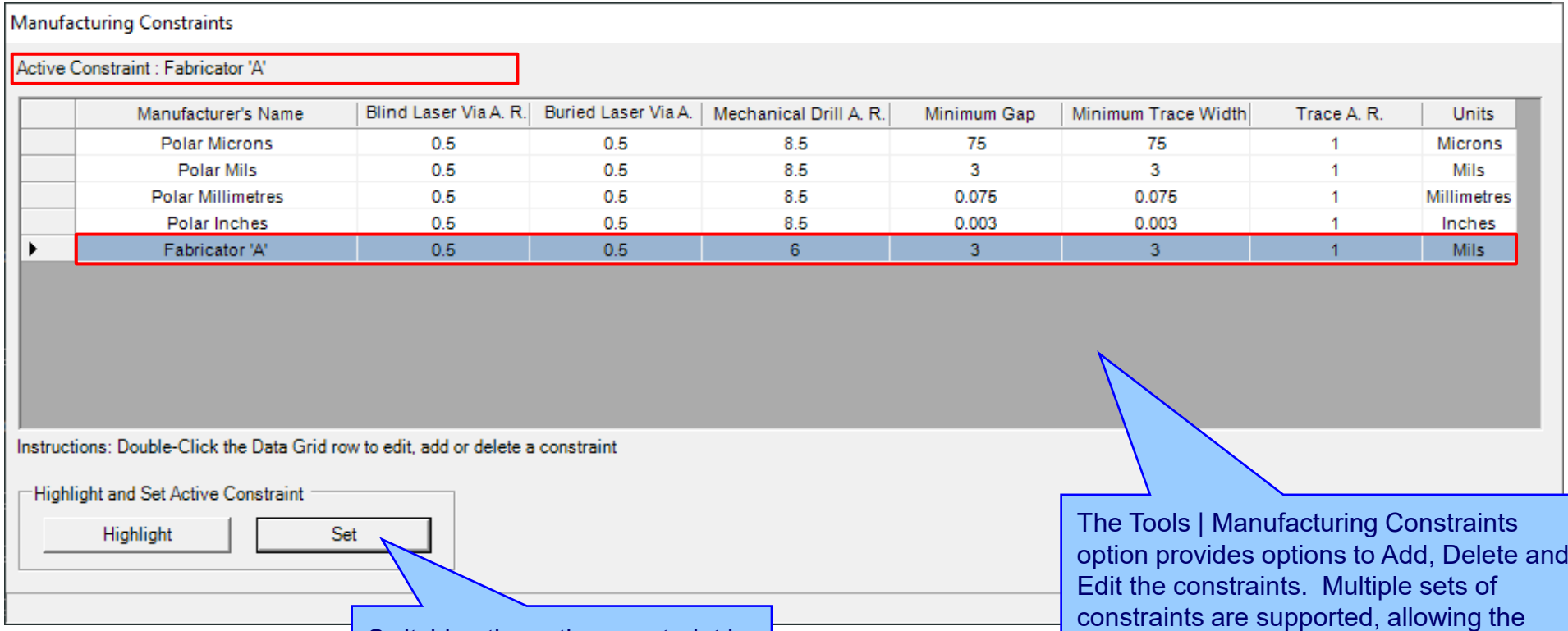
Manufacturing Constraints / Design Rule Check Enhancements



Switching the active constraint is achieved by selecting the required Data Grid row and clicking Set

The Tools | Manufacturing Constraints option provides options to Add, Delete and Edit the constraints. Multiple sets of constraints are supported, allowing the stack up design to be checked against different fabricators capabilities.

The current active constraint used by the DRC tab, Fabricator ‘A’, is displayed above the Data Grid

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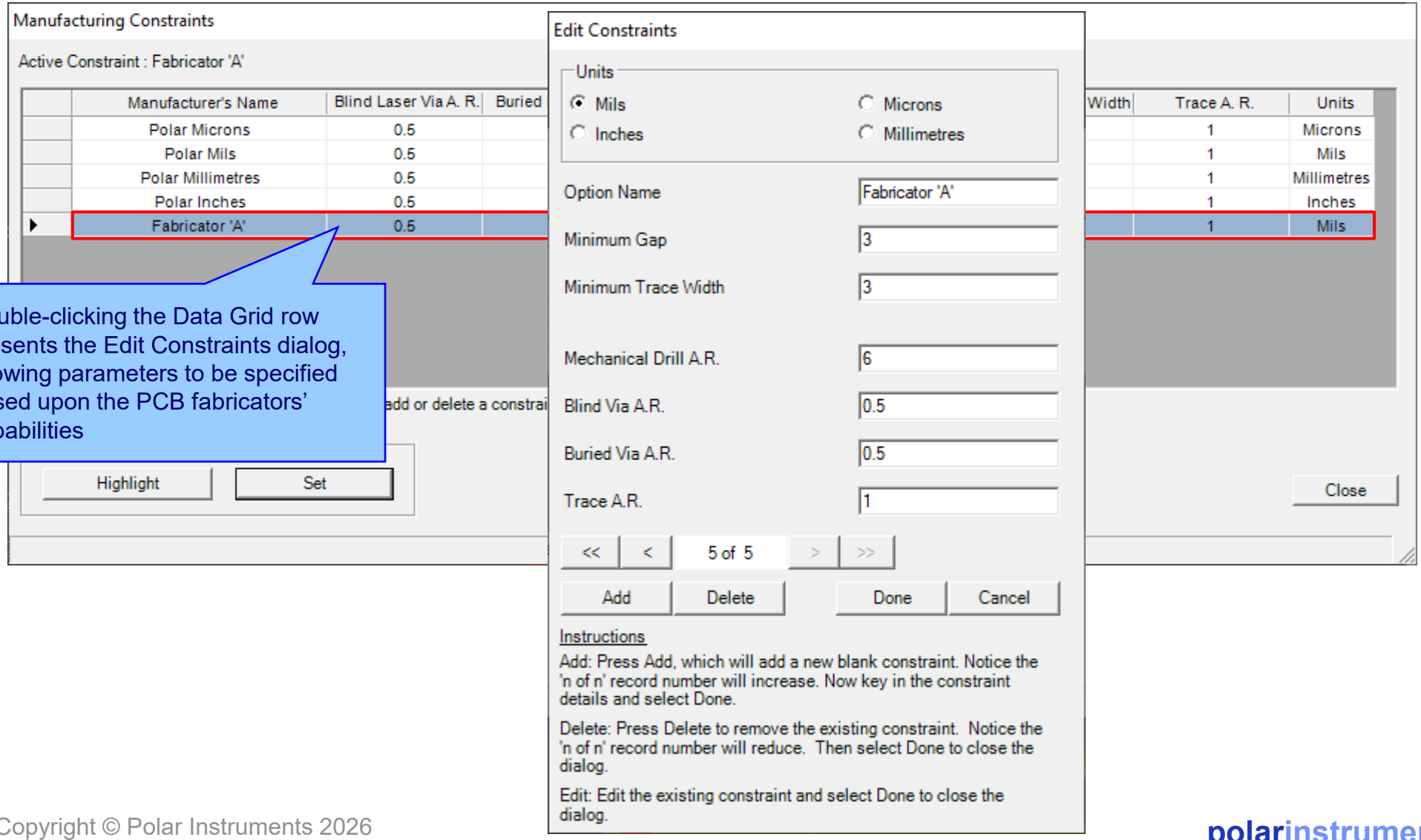
Manufacturing Constraints / Design Rule Check Enhancements



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Speedstack v23.03.01 (March 2023)

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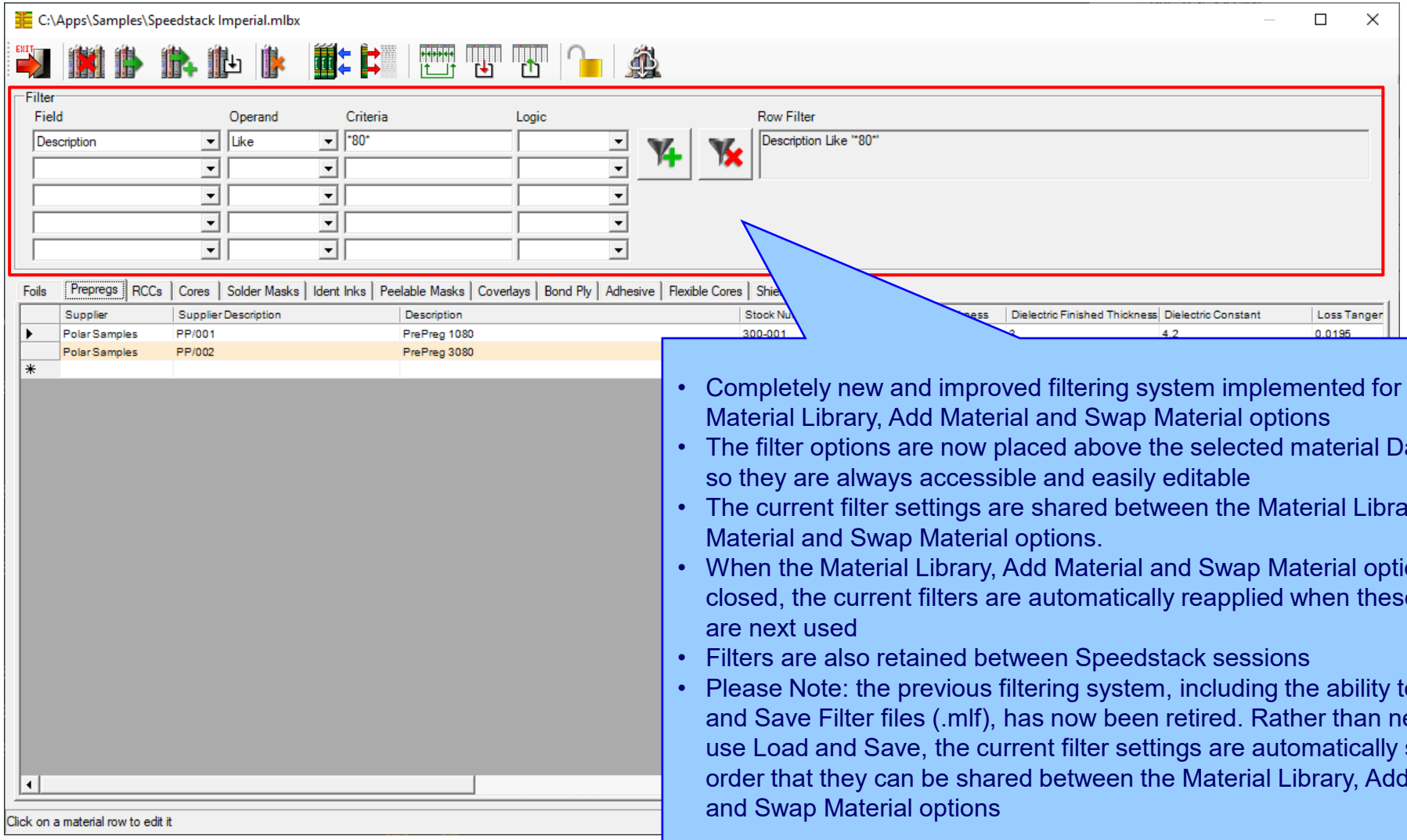
Material Library Filter / Search Enhancements



- Completely new and improved filtering system implemented for the Material Library, Add Material and Swap Material options
- The filter options are now placed above the selected material Data Grid, so they are always accessible and easily editable
- The current filter settings are shared between the Material Library, Add Material and Swap Material options.
- When the Material Library, Add Material and Swap Material options are closed, the current filters are automatically reapplied when these options are next used
- Filters are also retained between Speedstack sessions
- Please Note: the previous filtering system, including the ability to Load and Save Filter files (.mlf), has now been retired. Rather than needing to use Load and Save, the current filter settings are automatically saved in order that they can be shared between the Material Library, Add Material and Swap Material options

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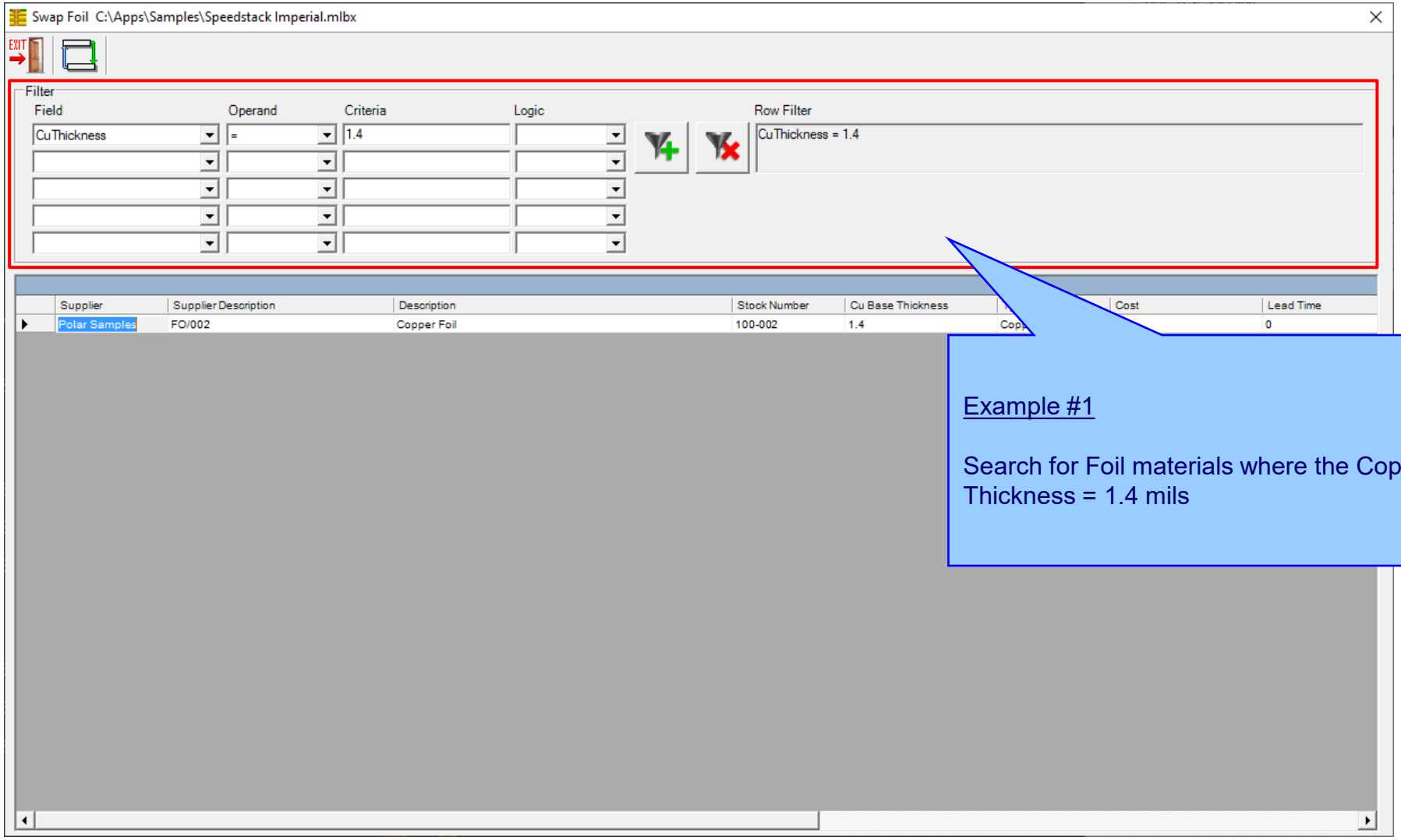
Material Library Filter / Search Enhancements



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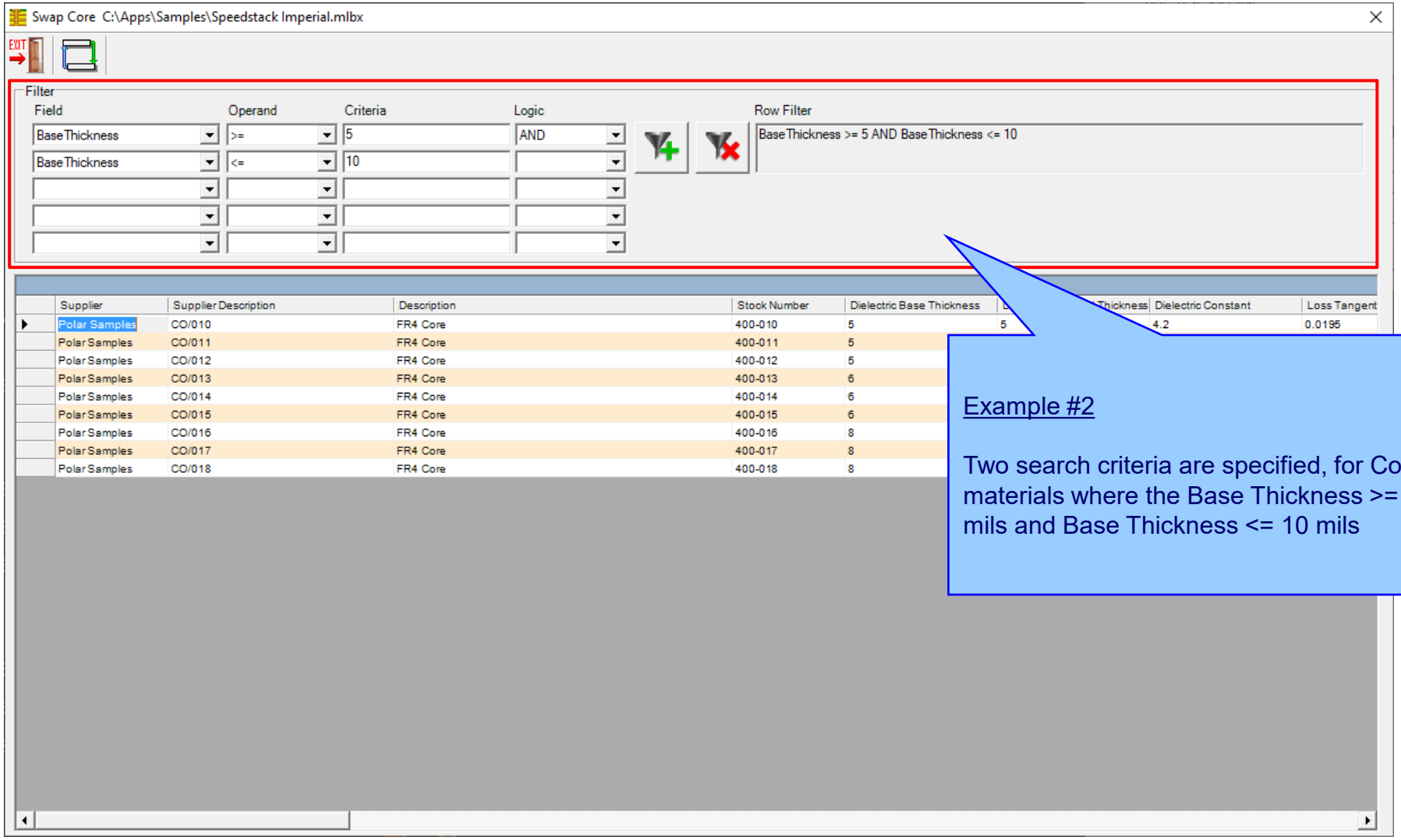
Material Library Filter / Search Enhancements



Example #2

Two search criteria are specified, for Core materials where the Base Thickness >= 5 mils and Base Thickness <= 10 mils

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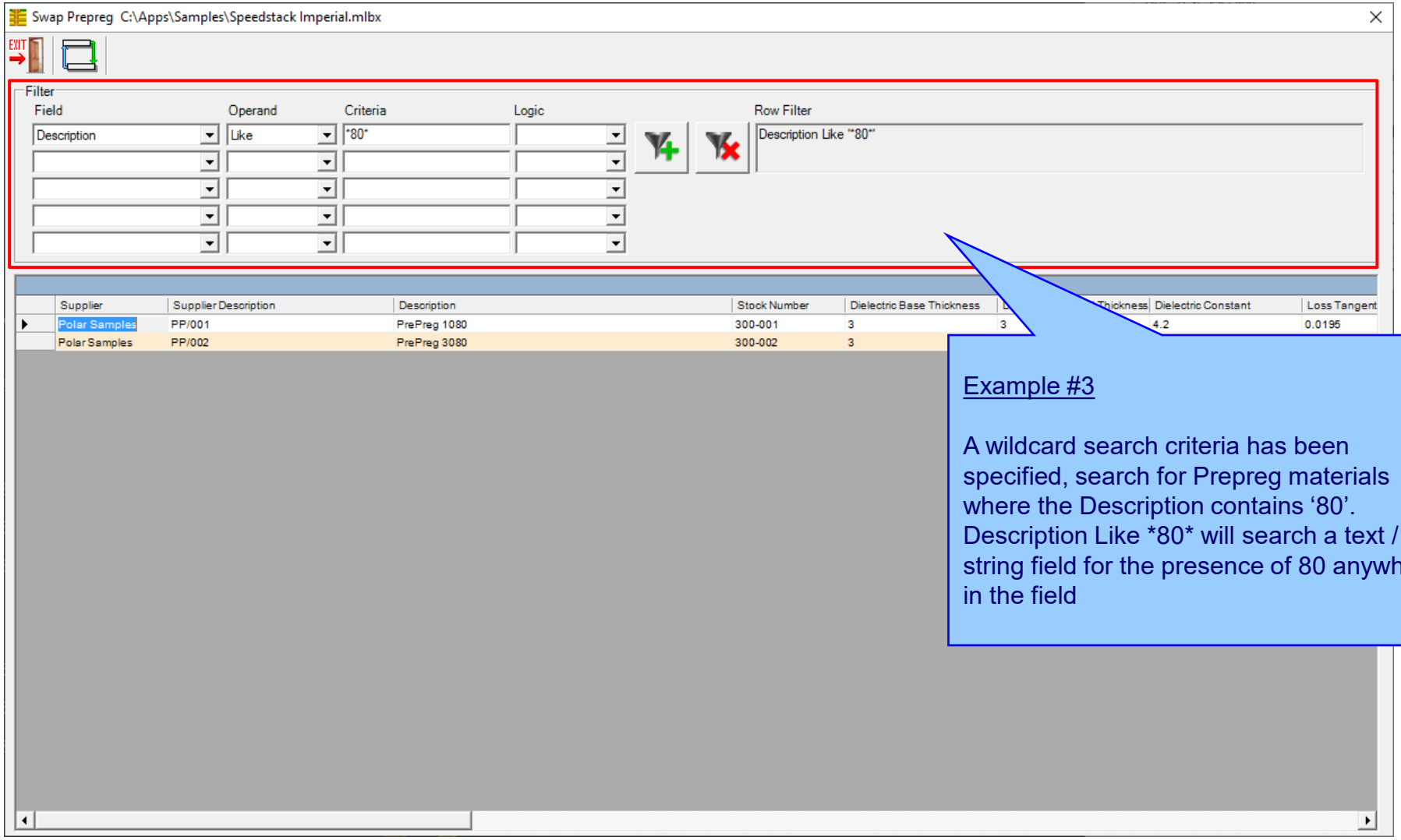
Material Library Filter / Search Enhancements



Example #3

A wildcard search criteria has been specified, search for Prepreg materials where the Description contains '80'. Description Like *80* will search a text / string field for the presence of 80 anywhere in the field

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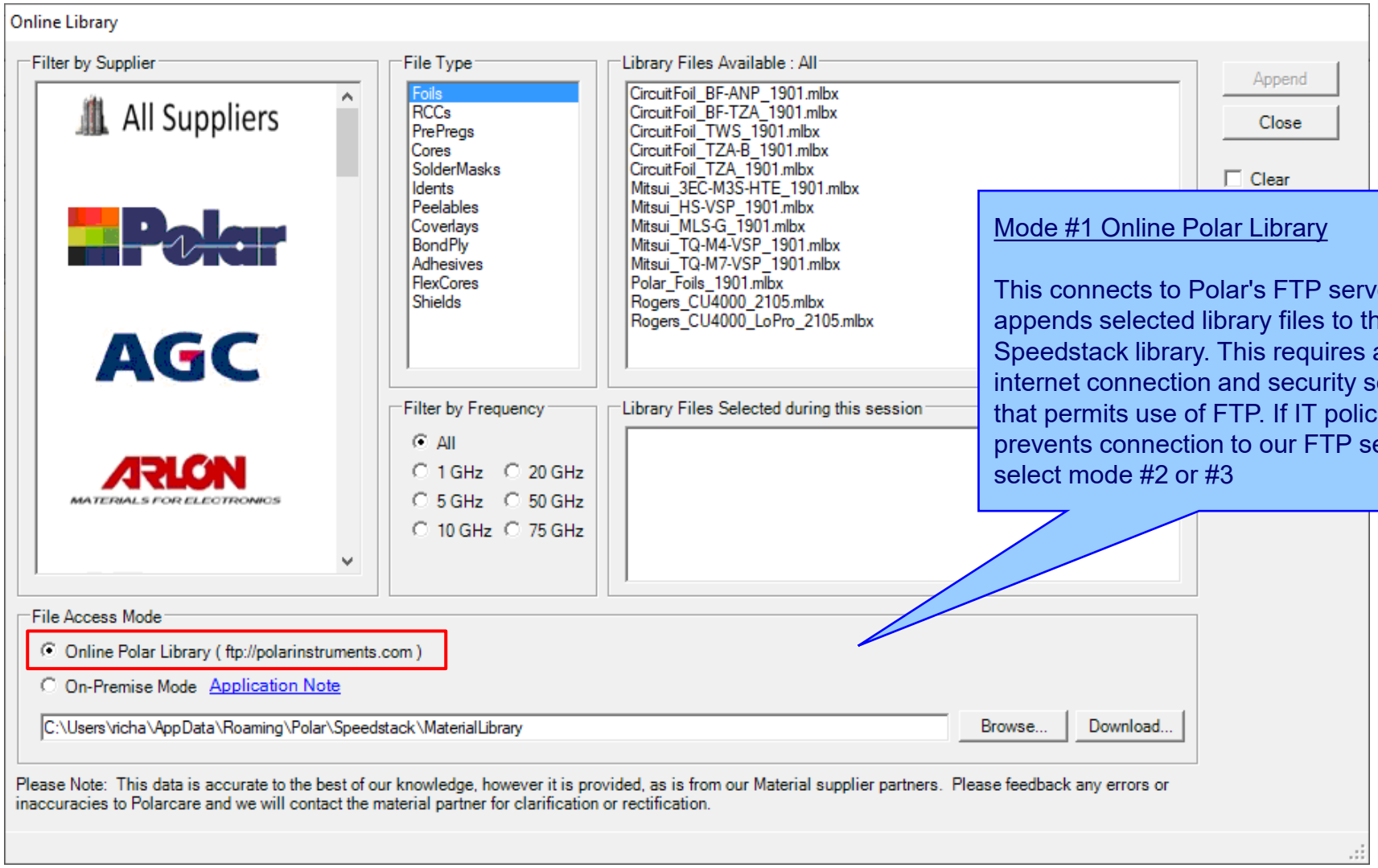
Online Library – Now supports three modes



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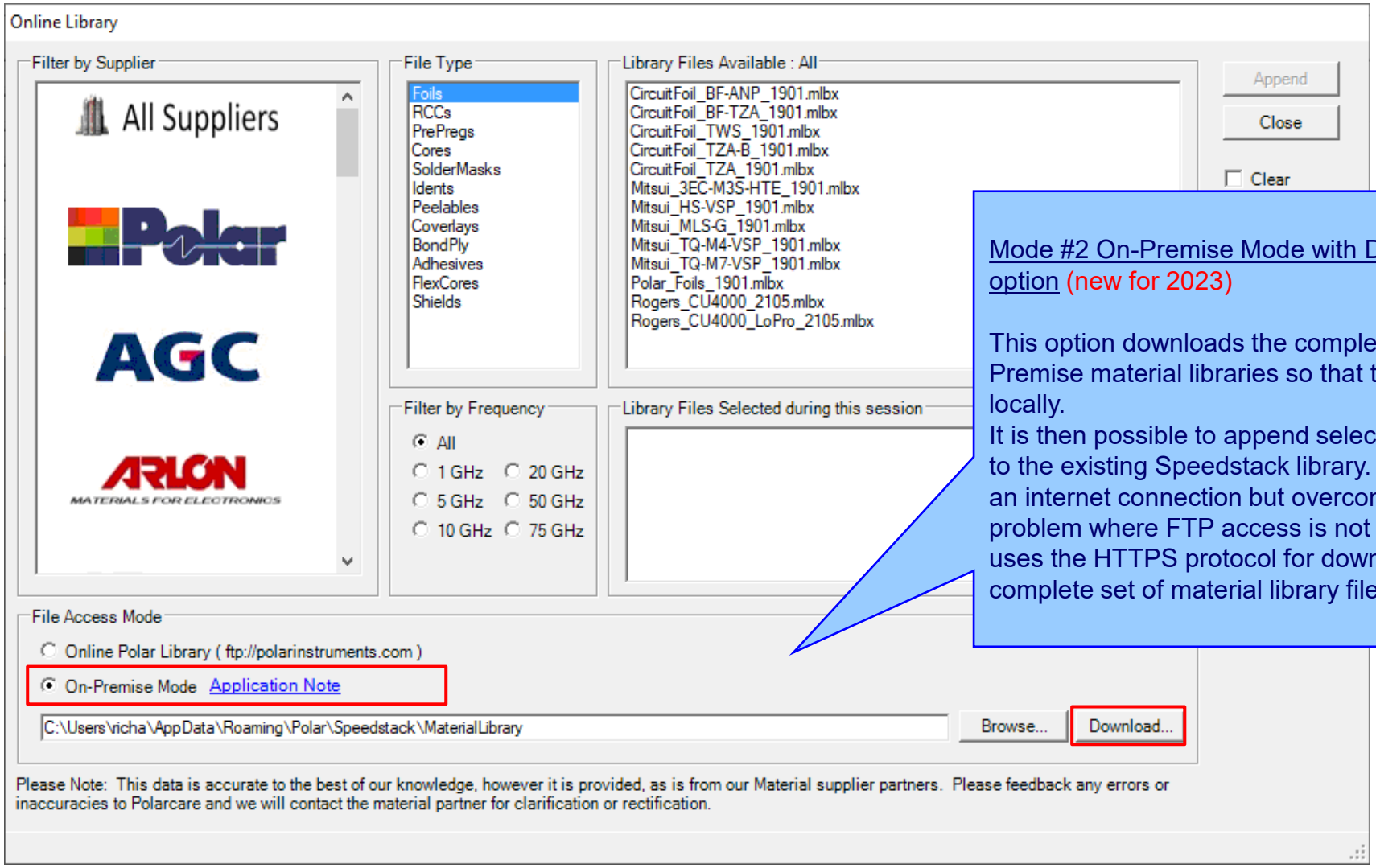
Online Library – Now supports three modes



Mode #2 On-Premise Mode with Download option (new for 2023)

This option downloads the complete set of On-Premise material libraries so that they are stored locally.
It is then possible to append selected library files to the existing Speedstack library. This requires an internet connection but overcomes the problem where FTP access is not permitted as it uses the HTTPS protocol for downloading the complete set of material library files.

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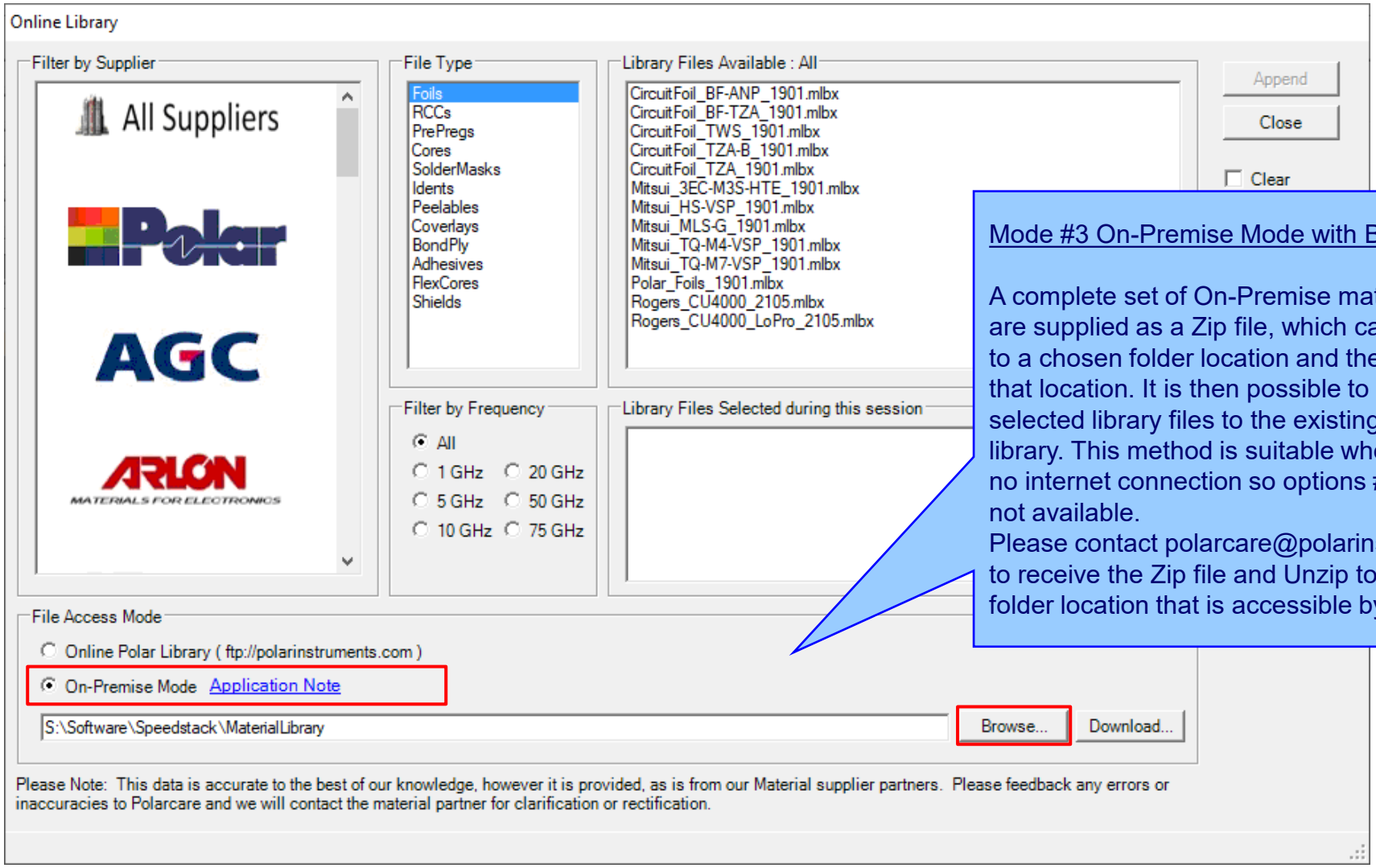
Online Library – Now supports three modes



Mode #3 On-Premise Mode with Browse option

A complete set of On-Premise material libraries are supplied as a Zip file, which can be Unzipped to a chosen folder location and then Browse to that location. It is then possible to append selected library files to the existing Speedstack library. This method is suitable where users have no internet connection so options #1 and #2 are not available.
Please contact polarcare@polarinstruments.com to receive the Zip file and Unzip to a suitable folder location that is accessible by Speedstack

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Speedstack v22.11.01 (November 2022)

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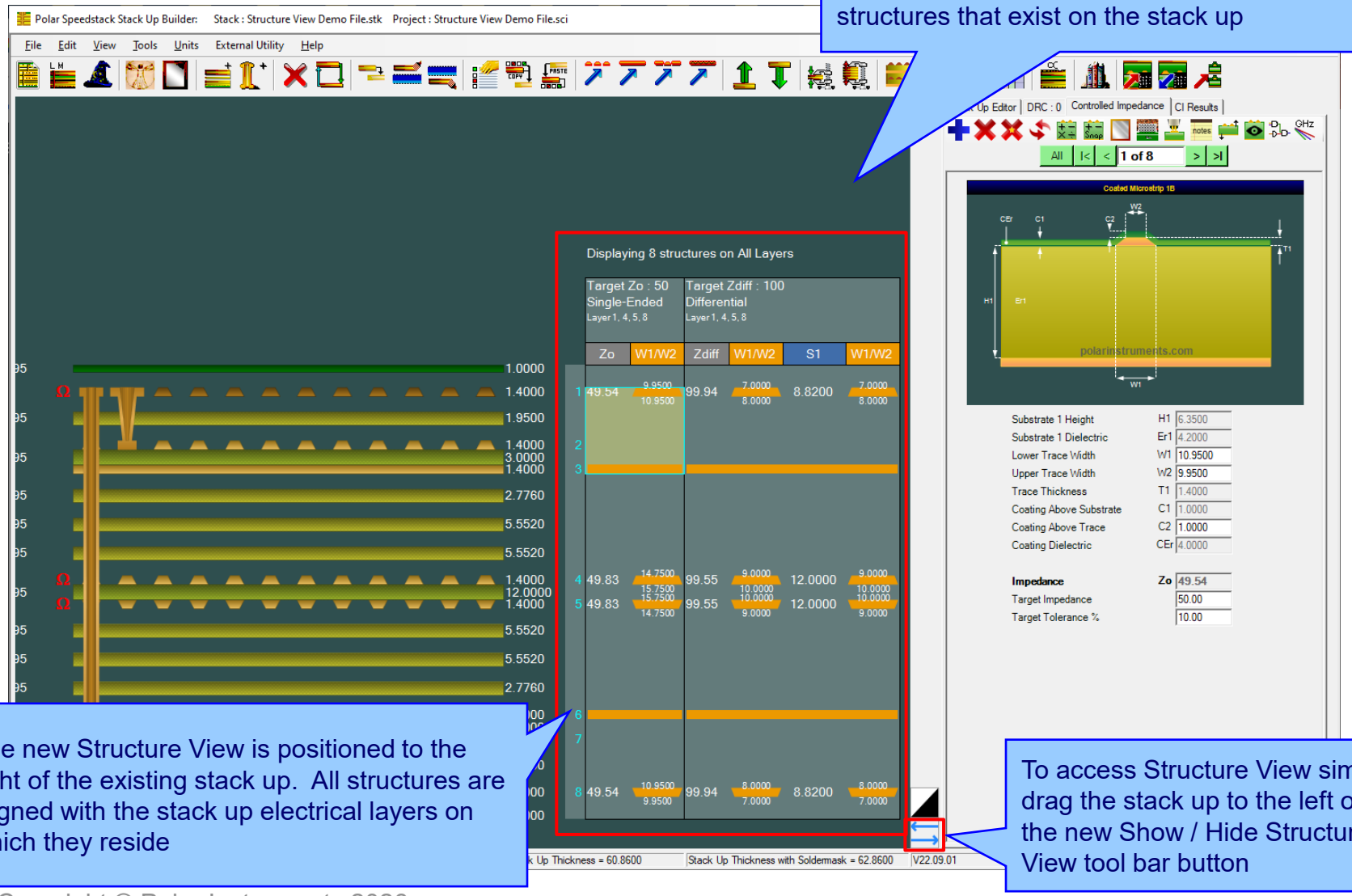
Introducing Structure View

Structure View presents a useful overview of the controlled impedance / insertion loss structures that exist on the stack up



The new Structure View is positioned to the right of the existing stack up. All structures are aligned with the stack up electrical layers on which they reside

To access Structure View simply drag the stack up to the left or use the new Show / Hide Structure View tool bar button

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Introducing Structure View

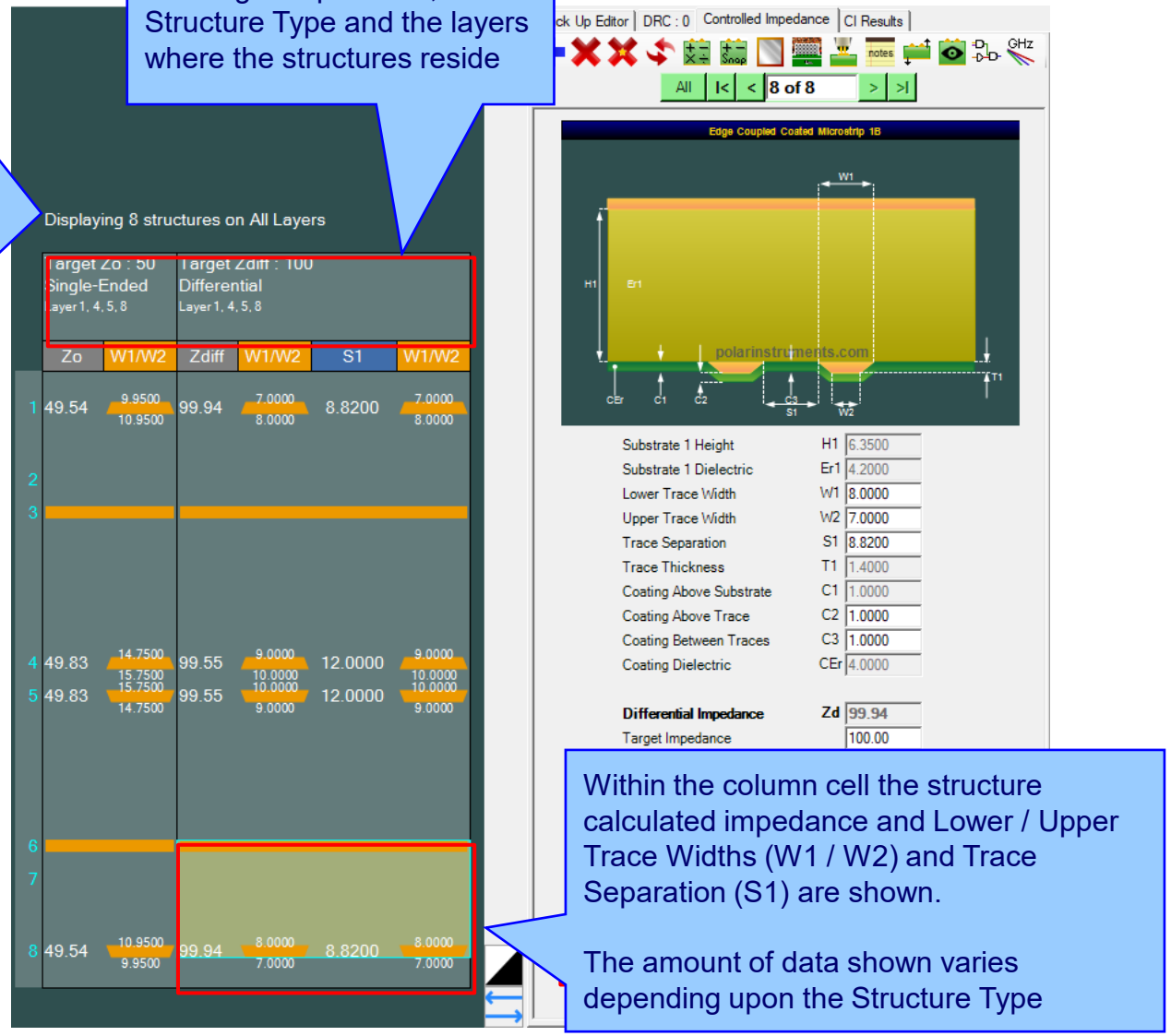
Structures are arranged by Target Impedance, low to high, then by Structure Type.

All structures of the same Target Impedance and Structure Type will be positioned in the same column

In this example there are 8 structures in total:

4 x 50 ohm singled-ended (column 1)
4 x 100 ohm differential (column 2)

The column header contains the Target Impedance, Structure Type and the layers where the structures reside



Within the column cell the structure calculated impedance and Lower / Upper Trace Widths (W1 / W2) and Trace Separation (S1) are shown.

The amount of data shown varies depending upon the Structure Type

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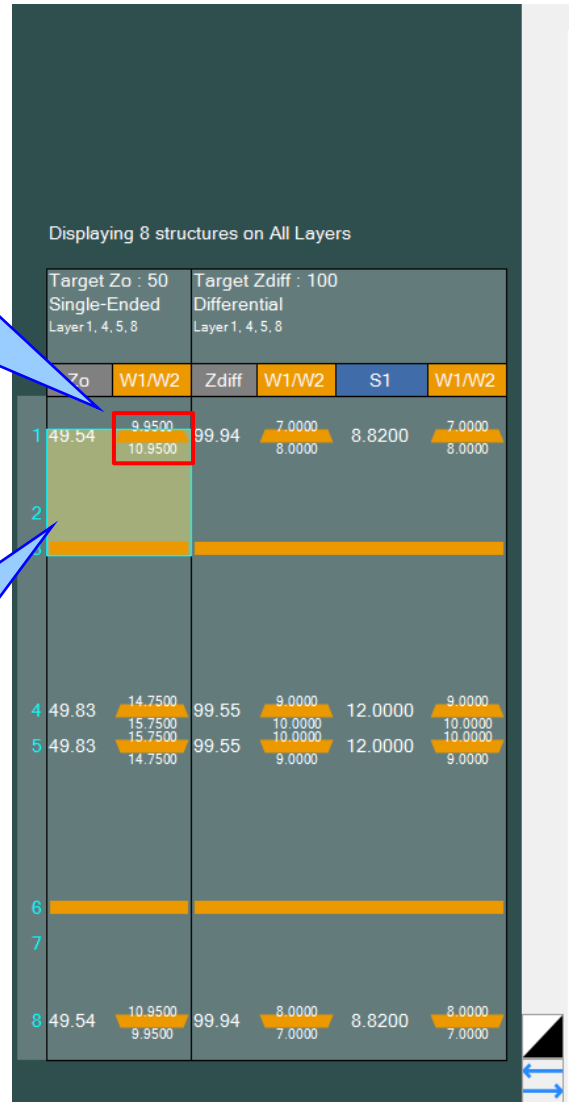
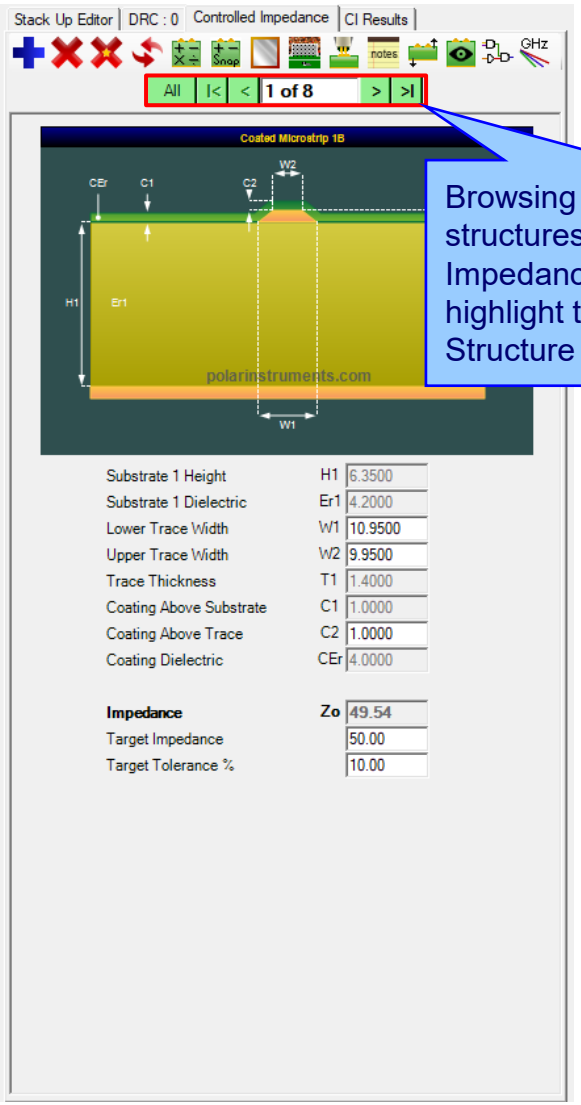
Introducing Structure View

Structure View is interactive. Clicking on the golden trace will auto-switch to that structure on the Controlled Impedance tab

The transparent blue highlight reflects the current structure selected on the Controlled Impedance tab





Browsing through the structures on the Controlled Impedance tab will auto highlight the structure on Structure View

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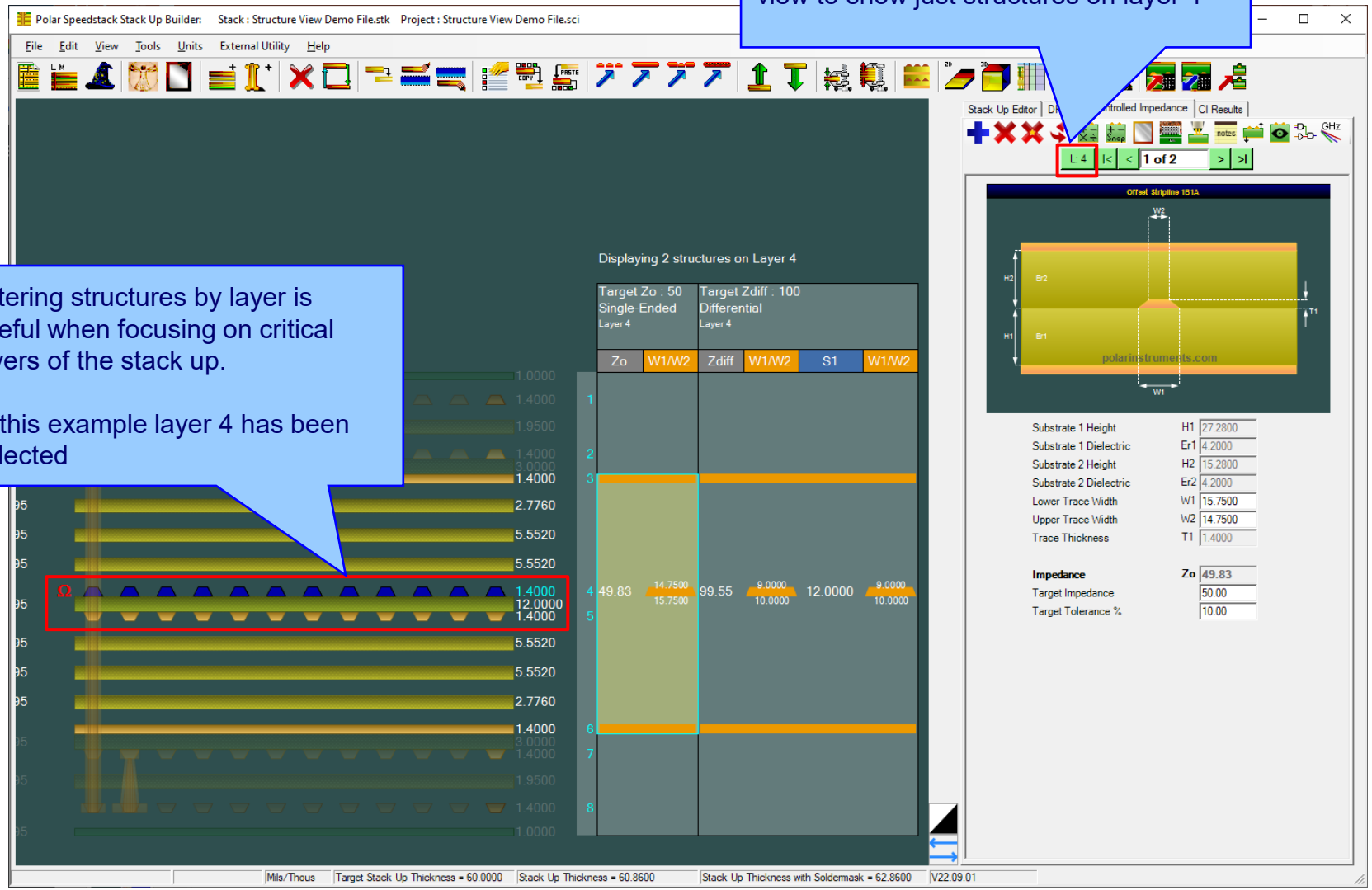
Introducing Structure View

Clicking the ‘Filter by Layer’ updates the view to show just structures on layer 4

Filtering structures by layer is useful when focusing on critical layers of the stack up.

In this example layer 4 has been selected



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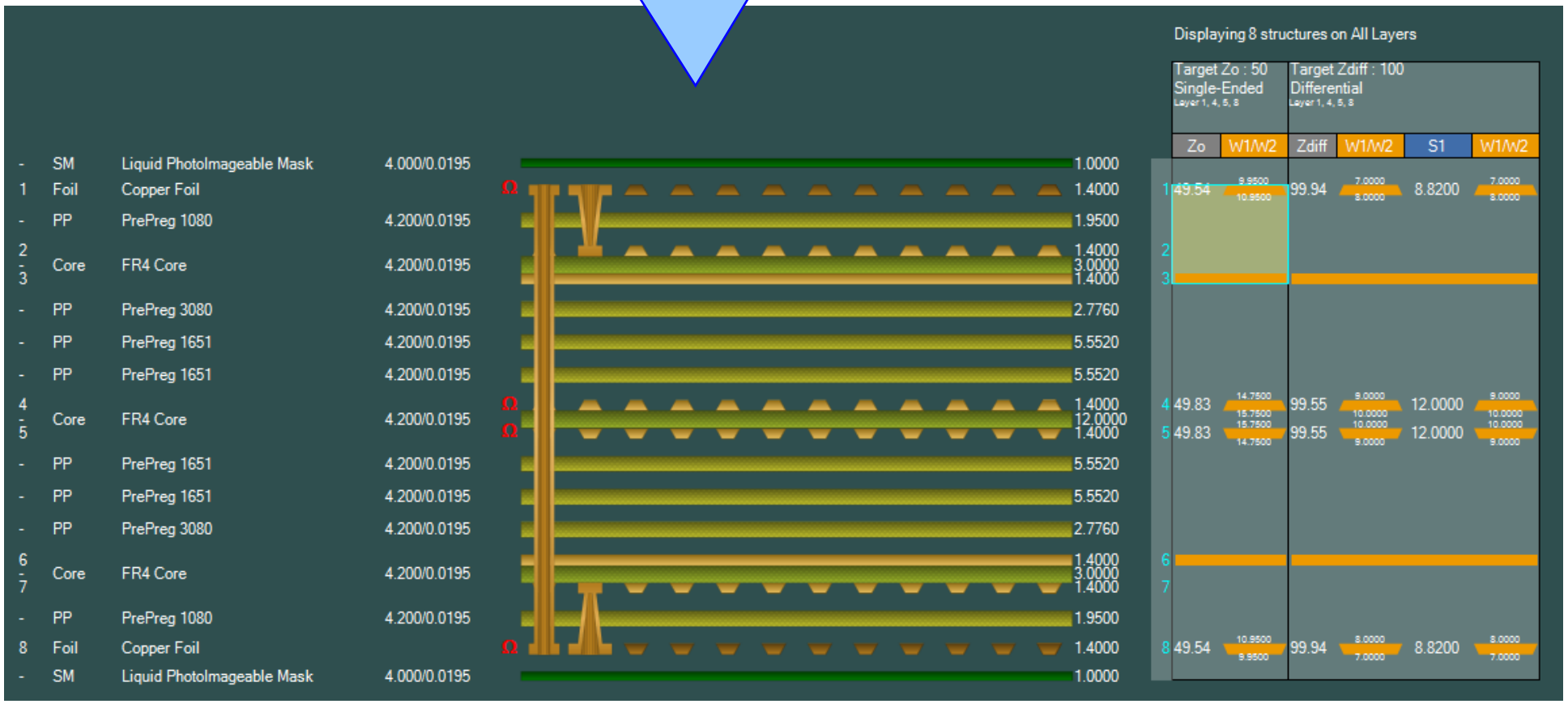
Introducing Structure View

Use the mouse wheel to zoom out and show the complete stack up together with the structures.

All data is now visible in one view



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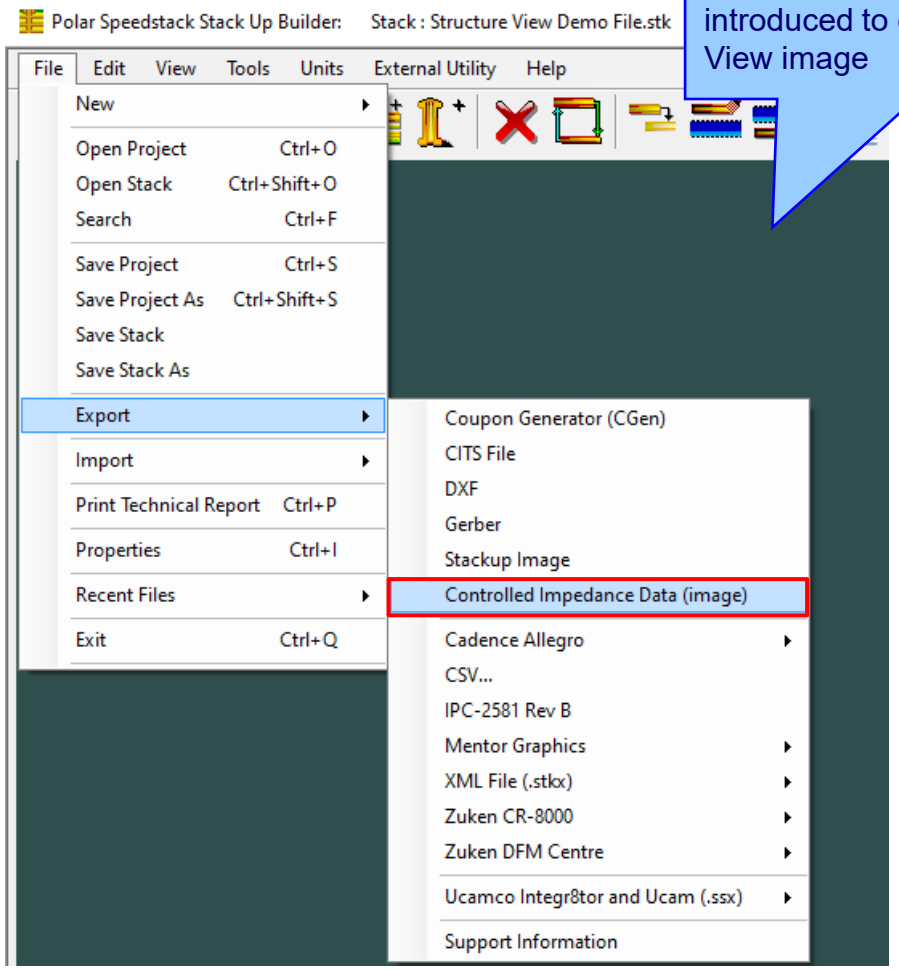
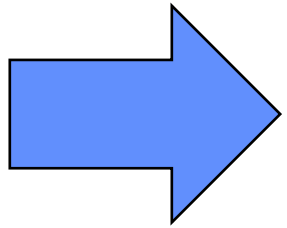
Introducing Structure View

A new File | Export | Controlled Impedance Data option has been introduced to export the Structure View image





Displaying 8 structures on All Layers

	Target Zo : 50 Single-Ended Layer 1, 4, 5, 8		Target Zdiff : 100 Differential Layer 1, 4, 5, 8			
	Zo	W1/W2	Zdiff	W1/W2	S1	W1/W2
1	49.54	9.9500 / 10.9500	99.94	7.0000 / 8.0000	8.8200	7.0000 / 8.0000
2						
3						
4	49.83	14.7500 / 15.7500	99.55	9.0000 / 10.0000	12.0000	9.0000 / 10.0000
5	49.83	15.7500 / 14.7500	99.55	10.0000 / 9.0000	12.0000	10.0000 / 9.0000
6						
7						
8	49.54	10.9500 / 9.9500	99.94	8.0000 / 7.0000	8.8200	8.0000 / 7.0000

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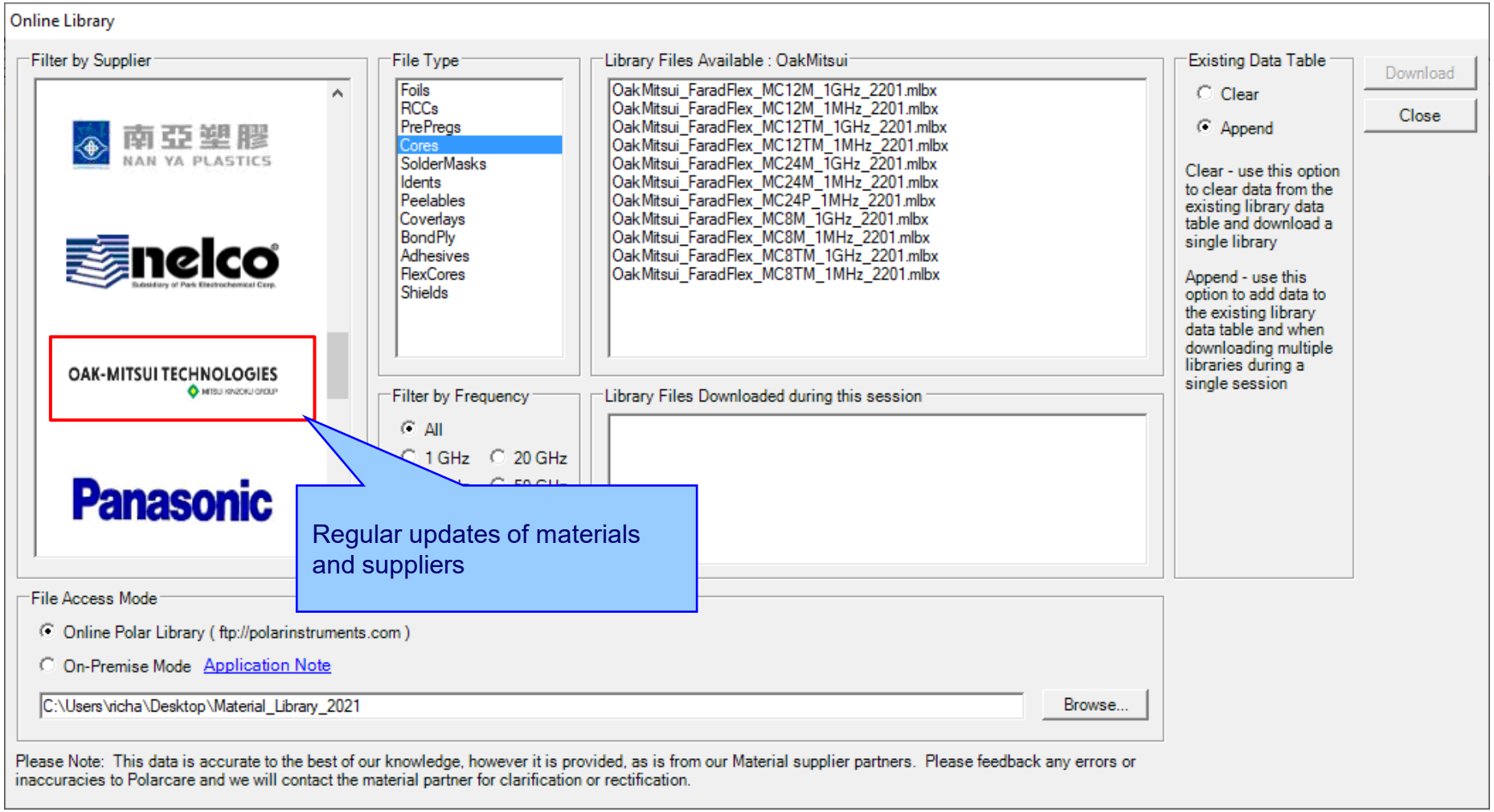
Online Library enhancements



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Speedstack v22.07.20 (July 2022)

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Introducing Grid View

Grid View presents the current stack up in an editable data grid form to allow for easy editing of multiple materials from a single dialog

Grid View allows for quick editing of key stack up information such as Material Description, Processed Thickness, Dielectric Constant and Loss Tangent.

The stack up data from Grid View can also be edited in Microsoft Excel using the Grid View copy and paste functions

Changes in Grid View can be saved back to the original stack up design

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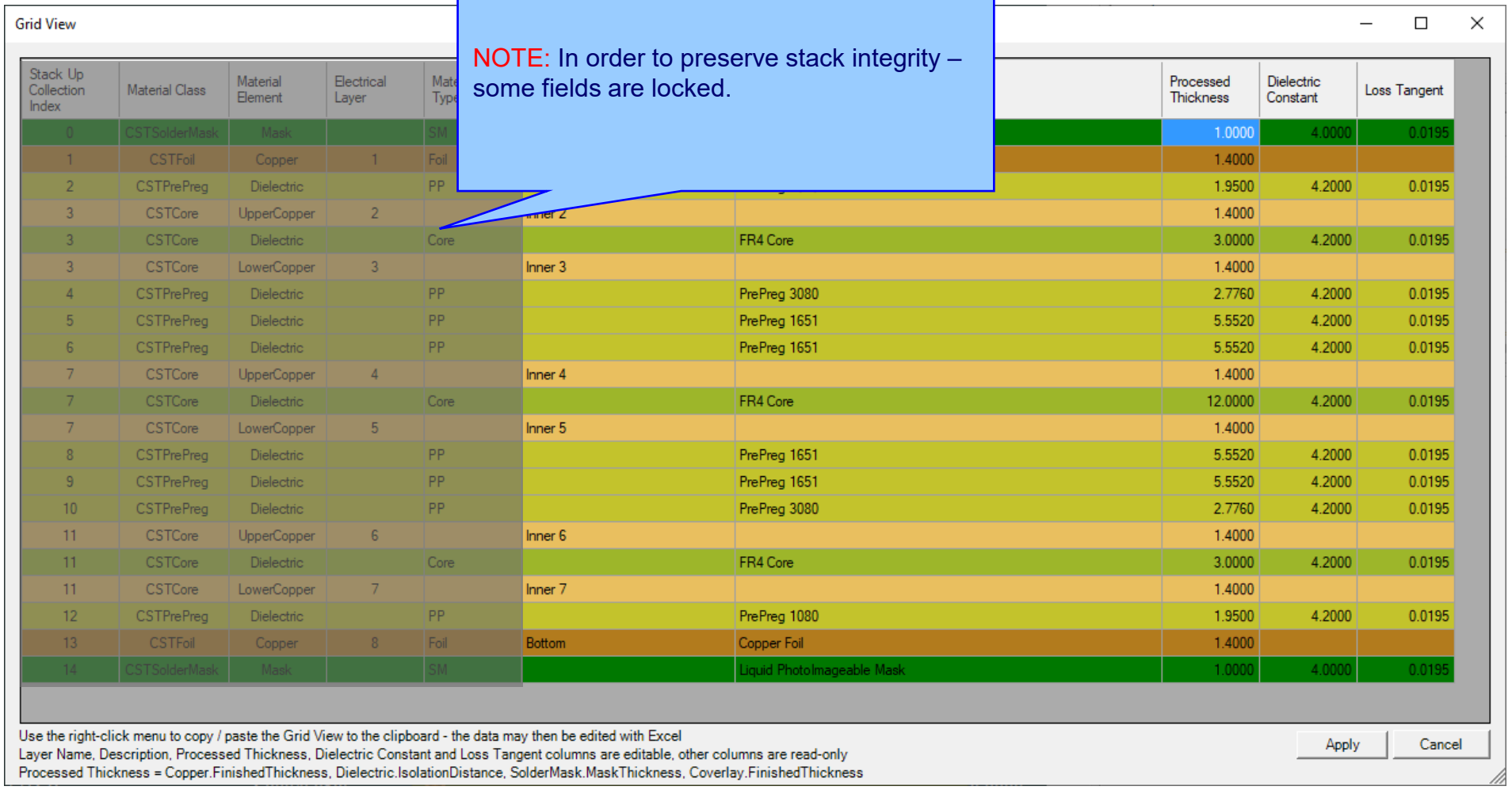
Introducing Grid View



Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Type			Processed Thickness	Dielectric Constant	Loss Tangent
0	CSTSolderMask	Mask		SM			1.0000	4.0000	0.0195
1	CSTFoil	Copper	1	Foil			1.4000		
2	CSTPrePreg	Dielectric		PP			1.9500	4.2000	0.0195
3	CSTCore	UpperCopper	2		Inner 2		1.4000		
3	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
3	CSTCore	LowerCopper	3		Inner 3		1.4000		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.7760	4.2000	0.0195
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
7	CSTCore	UpperCopper	4		Inner 4		1.4000		
7	CSTCore	Dielectric		Core		FR4 Core	12.0000	4.2000	0.0195
7	CSTCore	LowerCopper	5		Inner 5		1.4000		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.7760	4.2000	0.0195
11	CSTCore	UpperCopper	6		Inner 6		1.4000		
11	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
11	CSTCore	LowerCopper	7		Inner 7		1.4000		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.9500	4.2000	0.0195
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.4000		
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.0195

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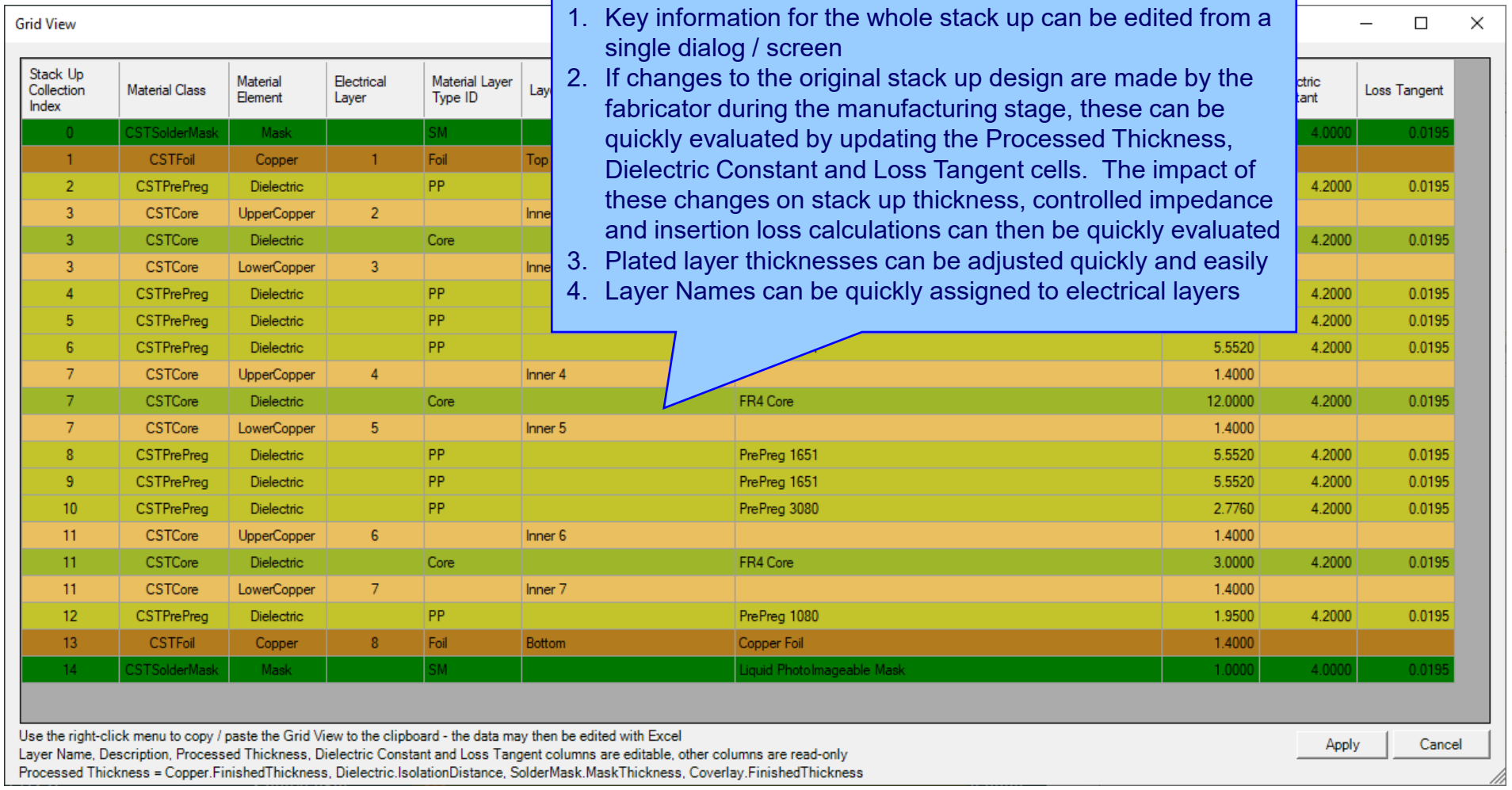
Introducing Grid View

Grid View has many uses, some are highlighted here:

1. Key information for the whole stack up can be edited from a single dialog / screen
2. If changes to the original stack up design are made by the fabricator during the manufacturing stage, these can be quickly evaluated by updating the Processed Thickness, Dielectric Constant and Loss Tangent cells. The impact of these changes on stack up thickness, controlled impedance and insertion loss calculations can then be quickly evaluated
3. Plated layer thicknesses can be adjusted quickly and easily
4. Layer Names can be quickly assigned to electrical layers



Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Lay				Loss Tangent
0	CSTSolderMask	Mask		SM				4.0000	0.0195
1	CSTFoil	Copper	1	Foil	Top				
2	CSTPrePreg	Dielectric		PP				4.2000	0.0195
3	CSTCore	UpperCopper	2		Inne				
3	CSTCore	Dielectric		Core				4.2000	0.0195
3	CSTCore	LowerCopper	3		Inne				
4	CSTPrePreg	Dielectric		PP				4.2000	0.0195
5	CSTPrePreg	Dielectric		PP				4.2000	0.0195
6	CSTPrePreg	Dielectric		PP			5.5520	4.2000	0.0195
7	CSTCore	UpperCopper	4		Inner 4		1.4000		
7	CSTCore	Dielectric		Core		FR4 Core	12.0000	4.2000	0.0195
7	CSTCore	LowerCopper	5		Inner 5		1.4000		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.7760	4.2000	0.0195
11	CSTCore	UpperCopper	6		Inner 6		1.4000		
11	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
11	CSTCore	LowerCopper	7		Inner 7		1.4000		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.9500	4.2000	0.0195
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.4000		
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.0195

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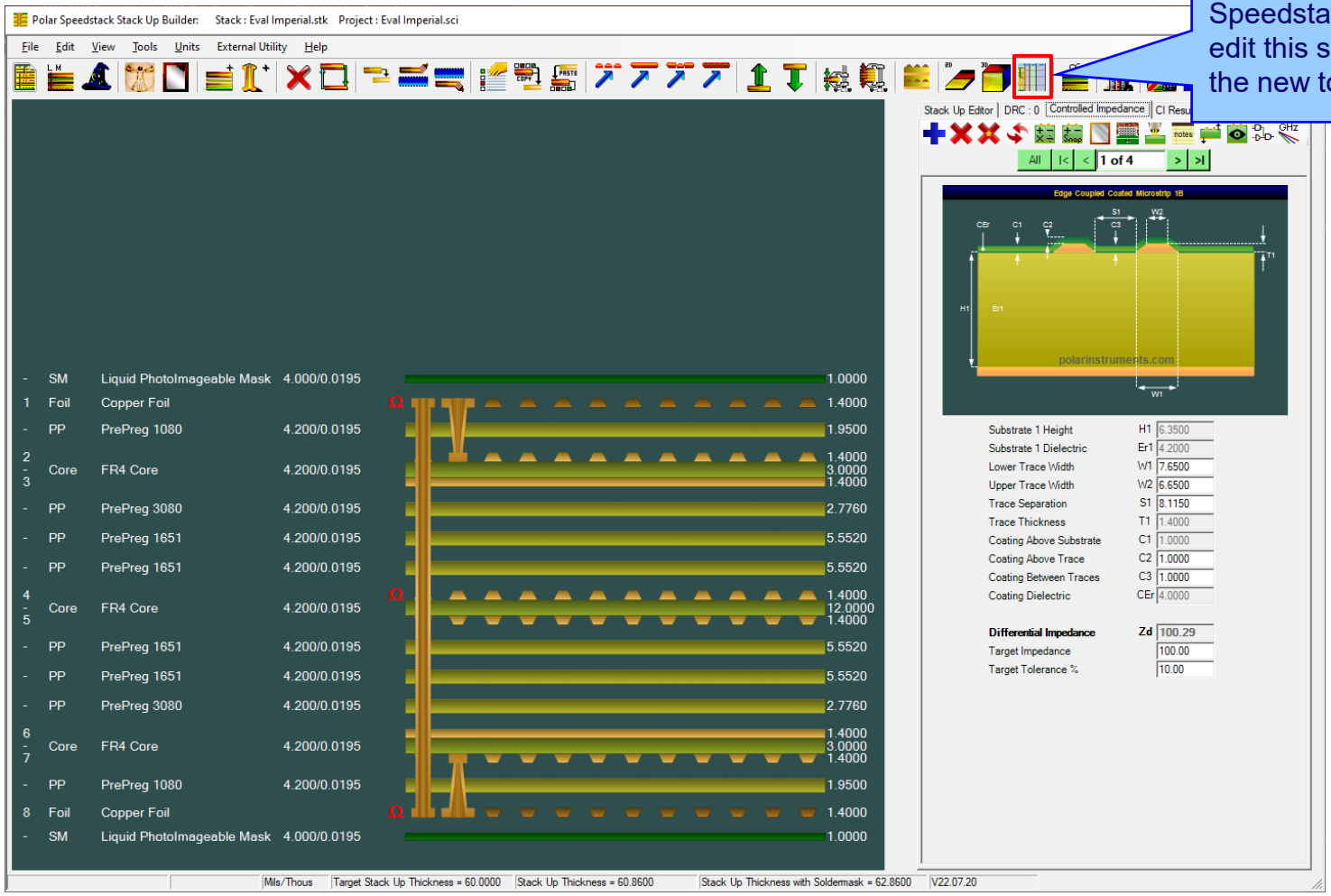
Grid View – Walkthrough Step #1

Step #1
An 8 layer stack up is loaded into the Speedstack editor. To examine and edit this stack up in Grid View select the new toolbar button



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Grid View – Walkthrough Step #2

Step #2
Using the Grid View editor the following cells are amended. Layer Names have been changed and Processed Thickness adjusted

Grid View

Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name	Description			
0	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.0195
1	CSTFoil	Copper	1	Foil	Top	Copper Foil	1.4000		
2	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.9500	4.2000	0.0195
3	CSTCore	UpperCopper	2		Inner 2		1.4000		
3	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
3	CSTCore	LowerCopper	3		Power		1.4000		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.5000	4.2000	0.0195
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	2.5000	4.2000	0.0195
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	6.0000	4.2000	0.0195
7	CSTCore	UpperCopper	4		Inner 4		1.4000		
7	CSTCore	Dielectric		Core		FR4 Core	12.0000	4.2000	0.0195
7	CSTCore	LowerCopper	5		Inner 5		1.4000		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	6.0000	4.2000	0.0195
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	6.0000	4.2000	0.0195
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.5000	4.2000	0.0195
11	CSTCore	UpperCopper	6		Ground		1.4000		
11	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
11	CSTCore	LowerCopper	7		Inner 7		1.4000		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.9500	4.2000	0.0195
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.4000		
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.0195

Use the right-click menu to copy / paste the Grid View to the clipboard - the data may then be edited with Excel
Layer Name, Description, Processed Thickness, Dielectric Constant and Loss Tangent columns are editable, other columns are read
Processed Thickness = Copper.FinishedThickness, Dielectric.IsolationDistance, SolderMask.MaskThickness, Coverlay.FinishedThi

Apply | Cancel

Selecting Apply will save the changes back to the stack up editor

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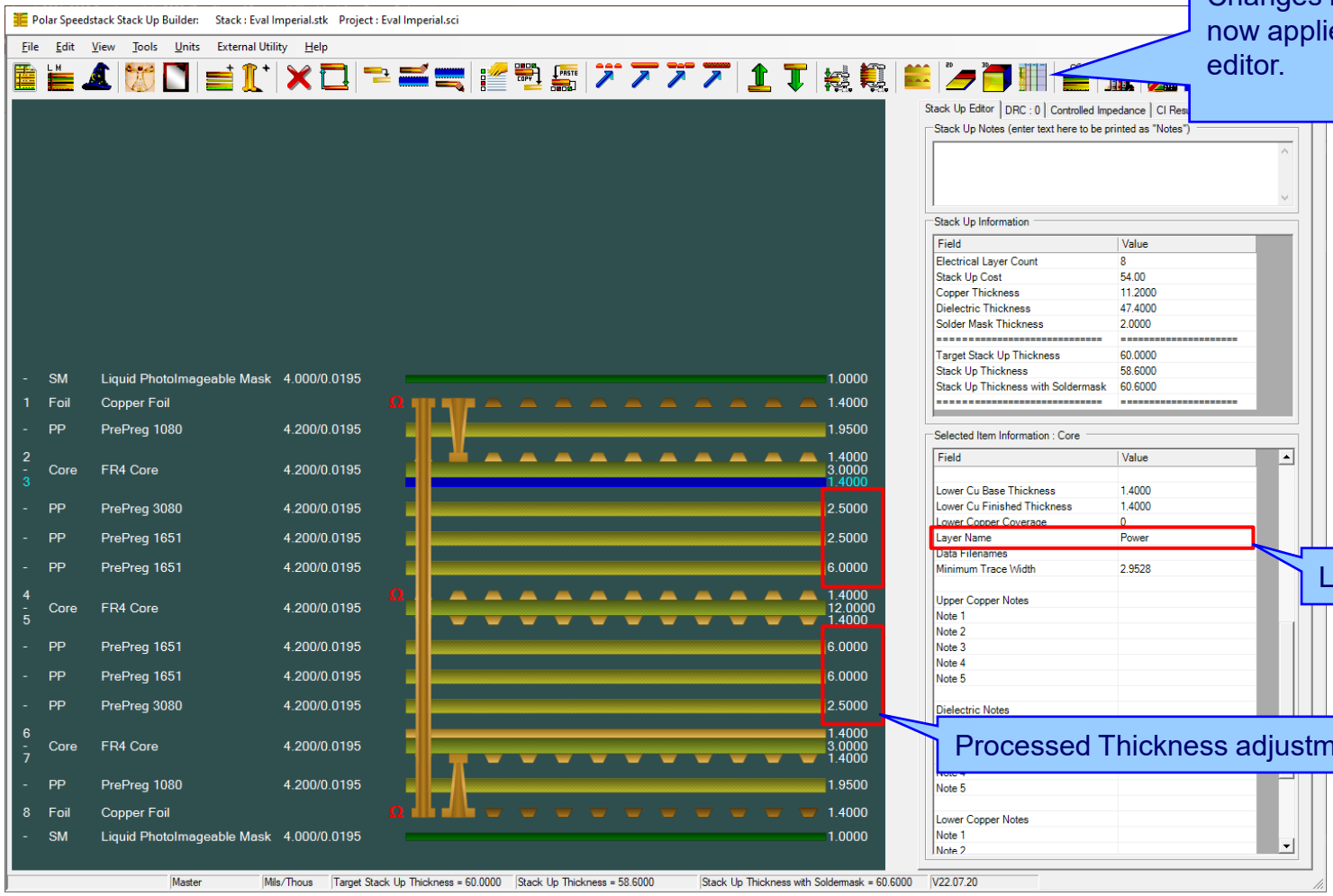
Grid View – Walkthrough Step #3



Step #3
Changes made under Grid View are now applied back to the stack up editor.

Layer Name change

Processed Thickness adjustments

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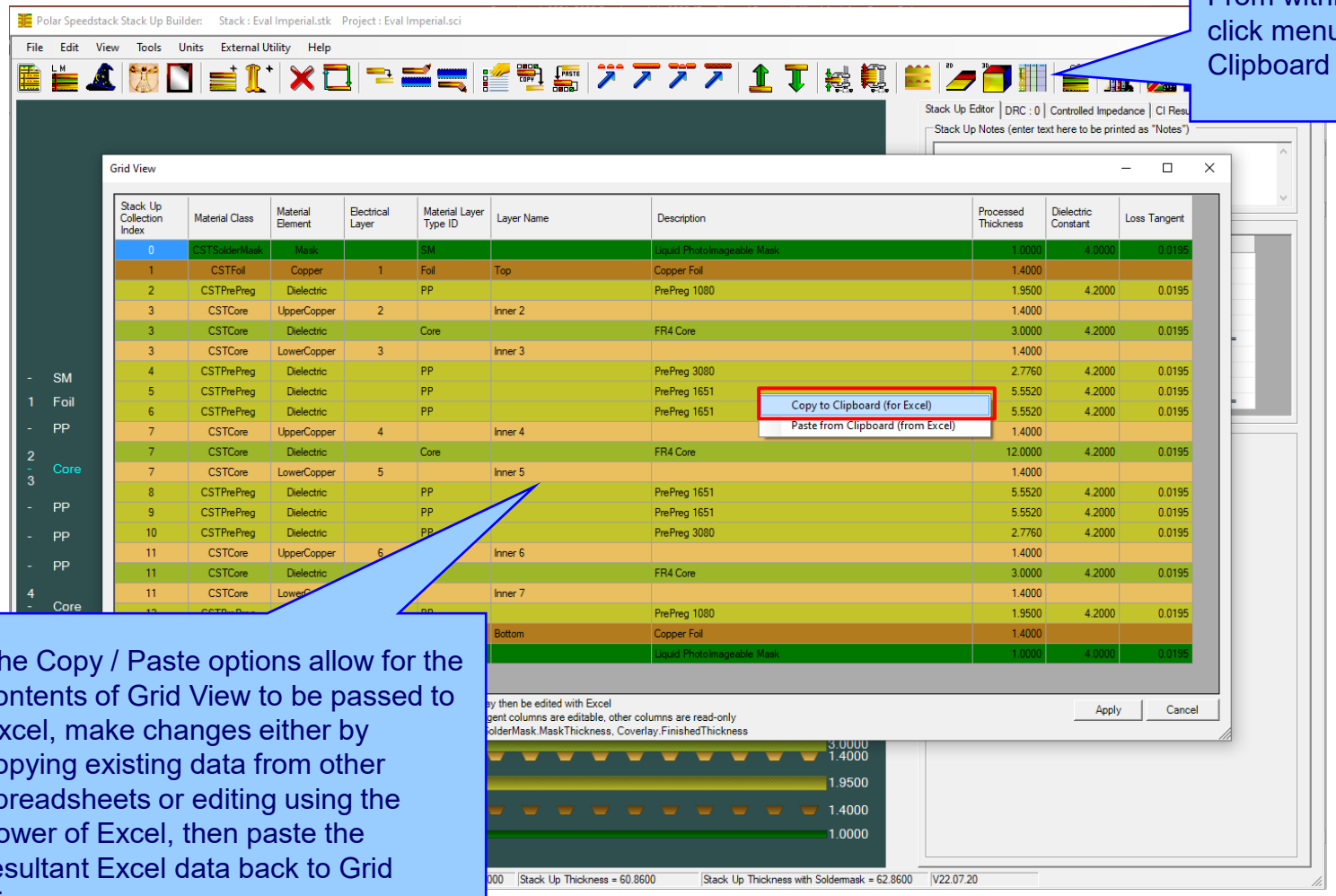
Using Grid View with Microsoft Excel – Step #1

Step #1
From within Grid View use the right-click menu and select the Copy to Clipboard option.



The Copy / Paste options allow for the contents of Grid View to be passed to Excel, make changes either by copying existing data from other spreadsheets or editing using the power of Excel, then paste the resultant Excel data back to Grid View.

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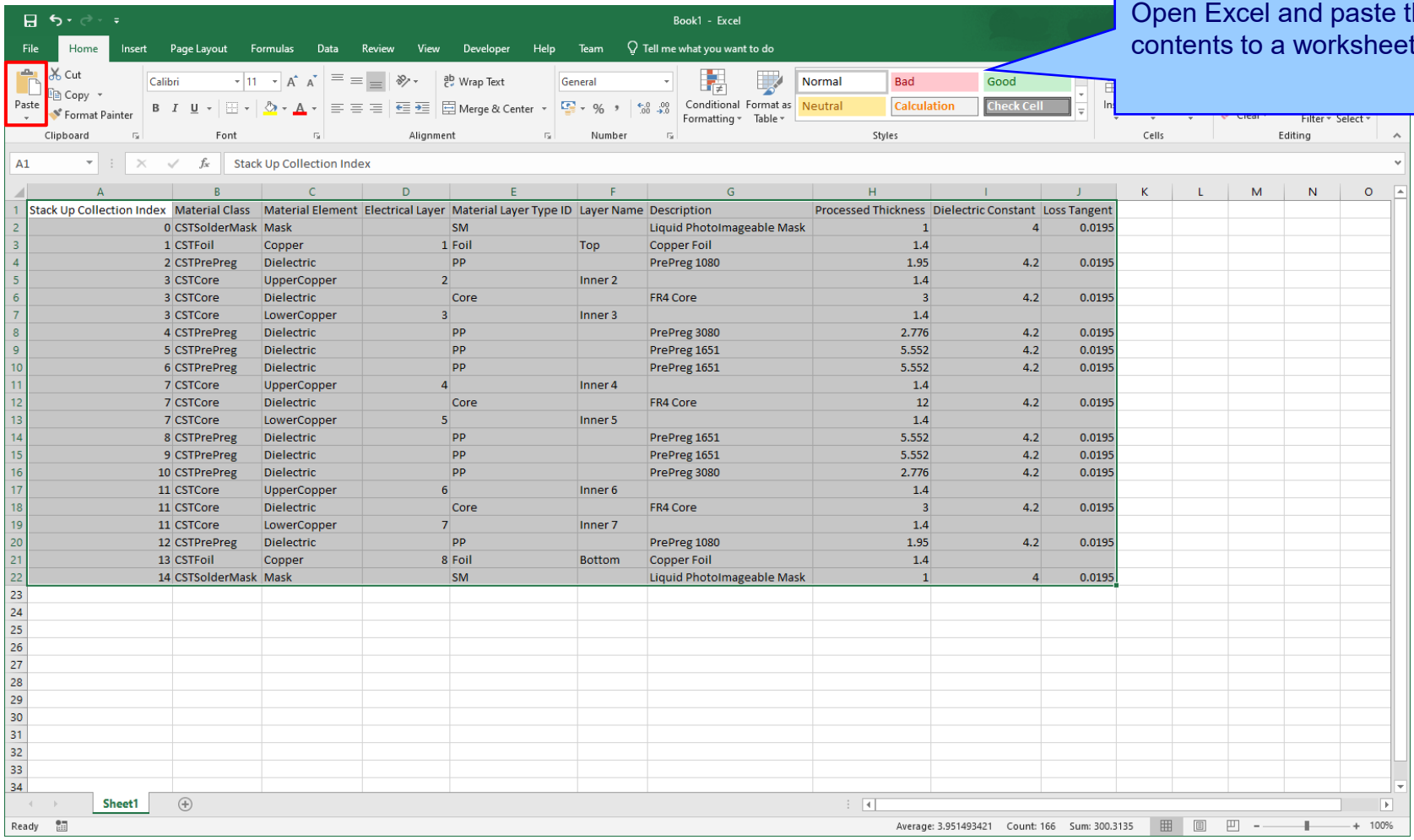
Using Grid View with Microsoft Excel – Step #2

Step #2
Open Excel and paste the clipboard contents to a worksheet



Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name	Description	Processed Thickness	Dielectric Constant	Loss Tangent
0	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1	4	0.0195
1	CSTFoil	Copper	1	Foil	Top	Copper Foil	1.4		
2	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.95	4.2	0.0195
3	CSTCore	UpperCopper	2		Inner 2		1.4		
3	CSTCore	Dielectric		Core		FR4 Core	3	4.2	0.0195
3	CSTCore	LowerCopper	3		Inner 3		1.4		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.776	4.2	0.0195
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
7	CSTCore	UpperCopper	4		Inner 4		1.4		
7	CSTCore	Dielectric		Core		FR4 Core	12	4.2	0.0195
7	CSTCore	LowerCopper	5		Inner 5		1.4		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.776	4.2	0.0195
11	CSTCore	UpperCopper	6		Inner 6		1.4		
11	CSTCore	Dielectric		Core		FR4 Core	3	4.2	0.0195
11	CSTCore	LowerCopper	7		Inner 7		1.4		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.95	4.2	0.0195
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.4		
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1	4	0.0195

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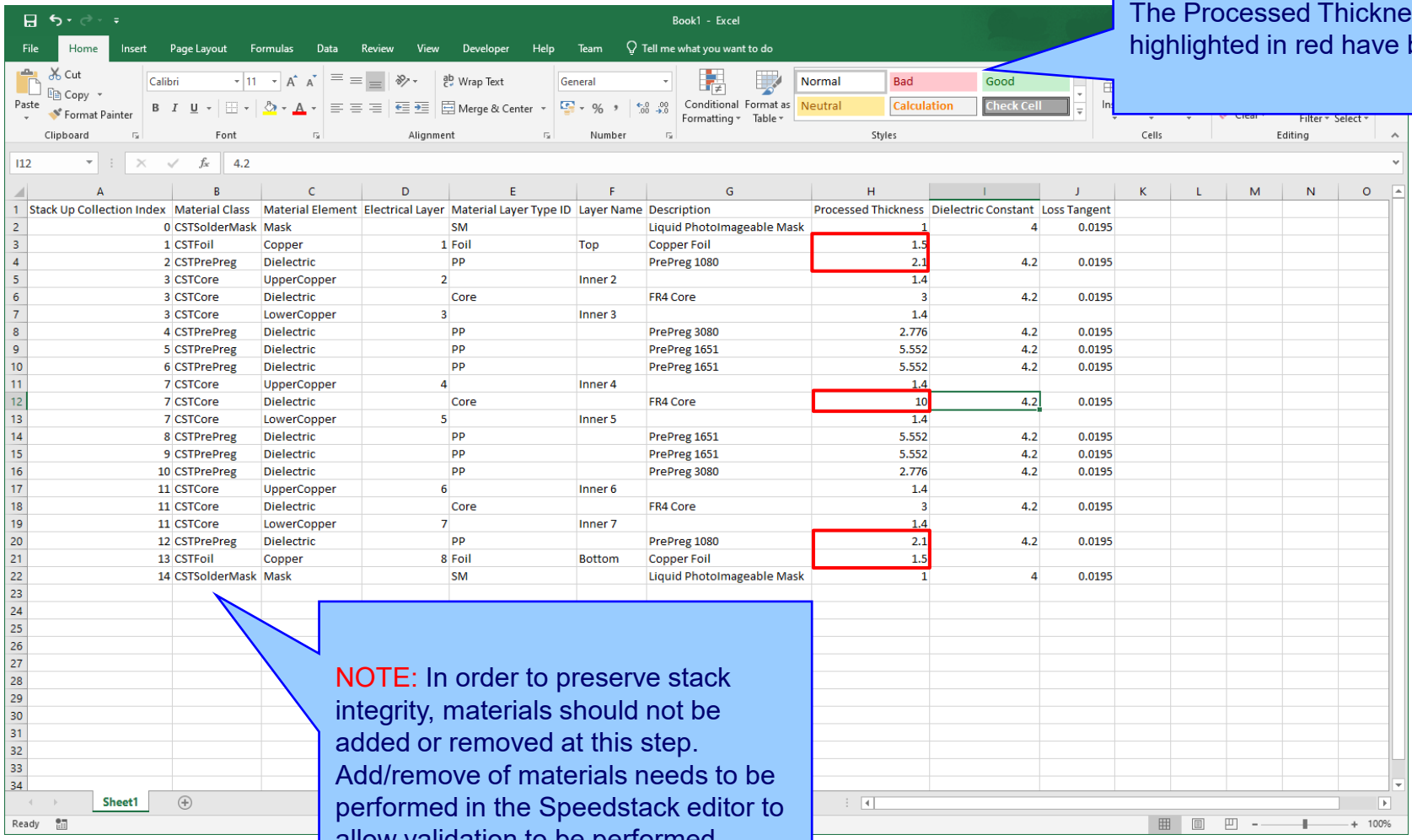
Using Grid View with Microsoft Excel – Step #3

Step #3
The Processed Thickness cells highlighted in red have been changed



Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name	Description	Processed Thickness	Dielectric Constant	Loss Tangent
0	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1	4	0.0195
1	CSTFoil	Copper	1	Foil	Top	Copper Foil	1.5		
2	CSTPrePreg	Dielectric		PP		PrePreg 1080	2.1	4.2	0.0195
3	CSTCore	UpperCopper	2		Inner 2		1.4		
3	CSTCore	Dielectric		Core		FR4 Core	3	4.2	0.0195
3	CSTCore	LowerCopper	3		Inner 3		1.4		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.776	4.2	0.0195
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
7	CSTCore	UpperCopper	4		Inner 4		1.4		
7	CSTCore	Dielectric		Core		FR4 Core	10	4.2	0.0195
7	CSTCore	LowerCopper	5		Inner 5		1.4		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.776	4.2	0.0195
11	CSTCore	UpperCopper	6		Inner 6		1.4		
11	CSTCore	Dielectric		Core		FR4 Core	3	4.2	0.0195
11	CSTCore	LowerCopper	7		Inner 7		1.4		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	2.1	4.2	0.0195
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.5		
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1	4	0.0195

NOTE: In order to preserve stack integrity, materials should not be added or removed at this step. Add/remove of materials needs to be performed in the Speedstack editor to allow validation to be performed.

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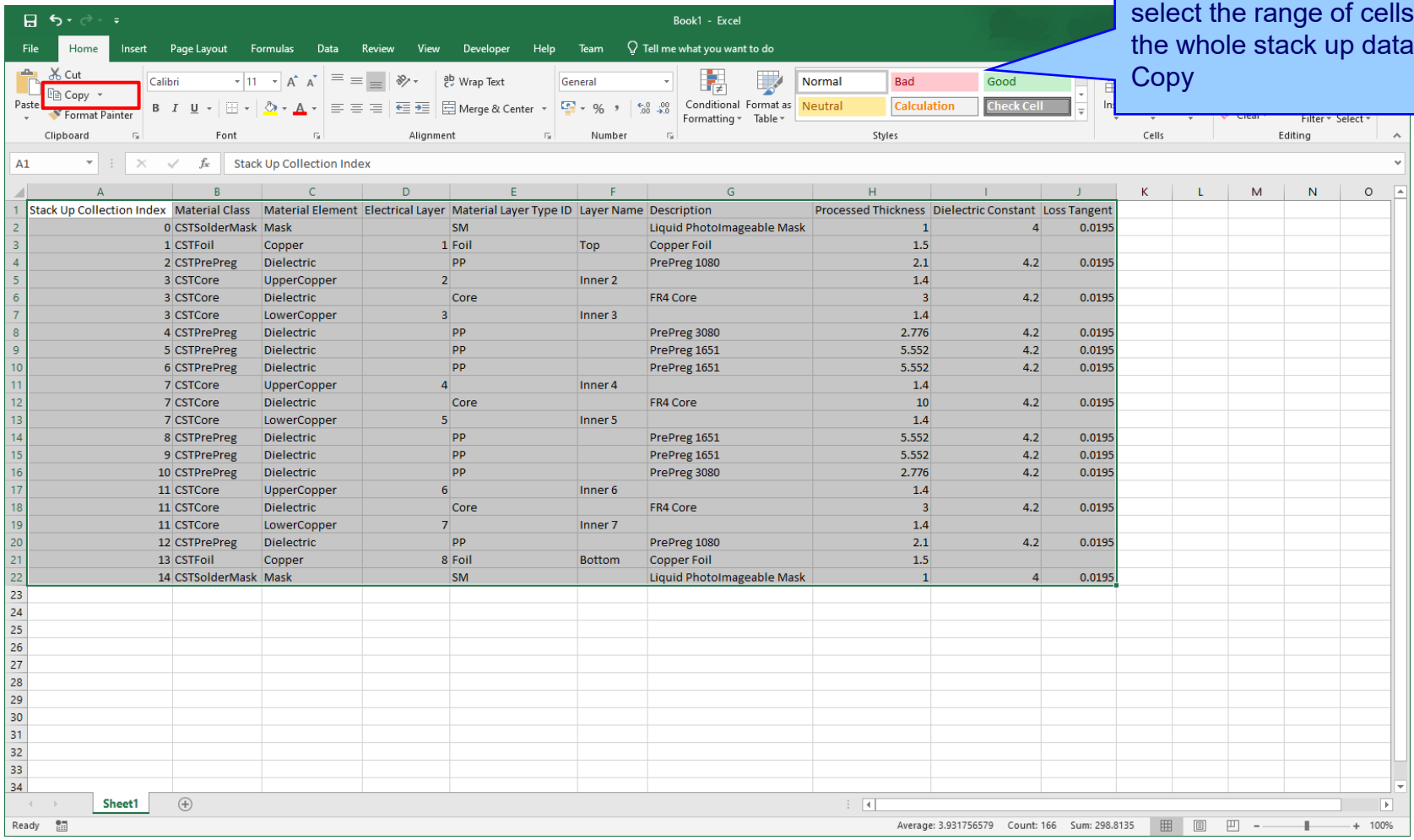
Using Grid View with Microsoft Excel – Step #4

Step #4
Once the Excel changes are complete select the range of cells representing the whole stack up data and select Copy



Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name	Description	Processed Thickness	Dielectric Constant	Loss Tangent
0	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1	4	0.0195
1	CSTFoil	Copper	1	Foil	Top	Copper Foil	1.5		
2	CSTPrePreg	Dielectric		PP		PrePreg 1080	2.1	4.2	0.0195
3	CSTCore	UpperCopper	2		Inner 2		1.4		
3	CSTCore	Dielectric		Core		FR4 Core	3	4.2	0.0195
3	CSTCore	LowerCopper	3		Inner 3		1.4		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.776	4.2	0.0195
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
7	CSTCore	UpperCopper	4		Inner 4		1.4		
7	CSTCore	Dielectric		Core		FR4 Core	10	4.2	0.0195
7	CSTCore	LowerCopper	5		Inner 5		1.4		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.552	4.2	0.0195
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.776	4.2	0.0195
11	CSTCore	UpperCopper	6		Inner 6		1.4		
11	CSTCore	Dielectric		Core		FR4 Core	3	4.2	0.0195
11	CSTCore	LowerCopper	7		Inner 7		1.4		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	2.1	4.2	0.0195
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.5		
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1	4	0.0195

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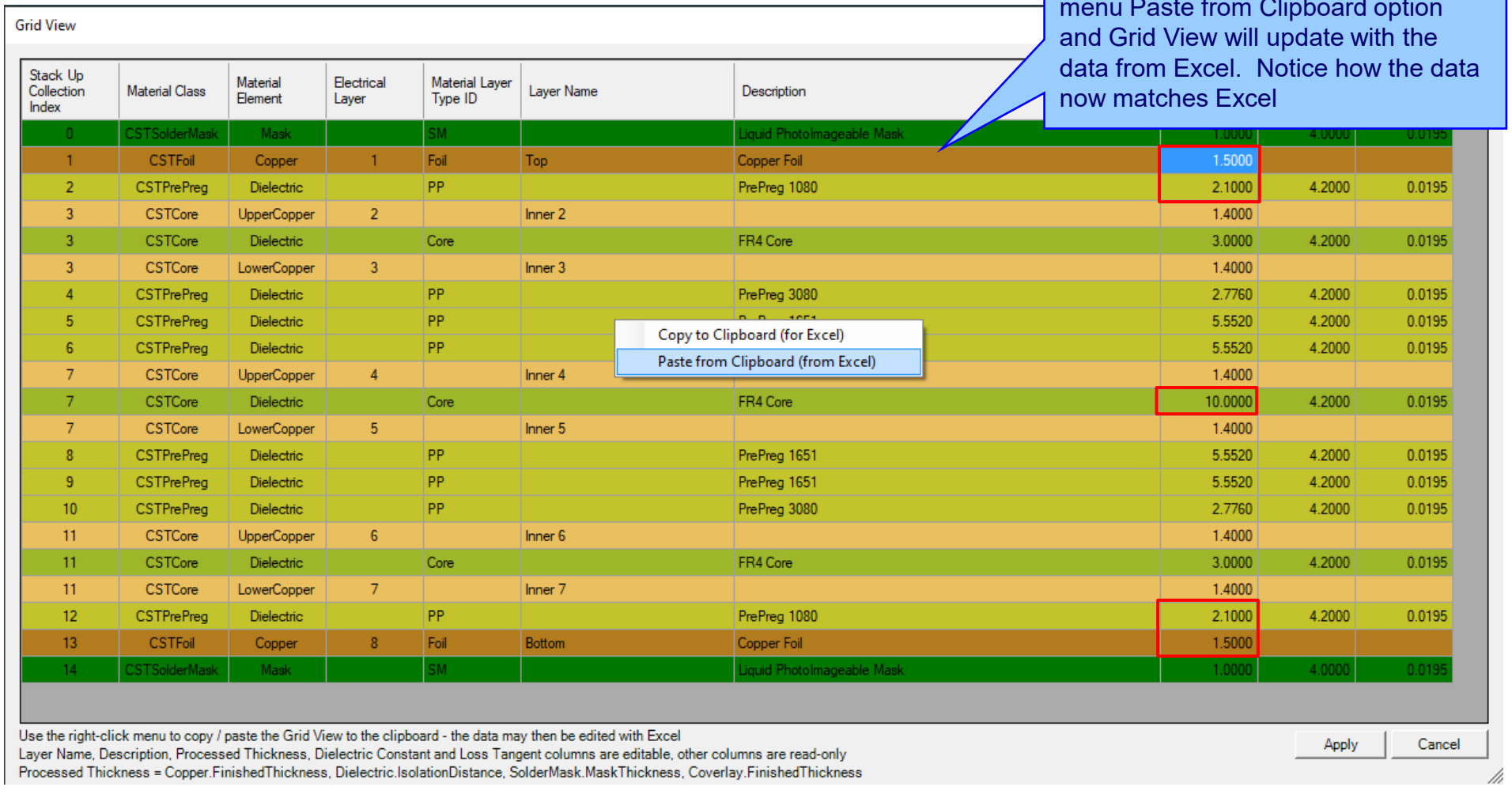
Using Grid View with Microsoft Excel – Step #5

Step #5
Back in Grid View select the right-click menu Paste from Clipboard option and Grid View will update with the data from Excel. Notice how the data now matches Excel



Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name	Description			
0	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.0195
1	CSTFoil	Copper	1	Foil	Top	Copper Foil	1.5000		
2	CSTPrePreg	Dielectric		PP		PrePreg 1080	2.1000	4.2000	0.0195
3	CSTCore	UpperCopper	2		Inner 2		1.4000		
3	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
3	CSTCore	LowerCopper	3		Inner 3		1.4000		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.7760	4.2000	0.0195
5	CSTPrePreg	Dielectric		PP			5.5520	4.2000	0.0195
6	CSTPrePreg	Dielectric		PP			5.5520	4.2000	0.0195
7	CSTCore	UpperCopper	4		Inner 4		1.4000		
7	CSTCore	Dielectric		Core		FR4 Core	10.0000	4.2000	0.0195
7	CSTCore	LowerCopper	5		Inner 5		1.4000		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.7760	4.2000	0.0195
11	CSTCore	UpperCopper	6		Inner 6		1.4000		
11	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
11	CSTCore	LowerCopper	7		Inner 7		1.4000		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	2.1000	4.2000	0.0195
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.5000		
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.0195

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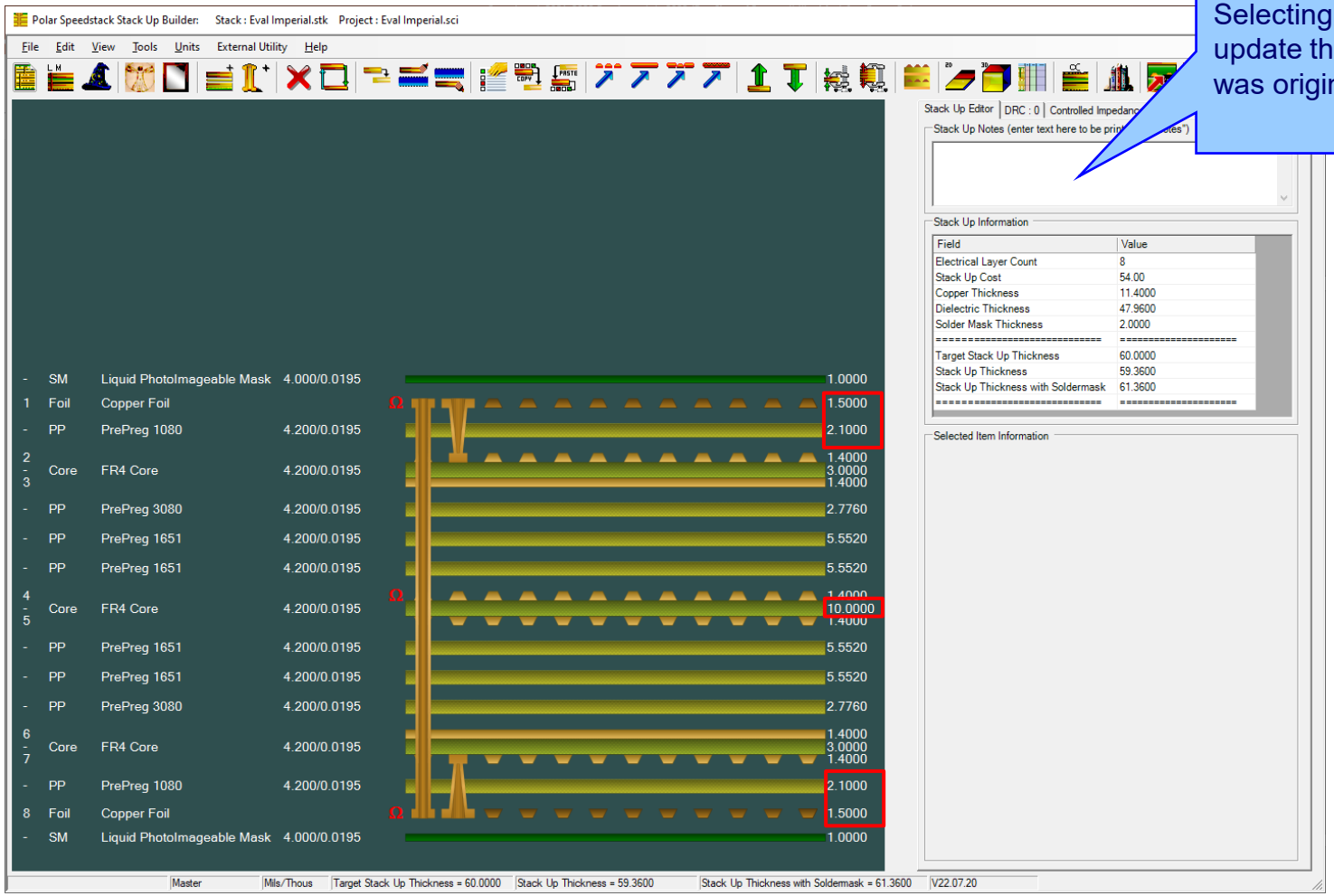
Using Grid View with Microsoft Excel – Step #6

Step #6
Selecting Apply in Grid View will update the stack up with the data that was originally changed in Excel



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Other enhancements

- Stack Up Notes user interface improvements
- The Tools | Options | Structure Defaults | Separation Region Dielectric (REr) now supports double data types. Previously, it only supported integers

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Speedstack v22.05.06 (May 2022)

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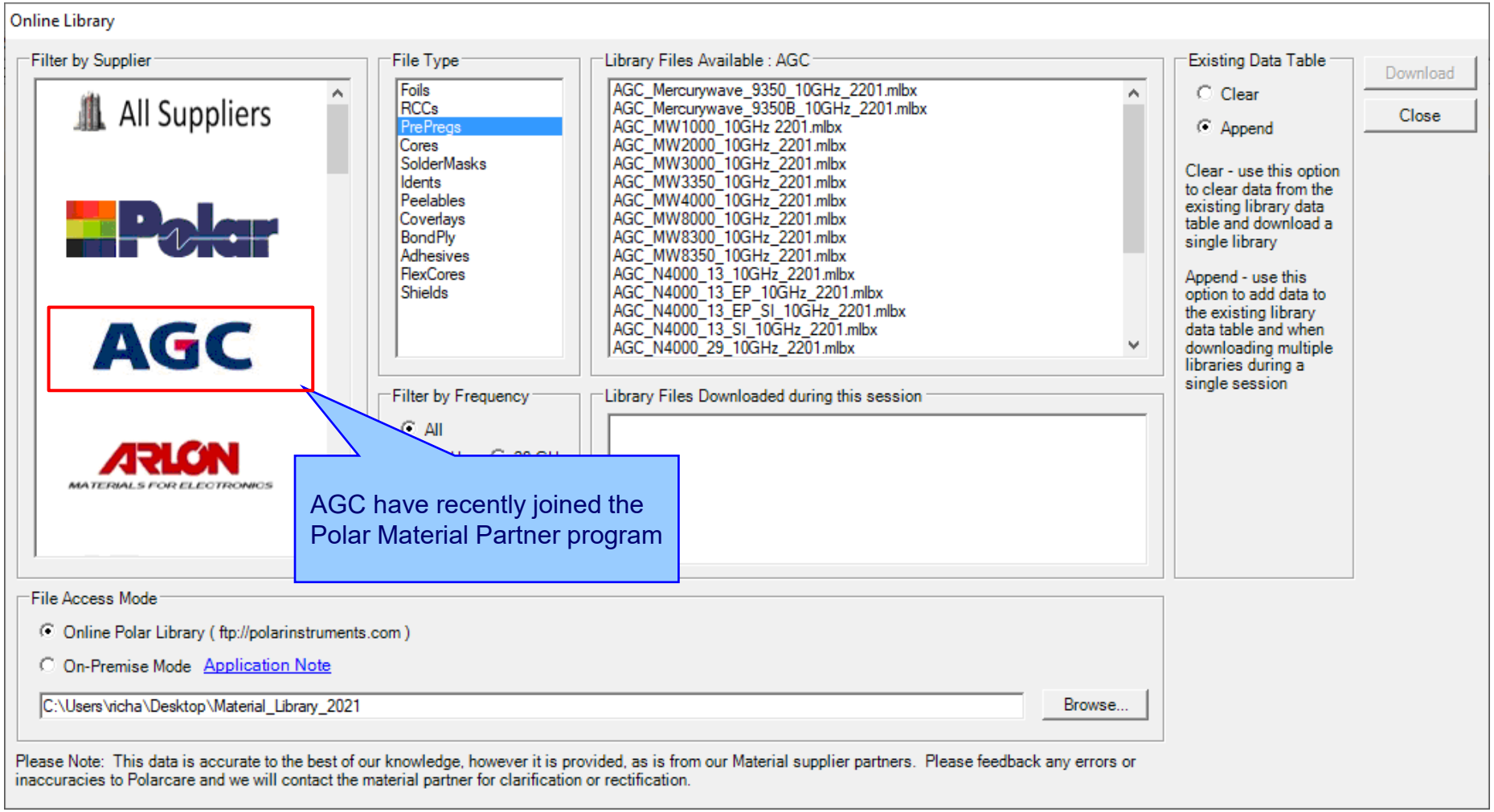
Online Library enhancements



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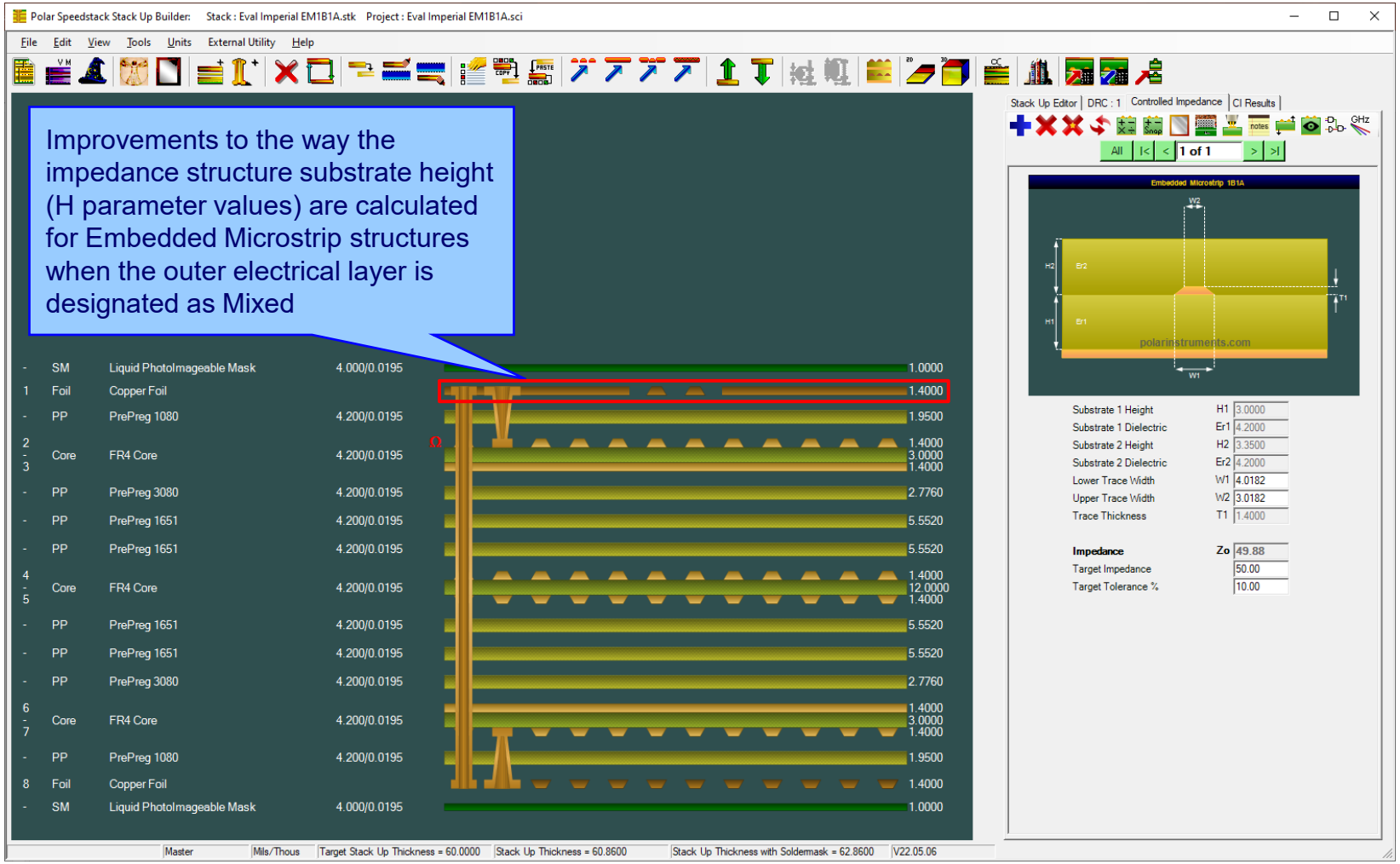
Embedded Microstrip structure enhancements



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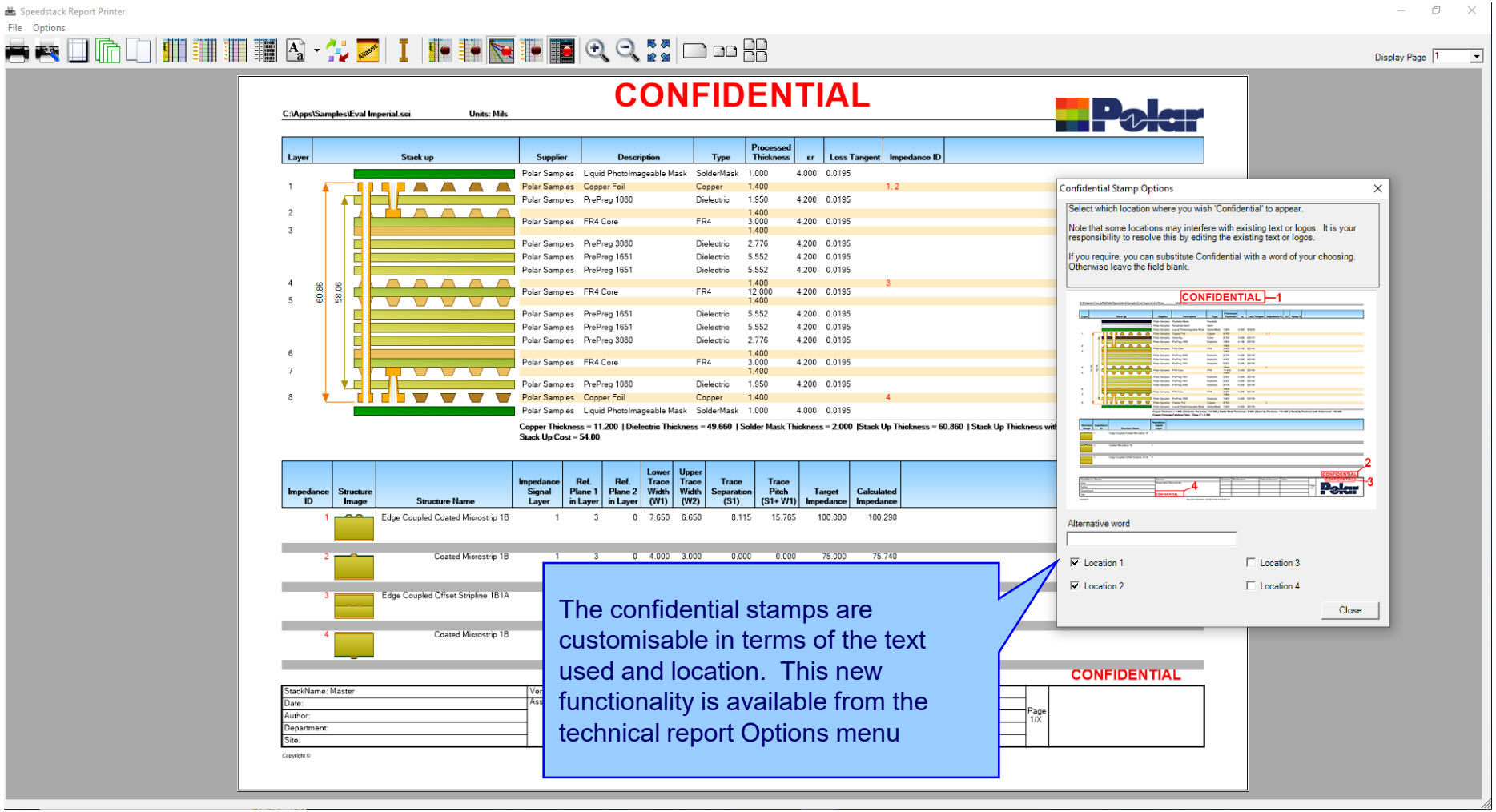
New Confidential Stamp options added to the technical report



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Speedstack v22.01.01 (January 2022)

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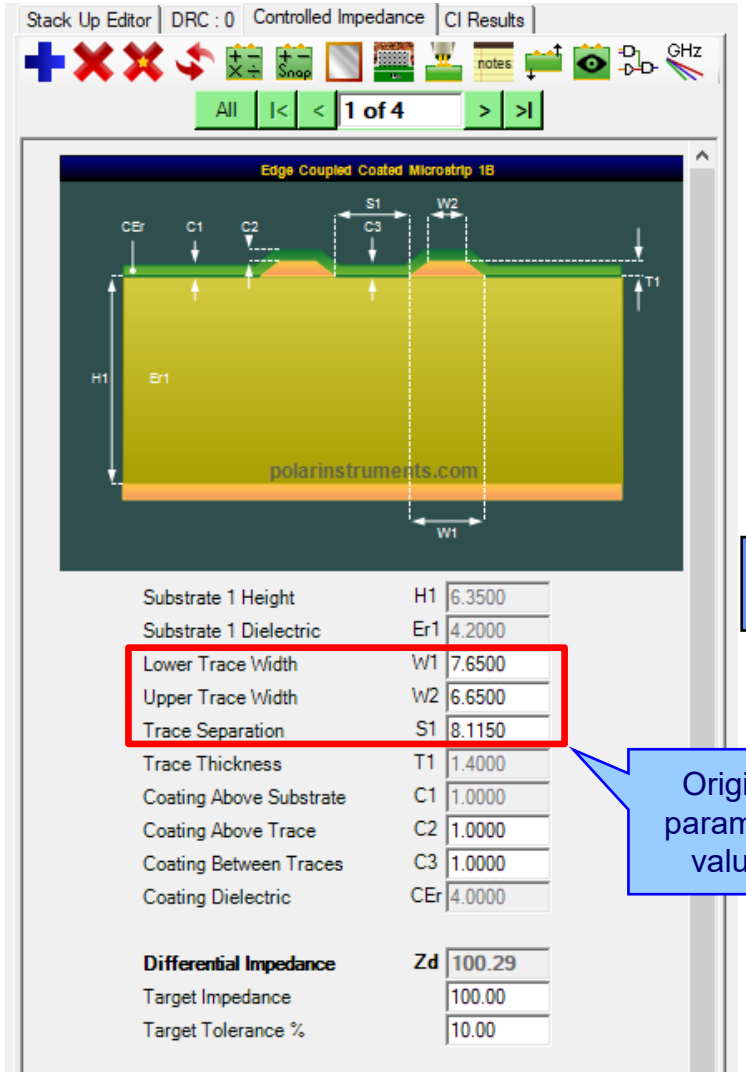
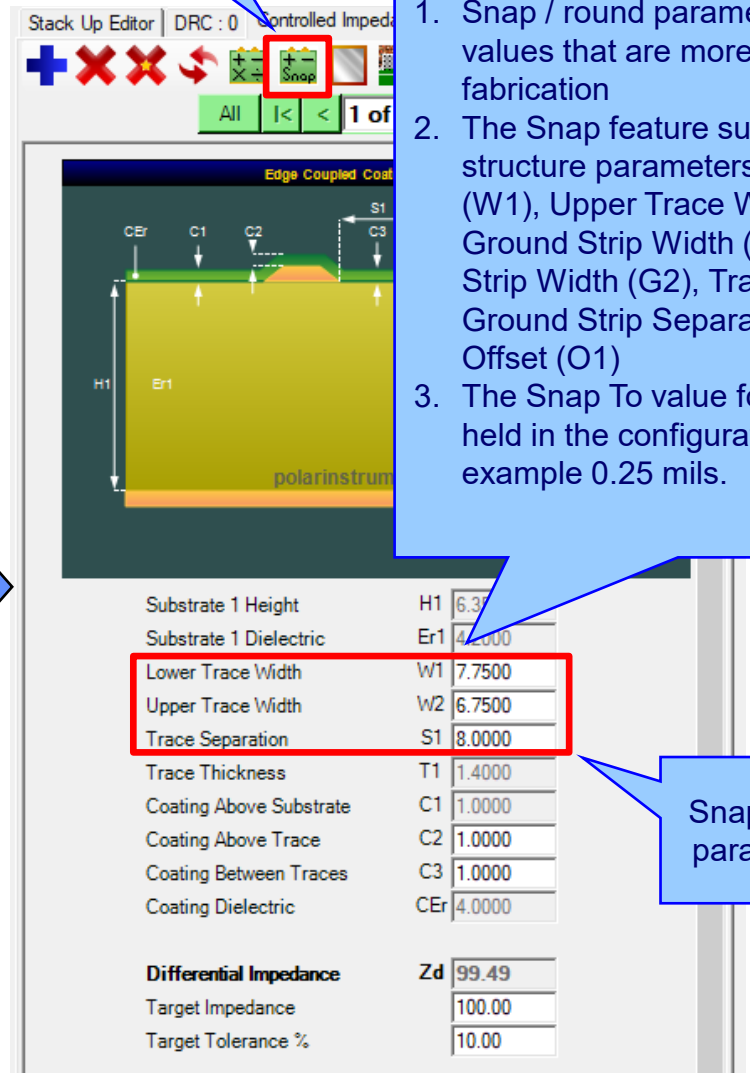
Snap Parameters and Calculate Structure



Original parameter values



Snapped/rounded parameter values

New option

Snap Parameters and Calculate Structure

1. Snap / round parameters to practical values that are more appropriate for fabrication
2. The Snap feature supports the following structure parameters : Lower Trace Width (W1), Upper Trace Width (W2), Lower Ground Strip Width (G1), Upper Ground Strip Width (G2), Trace Separation (S1), Ground Strip Separation (D1), Trace Offset (O1)
3. The Snap To value for each parameter is held in the configuration settings, in this example 0.25 mils.

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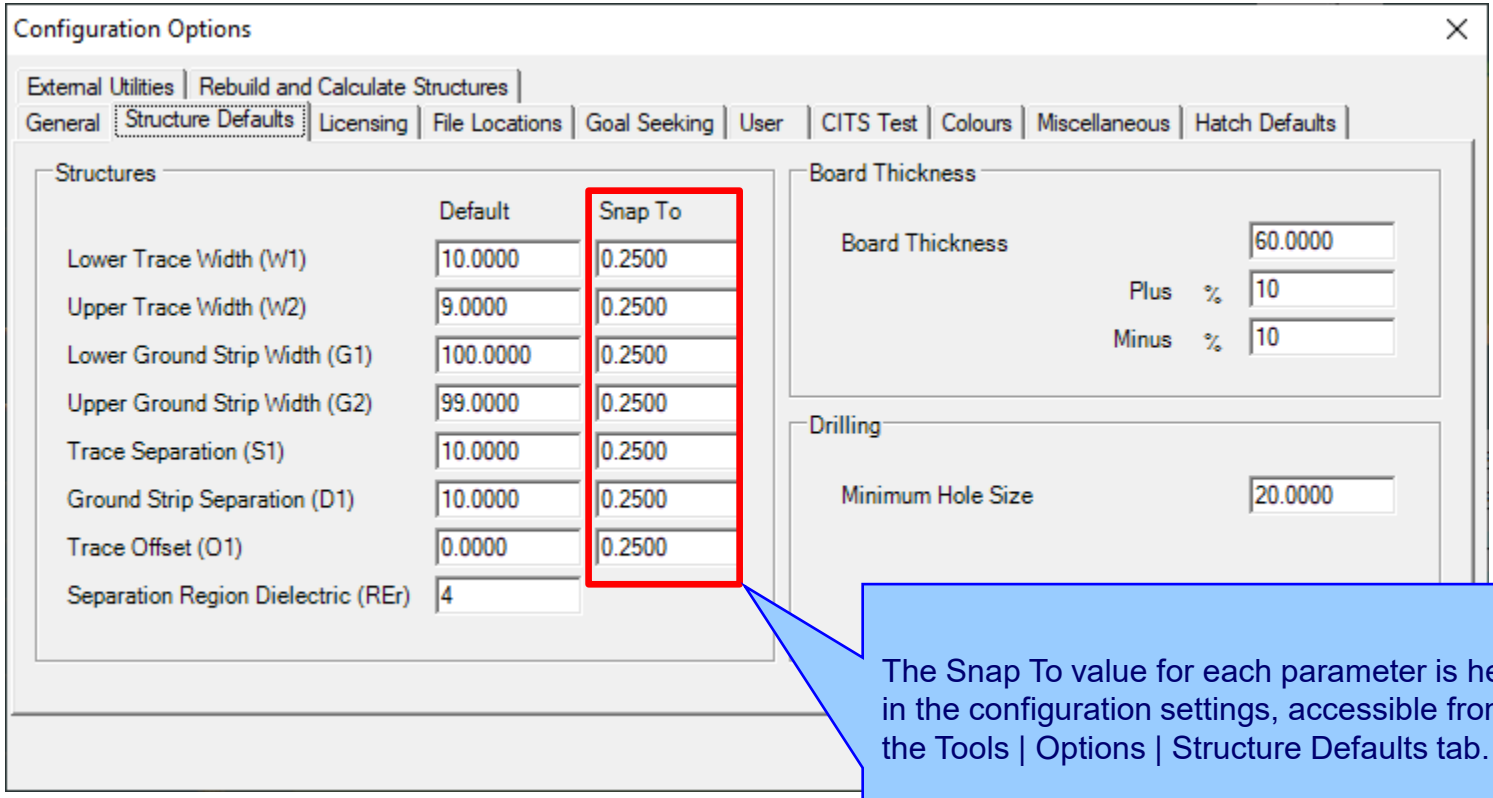
Snap Parameters and Calculate Structure



The Snap To value for each parameter is held in the configuration settings, accessible from the Tools | Options | Structure Defaults tab.

Although all Snap To values shown here are set to 0.25 mils, each parameter can support a different value

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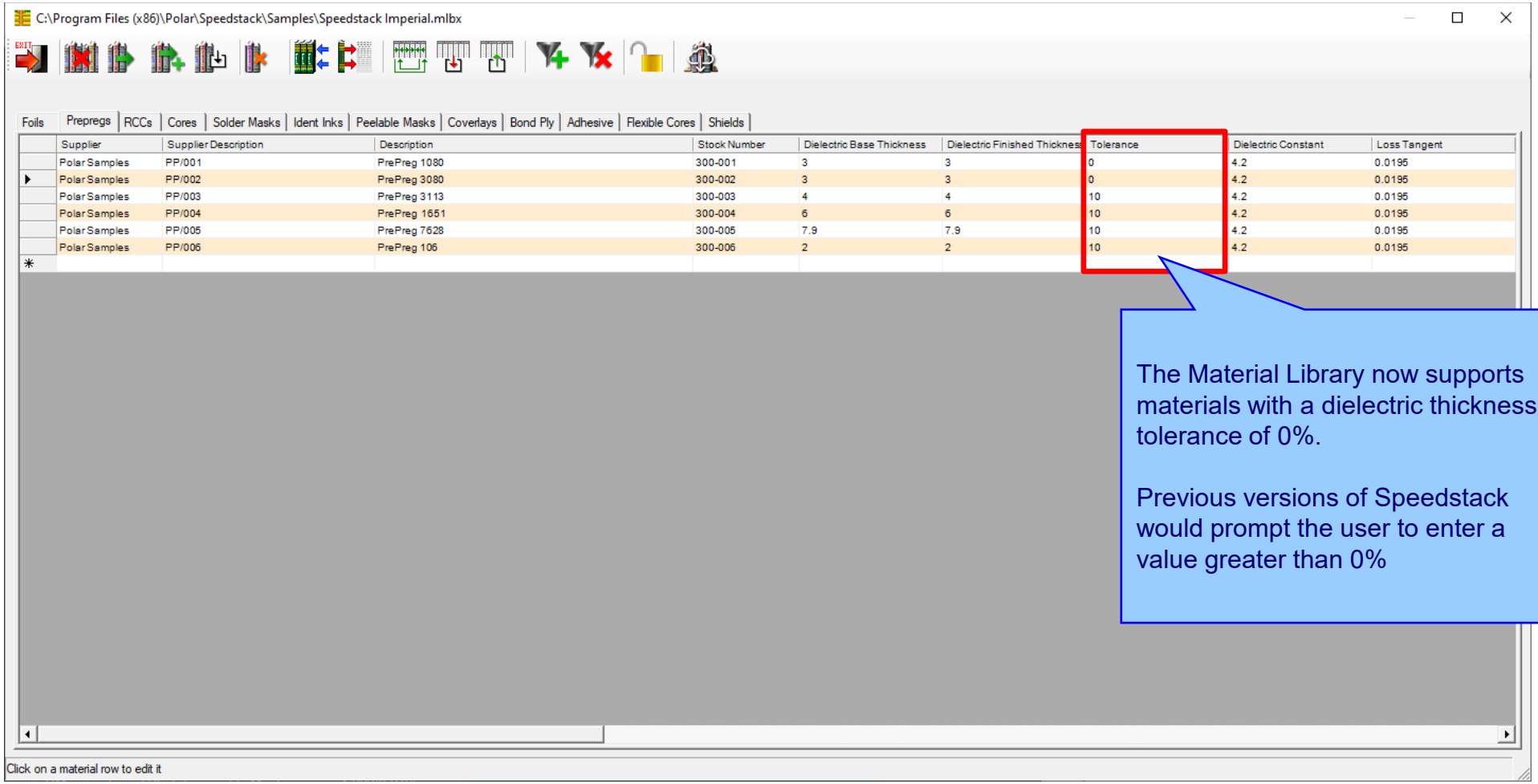
Material Library Enhancements



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Speedstack v21.11.01 (November 2021)

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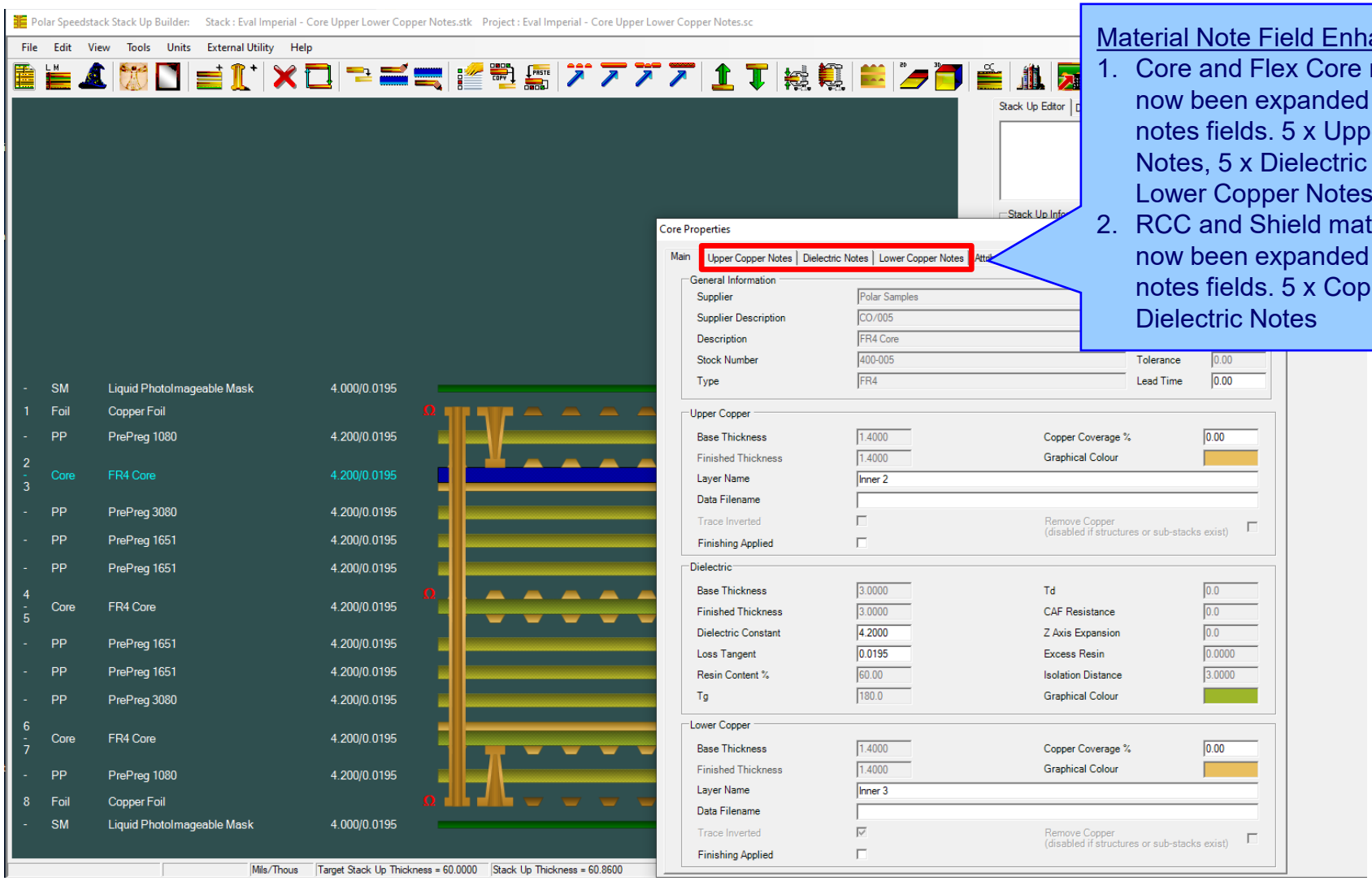
Material Note Field Enhancements – improvements to stack up documentation



Material Note Field Enhancements

1. Core and Flex Core materials have now been expanded to support 15 notes fields. 5 x Upper Copper Notes, 5 x Dielectric Notes, 5 x Lower Copper Notes
2. RCC and Shield materials have now been expanded to support 10 notes fields. 5 x Copper Notes, 5 x Dielectric Notes

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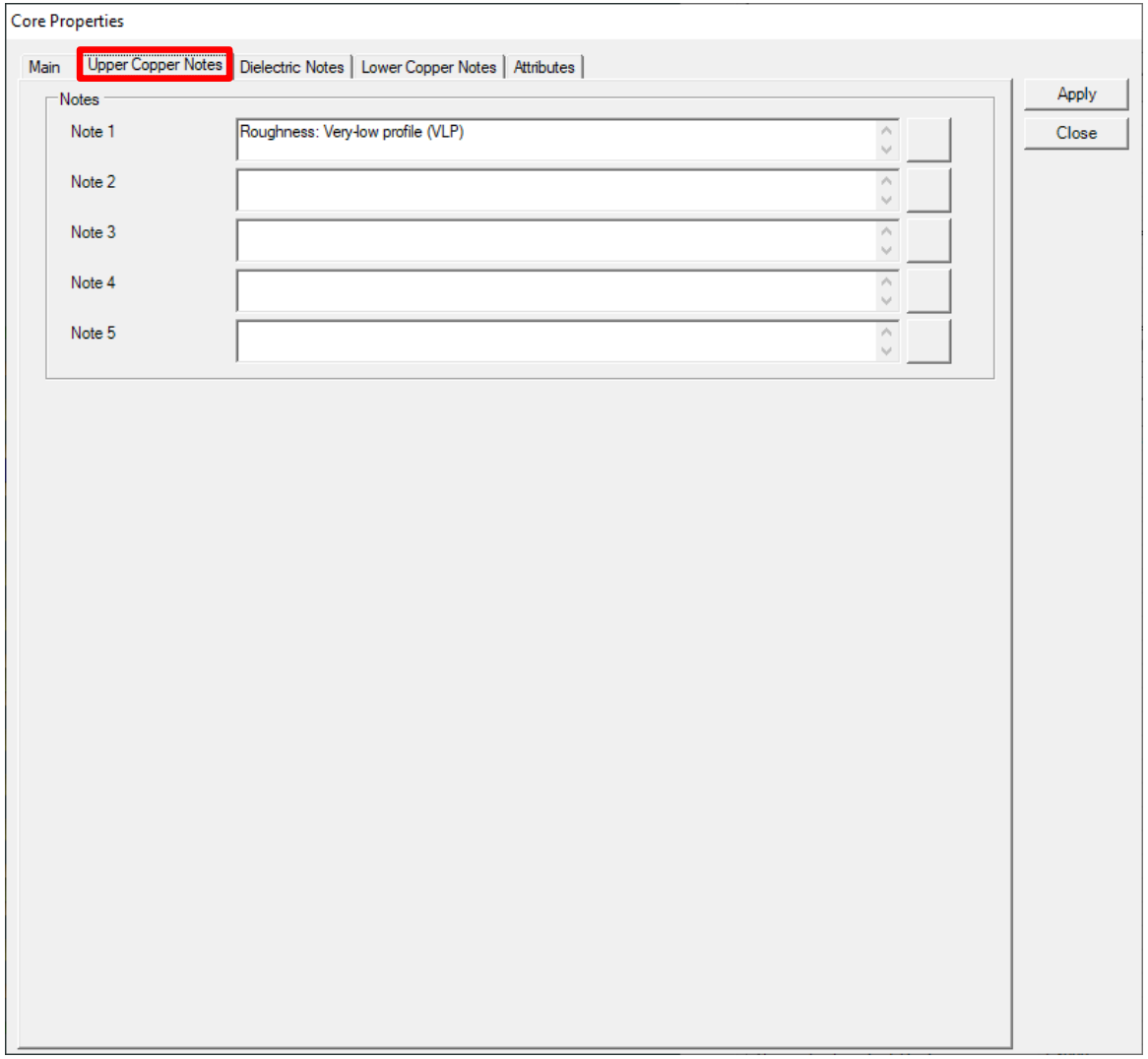
Material Note Field Enhancements – improvements to stack up documentation



The new Upper and Lower Copper Notes allow the user to specify important information about the copper surfaces for a Core and Flex Core material.

For instance, copper roughness and plating fabrication information can be specified

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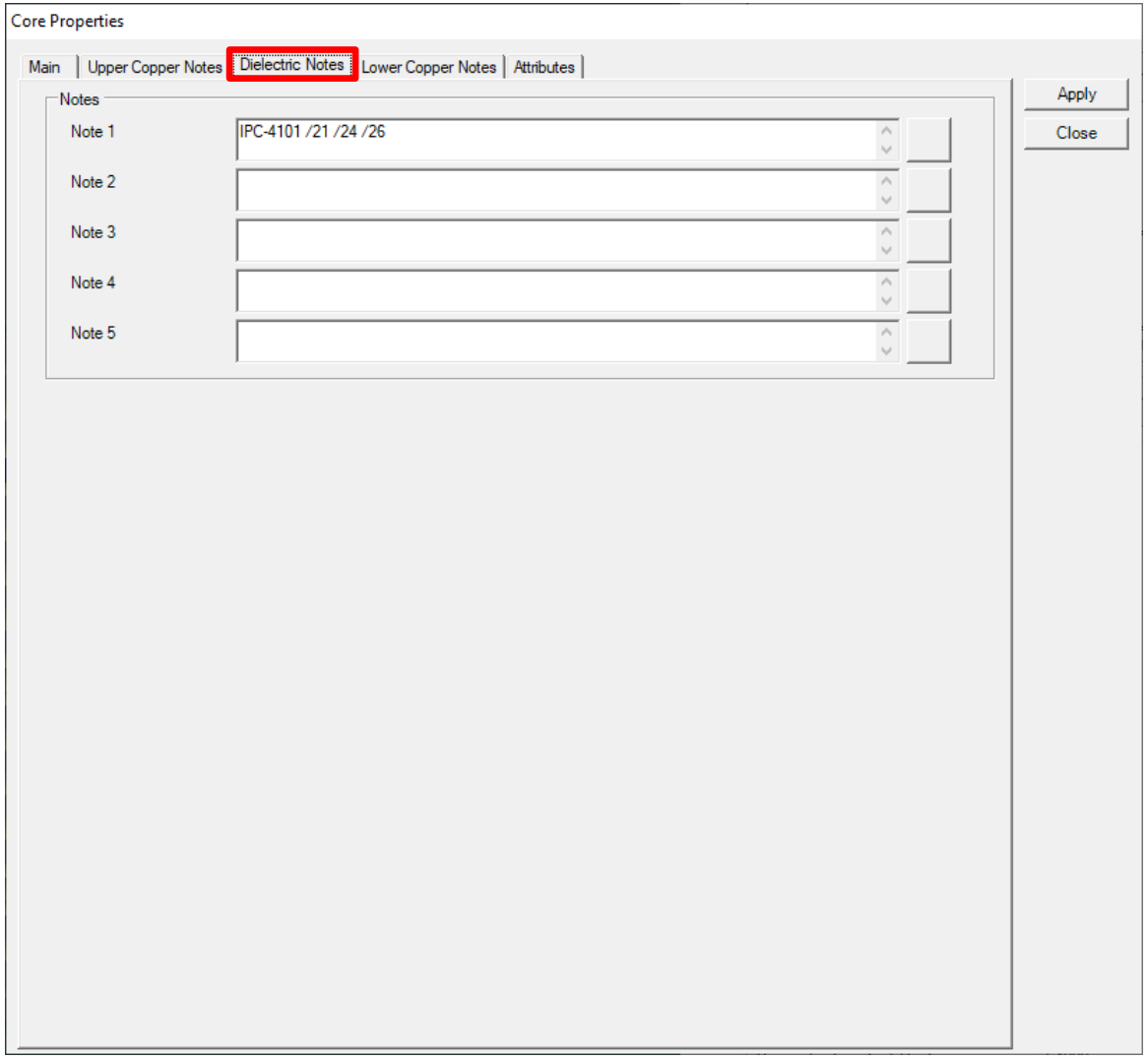
Material Note Field Enhancements – improvements to stack up documentation



Dielectric Notes are useful for specifying IPC-4101 slash sheet categories, glass weave information (spread glass) and other important information regarding the dielectric region of the core.

The existing five Notes fields from previous versions of Speedstack will be allocated as Dielectric Notes.

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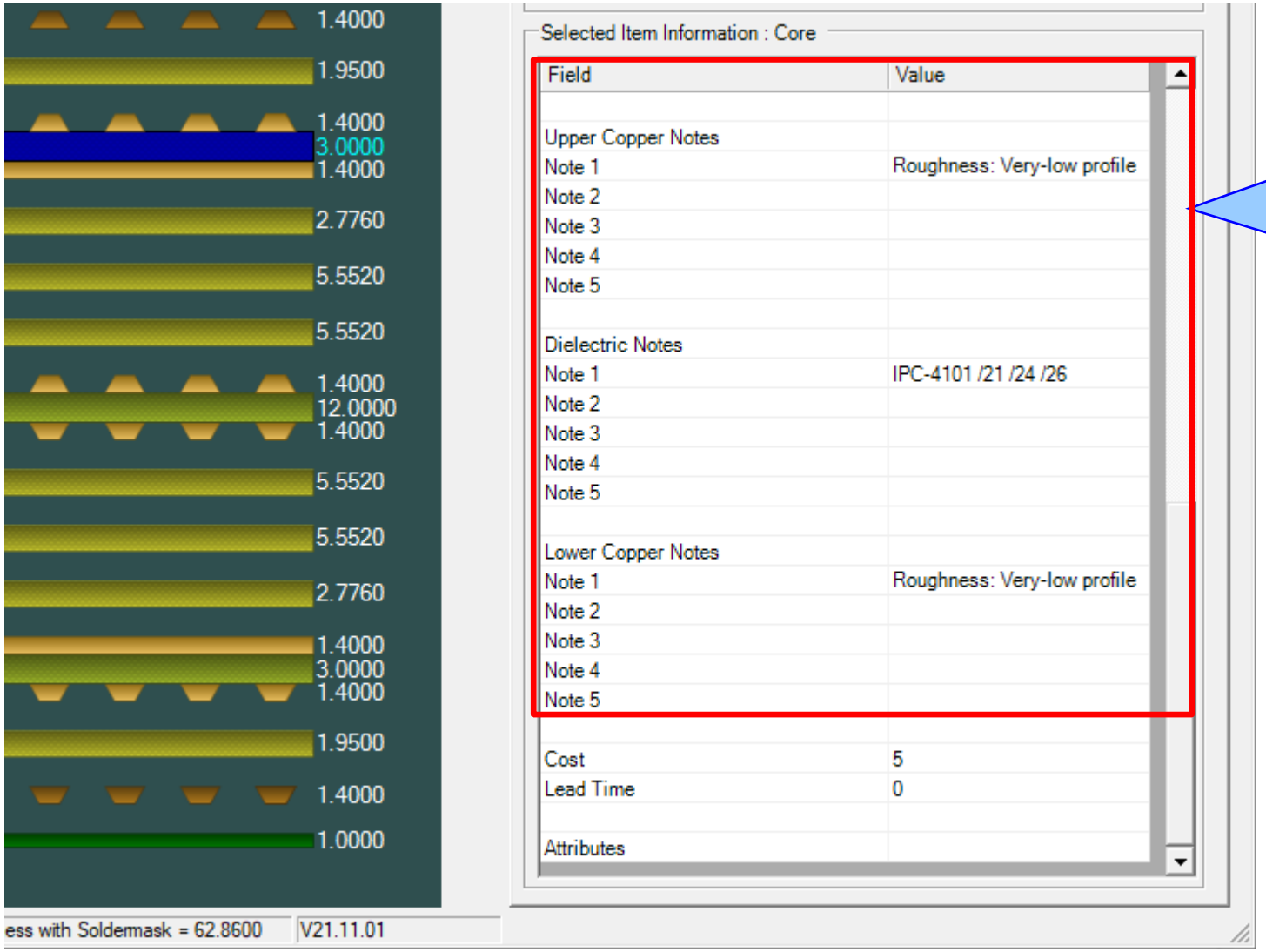
Material Note Field Enhancements – improvements to stack up documentation



When selecting a core / flex core material the Upper Copper, Dielectric and Lower Copper Notes can be confirmed here.

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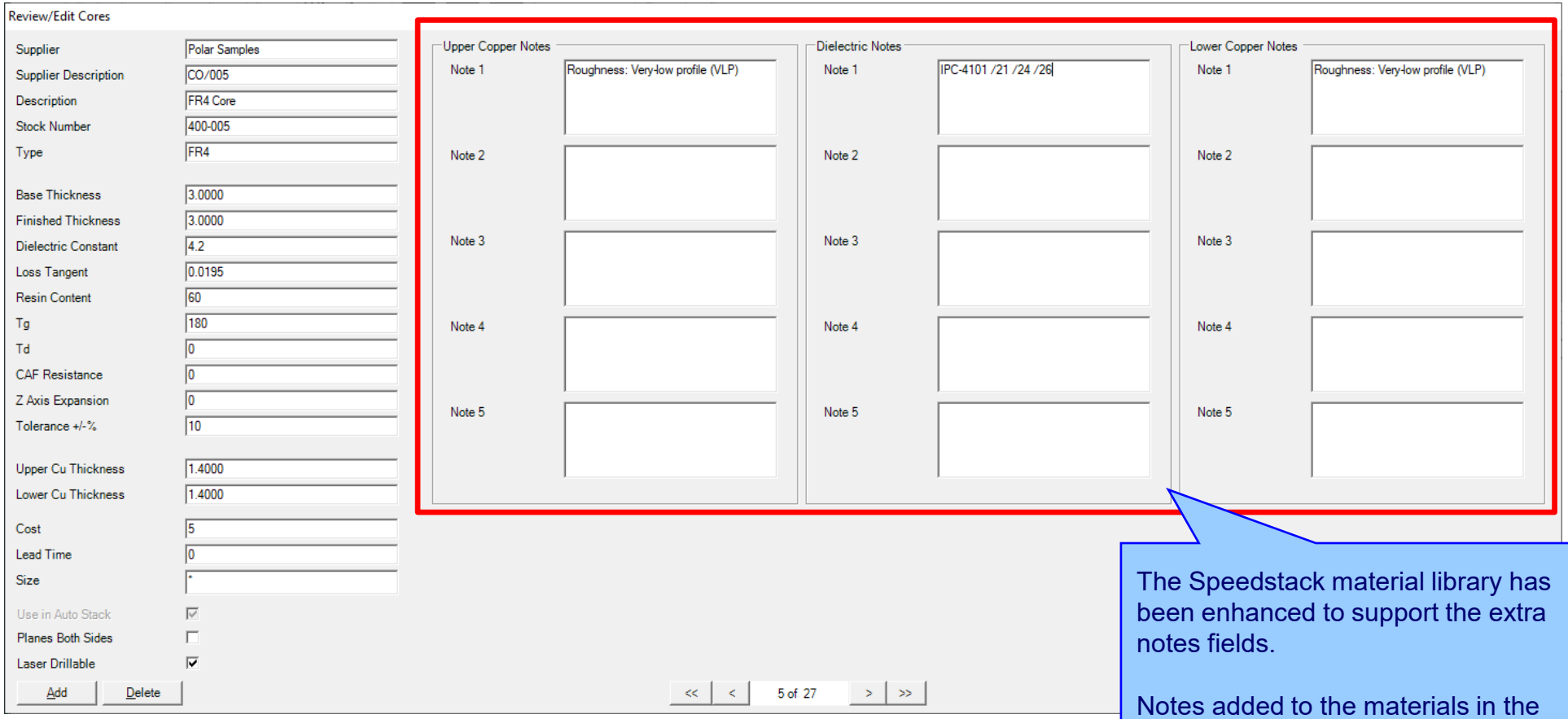
Material Note Field Enhancements – library enhancements



The Speedstack material library has been enhanced to support the extra notes fields.

Notes added to the materials in the library will automatically be transferred to the stack up.

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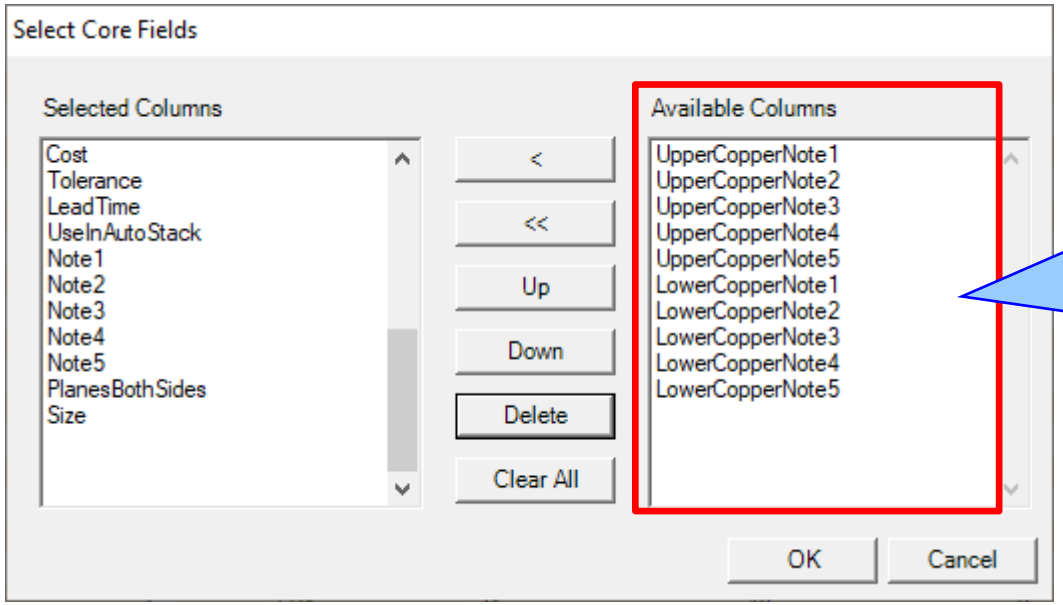
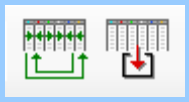
Material Note Field Enhancements – library enhancements



For existing Speedstack users upgrading to v21.11, use the Select and Arrange Columns and Save Column Order toolbar options to add these new material library columns to the Data Grid view



Material Library Import / Export

The import / export options have been enhanced to support the additional material library notes columns.

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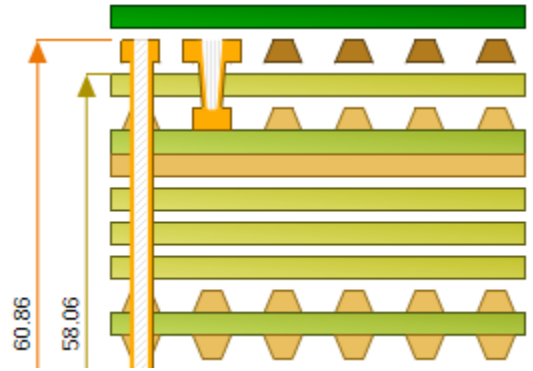
Material Note Field Enhancements – technical report enhancements

C:\Apps\Samples\Eval Imperial - Core Upper Lower Copper Notes.sci Units: Mils

Layer	Stack up	Manufacturing Notes	Copper Layer Name	Supplier	Description
				Polar Samples	Liquid PhotoImageable Mask
1			Top	Polar Samples	Copper Foil
				Polar Samples	PrePreg 1080
2		Roughness: Very-low profile (VLP) IPC-4101 /21 /24 /26	Inner 2	Polar Samples	FR4 Core
3		Roughness: Very-low profile (VLP)	Inner 3		
				Polar Samples	PrePreg 3080
				Polar Samples	PrePreg 1651
4					
5					

The technical report has been updated to support the additional notes fields. Notice the Upper Copper, Dielectric and Lower Copper Notes align with the appropriate part of the Core material.

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Import / Export enhancements

The following Import / Export options have been updated to support the additional material notes properties introduced with Speedstack v21.11.01:

- XML STKX v23.00 and SSX v13.00 import / export options
- CSV export option

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Speedstack v21.07.08 (July 2021)

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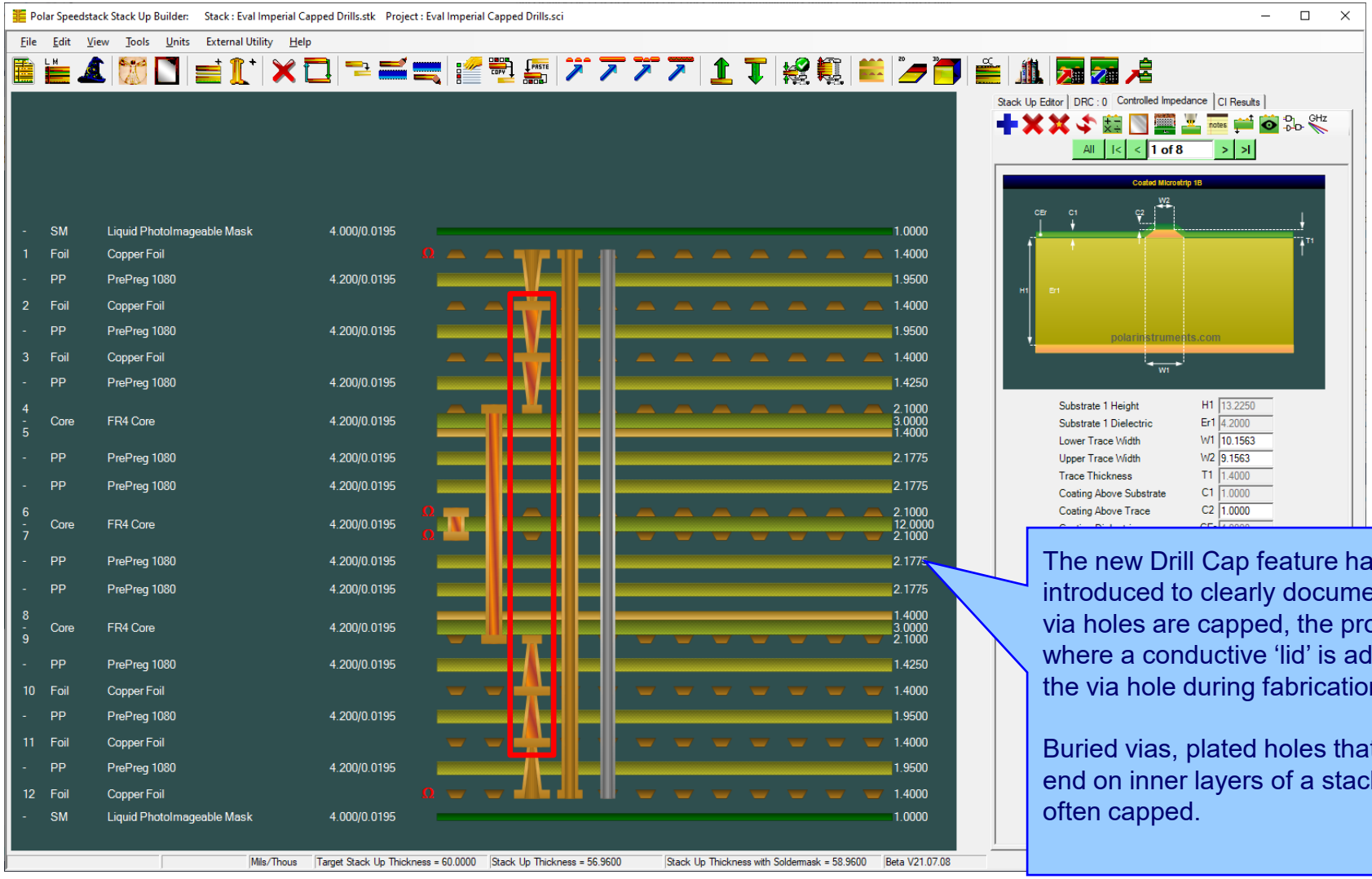
New Drill Cap feature



The new Drill Cap feature has been introduced to clearly document when via holes are capped, the process where a conductive ‘lid’ is added to the via hole during fabrication.

Buried vias, plated holes that start and end on inner layers of a stack up, are often capped.

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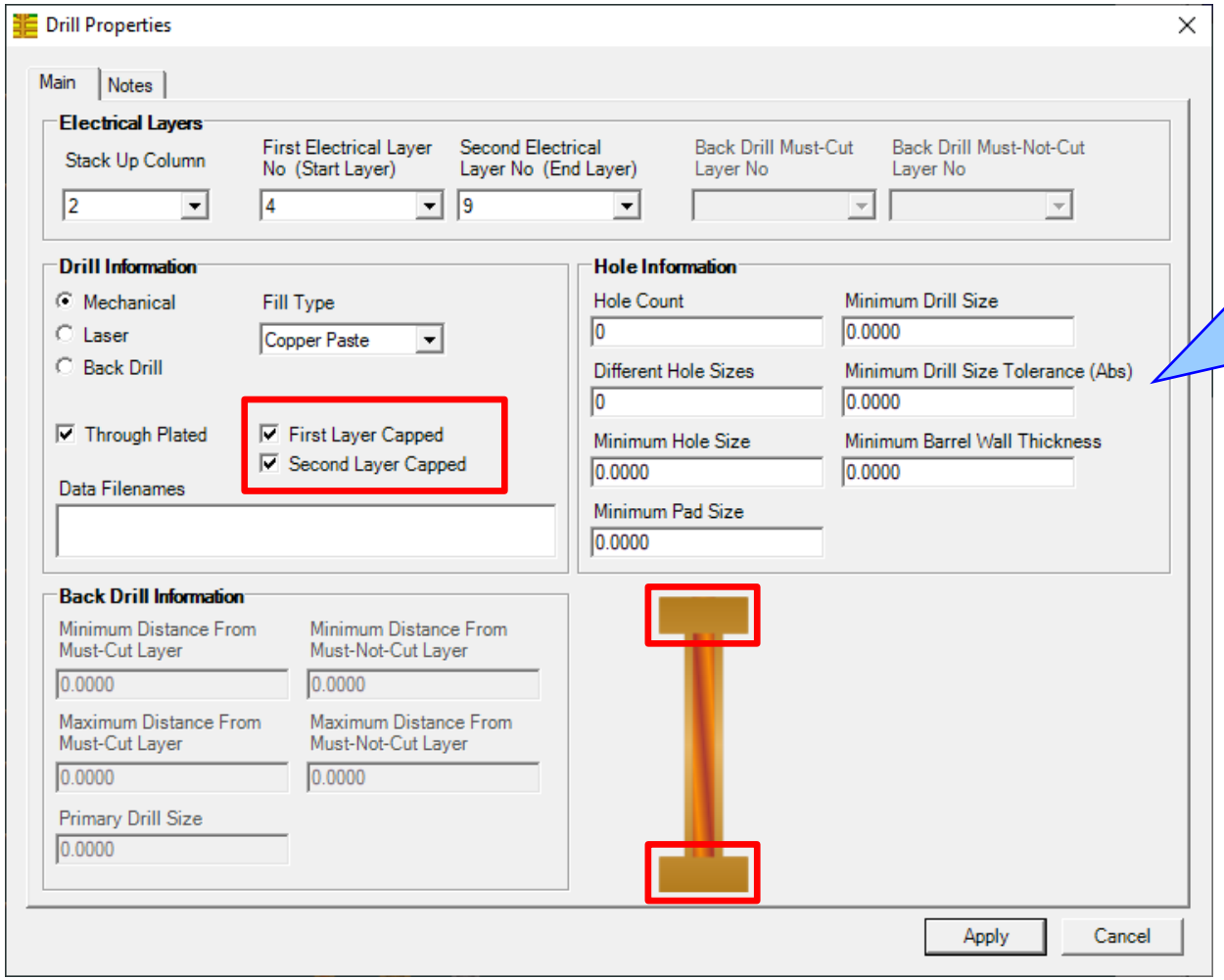
Drill Cap option – mechanical through plated drills



Mechanical
For mechanical drills it is possible to have four states:
1.Neither first or second layer capped (default when adding a drill)
2.First layer capped
3.Second layer capped
4.Both layers capped

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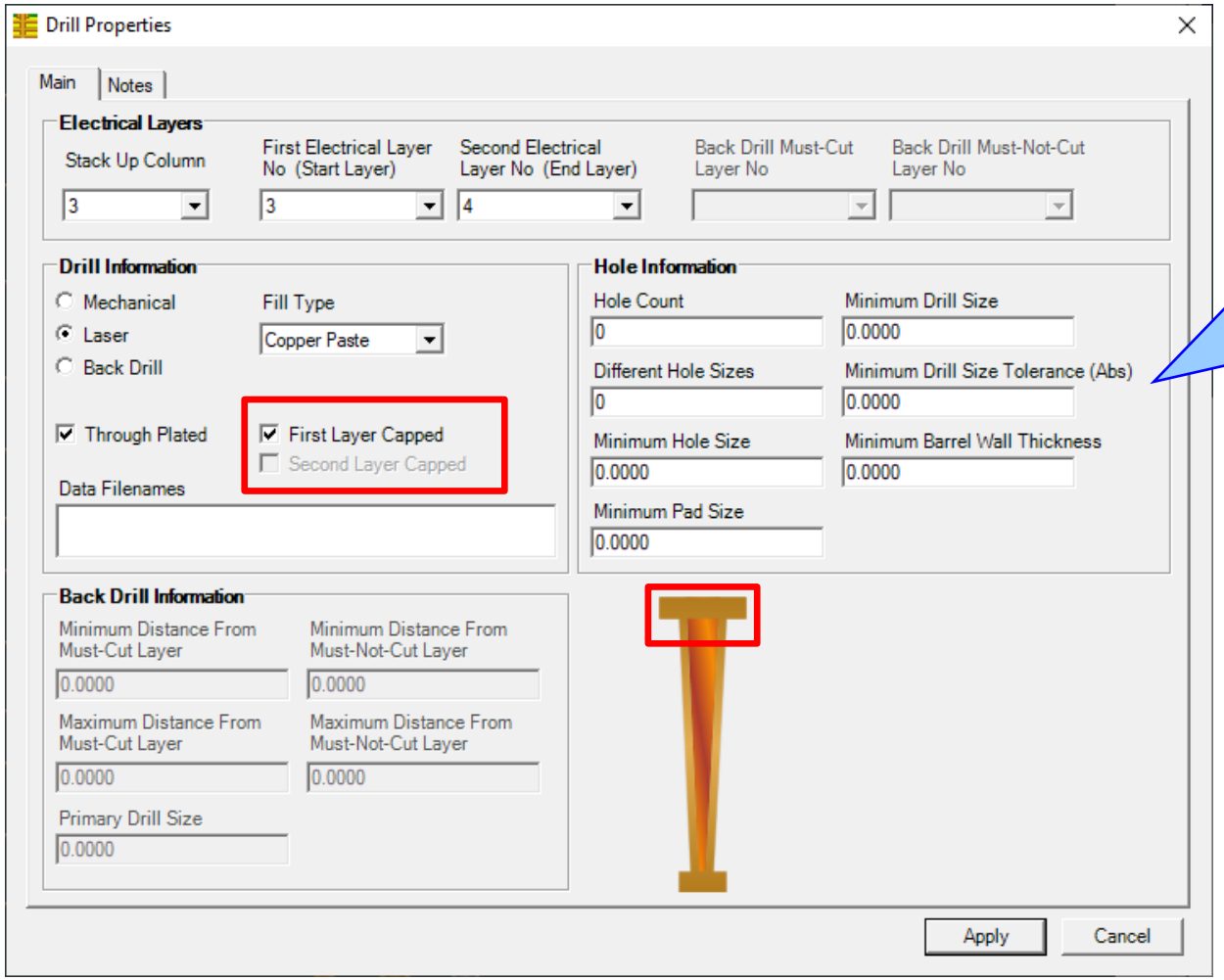
Drill Cap option – laser drills



Laser
For laser drills it is possible to have two states as the Second Layer Capped checkbox is disabled:
1.Not capped (default when adding a drill)
2.First layer capped

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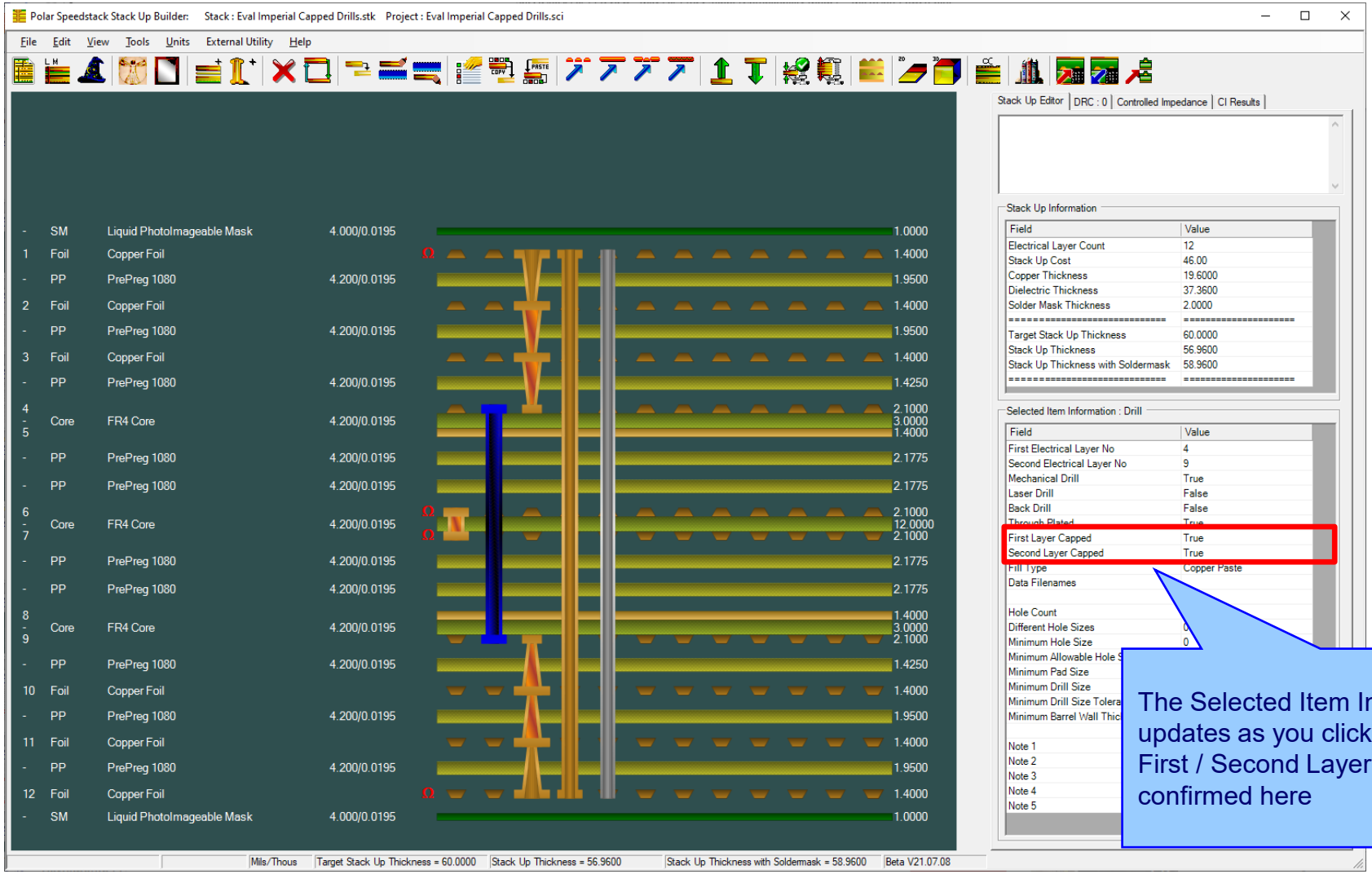
New Drill Cap feature



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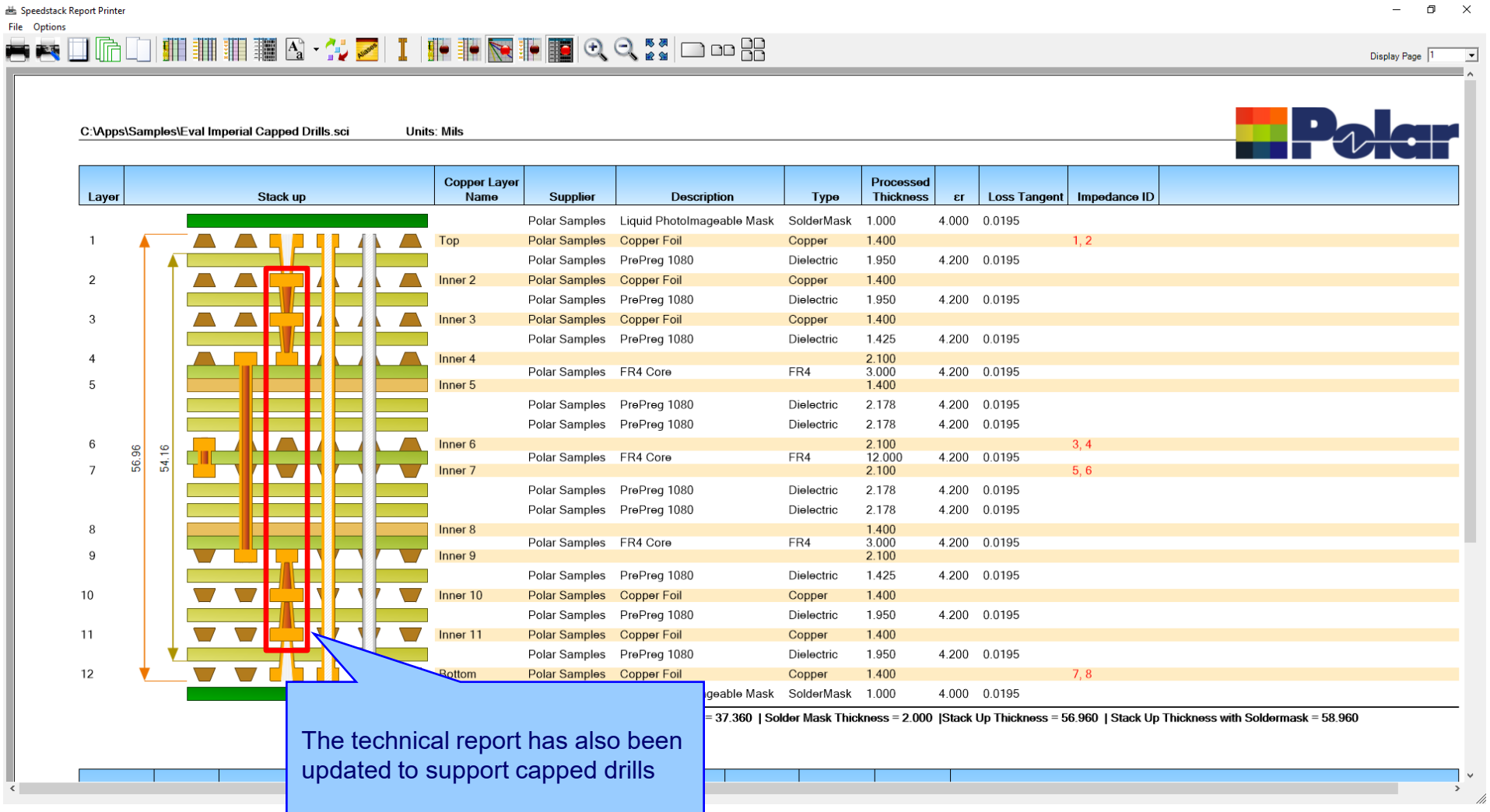
New Drill Cap feature – technical report enhancements



Layer	Stack up	Copper Layer Name	Supplier	Description	Type	Processed Thickness	εr	Loss Tangent	Impedance ID
			Polar Samples	Liquid PhotoImageable Mask	SolderMask	1.000	4.000	0.0195	
1		Top	Polar Samples	Copper Foil	Copper	1.400			1, 2
			Polar Samples	PrePreg 1080	Dielectric	1.950	4.200	0.0195	
2		Inner 2	Polar Samples	Copper Foil	Copper	1.400			
			Polar Samples	PrePreg 1080	Dielectric	1.950	4.200	0.0195	
3		Inner 3	Polar Samples	Copper Foil	Copper	1.400			
			Polar Samples	PrePreg 1080	Dielectric	1.425	4.200	0.0195	
4		Inner 4				2.100			
			Polar Samples	FR4 Core	FR4	3.000	4.200	0.0195	
5		Inner 5				1.400			
			Polar Samples	PrePreg 1080	Dielectric	2.178	4.200	0.0195	
			Polar Samples	PrePreg 1080	Dielectric	2.178	4.200	0.0195	
6		Inner 6				2.100			3, 4
			Polar Samples	FR4 Core	FR4	12.000	4.200	0.0195	
7		Inner 7				2.100			5, 6
			Polar Samples	PrePreg 1080	Dielectric	2.178	4.200	0.0195	
			Polar Samples	PrePreg 1080	Dielectric	2.178	4.200	0.0195	
8		Inner 8				1.400			
			Polar Samples	FR4 Core	FR4	3.000	4.200	0.0195	
9		Inner 9				2.100			
			Polar Samples	PrePreg 1080	Dielectric	1.425	4.200	0.0195	
10		Inner 10	Polar Samples	Copper Foil	Copper	1.400			
			Polar Samples	PrePreg 1080	Dielectric	1.950	4.200	0.0195	
11		Inner 11	Polar Samples	Copper Foil	Copper	1.400			
			Polar Samples	PrePreg 1080	Dielectric	1.950	4.200	0.0195	
12		Bottom	Polar Samples	Copper Foil	Copper	1.400			7, 8
				ageable Mask	SolderMask	1.000	4.000	0.0195	

= 37.360 | Solder Mask Thickness = 2.000 |Stack Up Thickness = 56.960 | Stack Up Thickness with Soldermask = 58.960

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Import / Export enhancements

The following Import / Export options have been updated to support the drill cap properties introduced with Speedstack v21.07.08:

- XML STKX v22.00 and SSX v12.00 import / export options
- CSV export option

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Speedstack v21.05.06 (May 2021)

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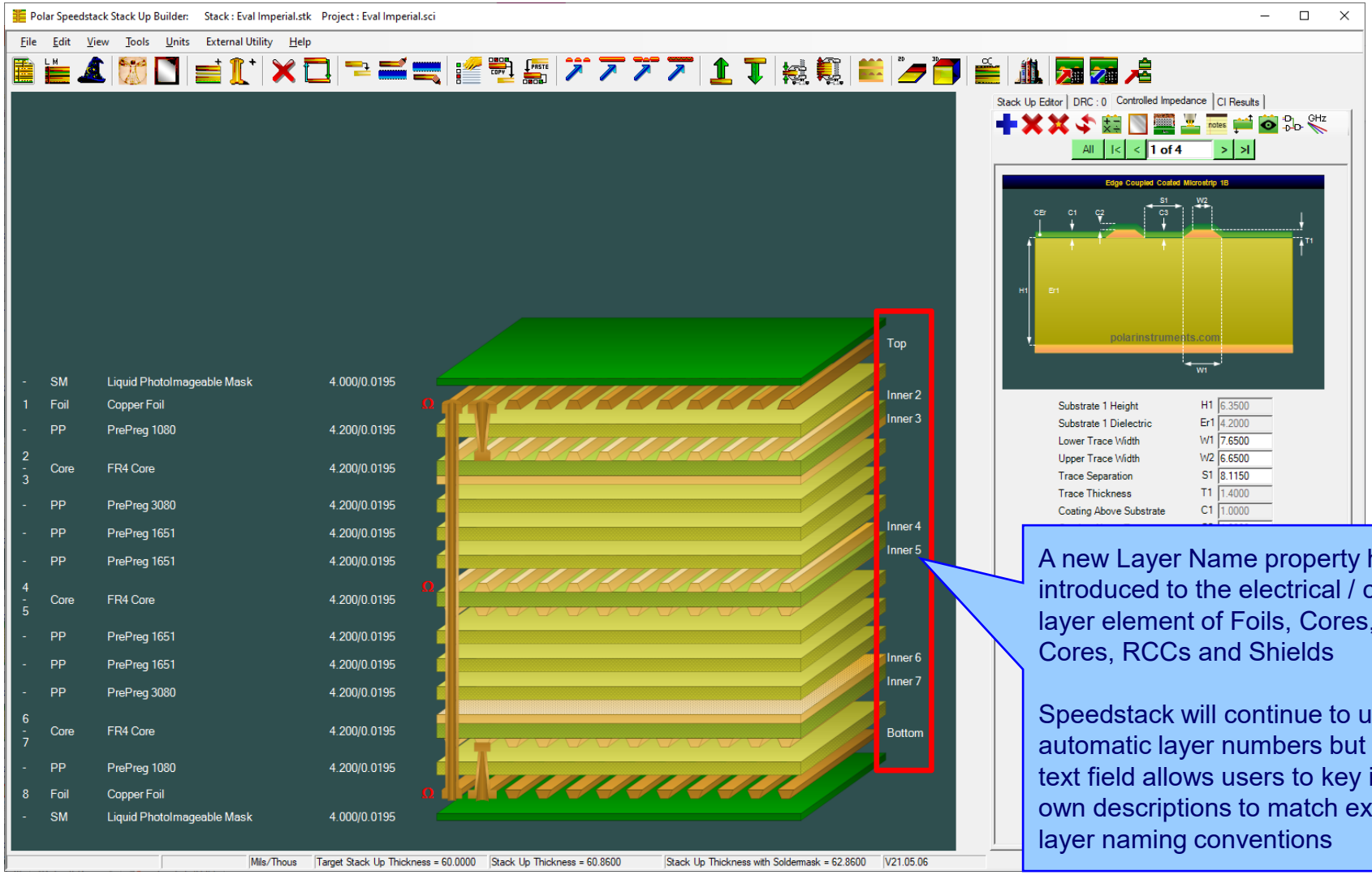
New Layer Name property for electrical / copper layers



A new Layer Name property has been introduced to the electrical / copper layer element of Foils, Cores, Flex Cores, RCCs and Shields

Speedstack will continue to use the automatic layer numbers but this new text field allows users to key in their own descriptions to match existing layer naming conventions

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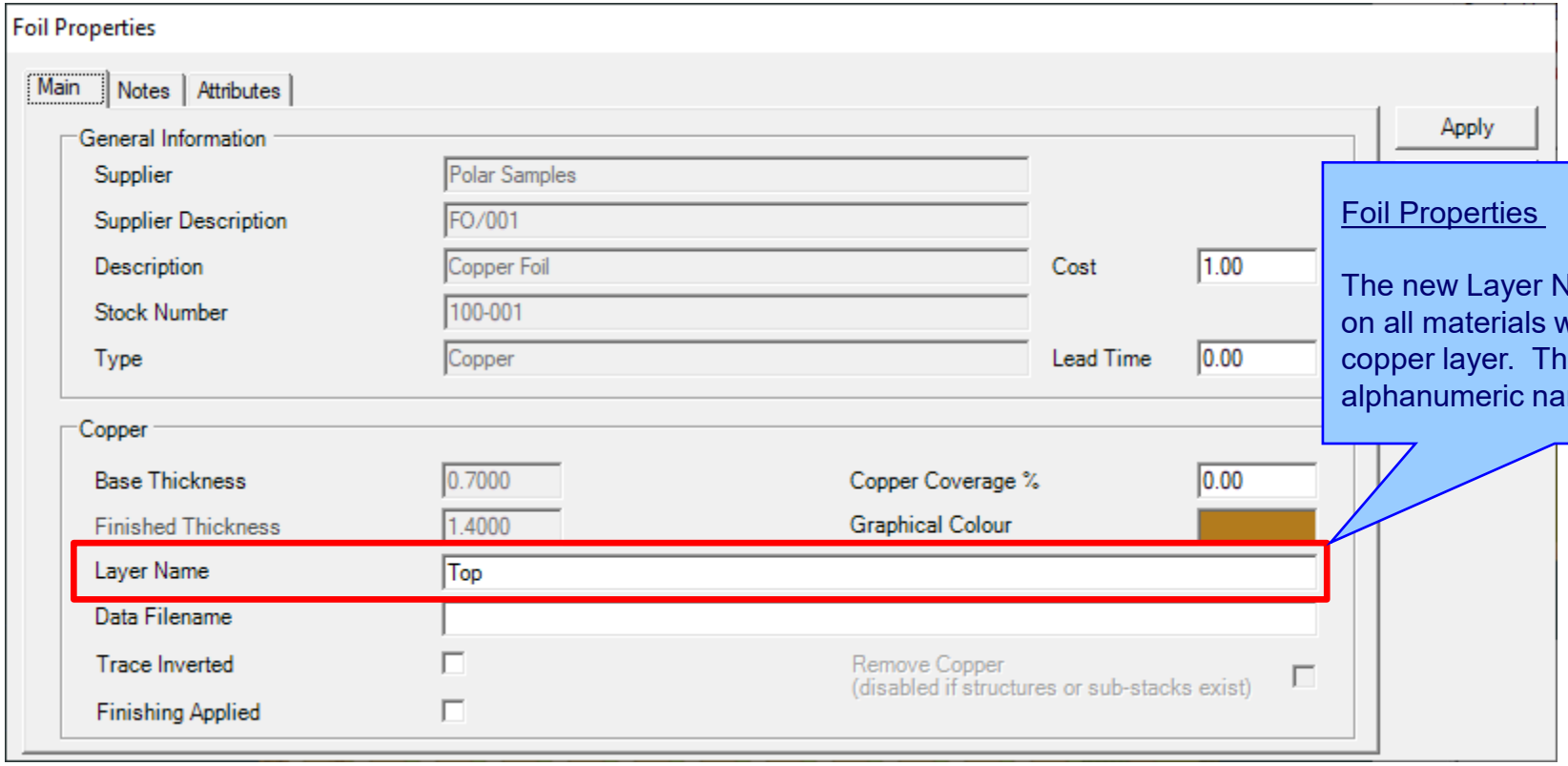
New Layer Name property for electrical / copper layers



Foil Properties

The new Layer Name property exists on all materials with an electrical / copper layer. The user can key in any alphanumeric name

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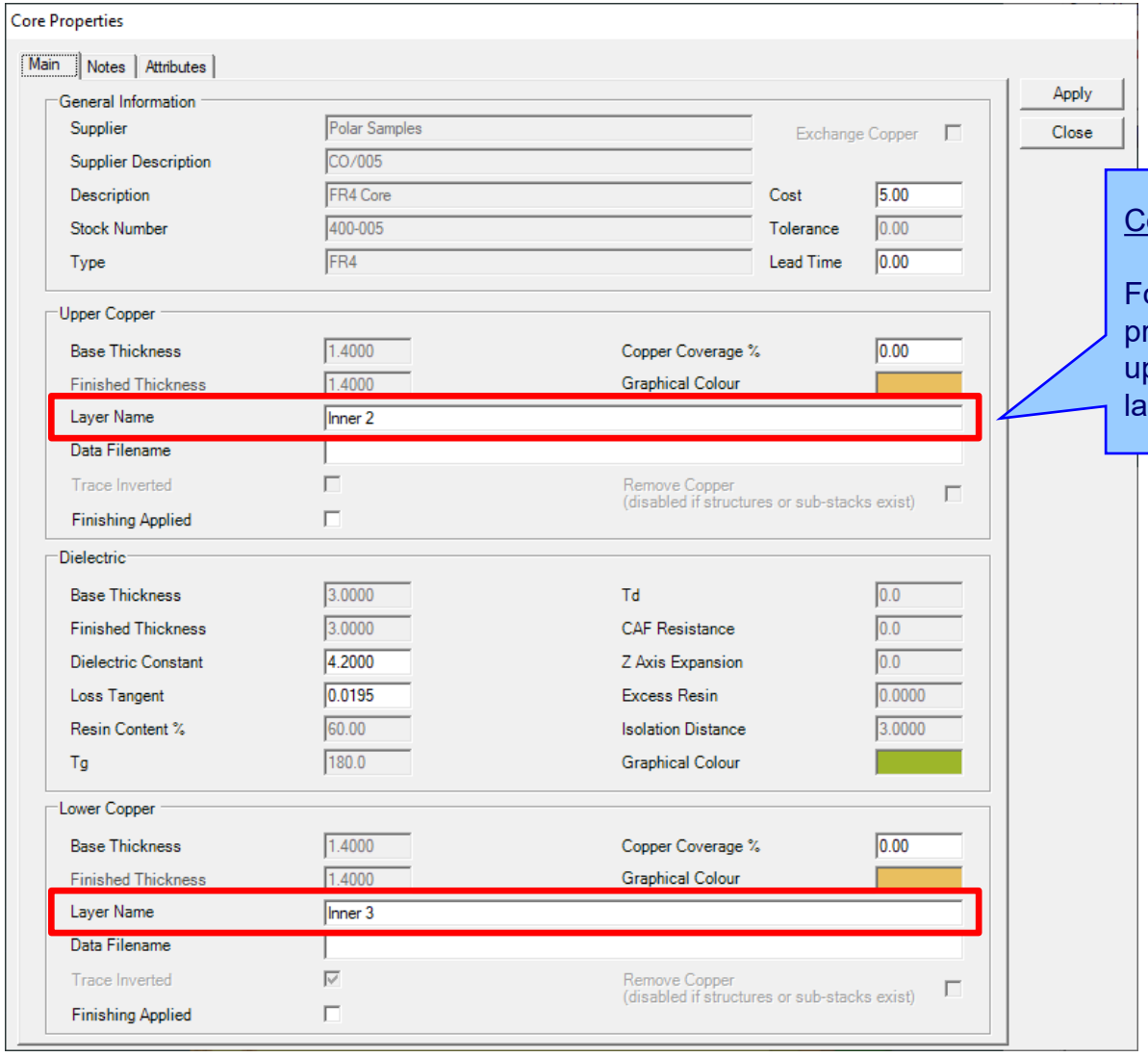
New Layer Name property for electrical / copper layers



Core Properties

For core materials, a new Layer Name property has been added for both upper and lower electrical / copper layers

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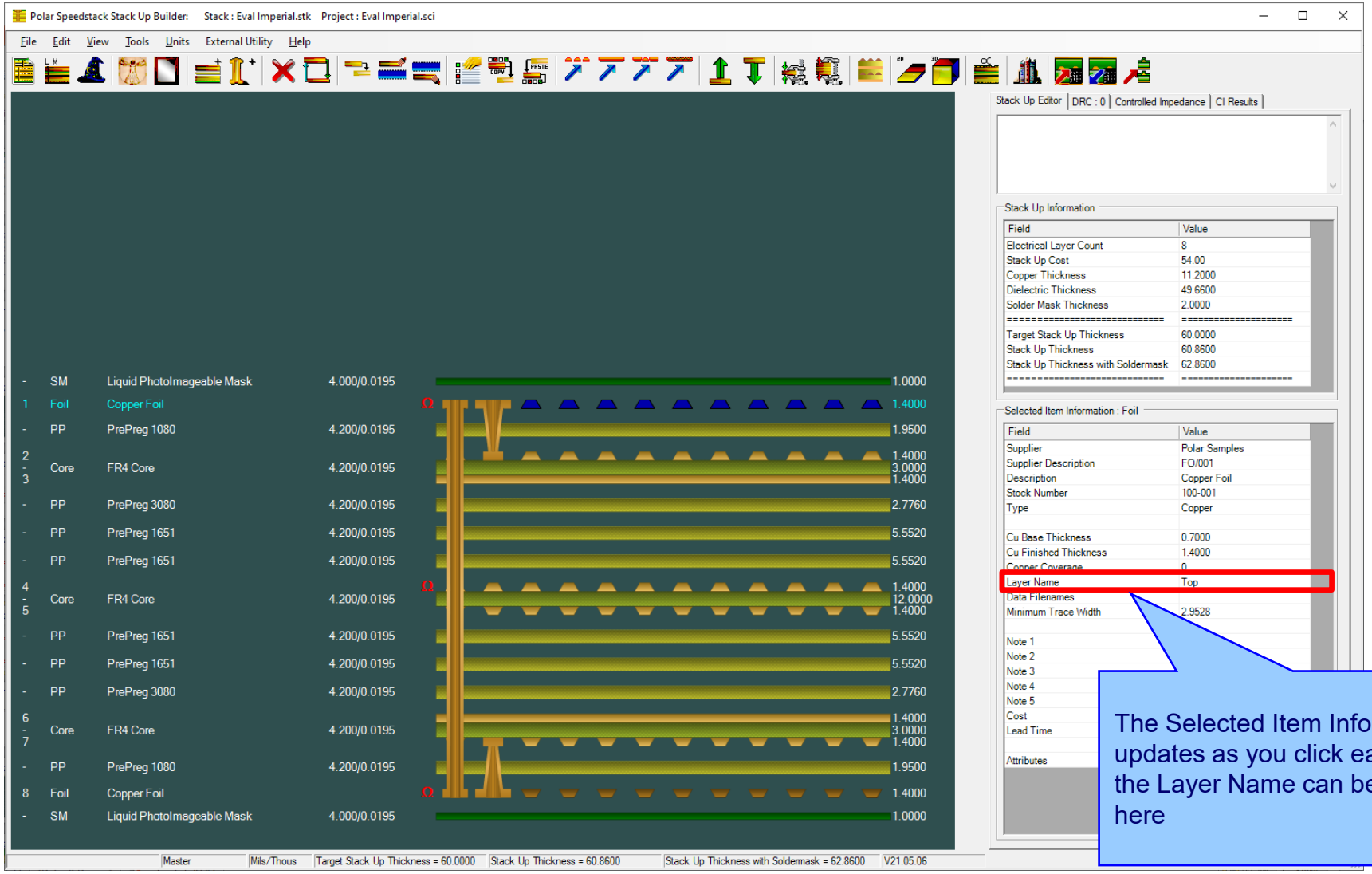
New Layer Name property for electrical / copper layers



The Selected Item Information auto updates as you click each material, the Layer Name can be confirmed here

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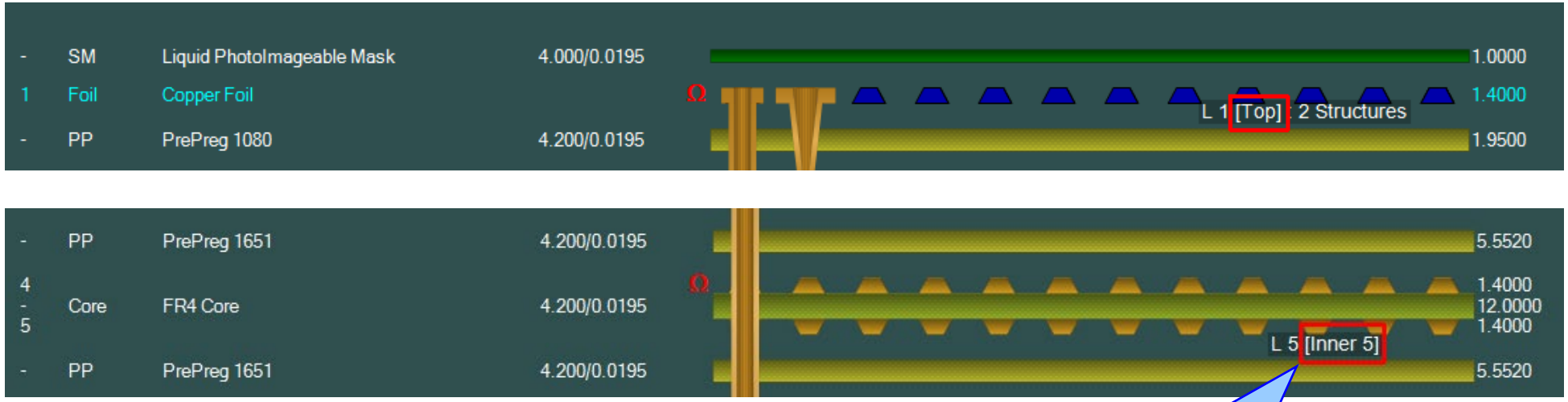
New Layer Name property for electrical / copper layers



Mouse over the electrical layer and the Layer Name will display alongside the layer number and the amount of structures. Very quickly confirm the Layer Name without needing to open the Properties dialog

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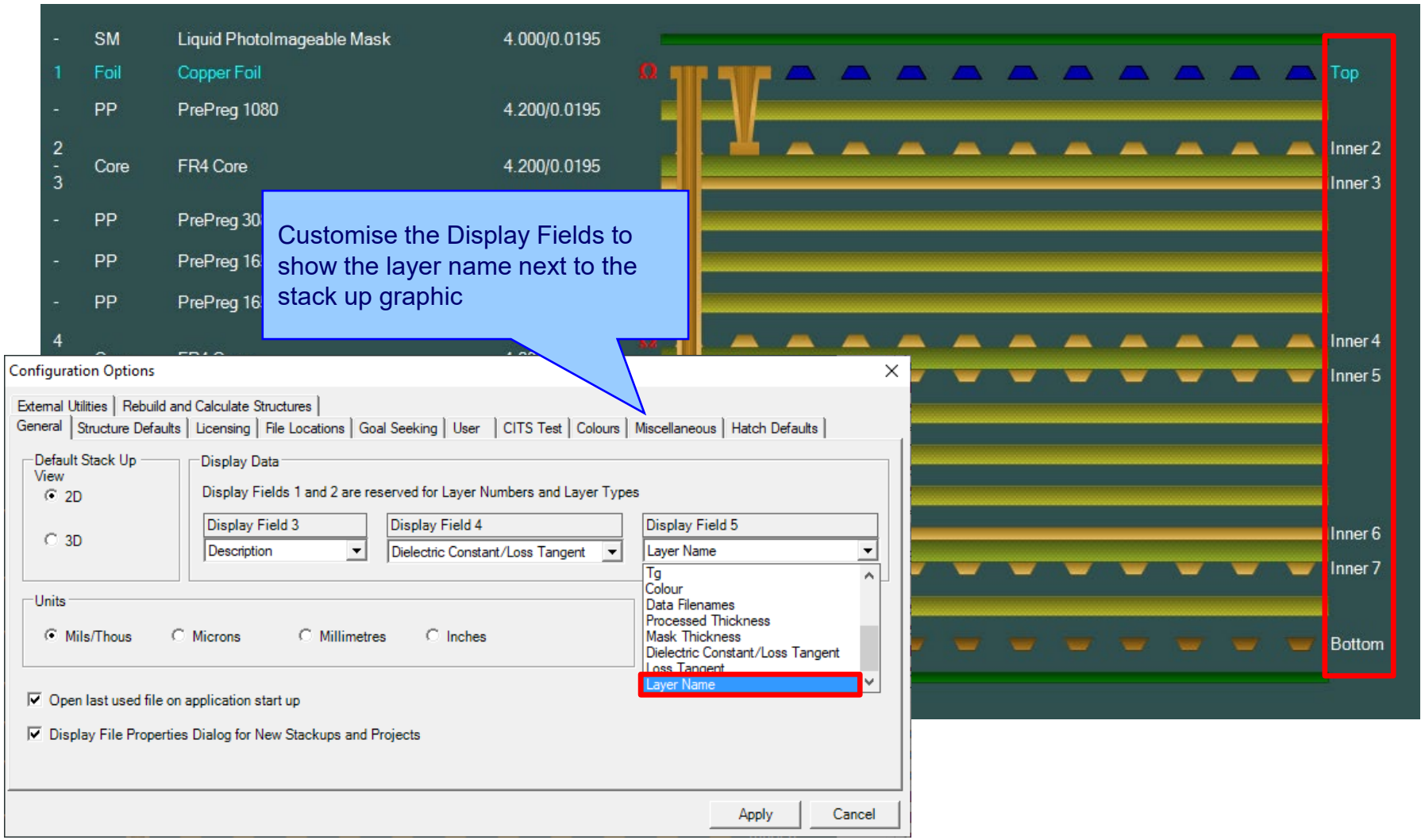
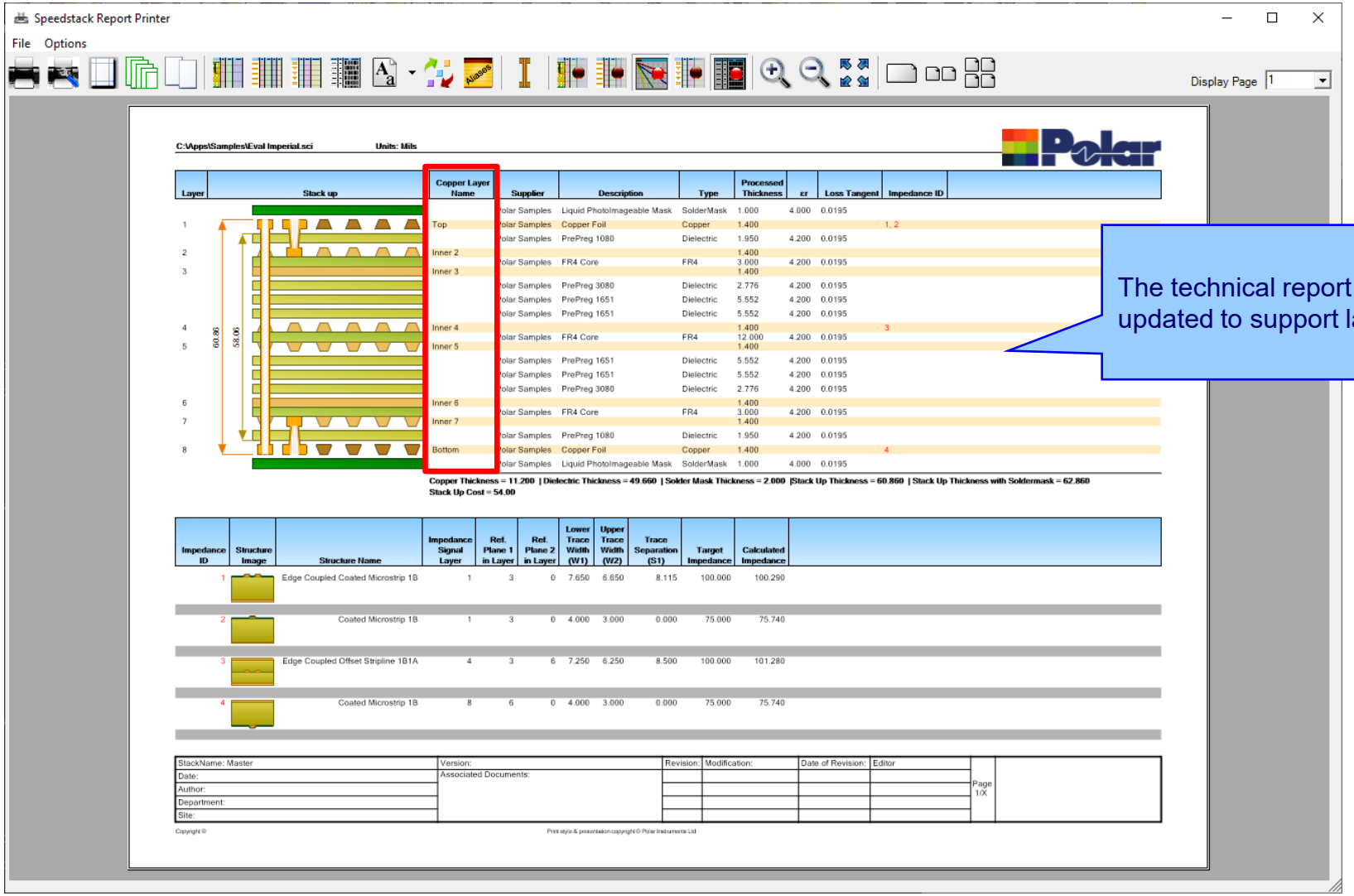
New Layer Name property for electrical / copper layers



Copyright © Polar Instruments 2026

New Layer Name property for electrical / copper layers



The technical report has also been updated to support layer names

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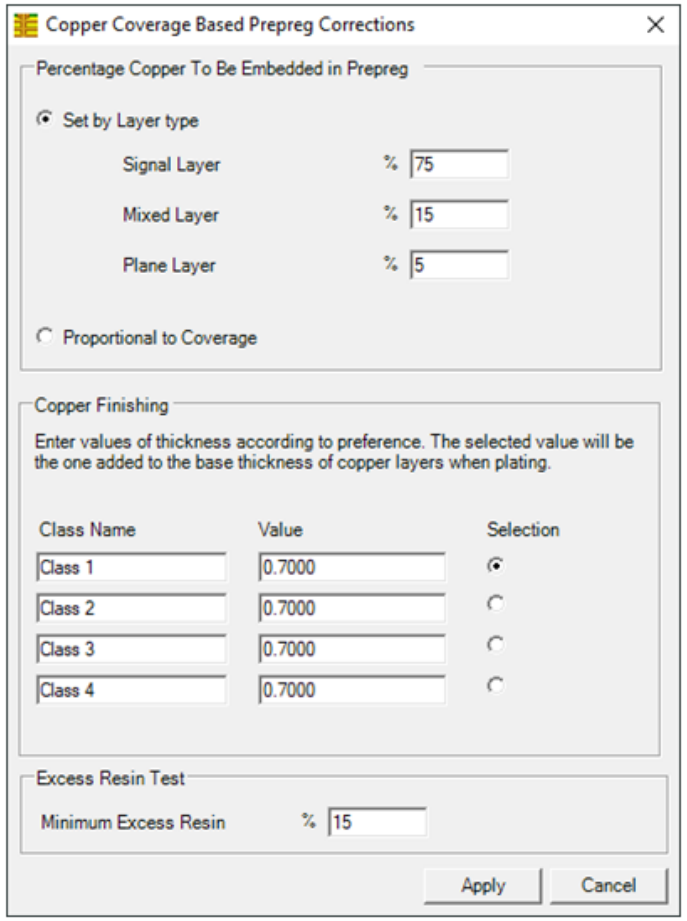
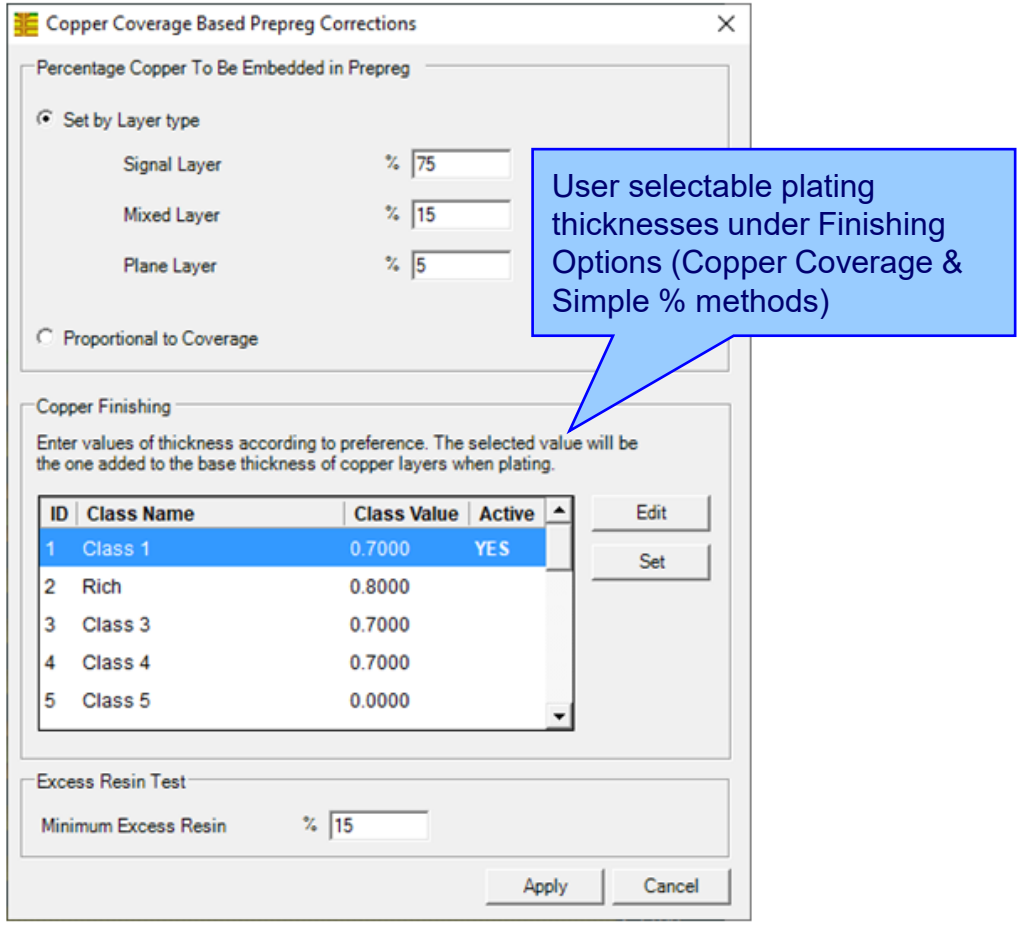
Copper Finishing classes increased



Speedstack v21.04 and earlier supported 4 classes



Speedstack v21.05 now supports 20 classes

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Import / Export enhancements

The following Import / Export options have been updated to support the layer name property introduced with Speedstack v21.05.06:

- XML STKX v21.00 and SSX v11.00 import / export options
- CSV export option
- Gerber / DXF export option

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Speedstack v21.04.00 (April 2021)

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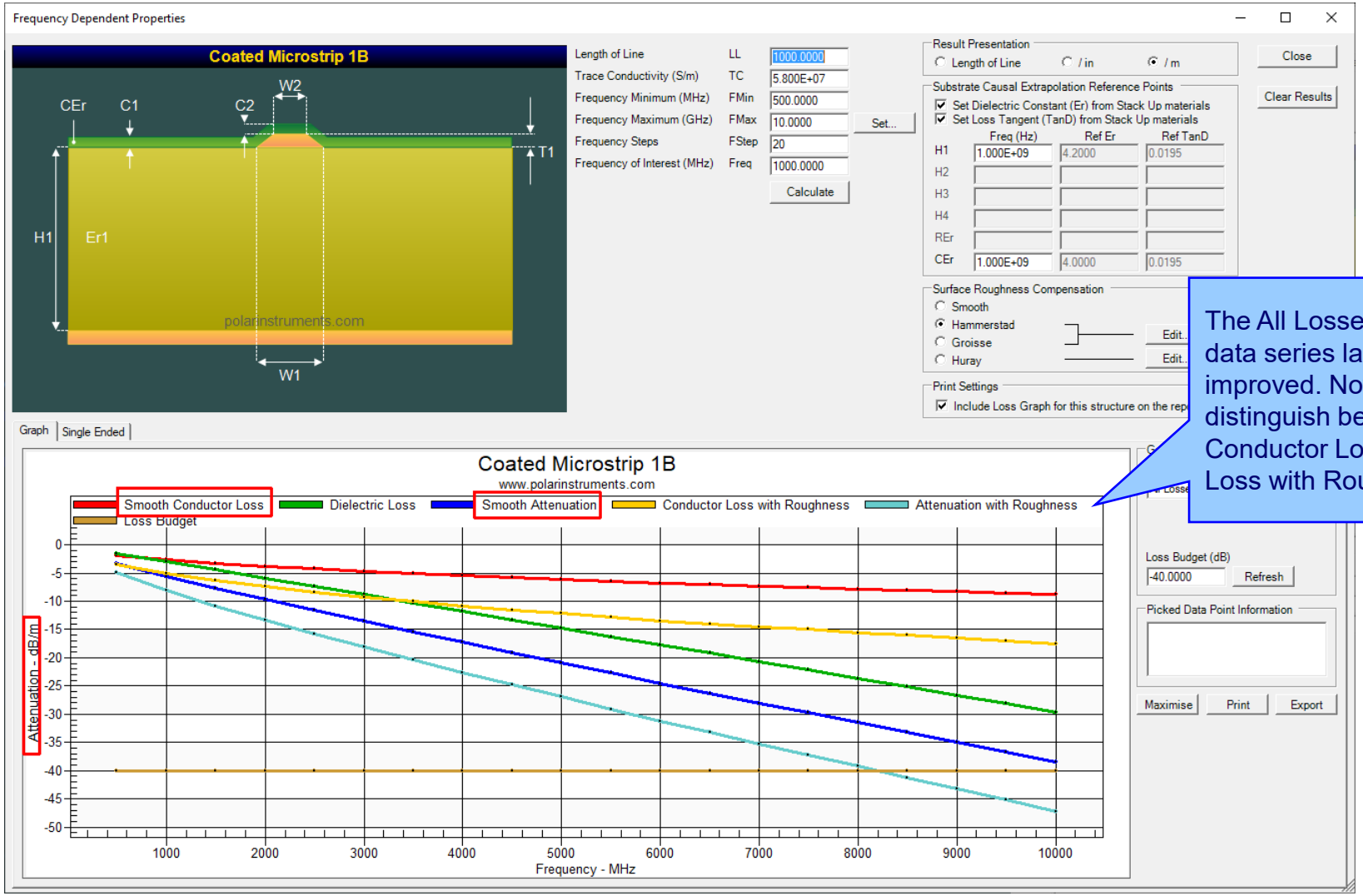
All Losses plot - clearer labelling



The All Losses plot y-axis and data series labelling has been improved. Now easier to distinguish between Smooth Conductor Loss and Conductor Loss with Roughness

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Other enhancements

- The controlled impedance and insertion loss Calculation Engine updated to the latest edition
- Frequency Dependent Calculations graphing library enhancements

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Speedstack v21.03.09 (March 2021)

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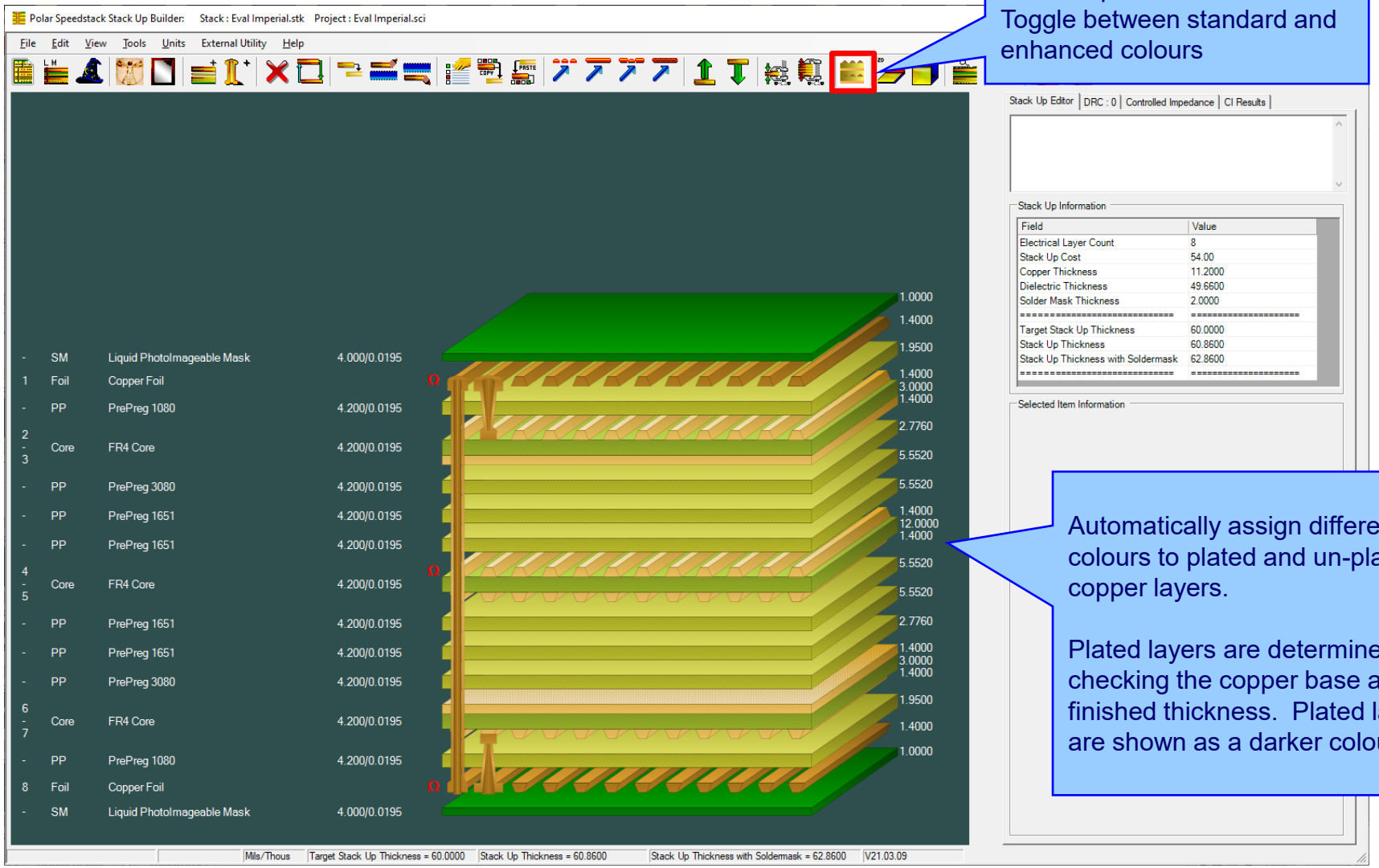
New Apply Plating Colours toolbar option



New Apply Plating Colours toolbar option.
Toggle between standard and enhanced colours

Automatically assign different colours to plated and un-plated copper layers.

Plated layers are determined by checking the copper base and finished thickness. Plated layers are shown as a darker colour

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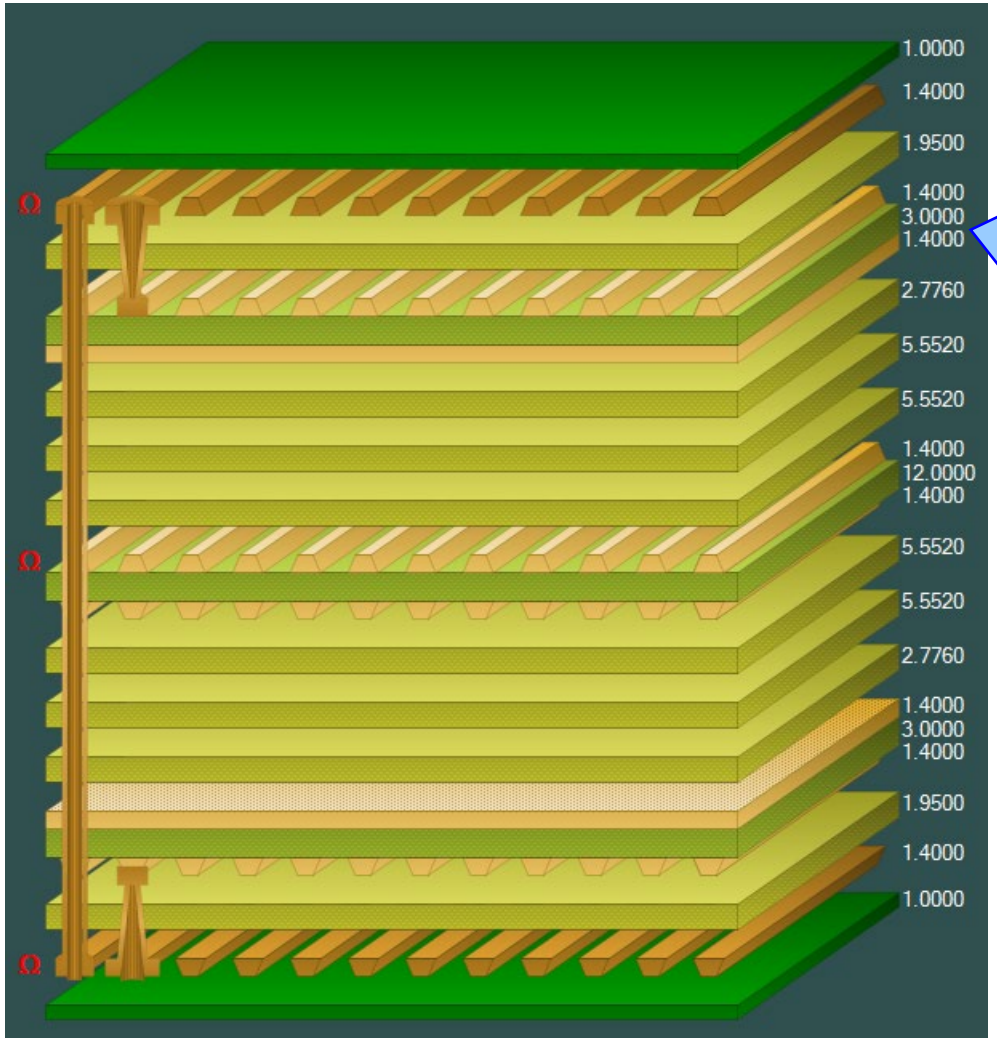
New Apply Plating Colours toolbar option



Plated Copper Layers

During PCB fabrication drill holes commonly have copper applied to the barrel wall by an electroplating process. This provides an interconnect between copper layers in the stack up.

This electroplating process often results in additional copper also being applied to the exposed copper layers where the mechanical drill starts / ends.

It is important to account for this additional plated copper thickness when calculating the overall stack up thickness and controlled impedance / insertion loss structures.

Speedstack has always allowed this additional plating thickness to be applied to the relevant copper layers. With v21.03 this has been enhanced further with automatic colour assignments to the plated and un-plated layers

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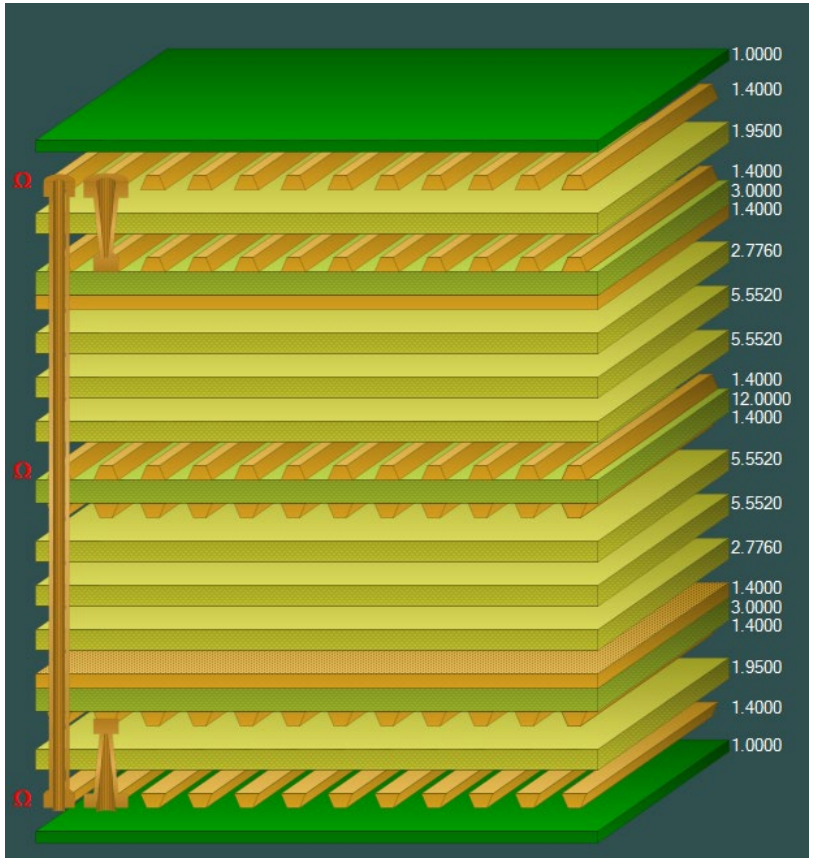
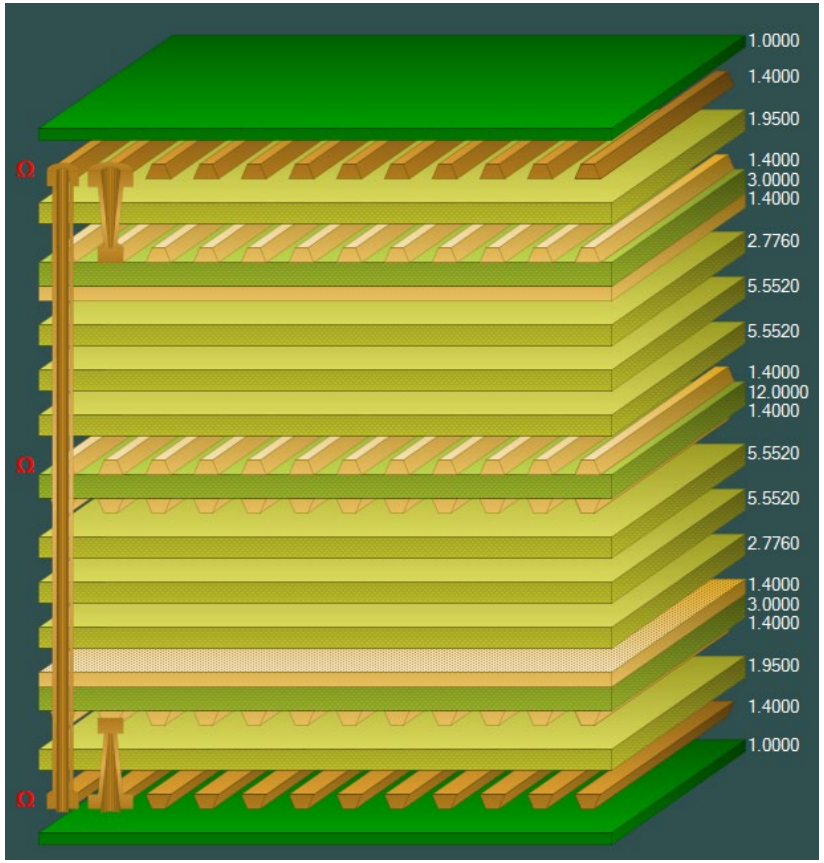
New Apply Plating Colours toolbar option

Standard Colours



Apply Plating Colours



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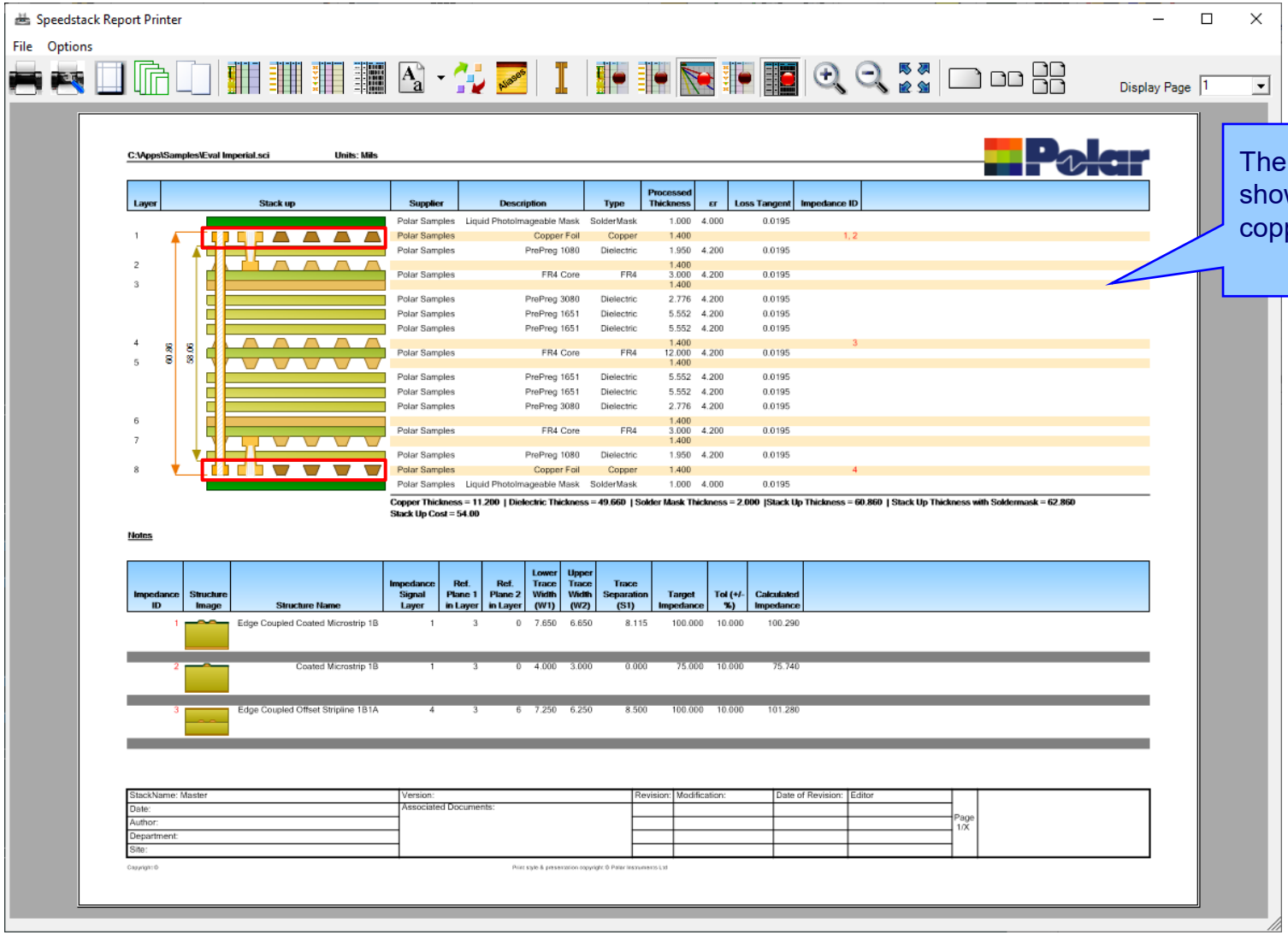
New Apply Plating Colours toolbar option



The technical report will also show the plated and un-plated copper layers.

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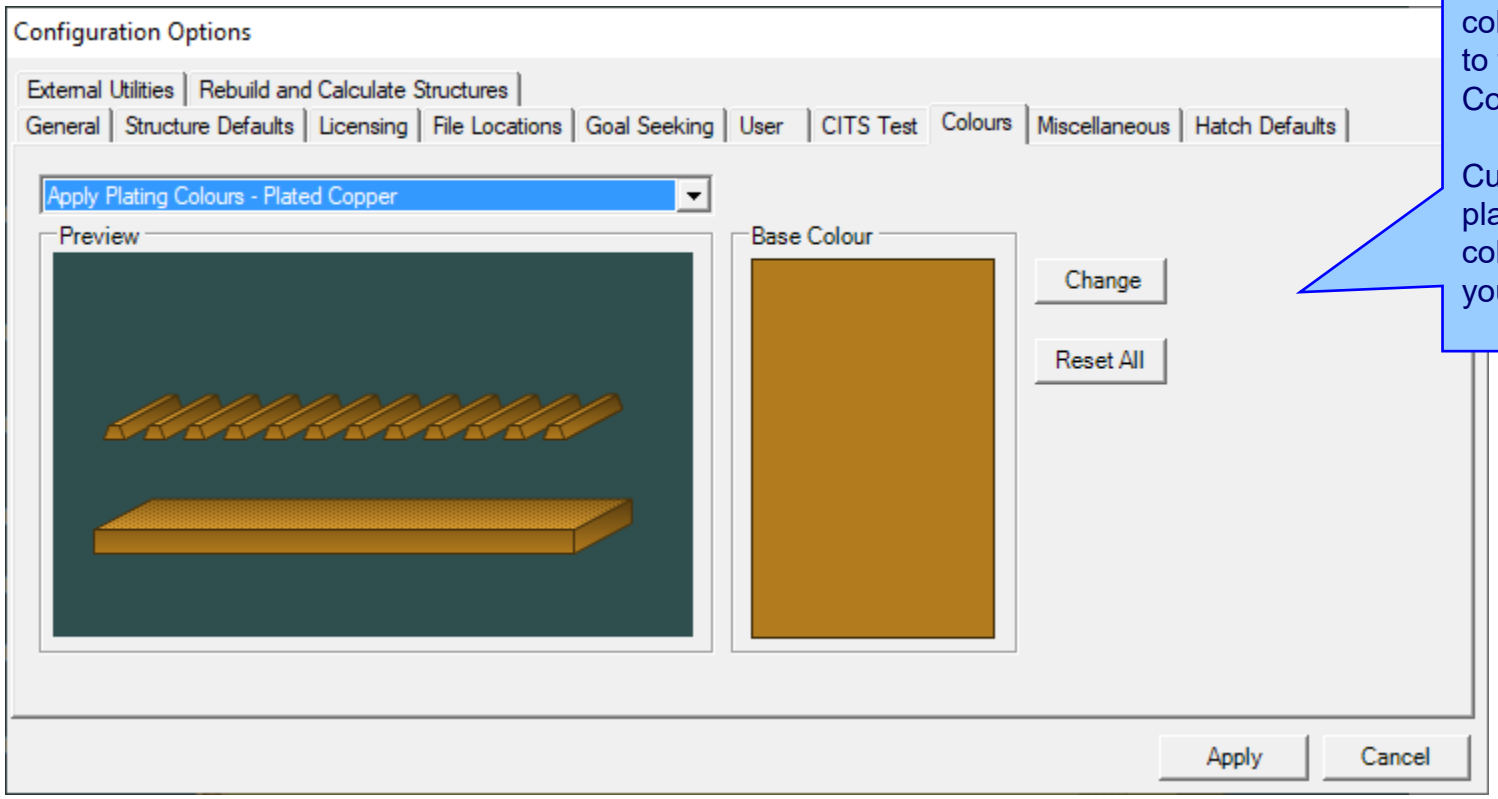
New Apply Plating Colours toolbar option



Two new user-definable colours have been introduced to the Speedstack Configuration Options.

Customise the Plated and Un-plated colours to suit existing colour schemes adopted by your organisation

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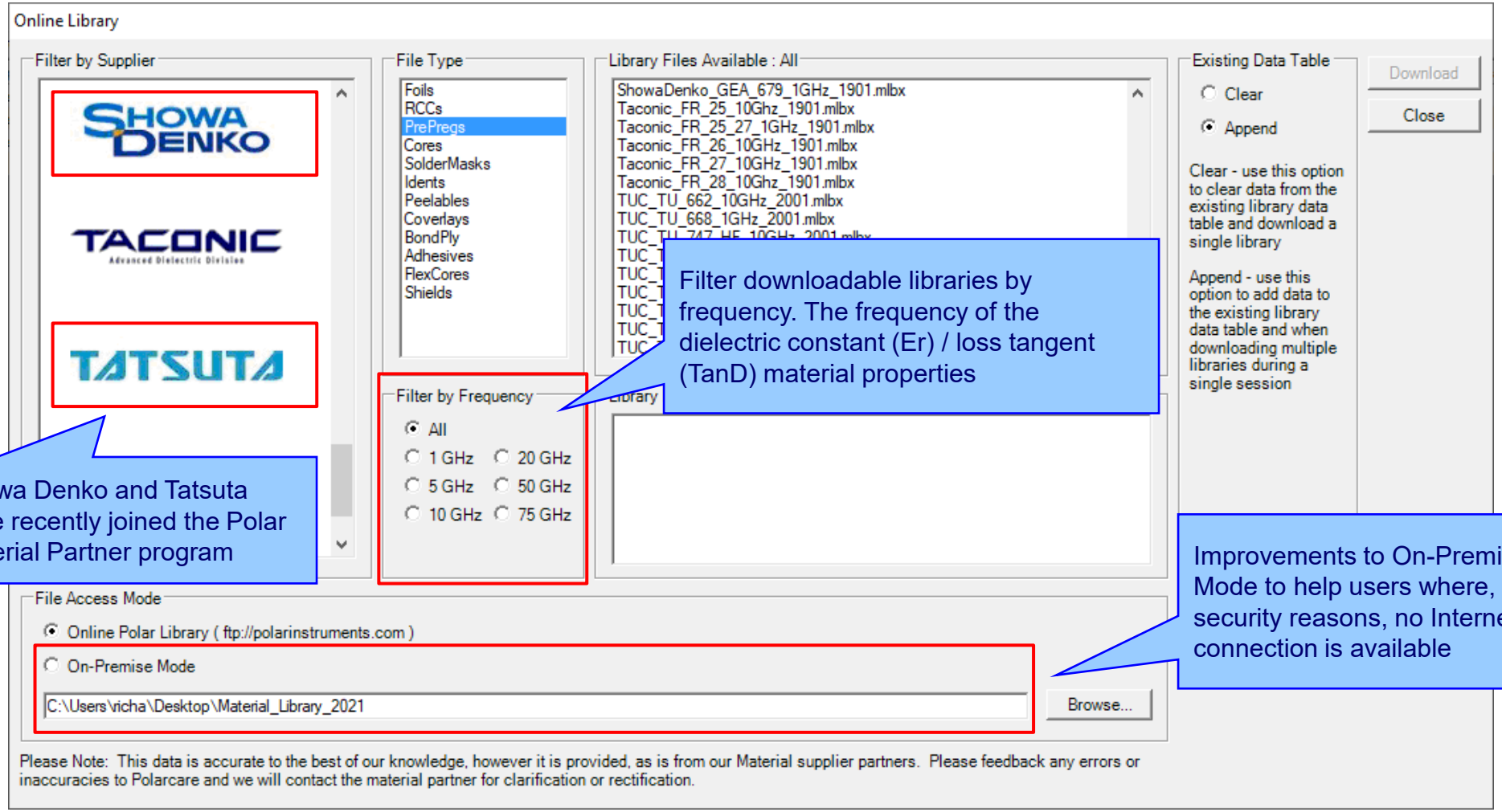
Online Library enhancements



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Speedstack v21.02.01 (February 2021)

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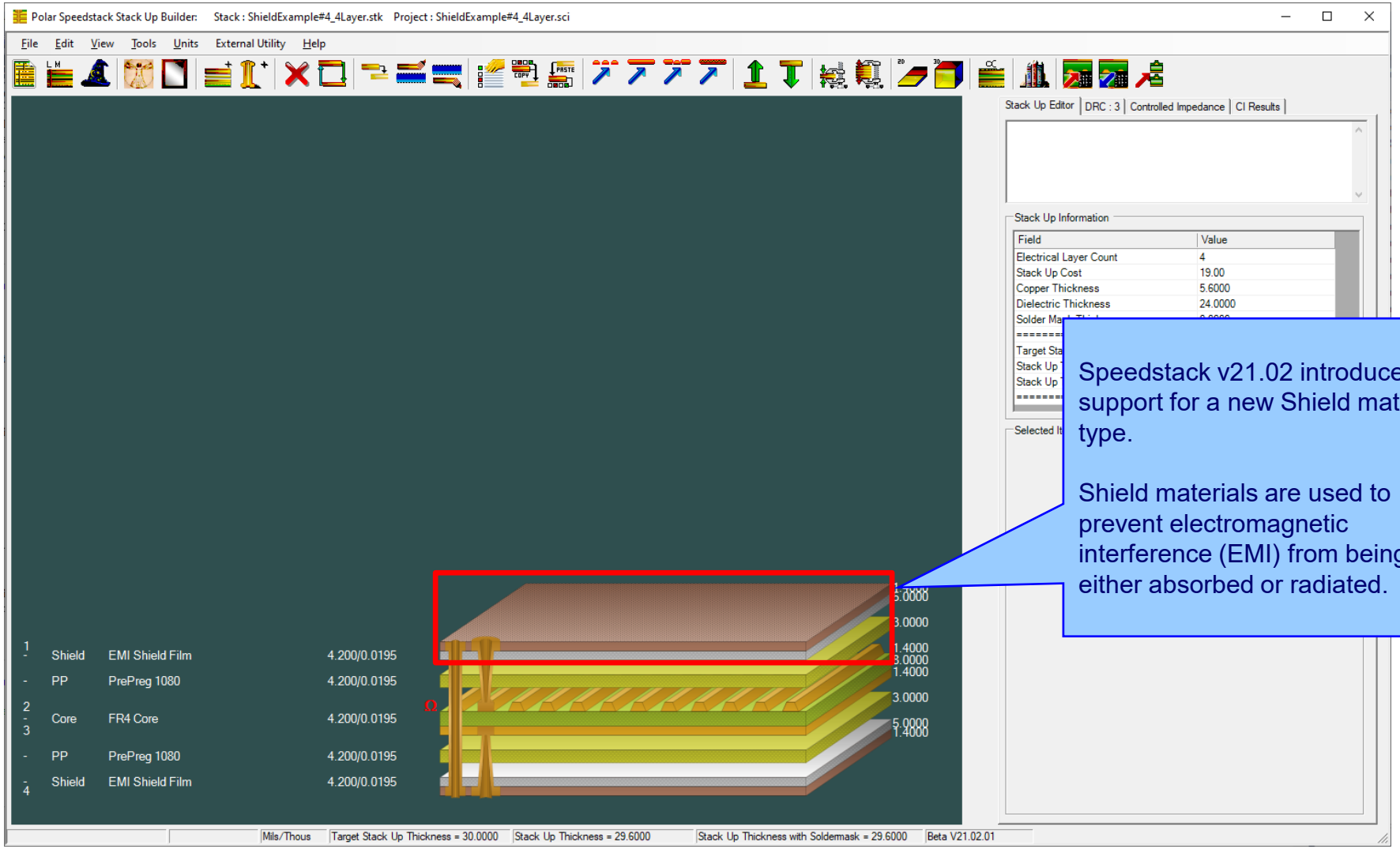
New Shield material



Speedstack v21.02 introduces support for a new Shield material type.

Shield materials are used to prevent electromagnetic interference (EMI) from being either absorbed or radiated.

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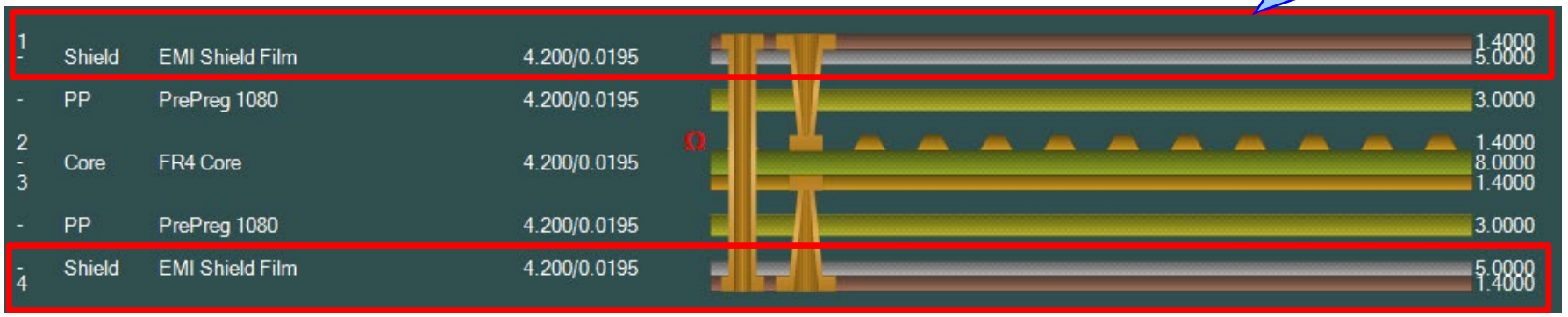
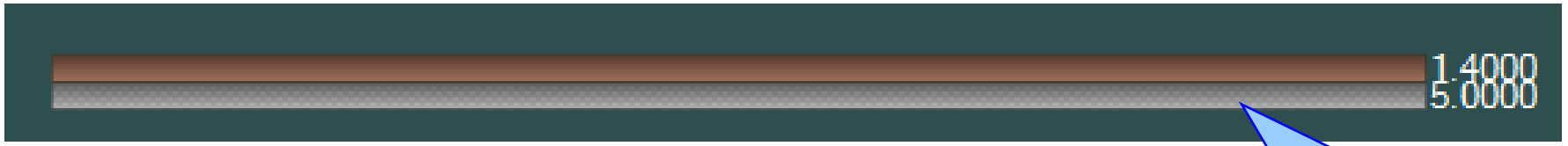
New Shield material

Shields are typically applied to the outer layer(s) of the stack up





They consist of a shield layer (brown) and dielectric adhesive (silver)

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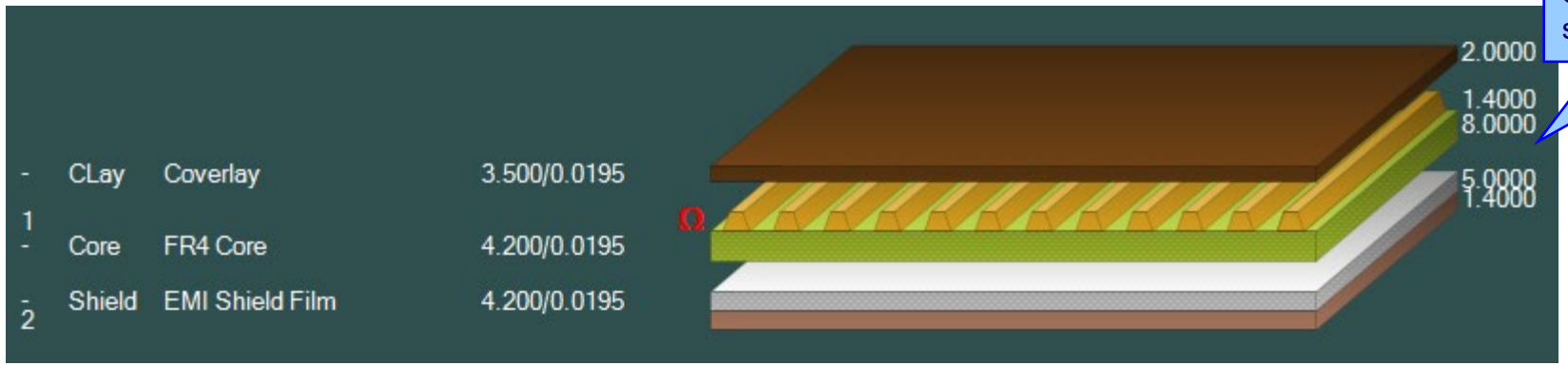
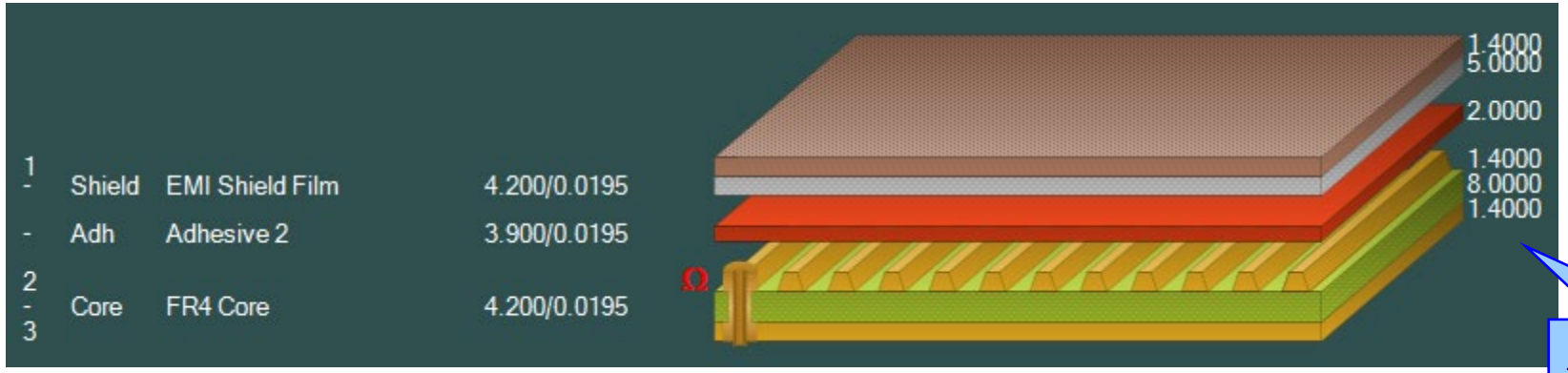
Shield material examples



Example #1
Single-sided core, coverlay above trace, shield below



Example #2
Double-sided core, adhesive and shield above

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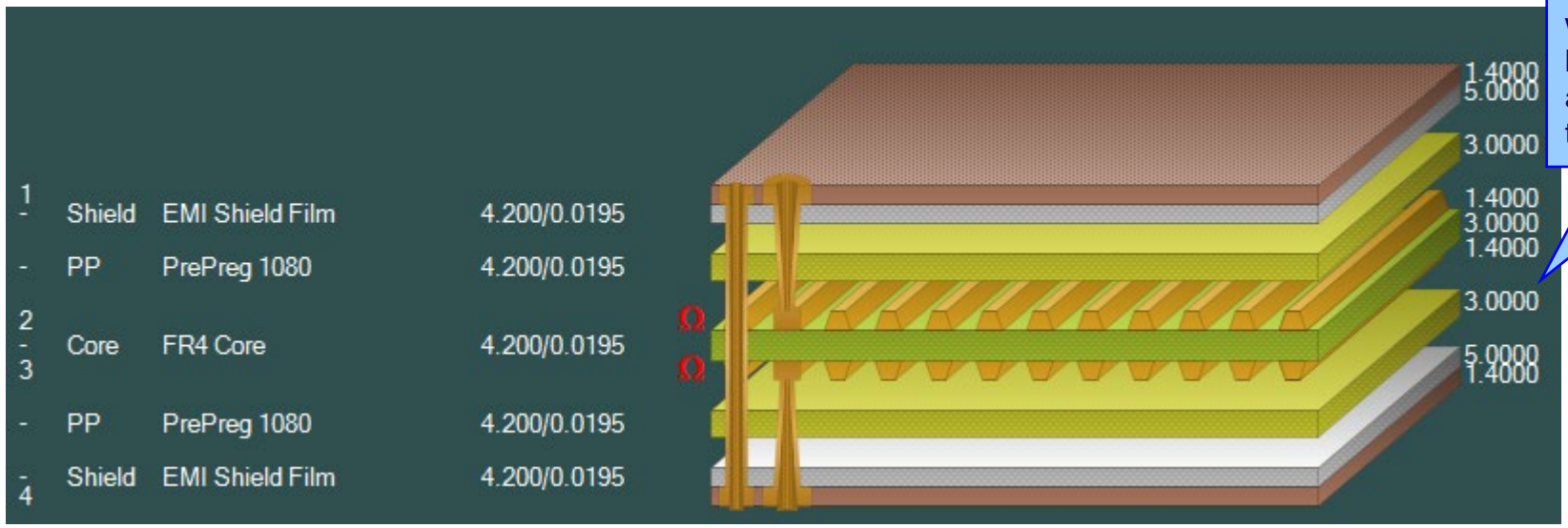
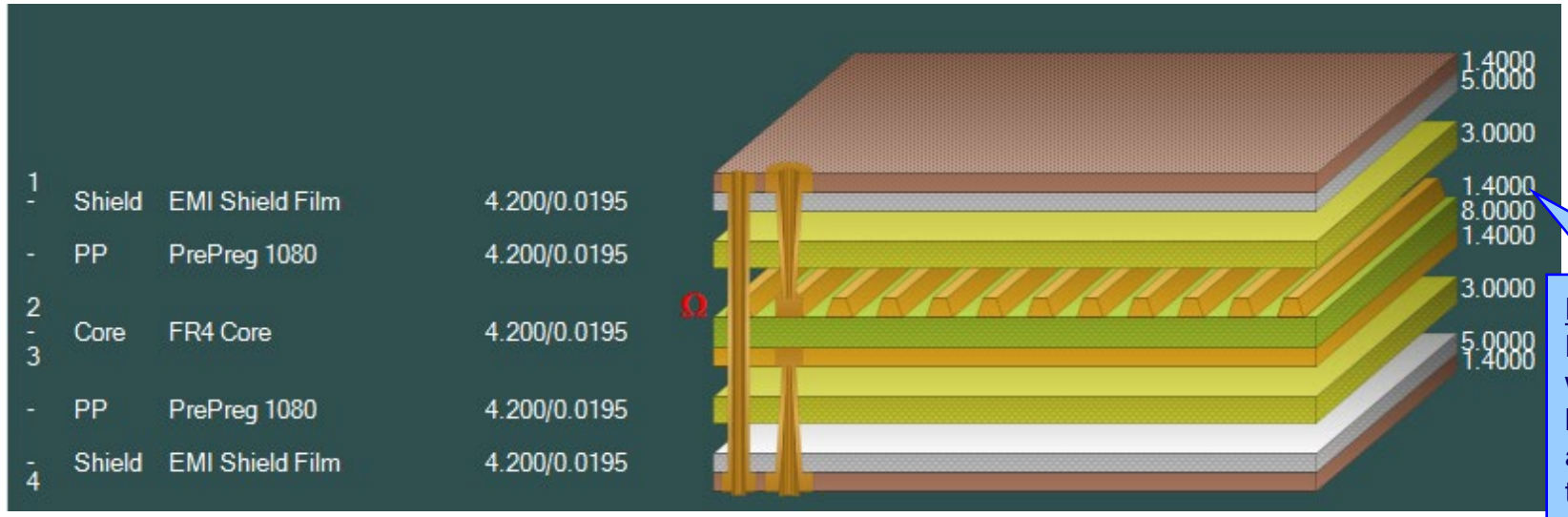
Shield material examples



Example #3
Double-sided core with two signal trace layers with shield above and below trace layers



Example #4
Double-sided core with one signal trace layer with shield above and below trace layers

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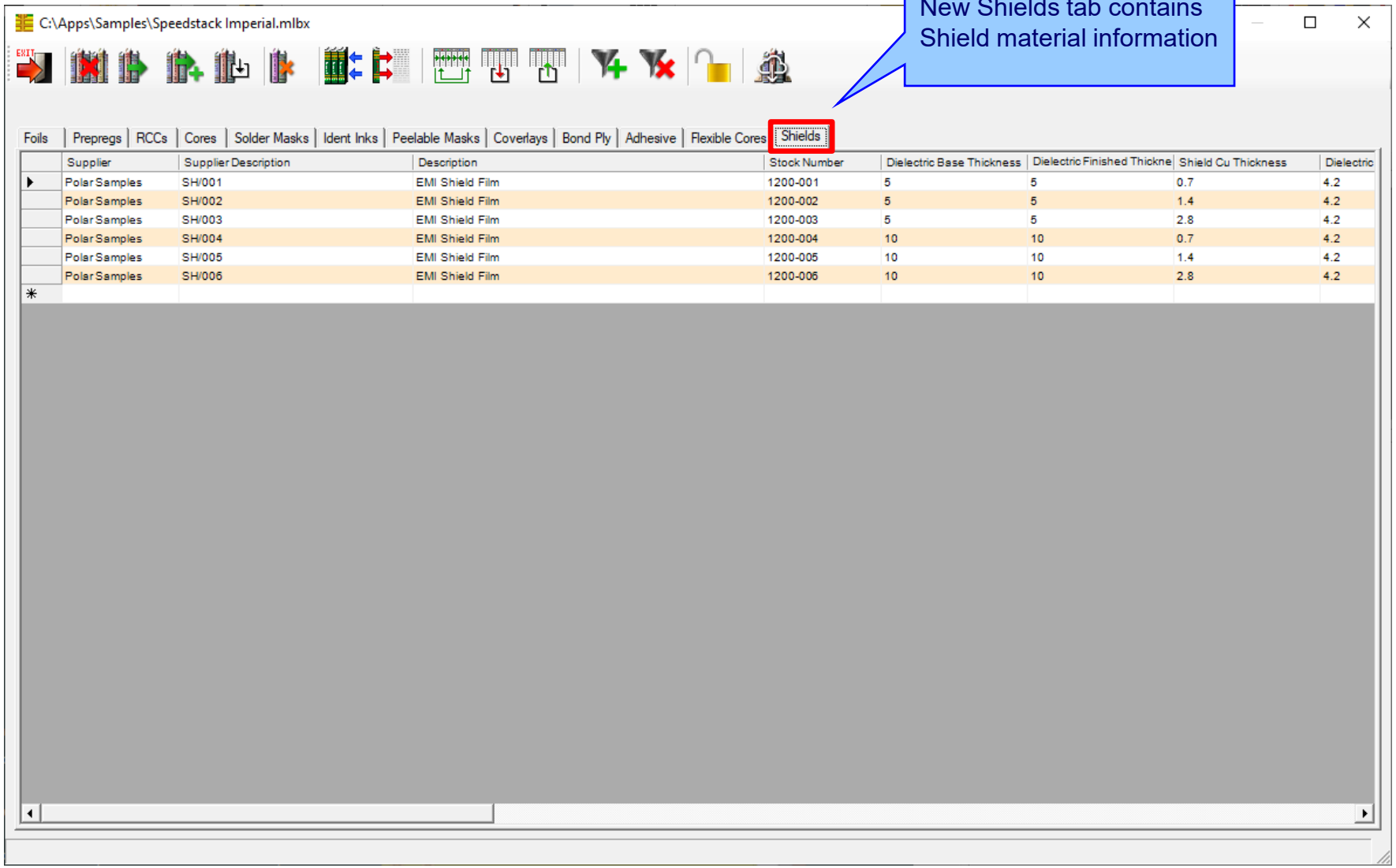
Material library enhancements



Supplier	Supplier Description	Description	Stock Number	Dielectric Base Thickness	Dielectric Finished Thickne	Shield Cu Thickness	Dielectric
Polar Samples	SH/001	EMI Shield Film	1200-001	5	5	0.7	4.2
Polar Samples	SH/002	EMI Shield Film	1200-002	5	5	1.4	4.2
Polar Samples	SH/003	EMI Shield Film	1200-003	5	5	2.8	4.2
Polar Samples	SH/004	EMI Shield Film	1200-004	10	10	0.7	4.2
Polar Samples	SH/005	EMI Shield Film	1200-005	10	10	1.4	4.2
Polar Samples	SH/006	EMI Shield Film	1200-006	10	10	2.8	4.2

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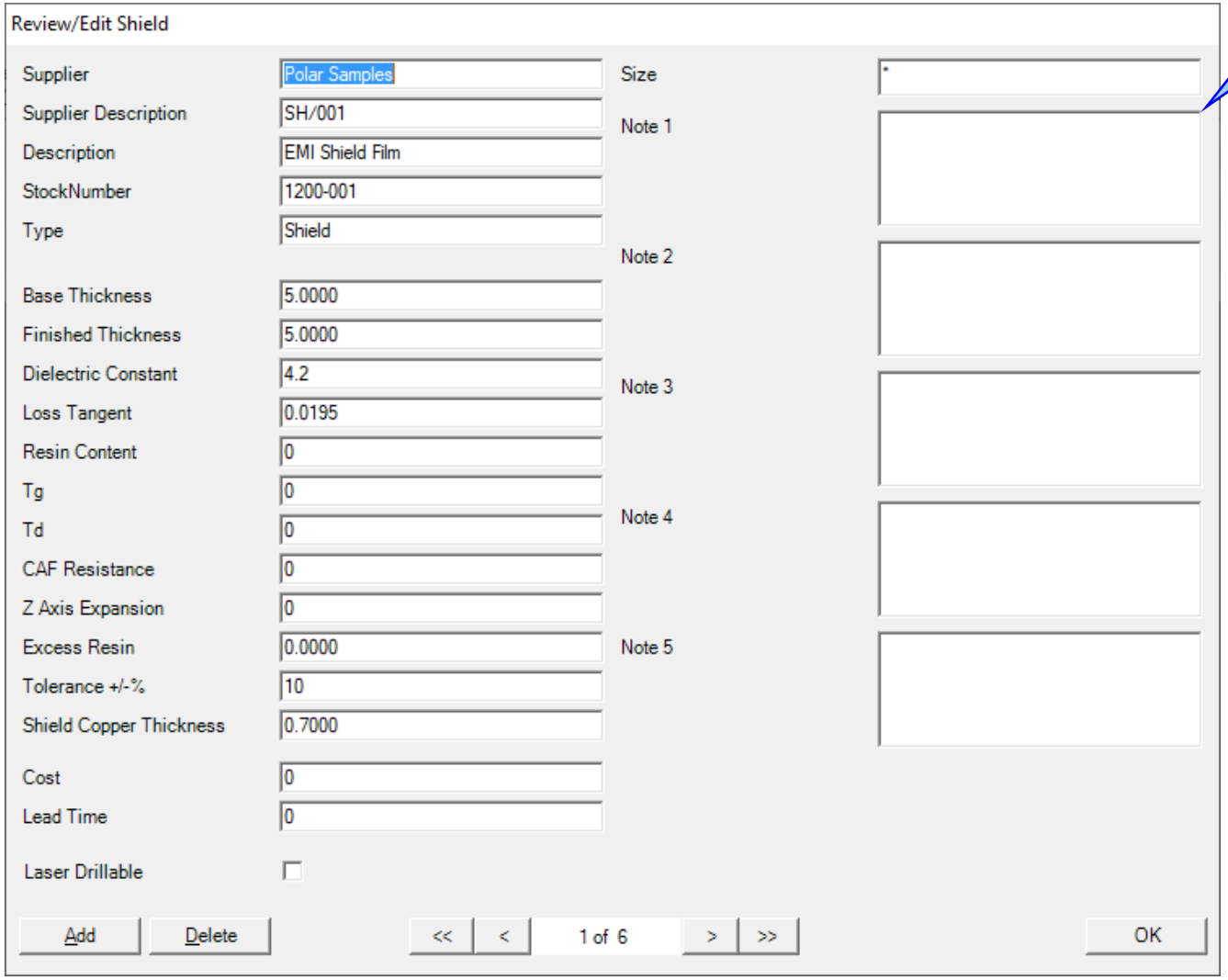
Material library enhancements



Material library Edit Shield dialog

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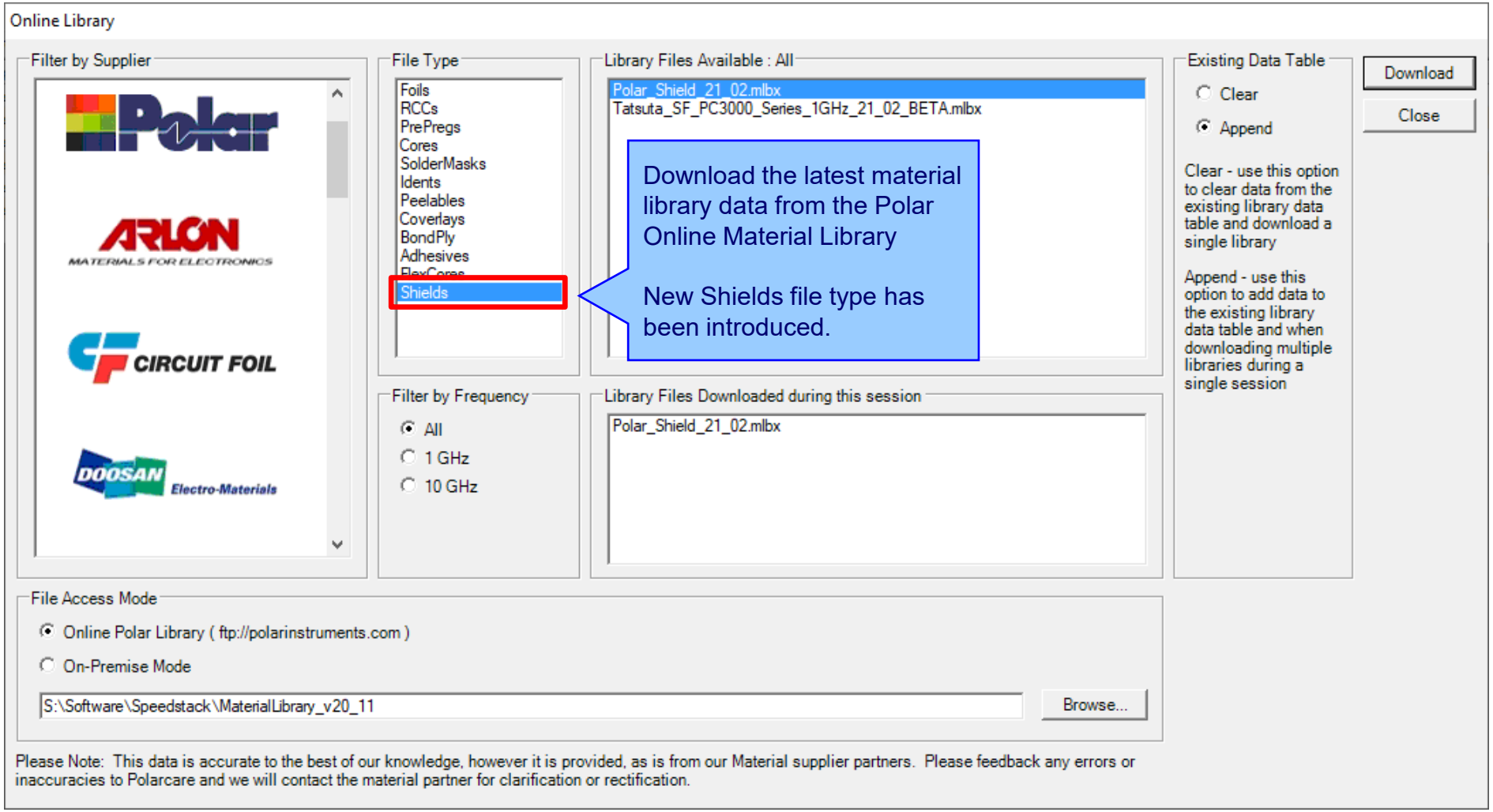
Online Library enhanced to support Shield materials



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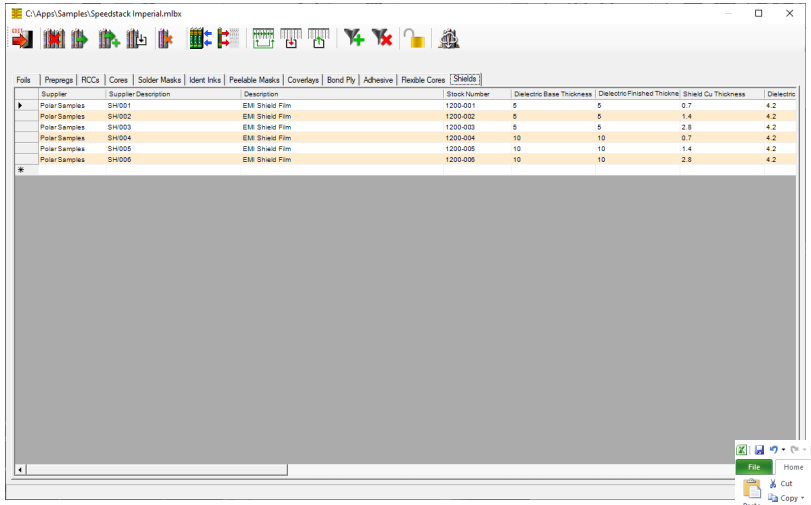
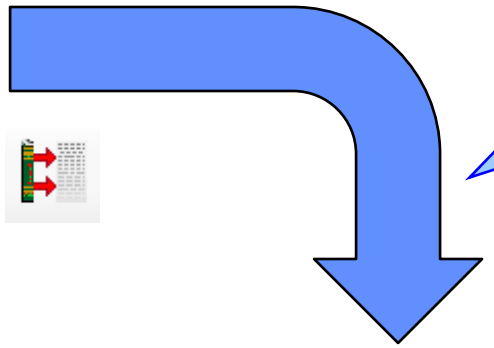
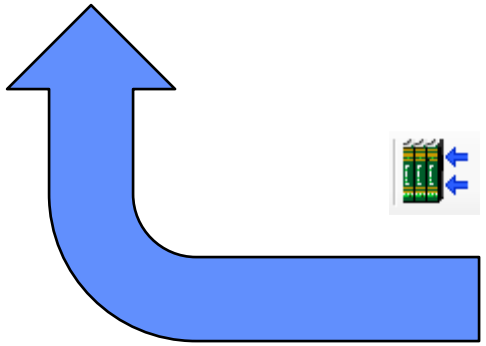
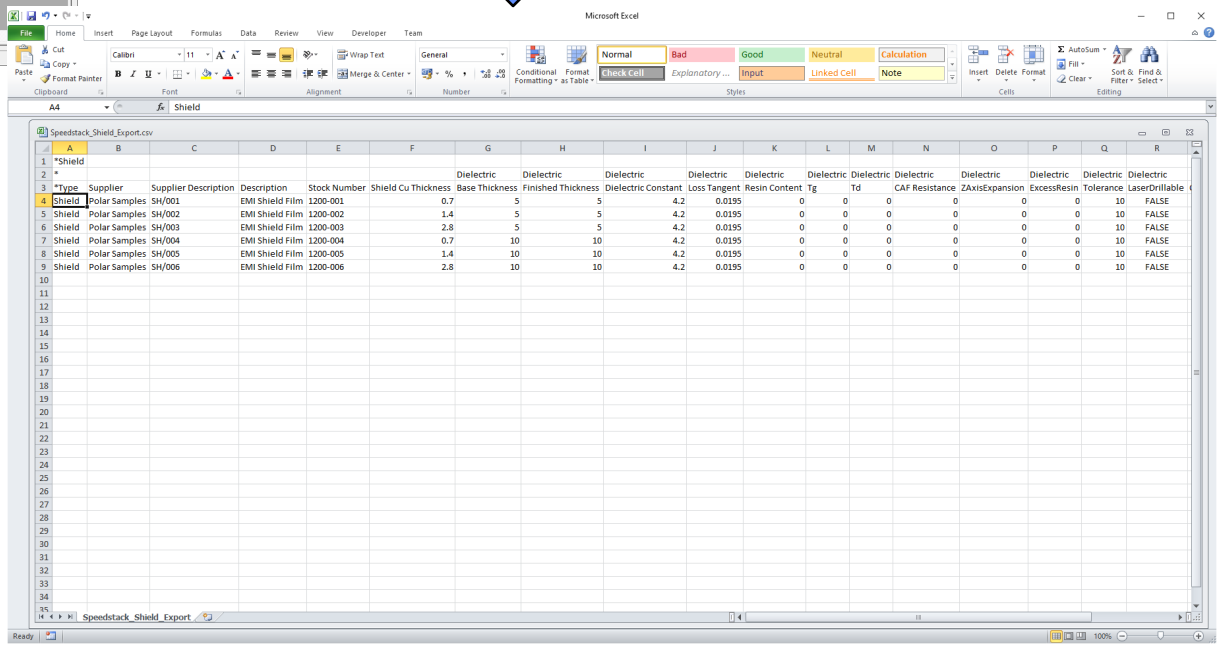
Export / Import Shield library to Excel





It is possible to export / import Shield library data with 3rd part tools like Excel





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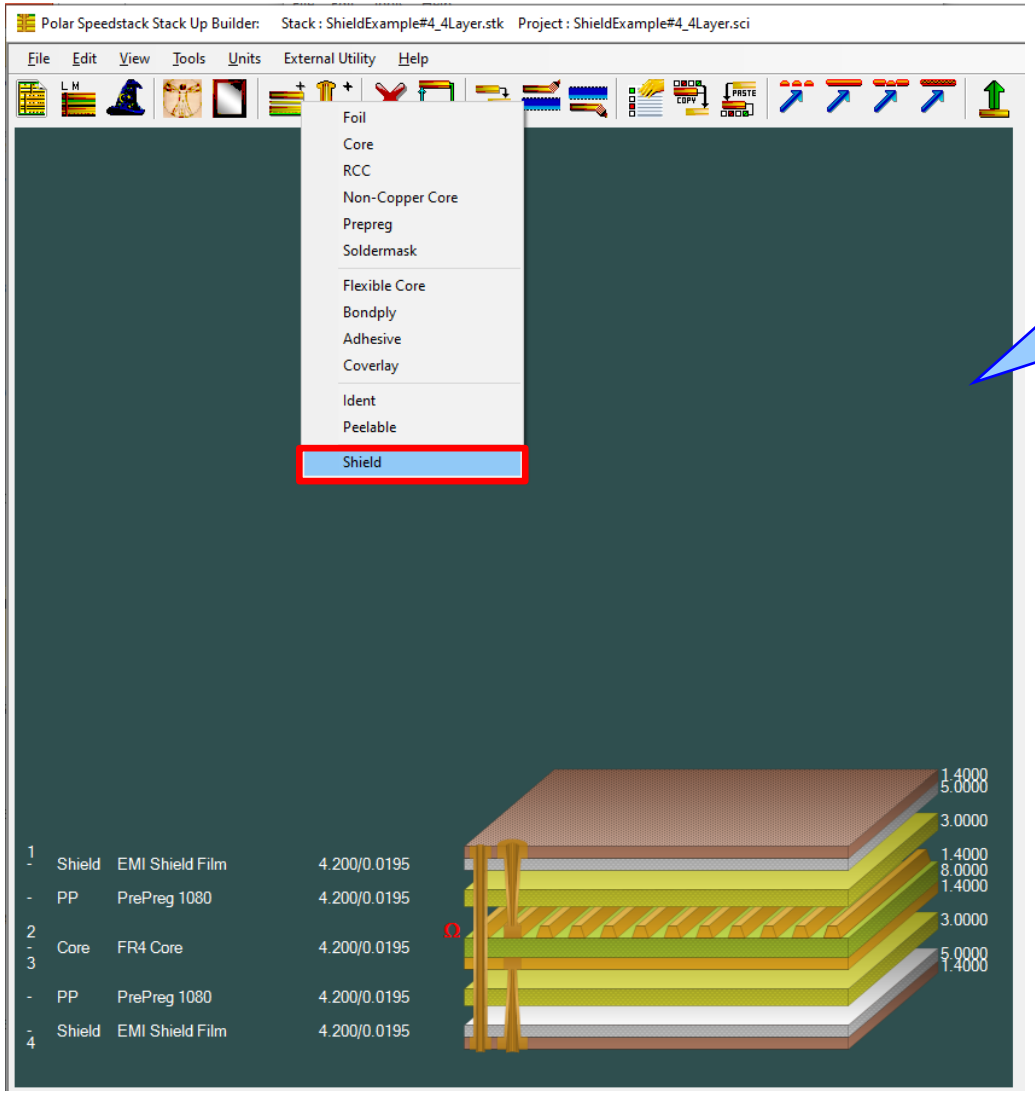
Stack up editor enhancements



Stack Up editor enhancements:

Shield material options to add, delete, swap, move up, move down, symmetry and set properties

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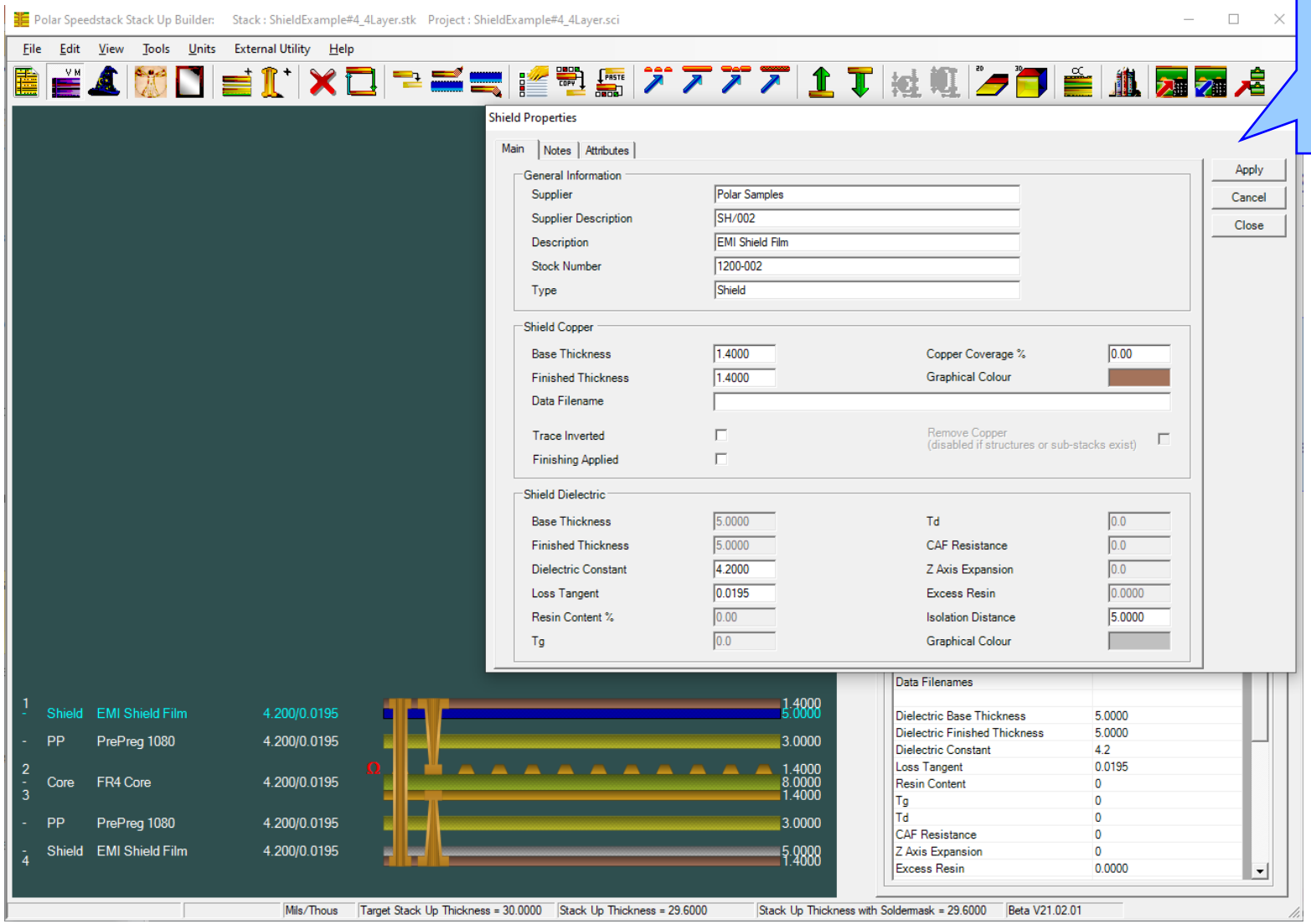
Shield properties



View and customise the Shield properties. Useful in 'what-if' scenarios

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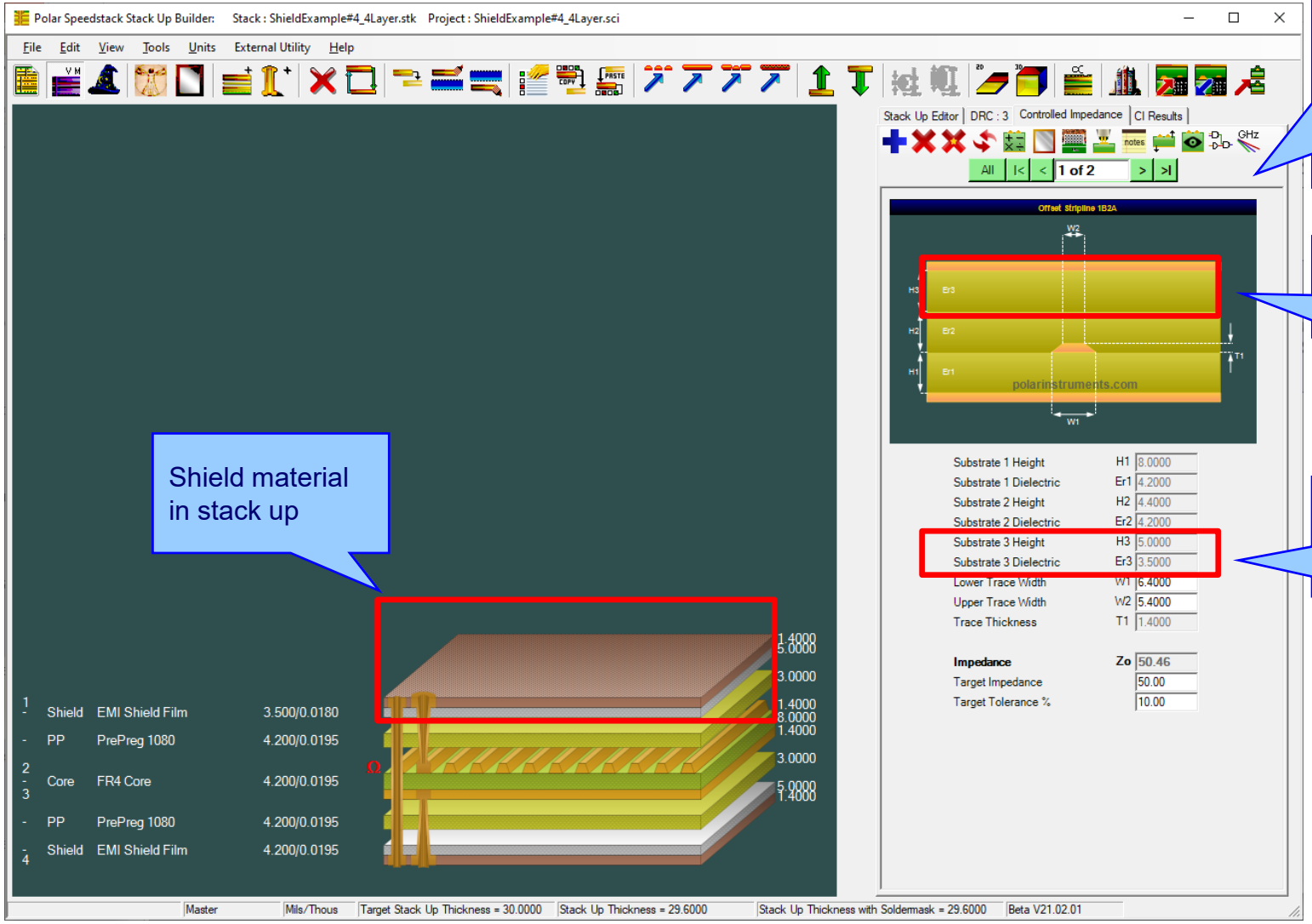
Controlled impedance and insertion loss calculations



Impedance and insertion calculations support the new Shield material type.

Shield material region of structure.

Shield adhesive height / thickness dimension and dielectric constant.

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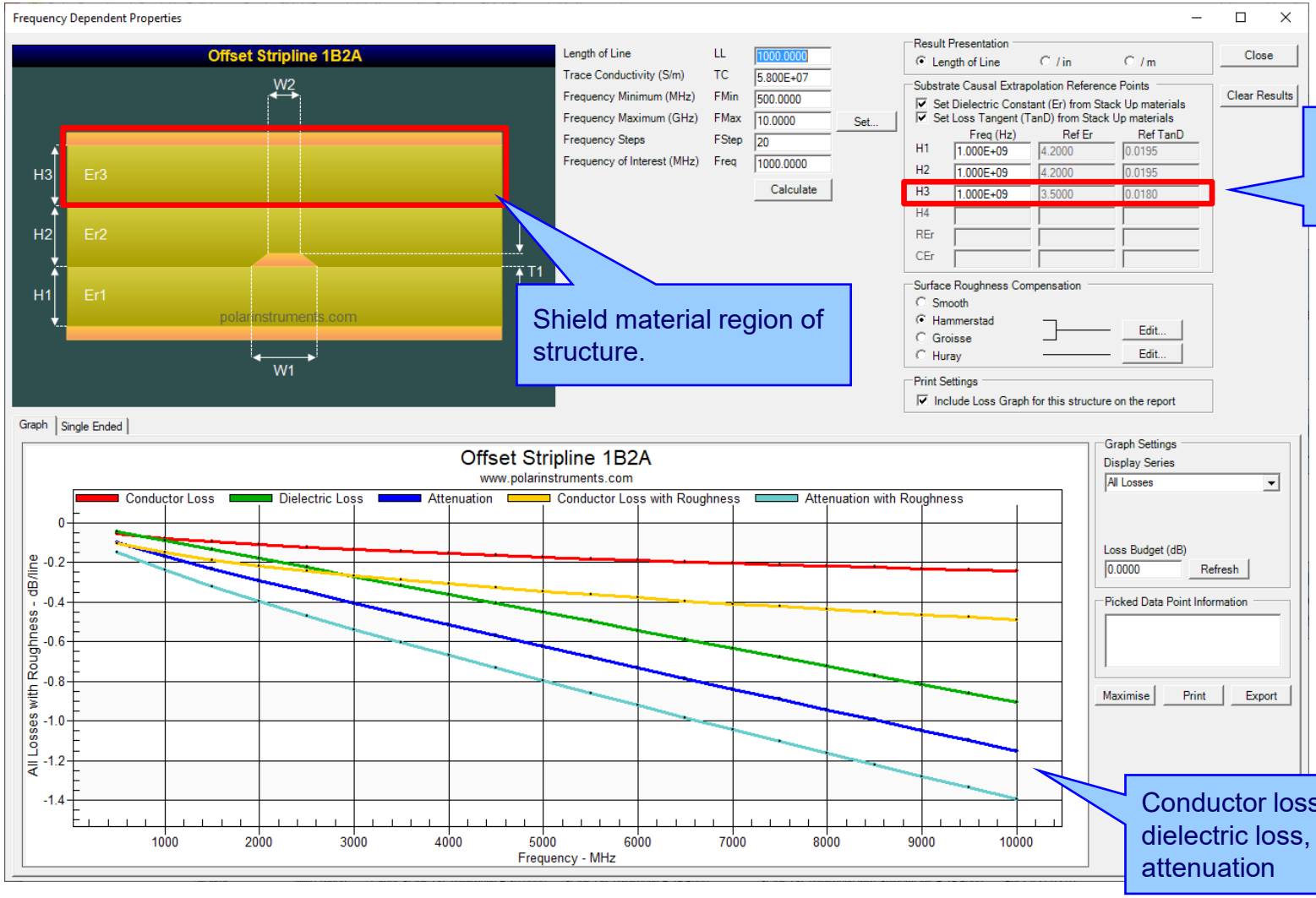
Controlled impedance and insertion loss calculations



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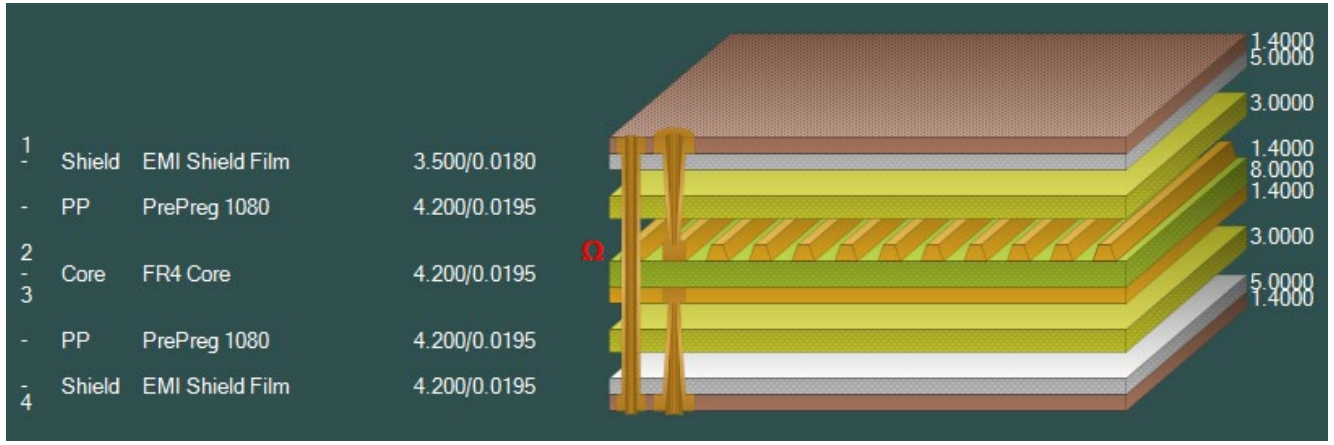
Controlled impedance and insertion loss calculations

Please note: Speedstack is capable of supporting many shield types for stack up design and documentation. However, it is important to use the correct type of shield material for controlled impedance and insertion loss applications. They are often designated by the shield vendor as 'for high speed signal transmission applications'.



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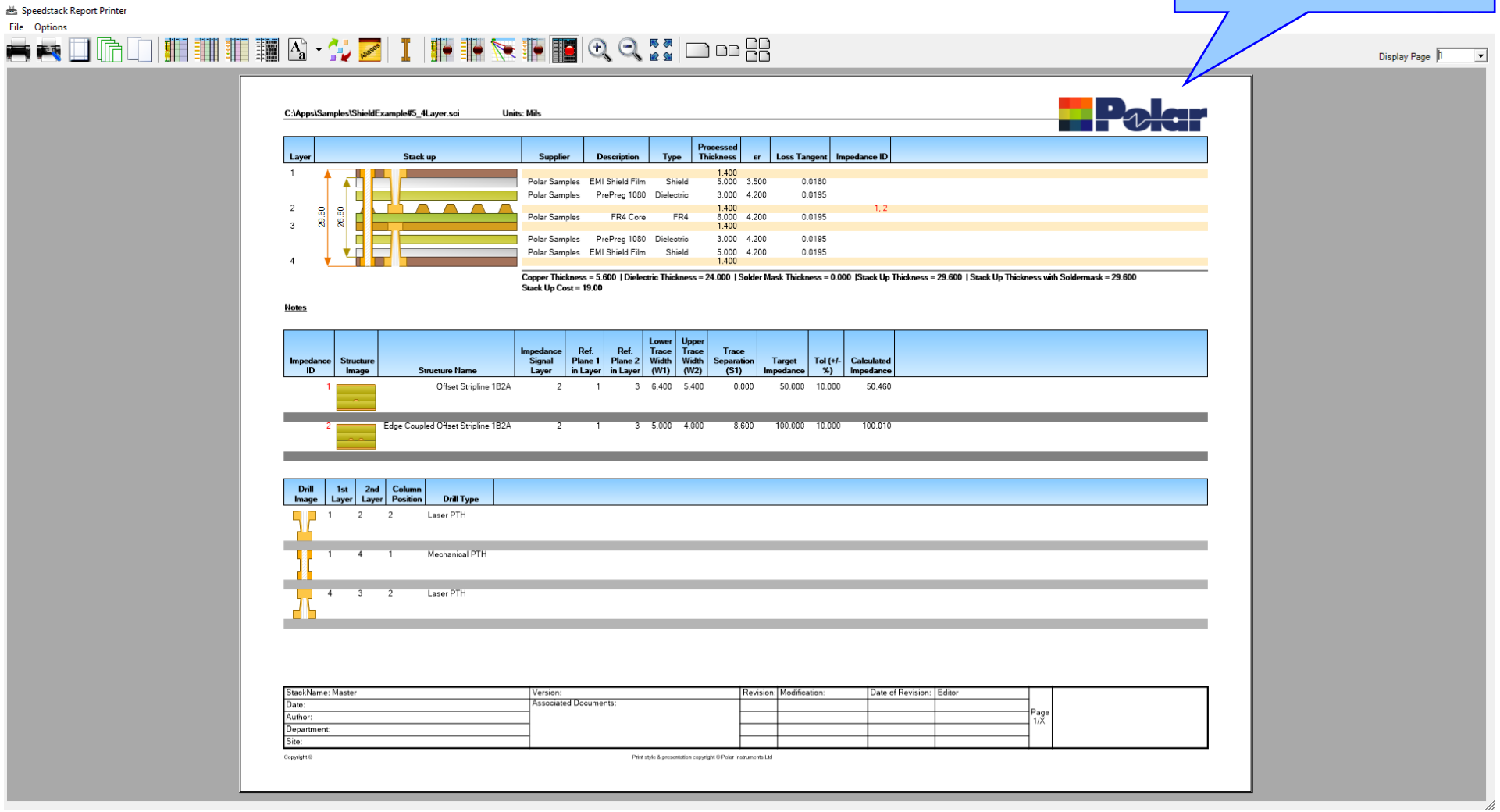
Technical report enhancements

Technical report showing shield materials



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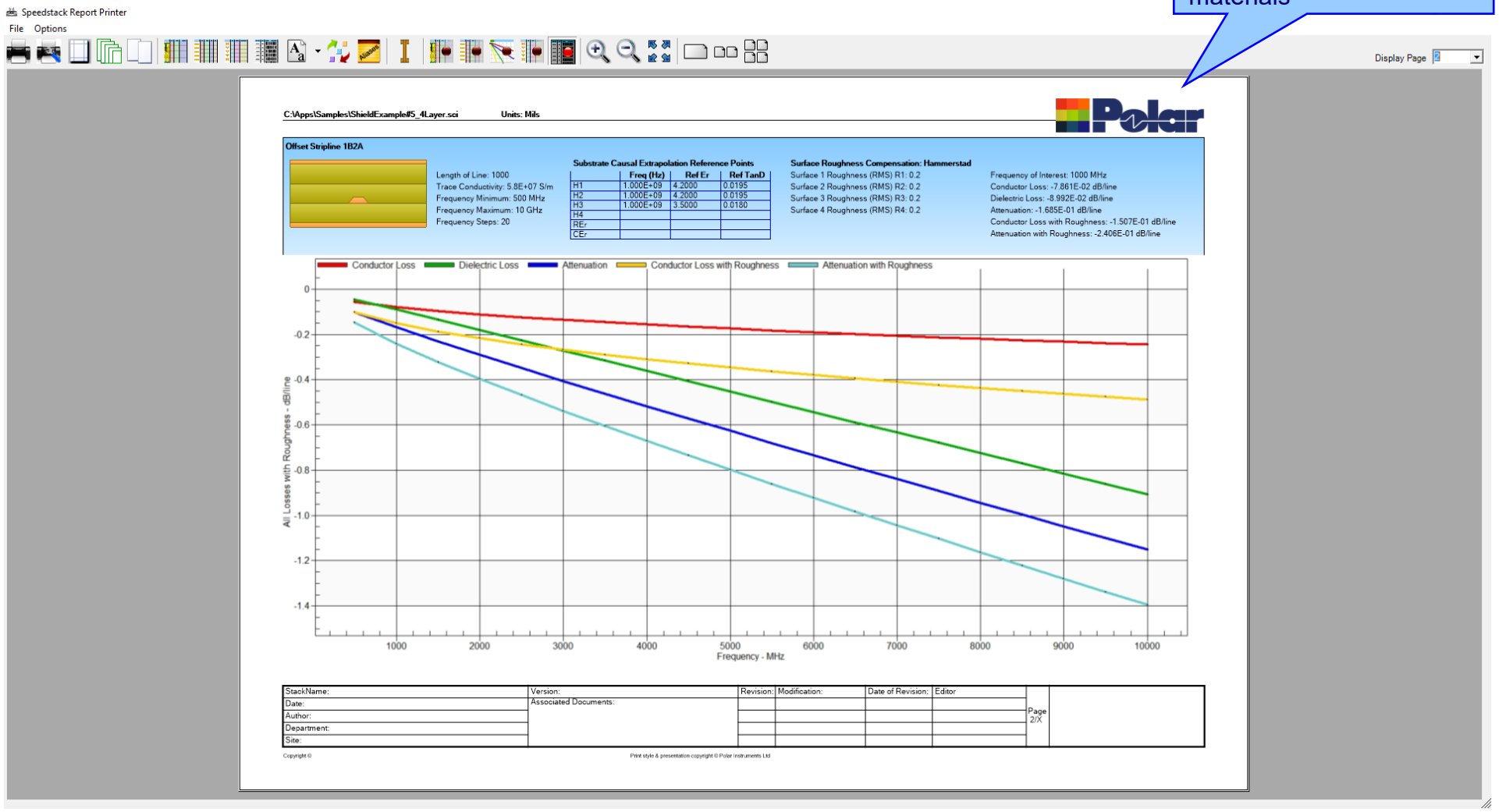
Technical report enhancements

Insertion loss report supporting shield materials



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Import / Export enhancements

The following Import / Export options have been updated to support the new shield material introduced with Speedstack 2021:

- XML STKX v20.00 and SSX v10.00 import / export options
- CSV export option
- Gerber / DXF export option

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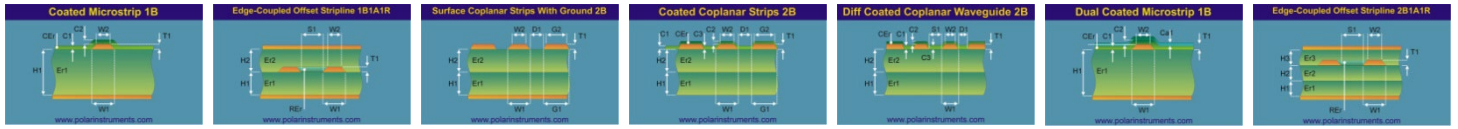

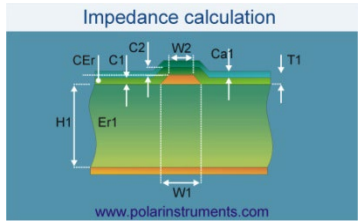

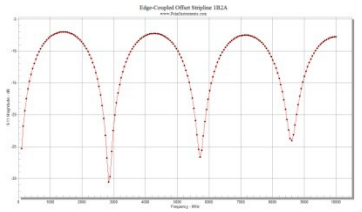

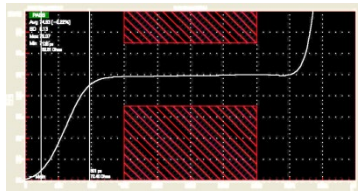

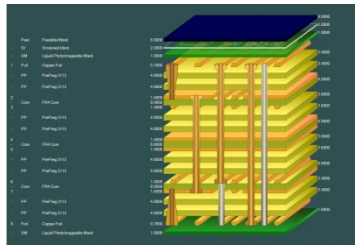

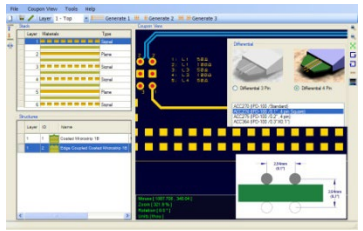

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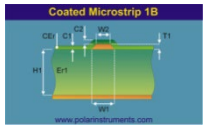

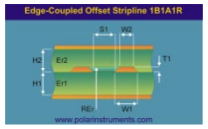

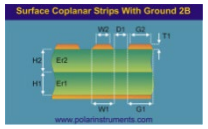

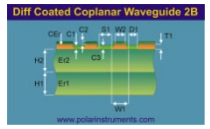

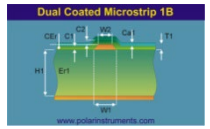

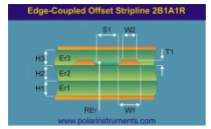

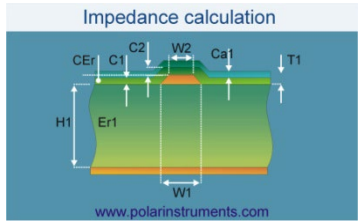

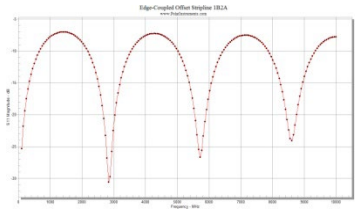

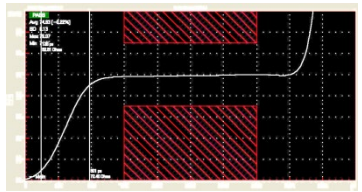

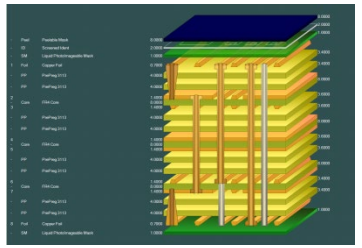

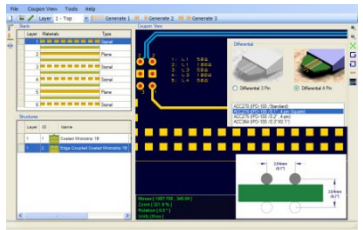

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